

The MEG II Cylindrical Drift CHamber (CDCH)

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Mini Workshop MEG CDCH - BELLE II CDC

26/09/2024

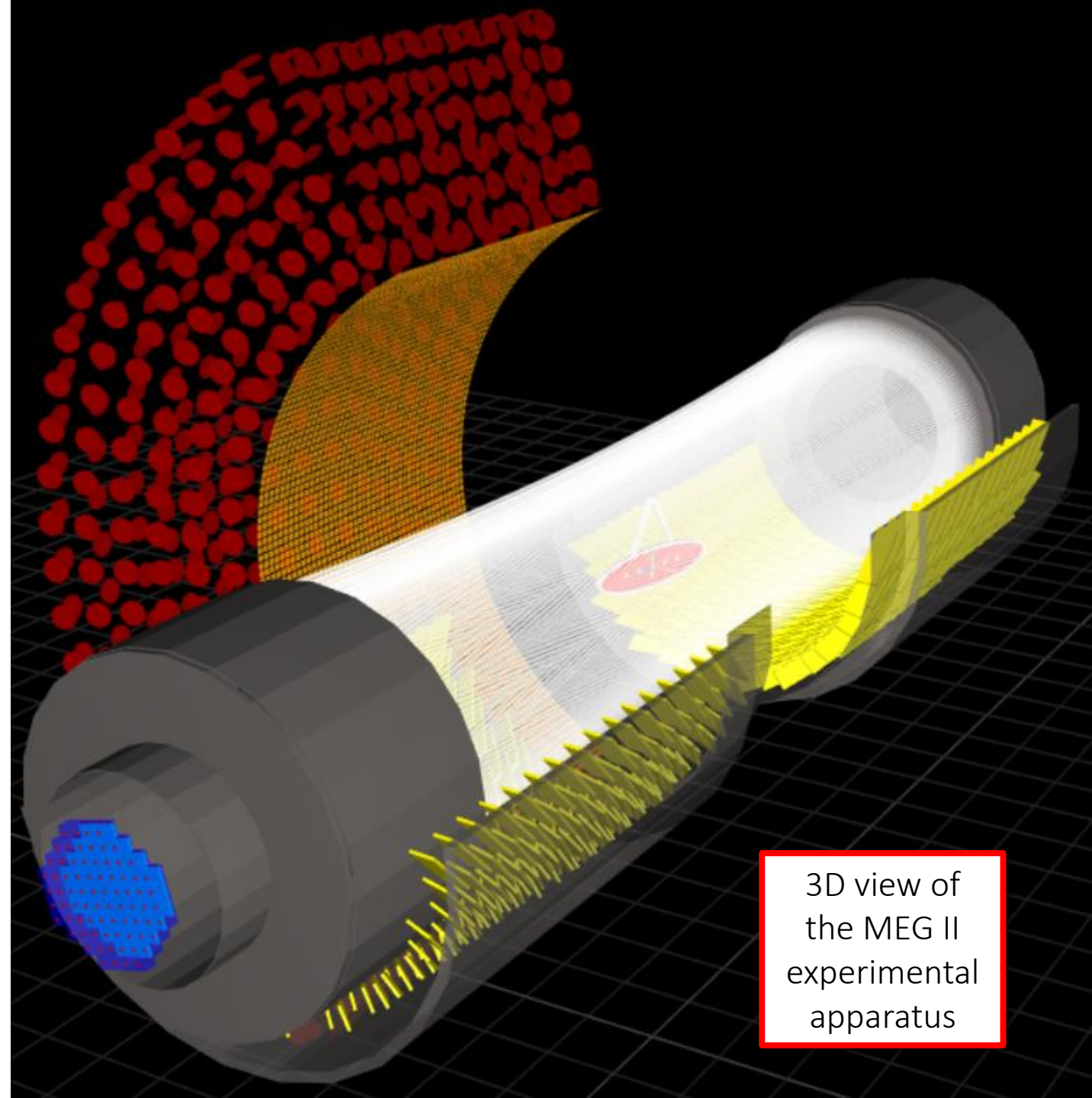


Istituto Nazionale di Fisica Nucleare



Outline

- Introduction to the MEG II experiment
- The MEG II Cylindrical Drift CHamber (CDCH)
 - Detector performance
 - New design concept and wiring
 - Assembly at INFN Pisa
 - Commissioning phase at the Paul Scherrer Institut (PSI)
 - Integration into the experimental apparatus
- Investigations on wire breakages
- Investigations on anomalous currents
- Ageing studies
- Conditioning with beam
- Physics data taking and measured performance
- Conclusions and prospects



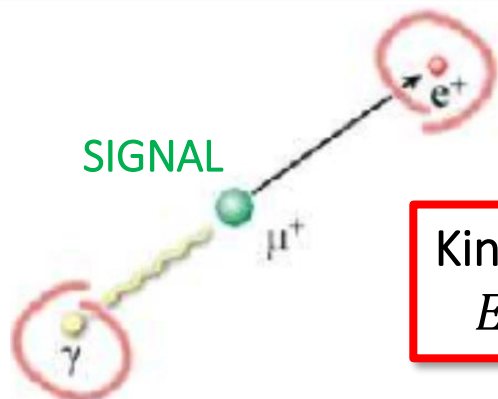
3D view of the MEG II experimental apparatus

Introduction to the MEG II experiment

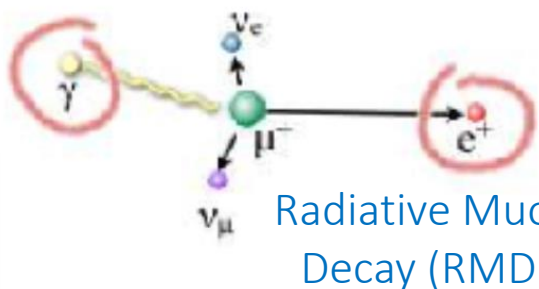
The $\mu^+ \rightarrow e^+ \gamma$ decay

- Lepton Flavour Violation (LFV) processes experimentally observed for neutral leptons
 - Neutrino oscillations $\nu_l \rightarrow \nu_{l'}$
- LFV for charged leptons (CLFV): $l \rightarrow l' ???$
- If found \rightarrow definitive evidence of **New Physics**

- In this context the **MEG experiment** represents the state of the art in the search for the CLFV $\mu^+ \rightarrow e^+ \gamma$ decay
 - **Final results** exploiting the **full statistics** collected during the 2009-2013 data taking period at **Paul Scherrer Institut (PSI, Switzerland)**
 - $BR(\mu^+ \rightarrow e^+ \gamma) < 4.2 \times 10^{-13}$ (90% C. L.) **world best upper limit**

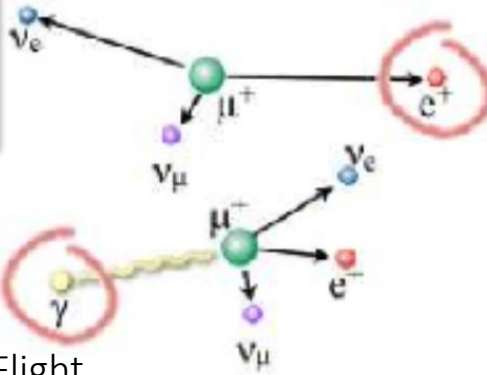


Kinematic variables
 $E_e, E_\gamma, t_{e\gamma}, \theta_{e\gamma}$



Radiative Muon Decay (RMD)

Standard μ decay
 \equiv
Michel decay



BACKGROUNDS

From RMD, Annihilation-In-Flight or bremsstrahlung

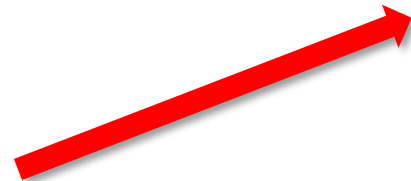
Accidental

- $E_\gamma < 52.8$ MeV
- $E_e < 52.8$ MeV
- $\theta_{e\gamma} < 180^\circ$
- $t_{e\gamma} = 0$ s

- $E_\gamma < 52.8$ MeV
- $E_e < 52.8$ MeV
- $\theta_{e\gamma} < 180^\circ$
- $t_{e\gamma} = \text{flat}$

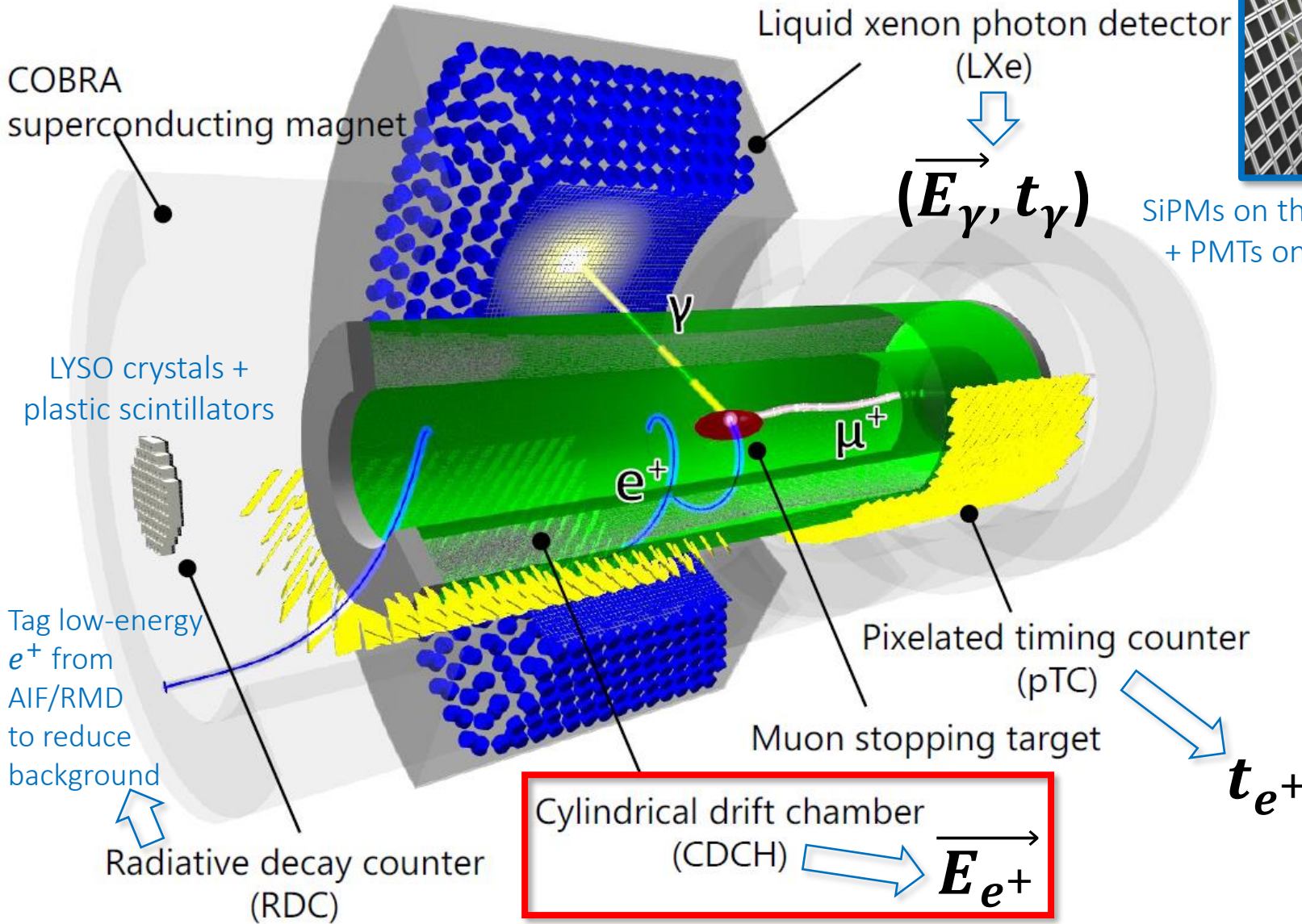
- 28 MeV/c μ^+ continuous beam stopped in a 174 μm -thick BC400 target (15° slant angle)
- Most intense DC muon beam in the world at PSI:
 $R_\mu \approx 10^8$ Hz
- μ^+ decay at rest: 2-body kinematics
- $E_\gamma = E_e = 52.8$ MeV
- $\theta_{e\gamma} = 180^\circ$
- $t_{e\gamma} = 0$ s

- $BKG_{ACC} \propto R_\mu \Delta E_e \Delta t_{e\gamma} \Delta E_\gamma^2 \Delta \theta_{e\gamma}^2 \rightarrow$ **DOMINANT** in high-rate environments
- $BKG_{RMD} \approx 10\% \times BKG_{ACC}$

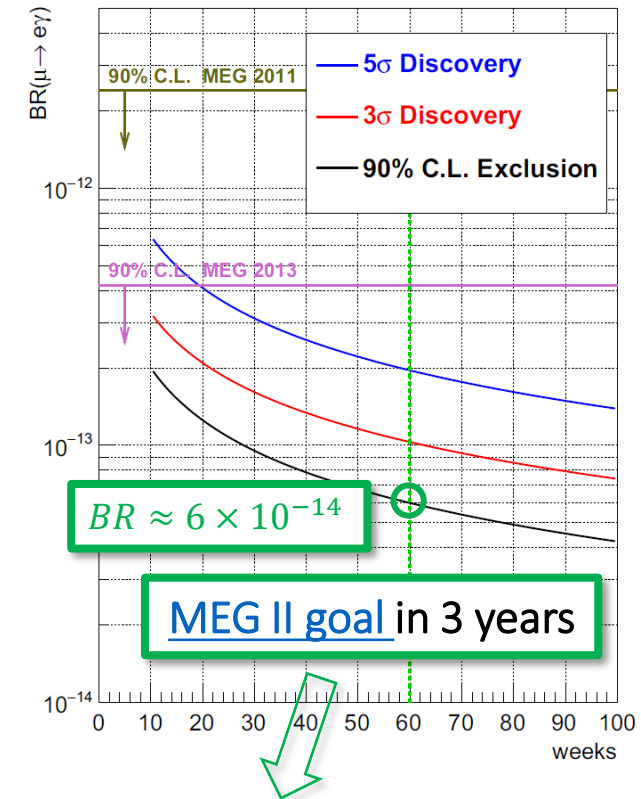


The MEG II experiment

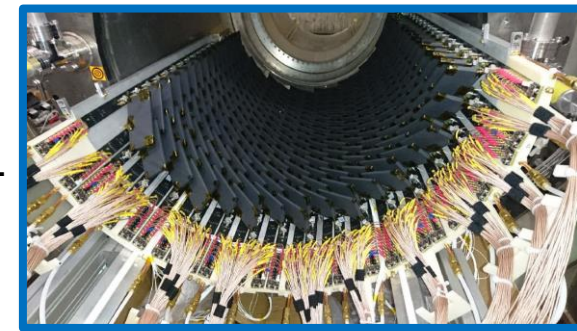
- [Full design paper](#)
- [Full commissioning paper](#)
- [Full operation paper](#)



SiPMs on the γ entrance face + PMTs on the other faces



- Increasing the μ^+ stopping rate
- Improving the detectors figures of merit
 - $\times 2$ factor than MEG

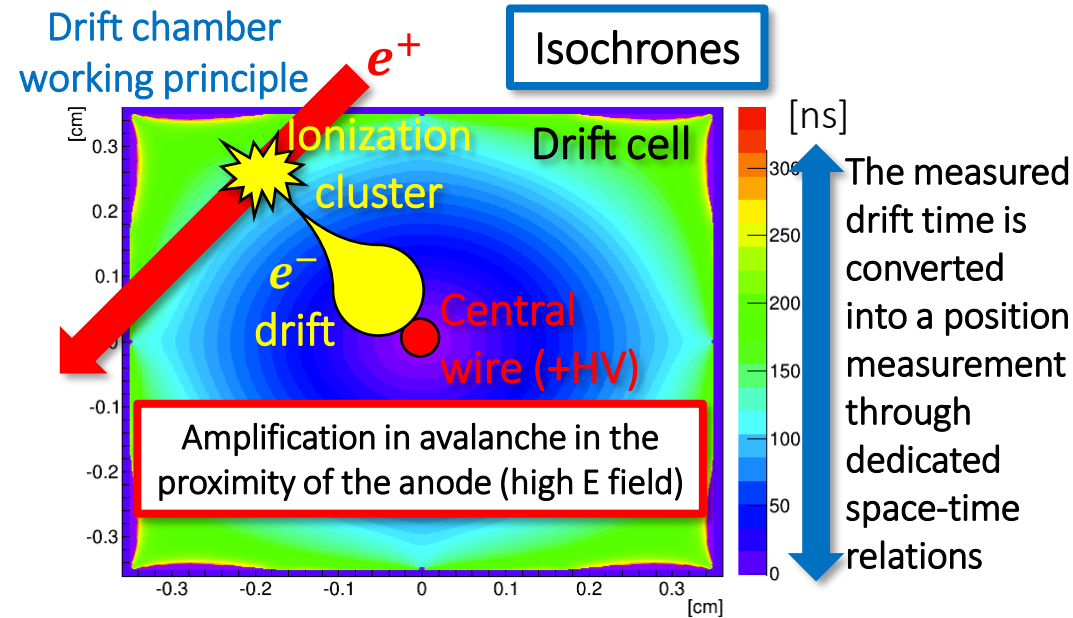
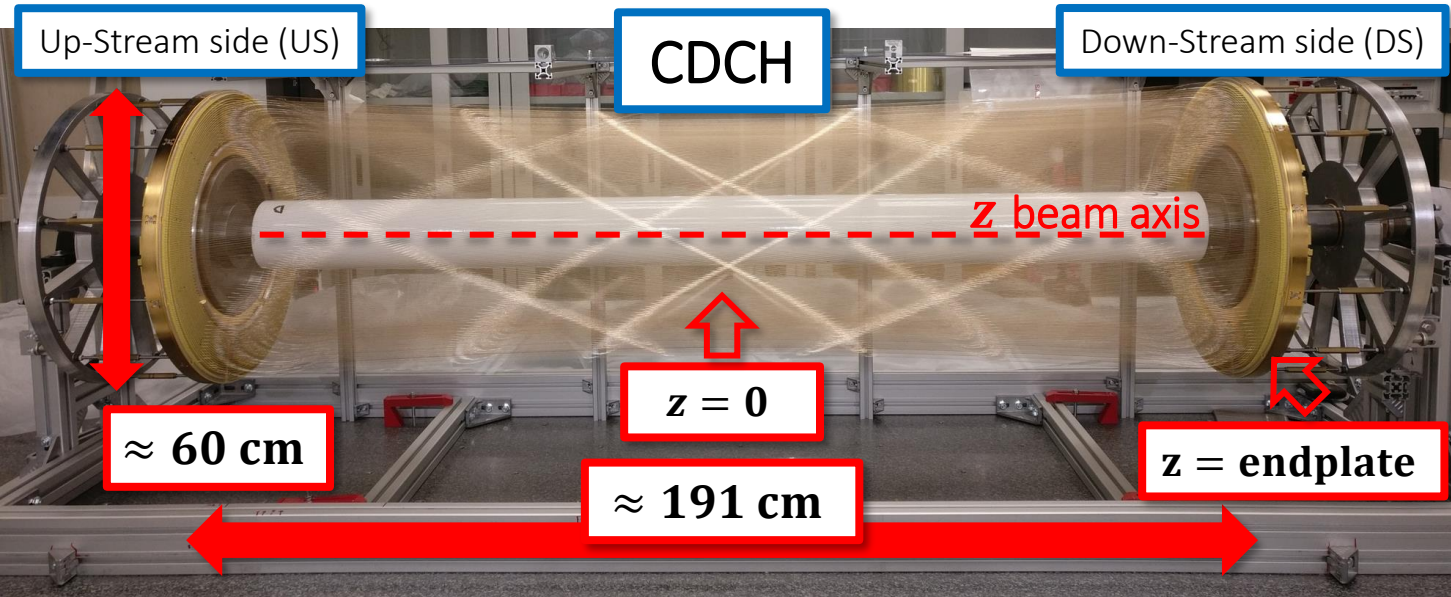


Plastic scintillator tiles read out by SiPMs

The MEG II Cylindrical Drift CHamber (CDCH)

- Design and assembly
- Commissioning

Detector performance



e^+ variable	MEG	MEG II
ΔE_e (keV)	380	91
$\Delta\theta_e, \Delta\varphi_e$ (mrad)	9.4, 8.7	7.2, 4.1
$\Delta Z, \Delta Y$ (at target, mm)	2.4, 1.2	2.0, 0.7
$\epsilon_{tracking} \times \epsilon_{TC-match}$ (%)	65 × 45	74 × 91

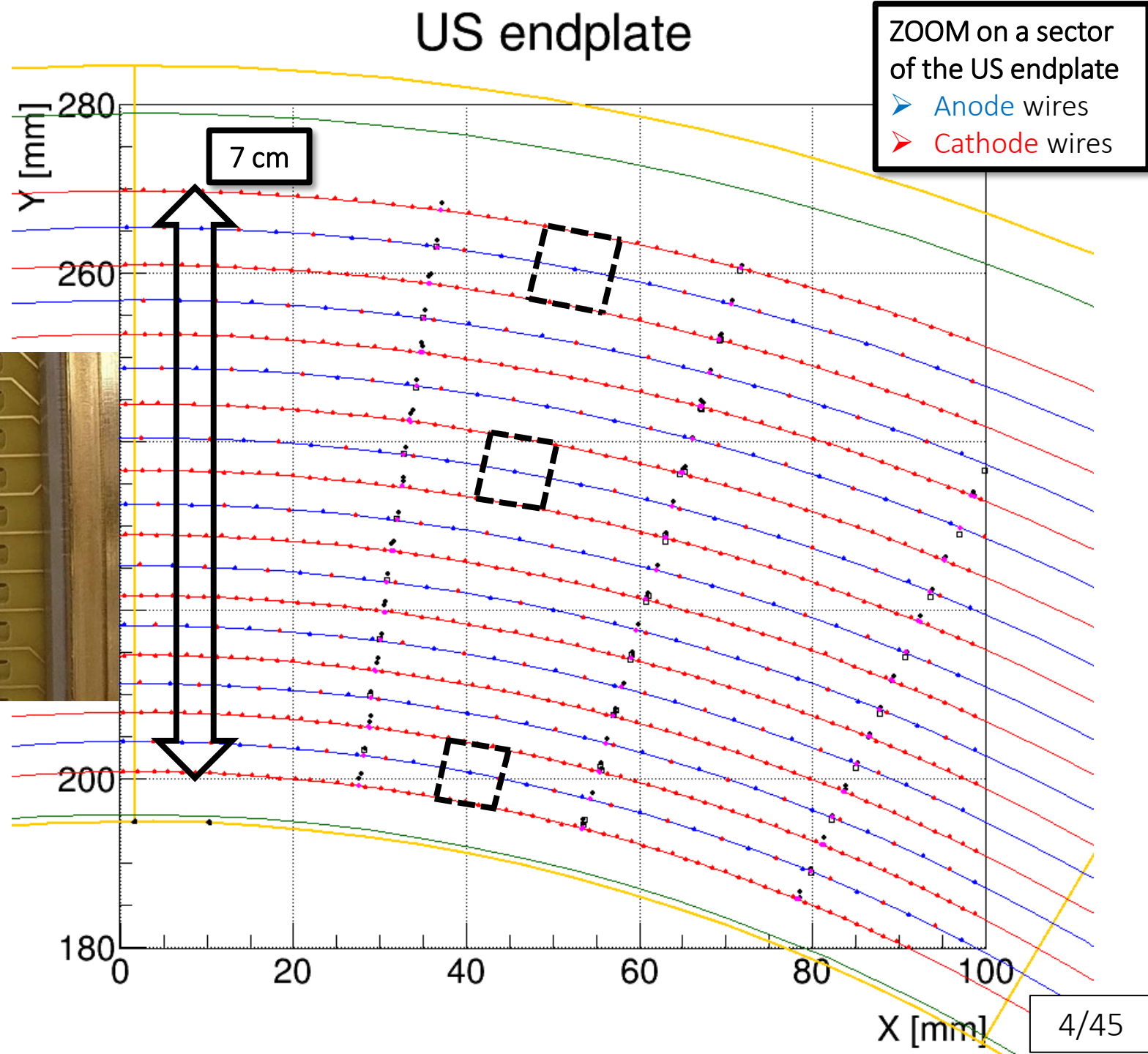
- Currently most updated reconstruction algorithms on real data
- Practically at the MC level

- Low-mass single volume detector with high granularity filled with He:iC₄H₁₀ 90:10 gas mixture
 - + additives to improve the operational stability: 1.5% isopropyl alcohol + 0.5% Oxygen
 - 9 concentric layers of 192 drift cells defined by 11904 wires
 - Small cells few mm wide: occupancy of ≈ 1.5 MHz/cell (center) near the stopping target
 - High density of sensitive elements: $\times 4$ hits more than MEG drift chamber (DCH)
- Total radiation length $1.5 \times 10^{-3} X_0$: less than $2 \times 10^{-3} X_0$ of MEG DCH or ≈ 150 μm of Silicon
 - MCS minimization and γ background reduction (bremsstrahlung and Annihilation-In-Flight)
- Single-hit resolution (measured on prototypes): $\sigma_{hit} < 120$ μm
- Extremely high wires density (12 wires/cm²) → the classical technique with wires anchored to endplates with feedthroughs is hard to implement
 - CDCH is the first drift chamber ever designed and built in a modular way

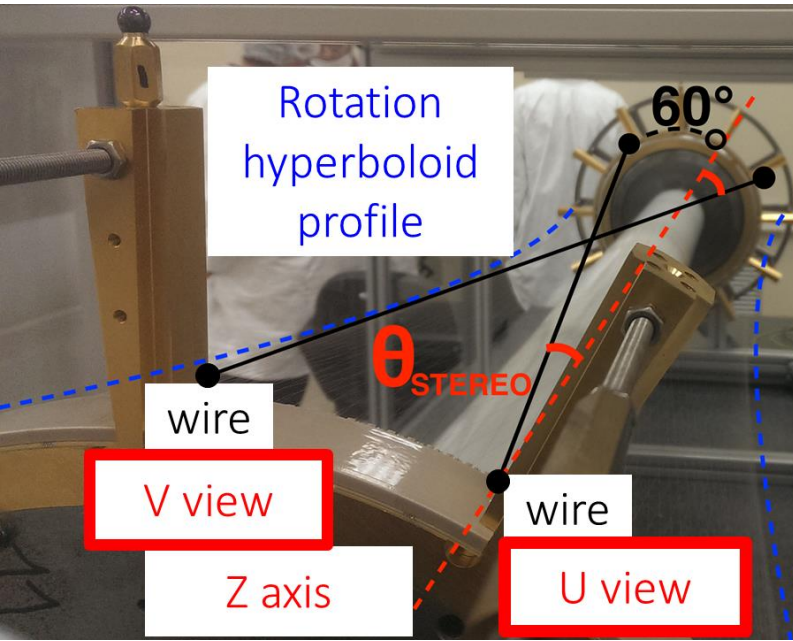
Wire density



stereo wire geometry
radial perspective

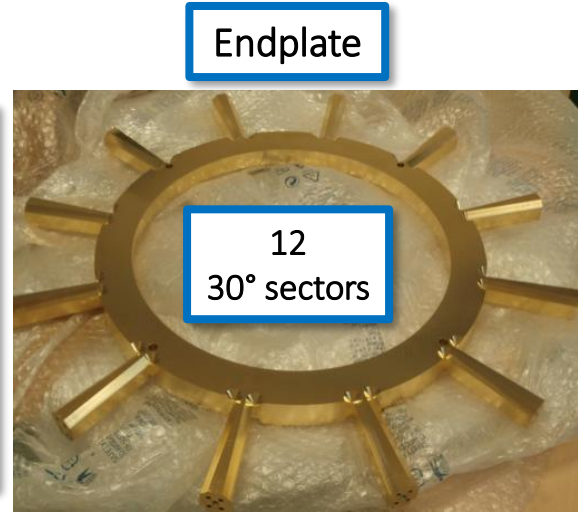


Design and wiring

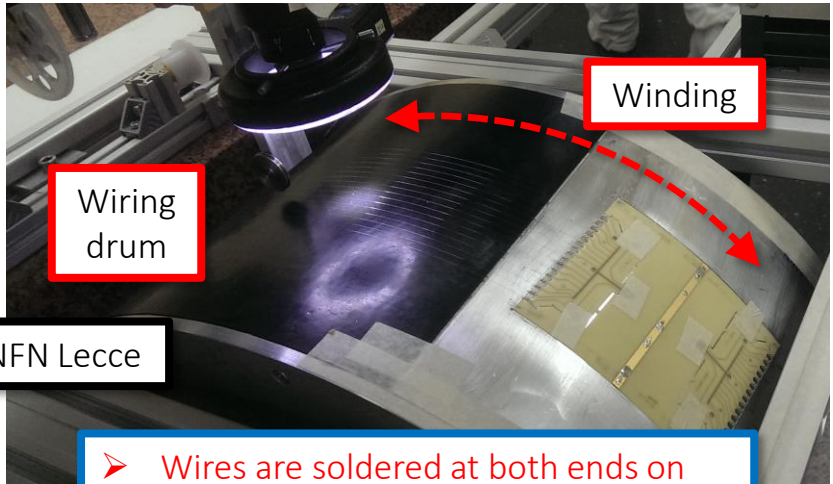
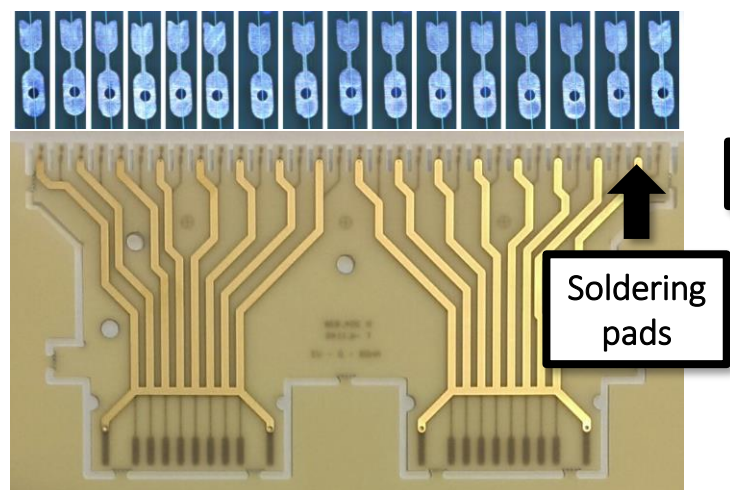
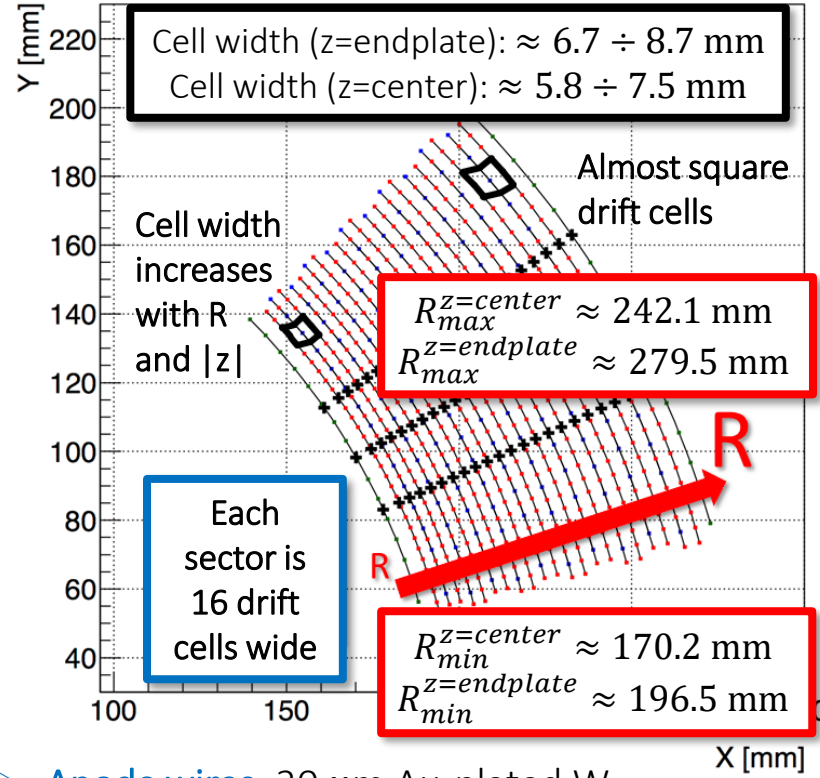


Stereo wires geometry for longitudinal hit localization

- $\theta_{\text{stereo}} \approx 6^\circ \div 8.5^\circ$ as R increases



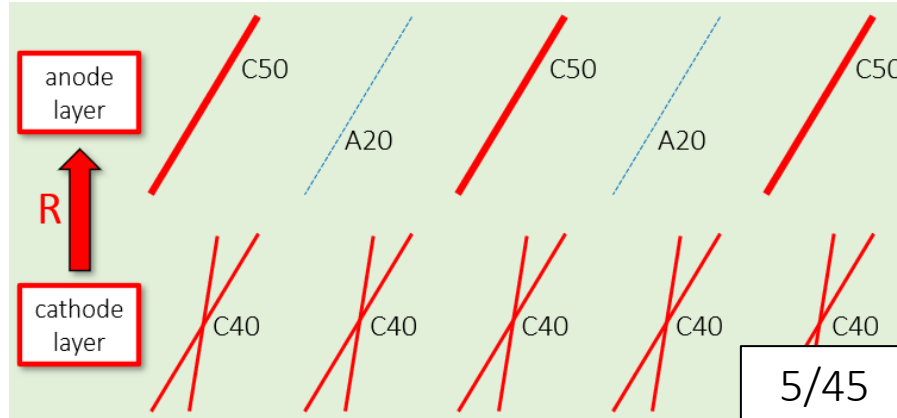
Endplate



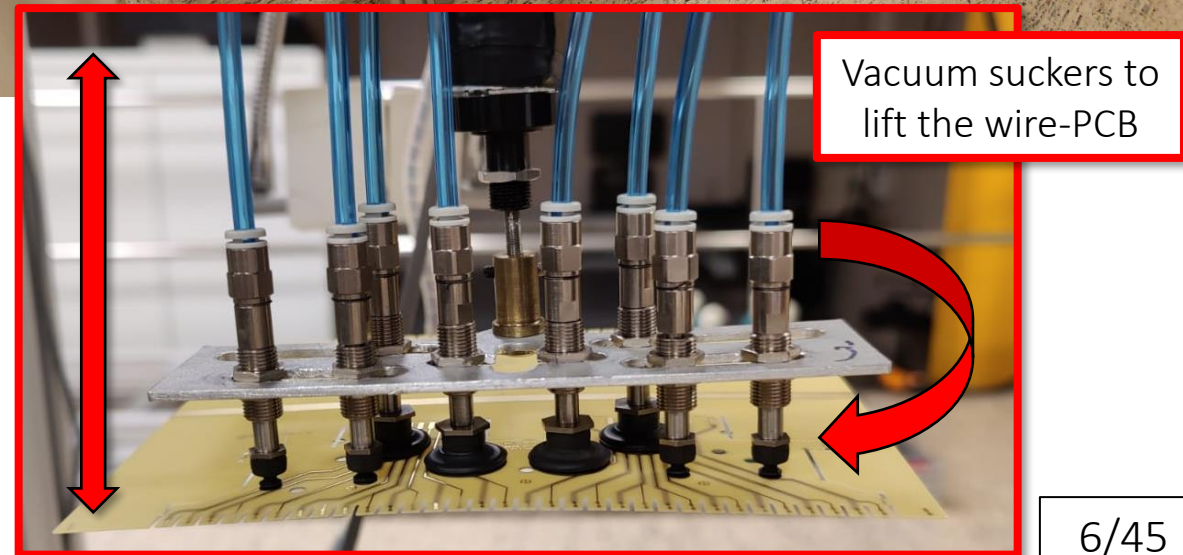
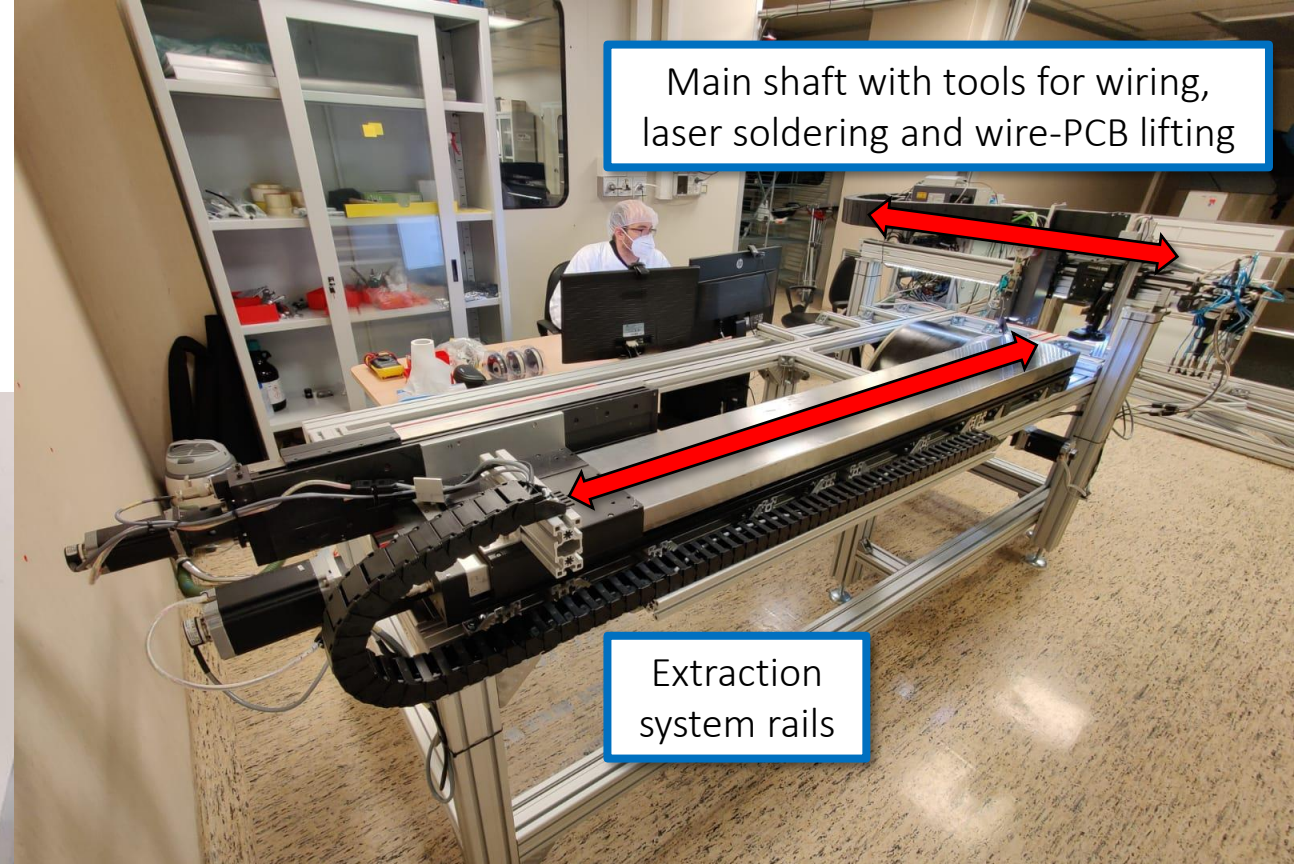
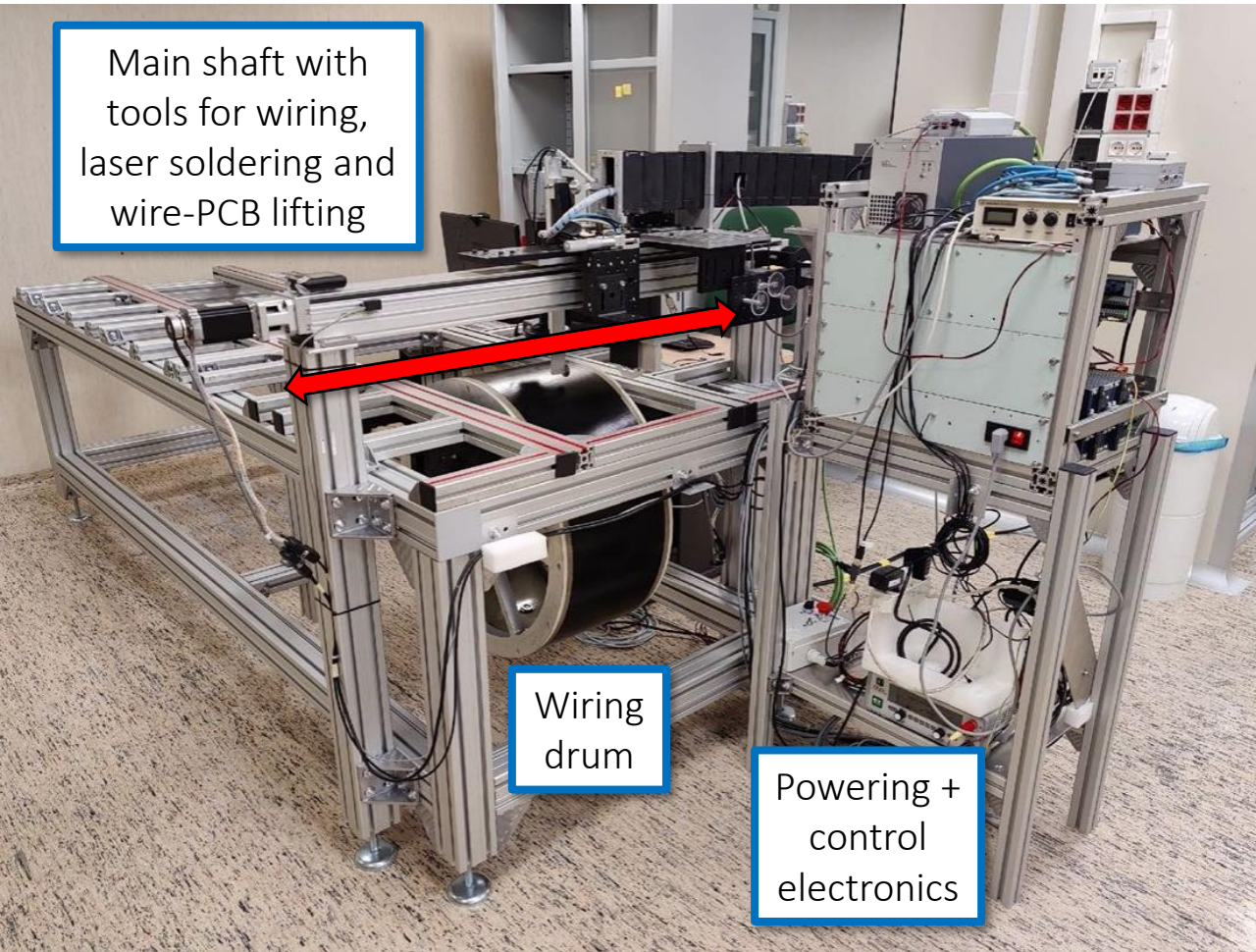
Wiring drum

- Wires are soldered at both ends on the pads of 2 PCBs (wire-PCBs) which are then mounted on CDCH endplates
- Wiring inside a cleanroom

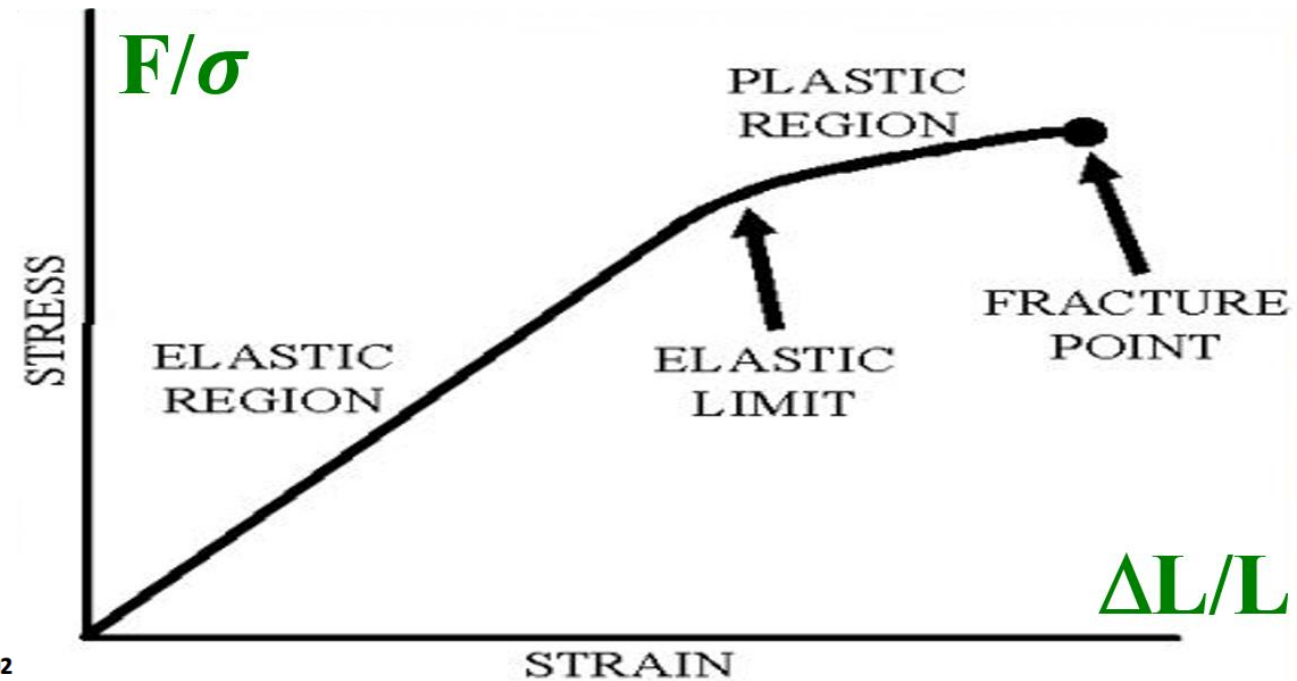
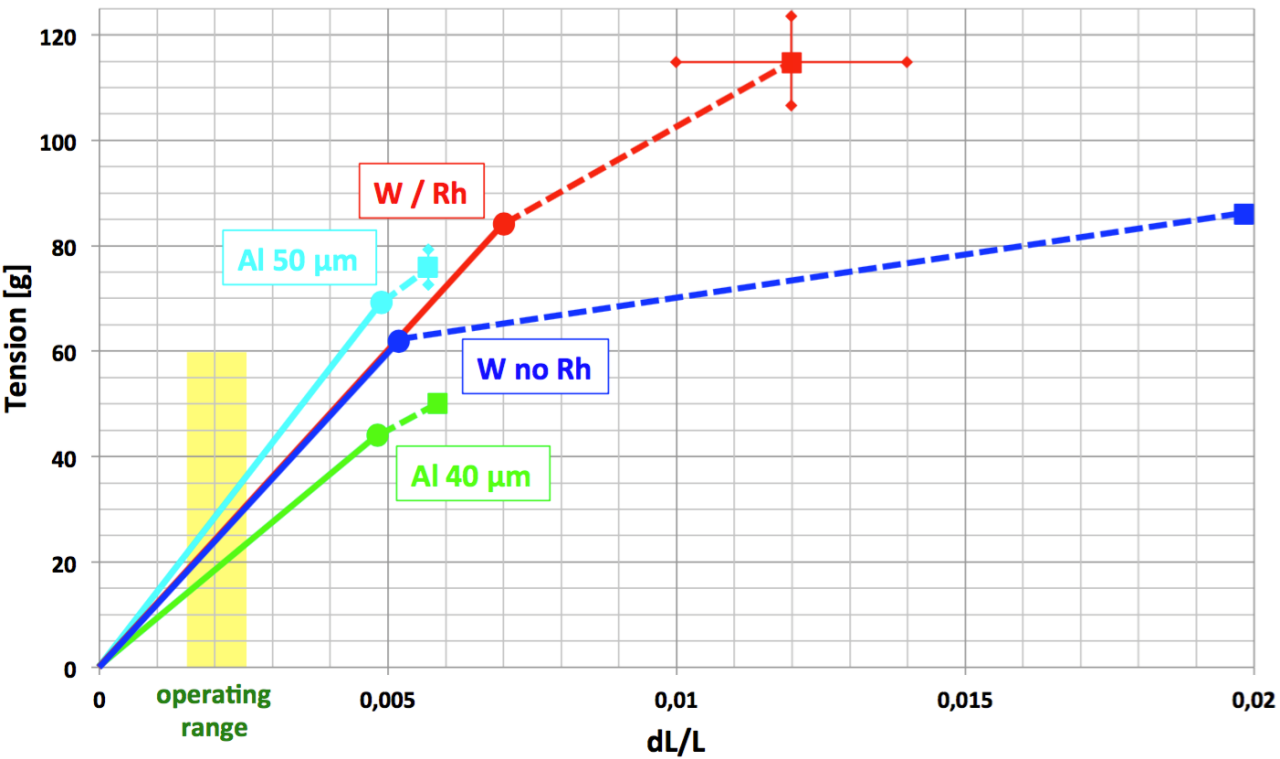
- **Anode wires:** 20 μm Au-plated W
- **Cathode wires:** 40/50 μm Ag-plated Al
 - 40 μm ground mesh between layers
- **Guard wires:** 50 μm Ag-plated Al
- Field-to-Sense wire ratio 5:1



Wiring machine



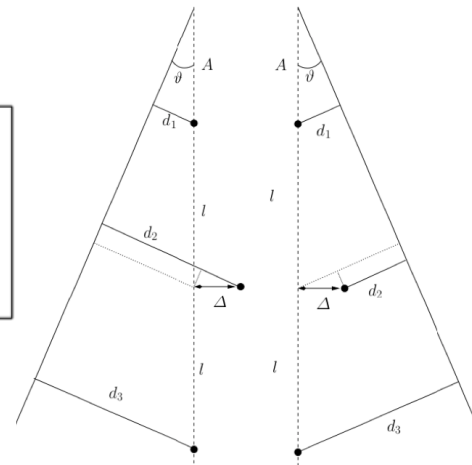
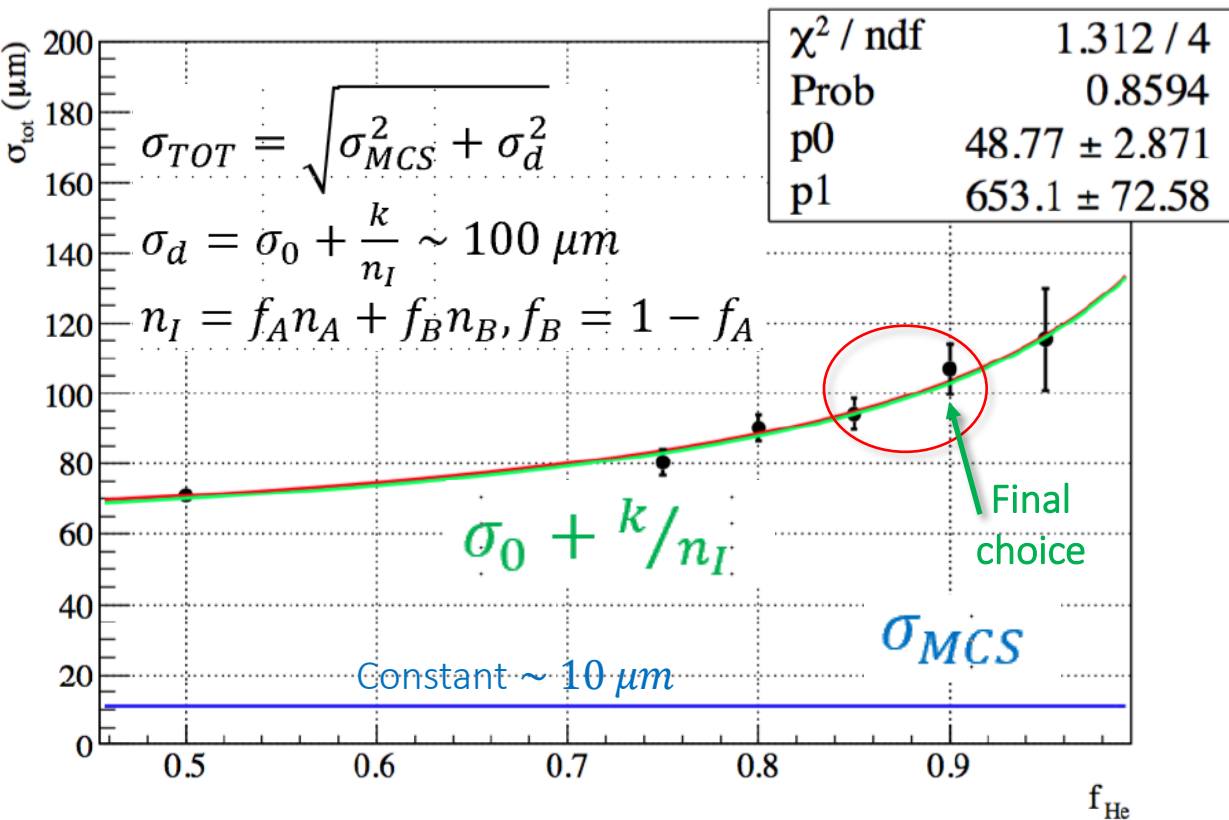
Mechanical properties of wires



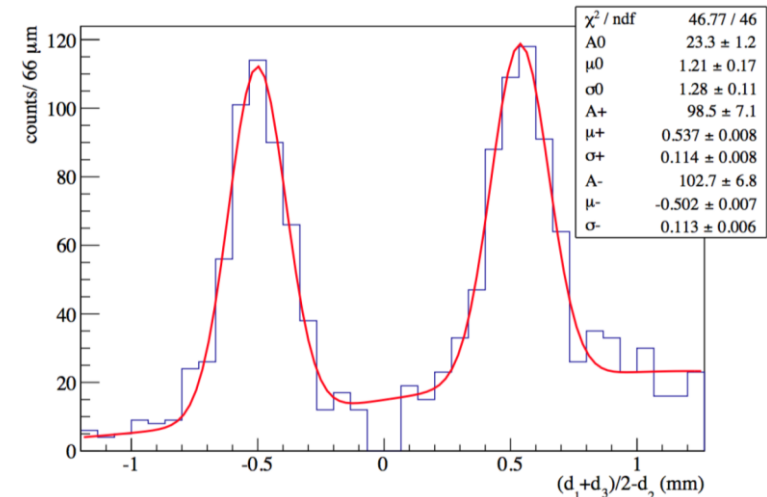
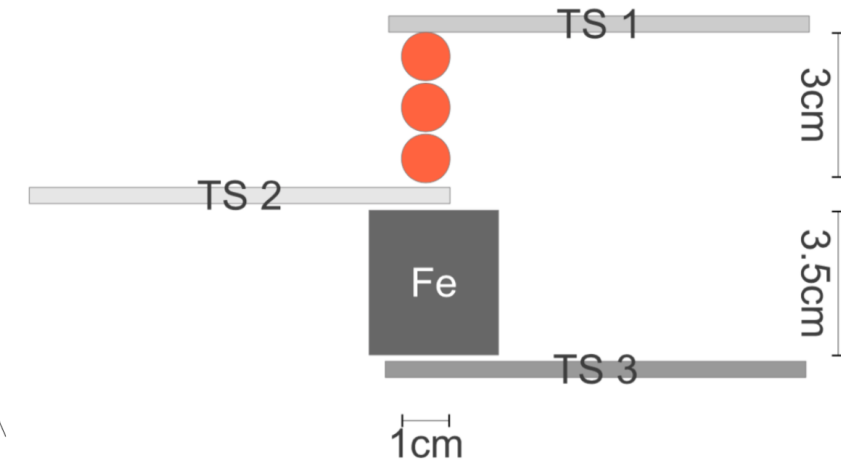
Single-hit resolution and gas choice

➤ Strictly connected to the gas mixture choice → measurement of σ_d vs f_A with dedicated prototypes

- Final choice = compromise between σ_d and material budget
- Base gas mixture → He:isobutane 90:10



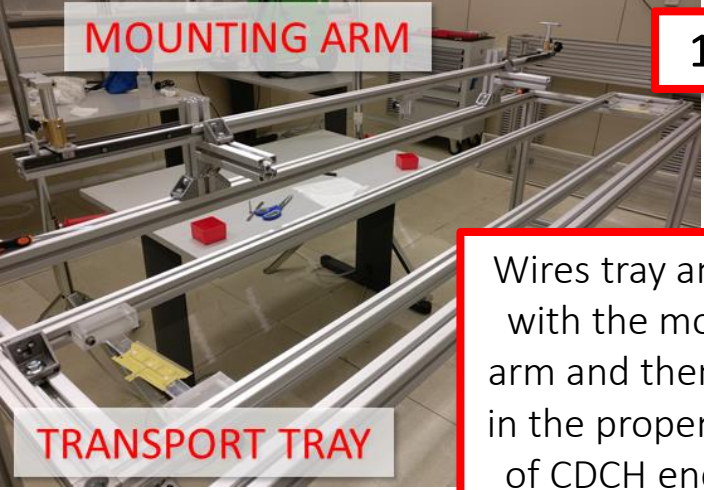
External Si telescope for the reference track



CDCH assembly

Modular assembly

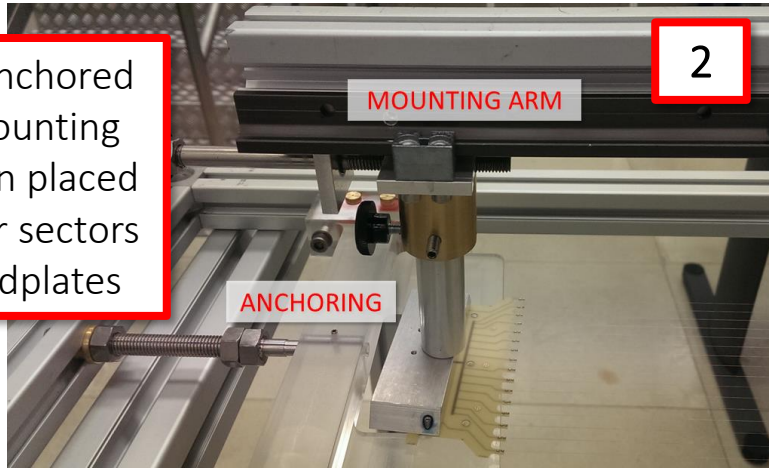
San Piero a Grado
(INFN Pisa)
cleanroom facility



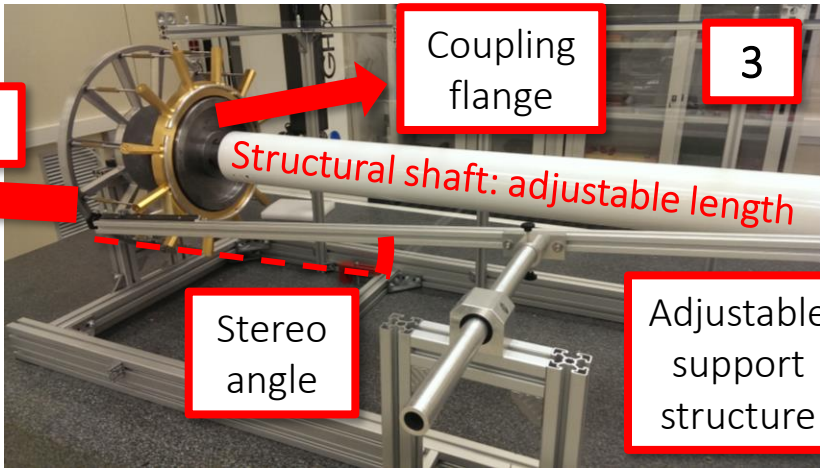
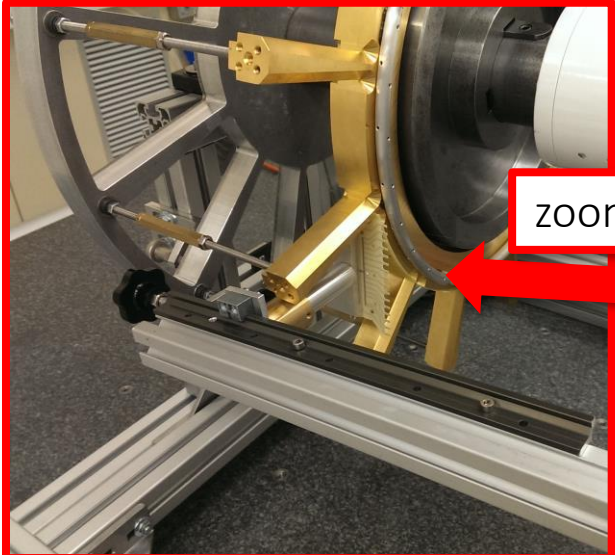
1

This operation is repeated for the 12 sectors in one layer and for all the wires layer

Wires tray anchored with the mounting arm and then placed in the proper sectors of CDCH endplates

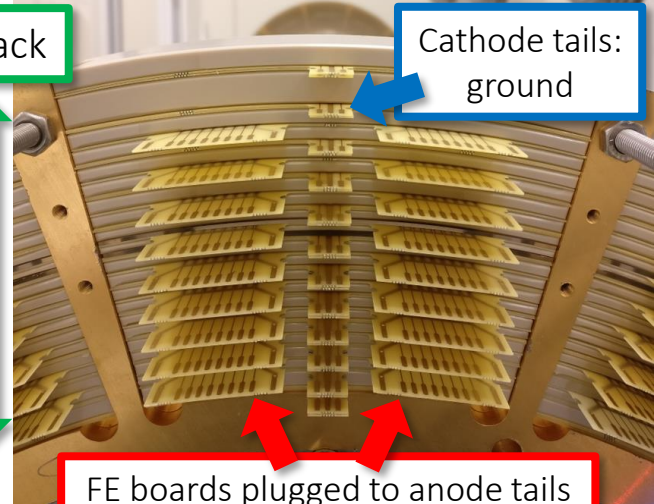


2



3

Final wire-PCBs stack



FE boards plugged to anode tails (HV + signals)

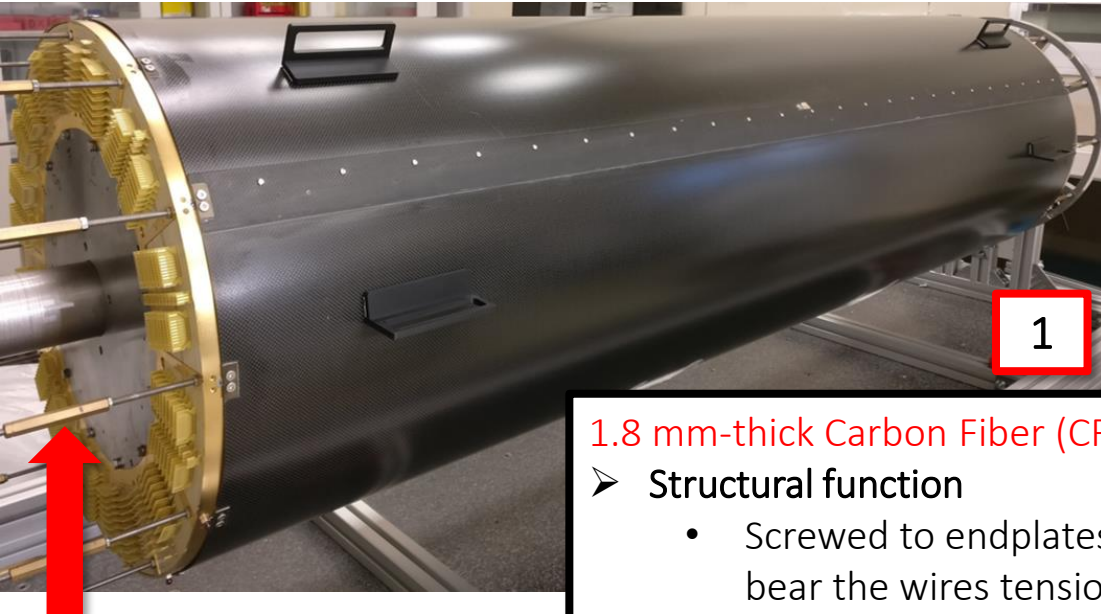
PEEK spacers to mount the PCB at the correct radius



- Once each wires layer is mounted a geometry survey campaign with a Coordinate Measuring Machine (CMM) is performed to record the mounting position of each wire-PCB ($\approx 20 \mu\text{m}$ accuracy)
- Thickness of the PEEK spacers adjusted to minimize the discrepancy from the nominal mounting radius

Sealing

San Piero a Grado
(INFN Pisa) facility

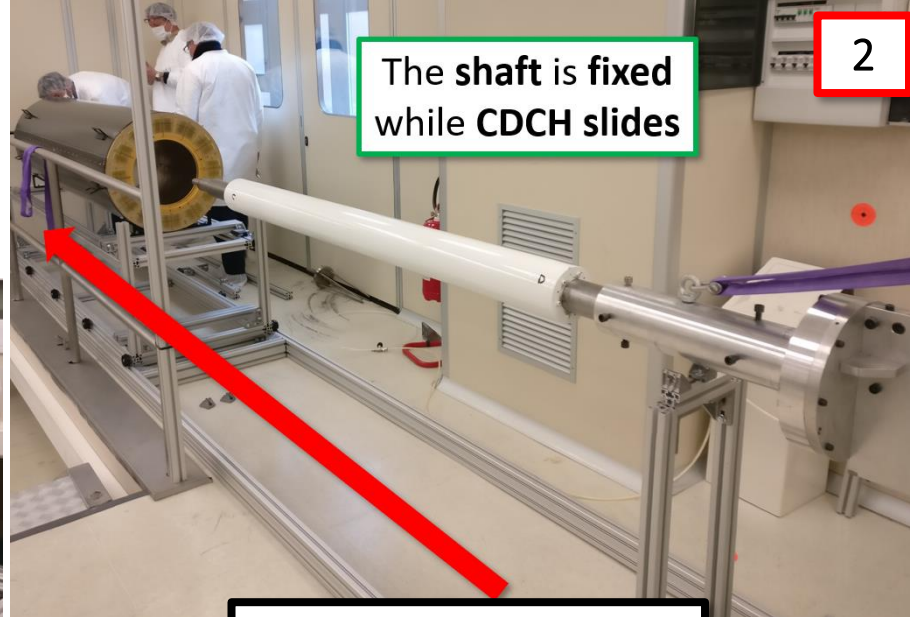


- Fine geometry tuning by adjusting the positions of each individual spoke by acting on the 12 turnbuckles per side
- Endplate planarity and parallelism at a level better than 100 μm thanks to the CMM

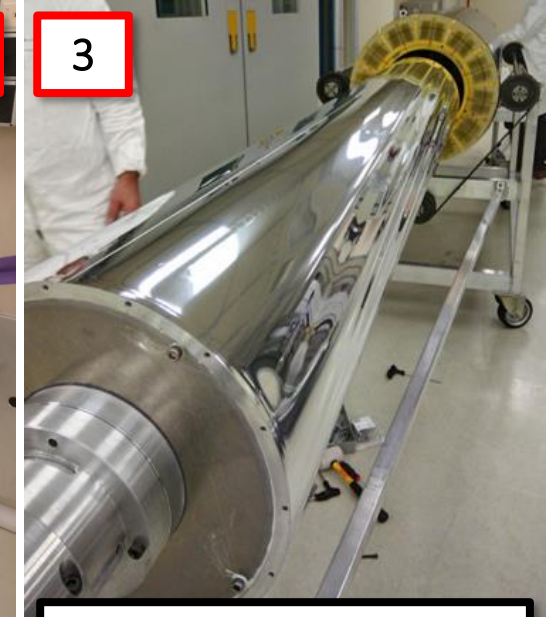
1.8 mm-thick Carbon Fiber (CF) shell

- Structural function
 - Screwed to endplates to bear the wires tension and keep the CDCH length
- Gas mixture tightness
 - Sealing of CF perimeters and wire-PCBs stack with special encapsulants and adhesives (Stycast + ThreeBond)

Assembly and sealing performed inside a cleanroom with a strict monitoring of temperature and relative humidity



Central shaft extraction



- 20 μm -thick one-side aluminized Mylar foil at inner radius
- To separate the inner beam + target volume filled with pure He from the wires volume filled with He: IsoB 90:10 mixture

At this point CDCH was locked into a handling cage with a dumping system and transported to PSI for the commissioning activities

CDCH transport to PSI

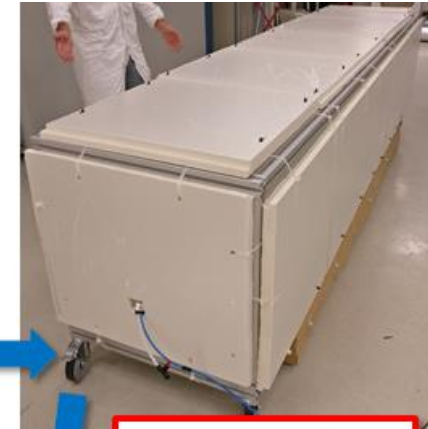
CDCH packing



- First dumping system
 - CDCH-cage silent blocks
- First wrapping



- Second dumping system
 - Cage-floor rubber pillows
- Number of layers optimized to dump low frequency oscillations typical of a car travel



- Thermal insulation panels
- Second wrapping

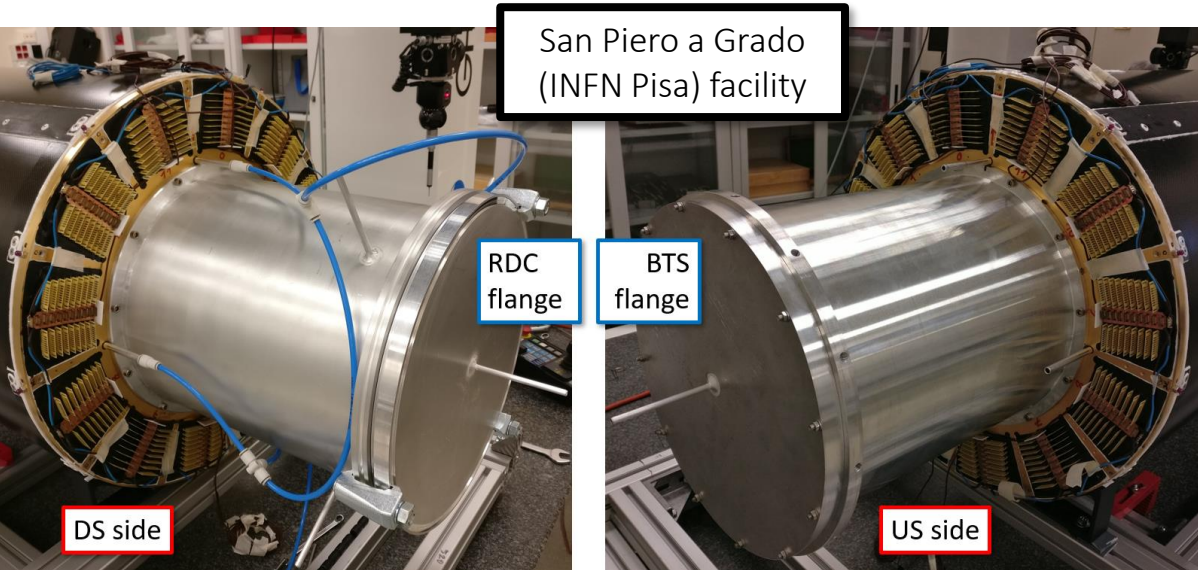


- Ready for packing

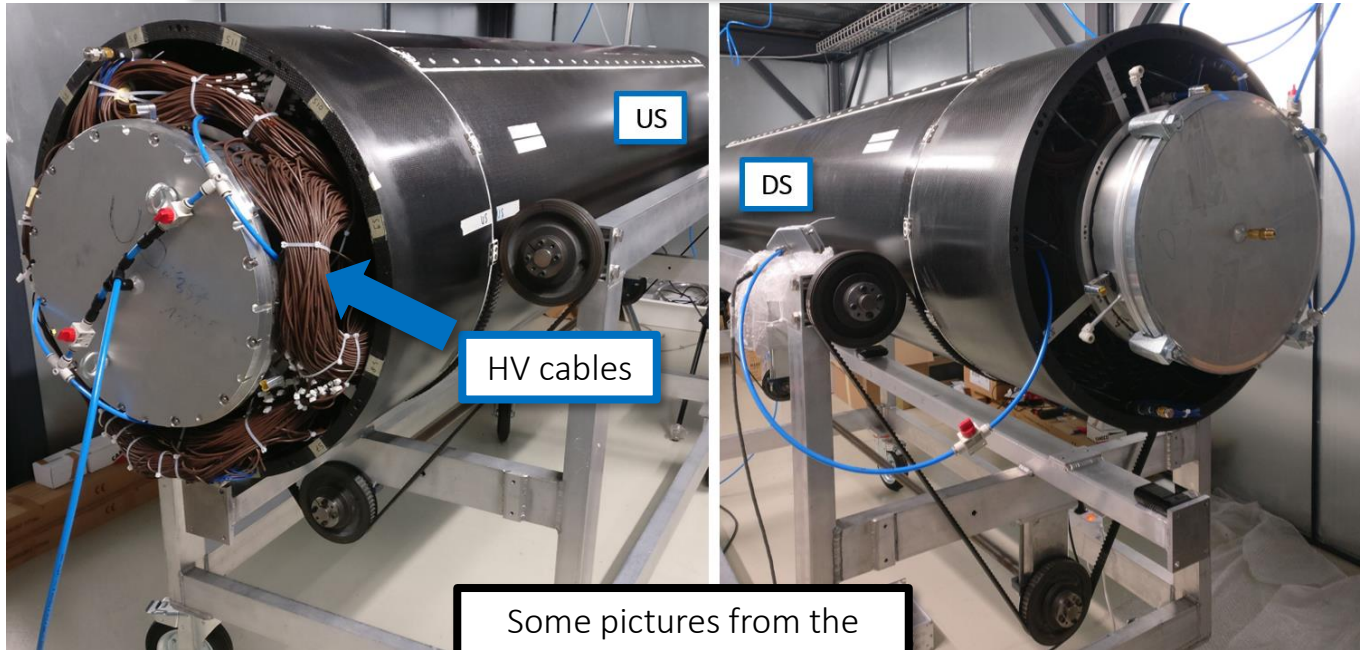


CDCH commissioning

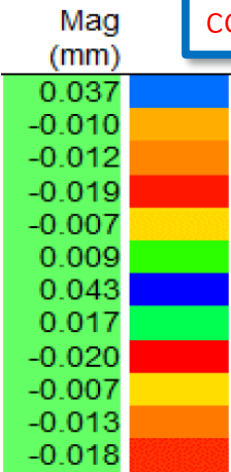
External mechanical structures



- External CF structure
 - Structural + gas tightness function
- CDCH mechanics proved to be stable and adequate to sustain a full MEG II run and multiple handling operations during the maintenance periods
 - Survey measurements before/after a run show total agreement at the 10 μm level



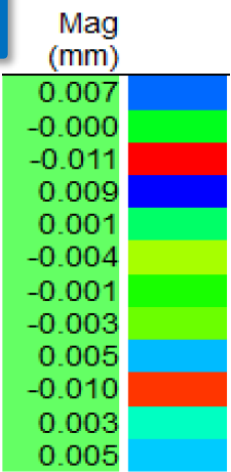
Aluminum inner extensions to connect CDCH to the MEG II beam line



Endplate planarity check in the DAQ configuration

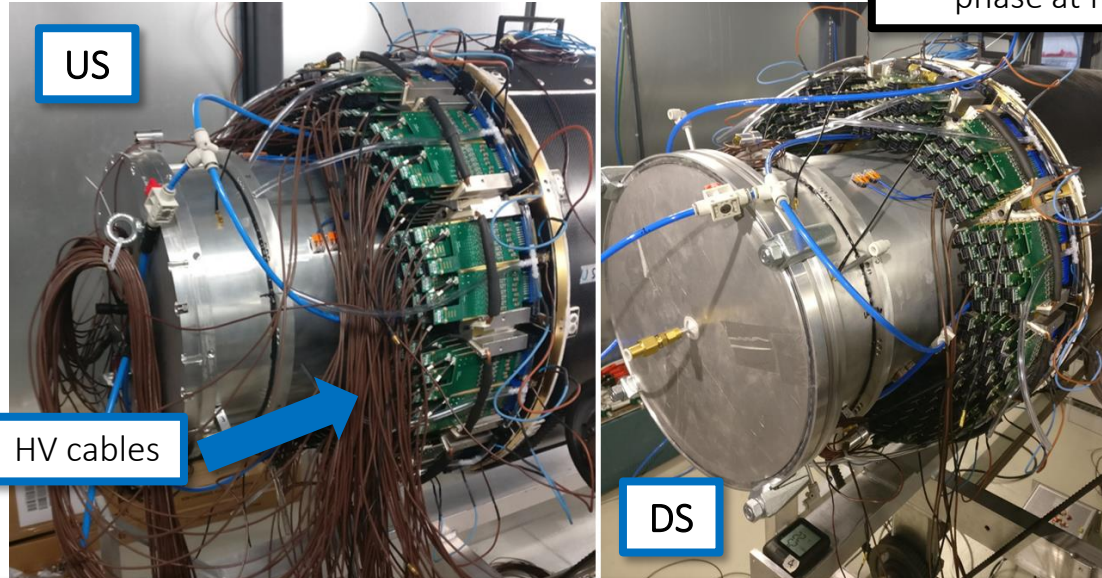
US

DS

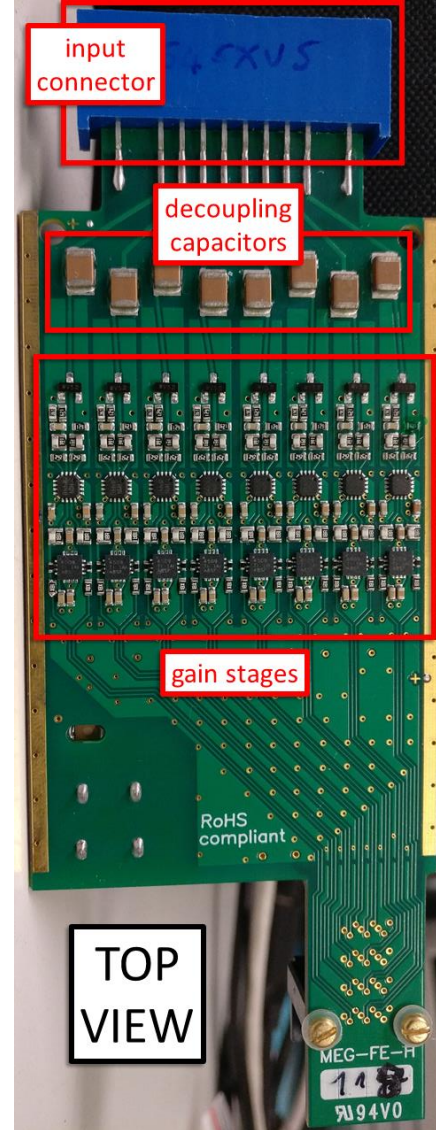


Some pictures from the commissioning phase at PSI

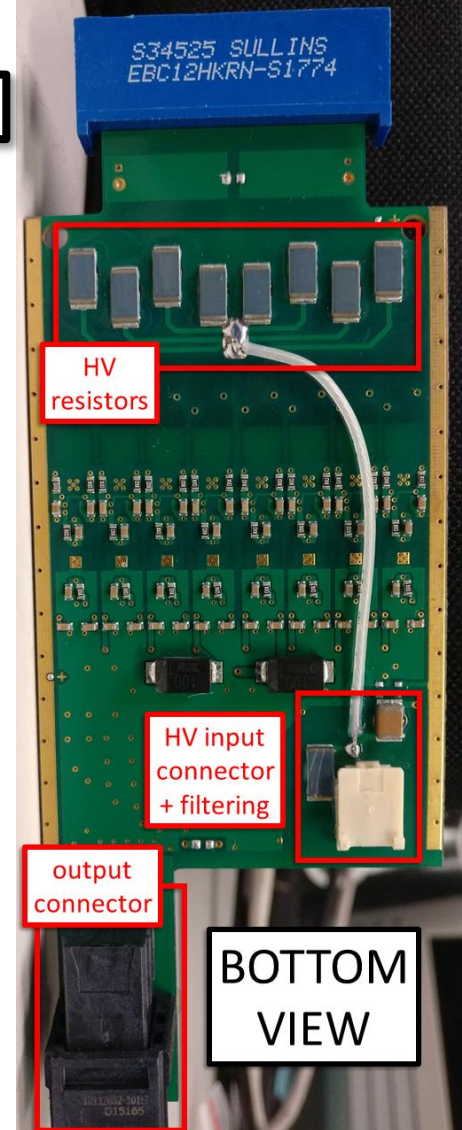
FE electronics



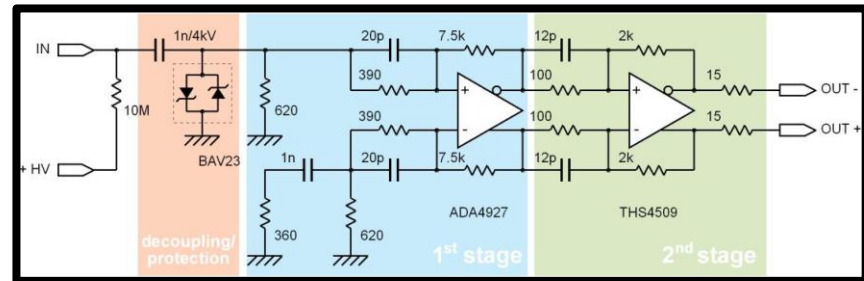
Some pictures from the commissioning phase at PSI



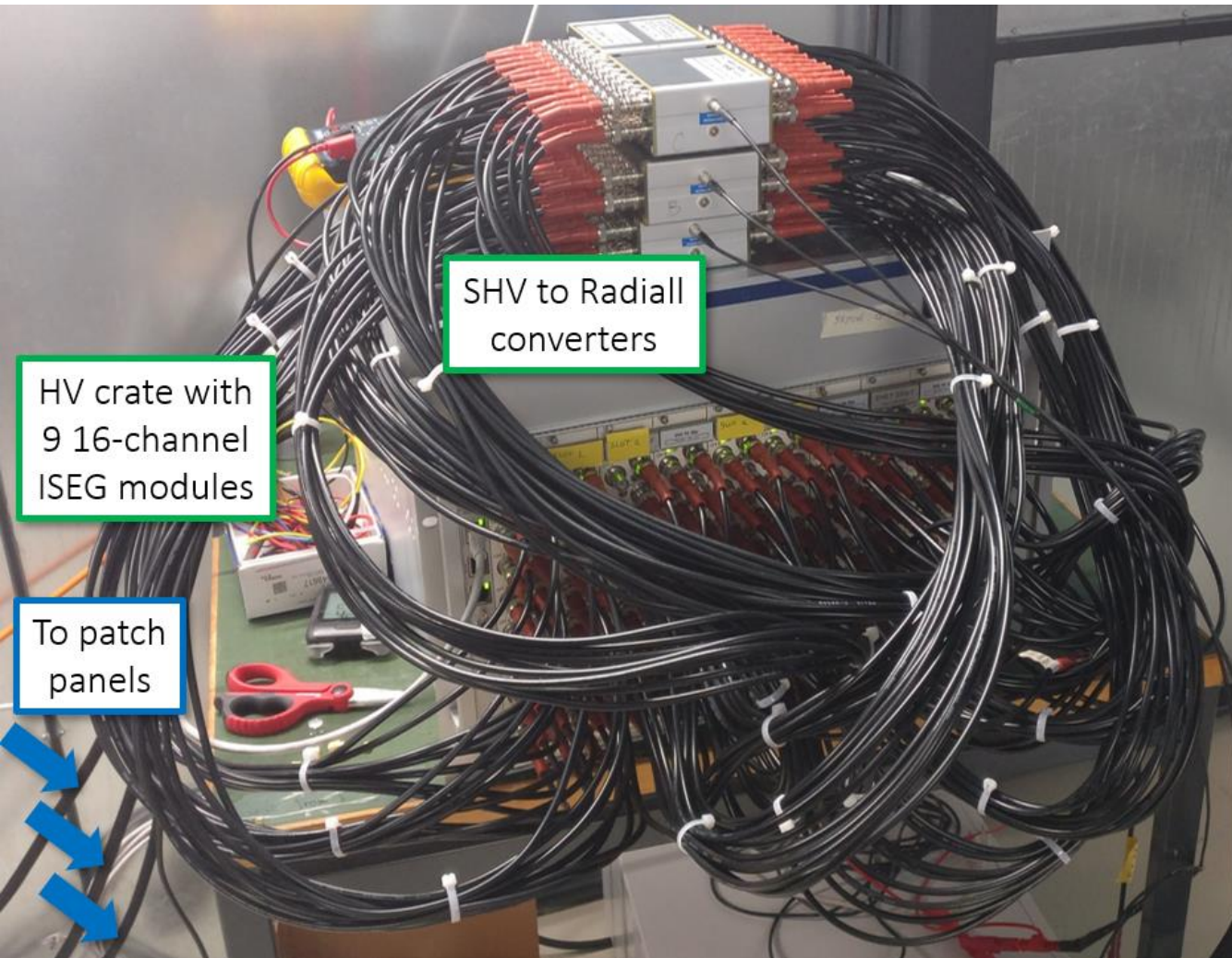
INFN Lecce



- 216 FE boards per side
 - 8 differential channels to read out signal from 8 cells
 - Double amplification stage with low noise and distortion
 - High bandwidth of nearly 400 MHz
 - To be sensitive to the single ionization cluster and improve the drift distance measurement ([cluster timing technique](#))
- Signal read out from both CDCH sides
- HV supplied from the US side



HV distribution

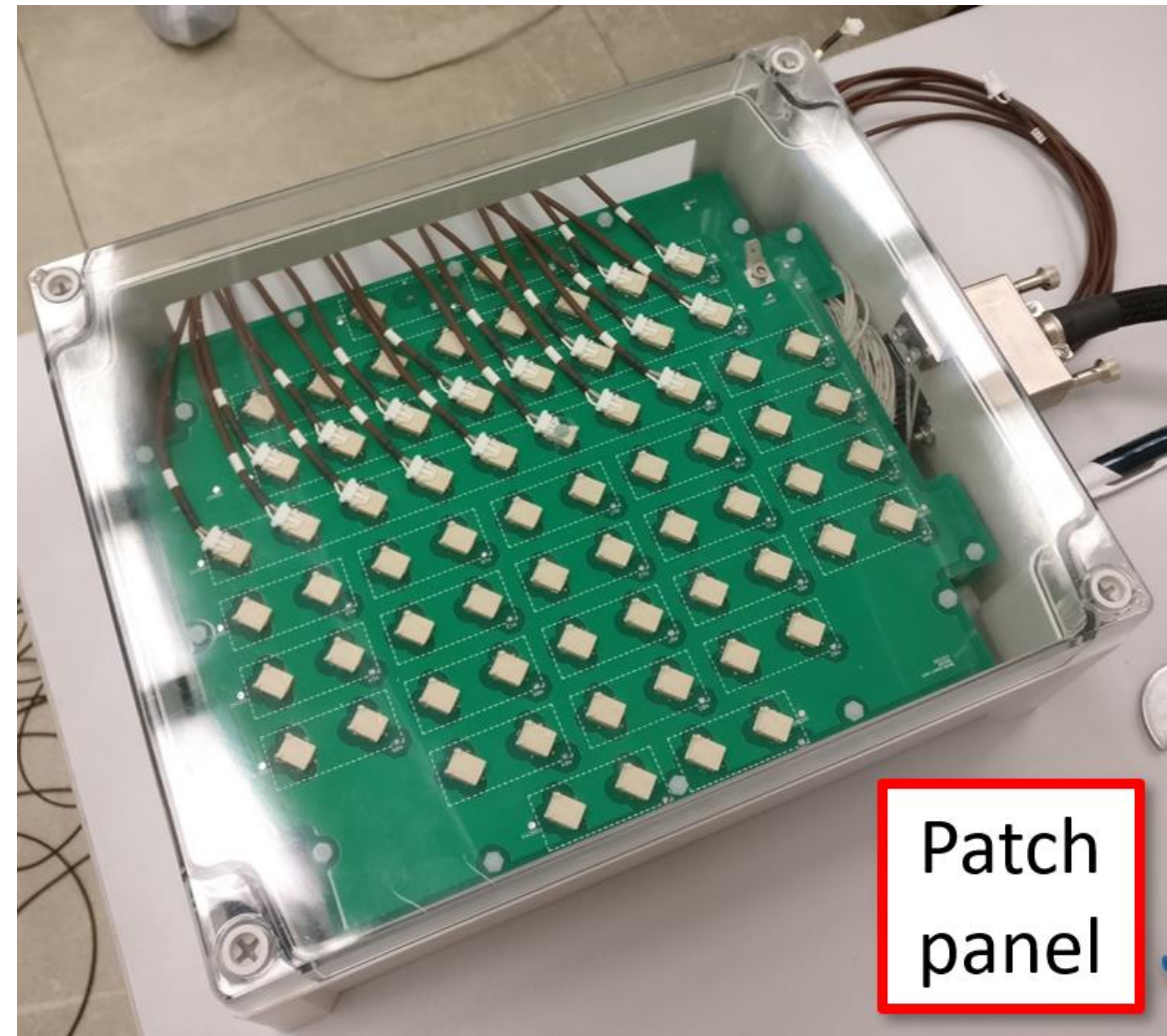


SHV to Radial converters

HV crate with 9 16-channel ISEG modules

To patch panels

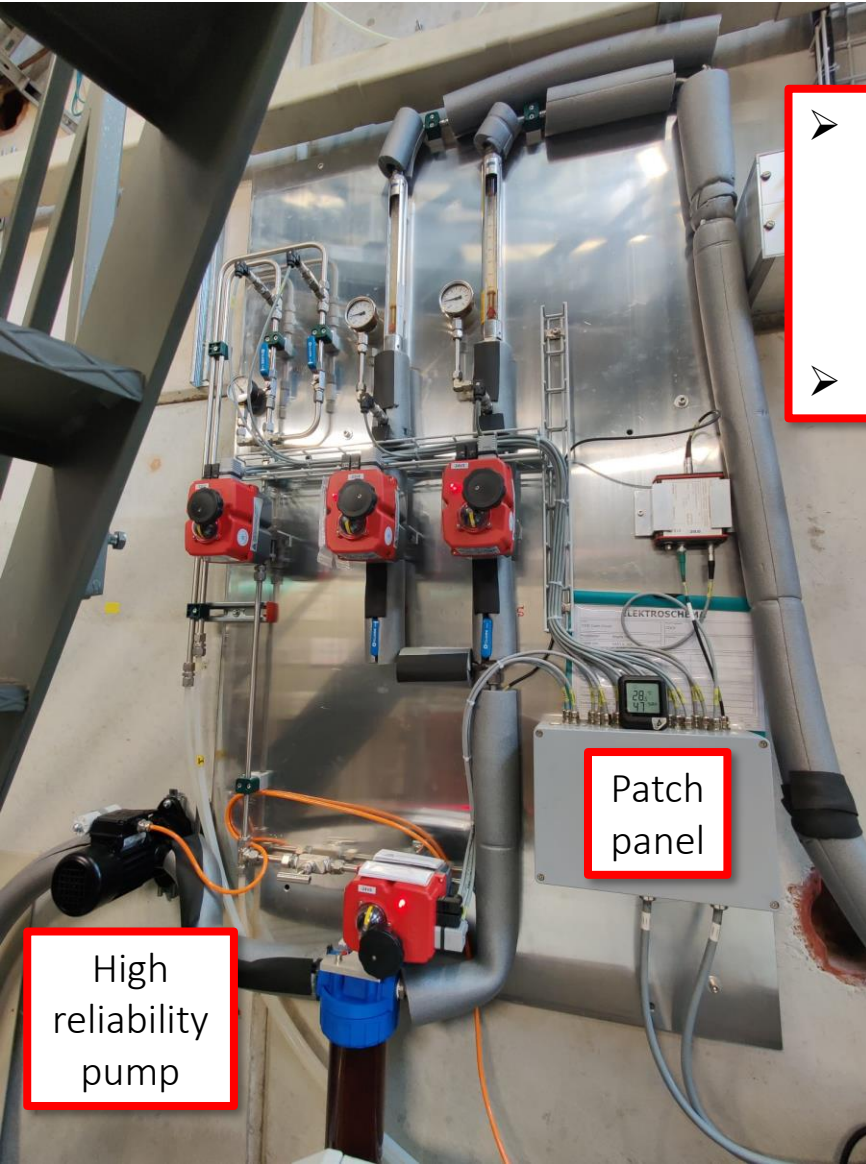
HV crate



Patch panel

HV distribution

Cooling system

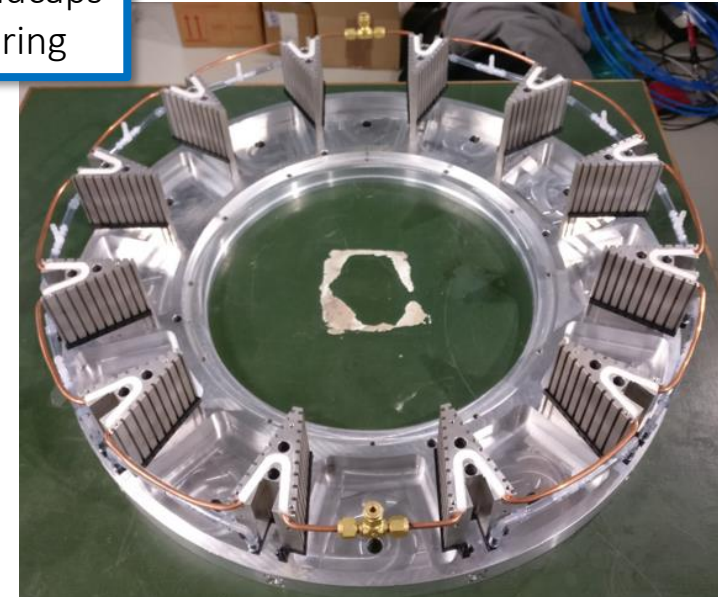


- Cooling system water distribution panel with active components
 - 4 proportional valves
 - 4 pressure sensors
 - 1 flowmeter
- We kept the manual components

Patch panel

High reliability pump

Several T and RH sensors are placed inside the endcaps for monitoring

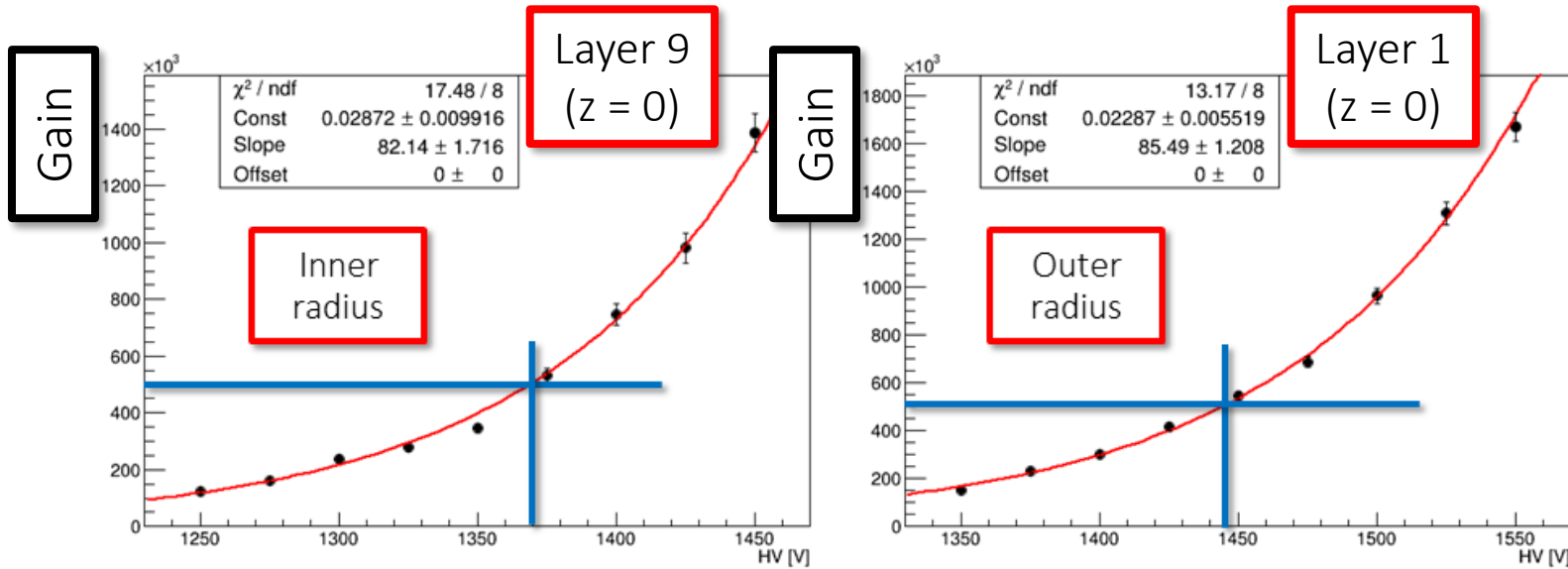


- Slow control (SCS 3000) crate with 3 power supply units (60 W each) and 2 input/output modules
 - Valve control via software
 - Valves/sensors history available

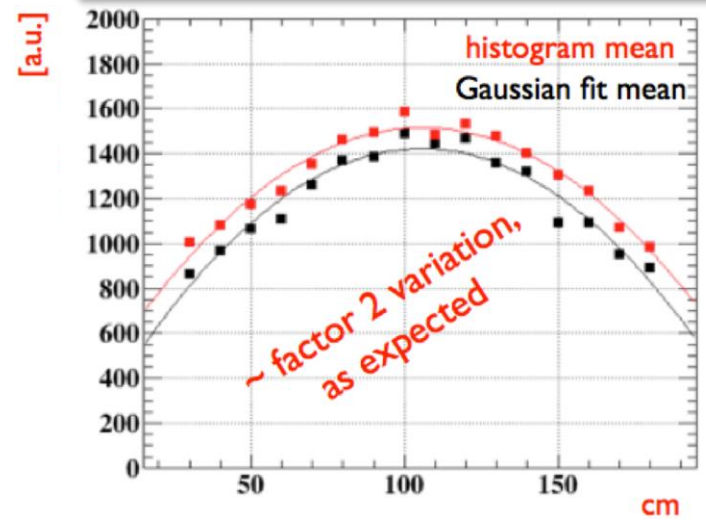
- FE electronics cooling system embedded in the board holders
 - Power consumption for each channel: 40 mA at 2.2 V
 - Heat dissipation capacity granted by a 1 kW chiller system: 300 W/endplate
- Dry air flushing inside the endcaps to avoid water condensation on electronics and dangerous temperature gradients



HV working point



Expected gain variation vs. longitudinal coordinate z given the CDCH hyperbolic shape



- Garfield simulations on single electron gain
 - Gas mixture He:Isobutane 90:10 and P = 970 mbar (typical at PSI)
- Working point → HV for gas gain $G = 5 \times 10^5$
 - To be sensitive to the single ionization cluster

HV tuning by 10 V/layer to compensate for the variable cell dimensions with radius and z

L1	L2	L3	L4	L5	L6	L7	L8	L9
1480 V	1470 V	1460 V	1450 V	1440 V	1430 V	1420 V	1410 V	1400 V

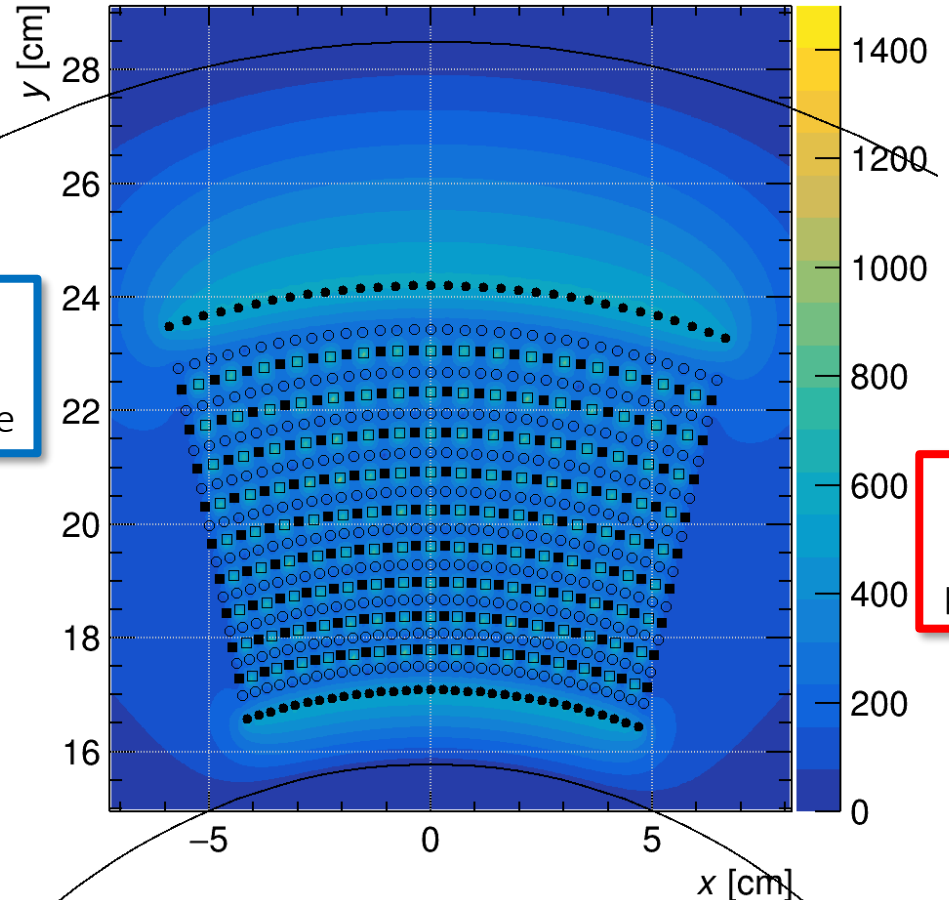
Average HV Working Point (WP) as a function of the layer

Outer layer

100 V safety margin above the HV WP to recover the gain drop with time

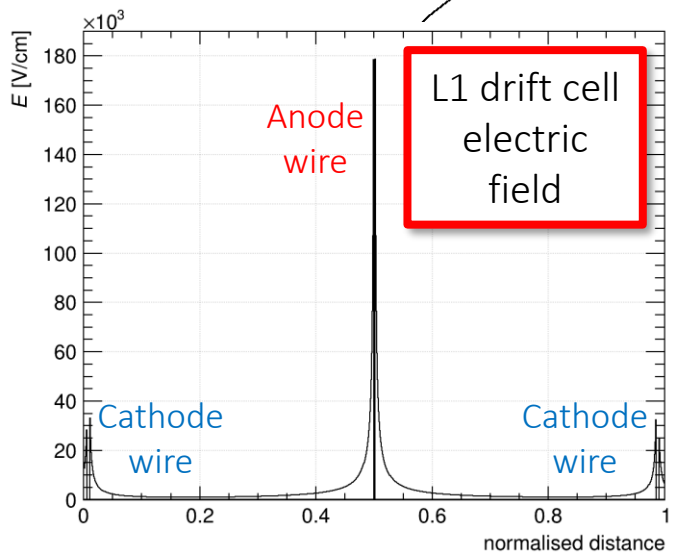
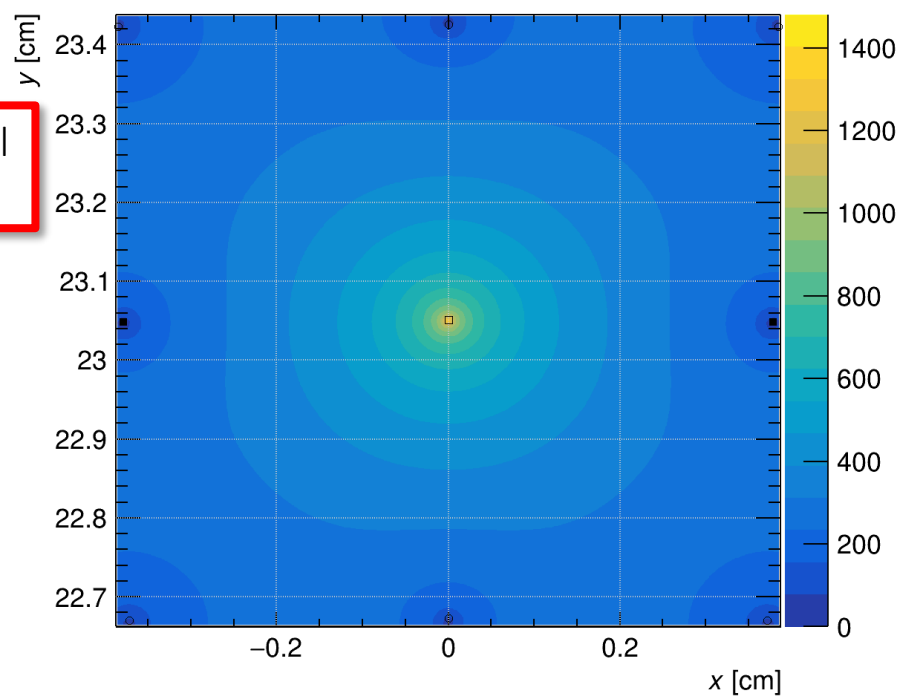
Inner layer

Garfield++
with HV WP and
standard gas mixture

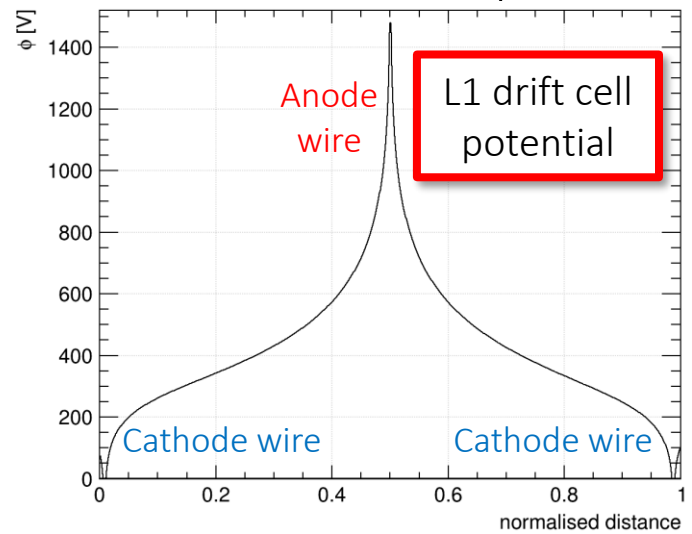


L1 drift cell
potential

One 30°
sector
potential

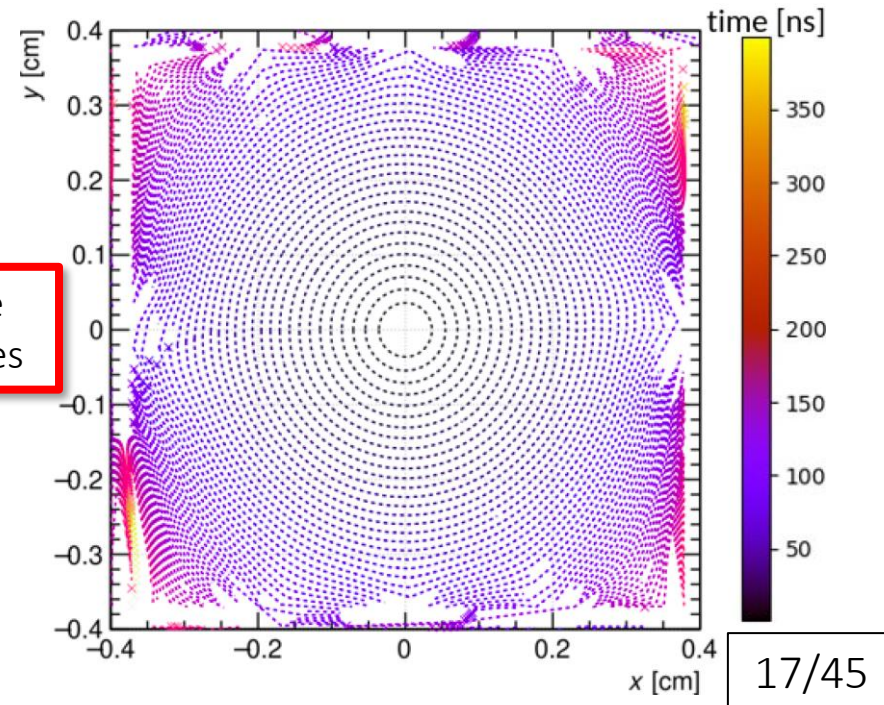


L1 drift cell
electric
field



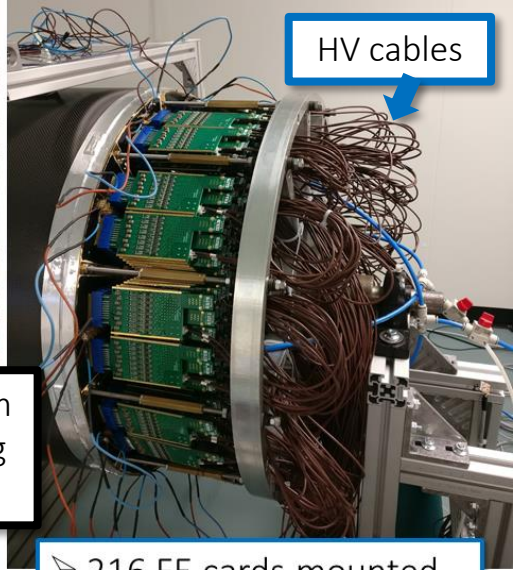
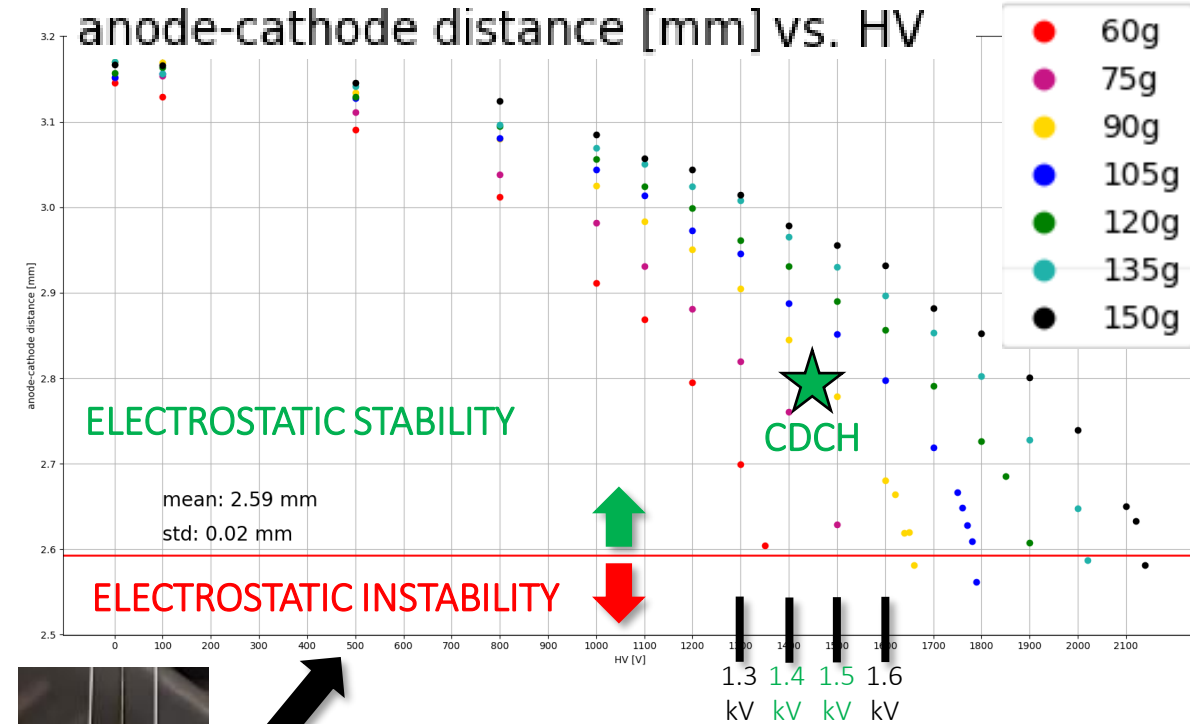
L1 drift cell
potential

Example
isochrones



Working length

anode-cathode distance [mm] vs. HV

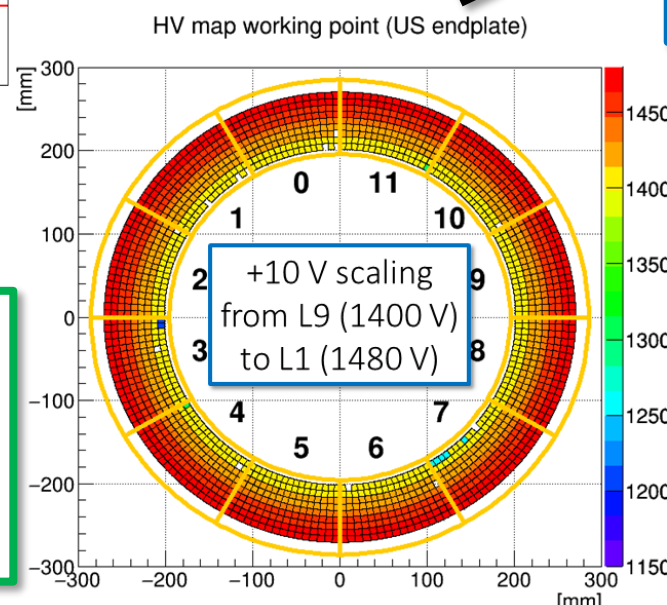


Some pictures from the commissioning phase at PSI

- CDCH temporarily sealed with CF + Al tape
- Nitrogen flux

- 216 FE cards mounted on the US side

Final CDCH length experimentally found through systematic HV tests at different lengths/wires elongations



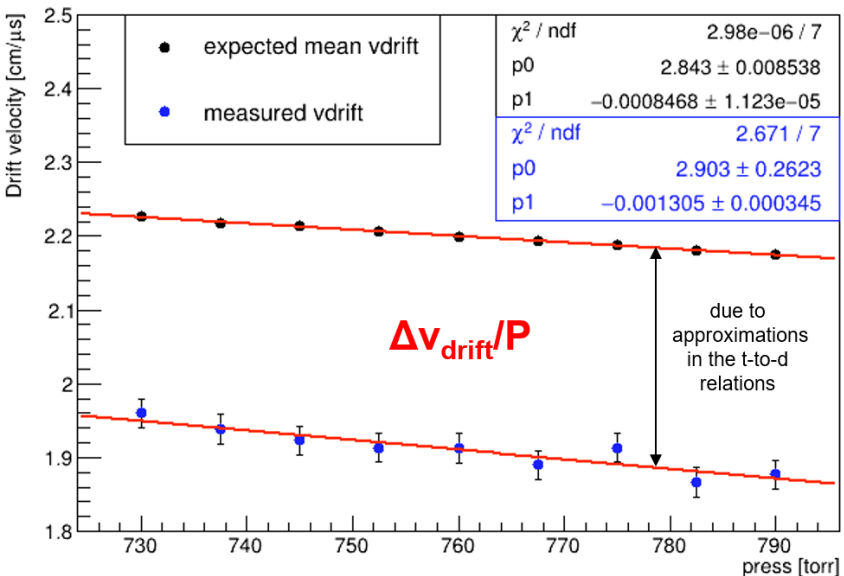
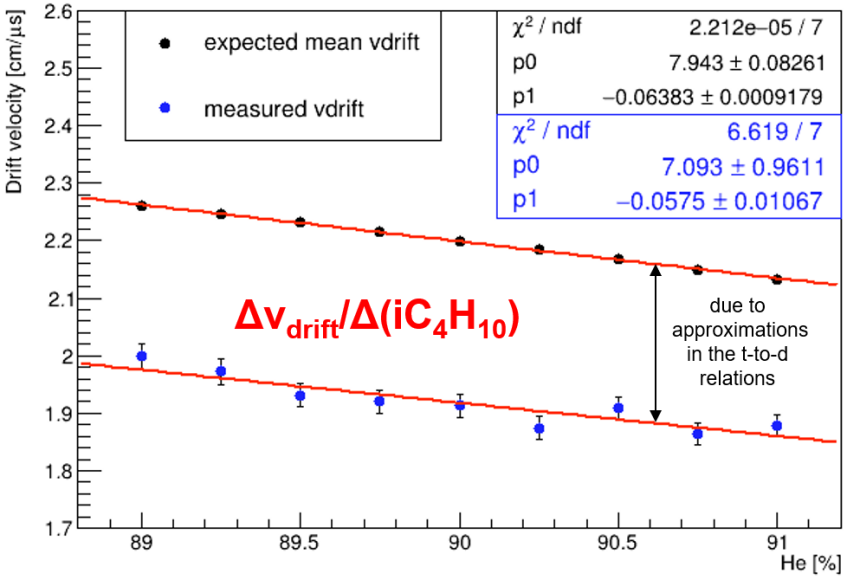
- Tests performed in 2019 and 2020 at PSI inside a cleanroom
- CDCH length adjusted through geometry survey campaigns with a laser tracker (20 μm accuracy)
- Final length set to +5.2 mm of wires elongation
 - 65% of the elastic limit

2 m-long 3-wires prototype in the MEG lab at INFN Pisa

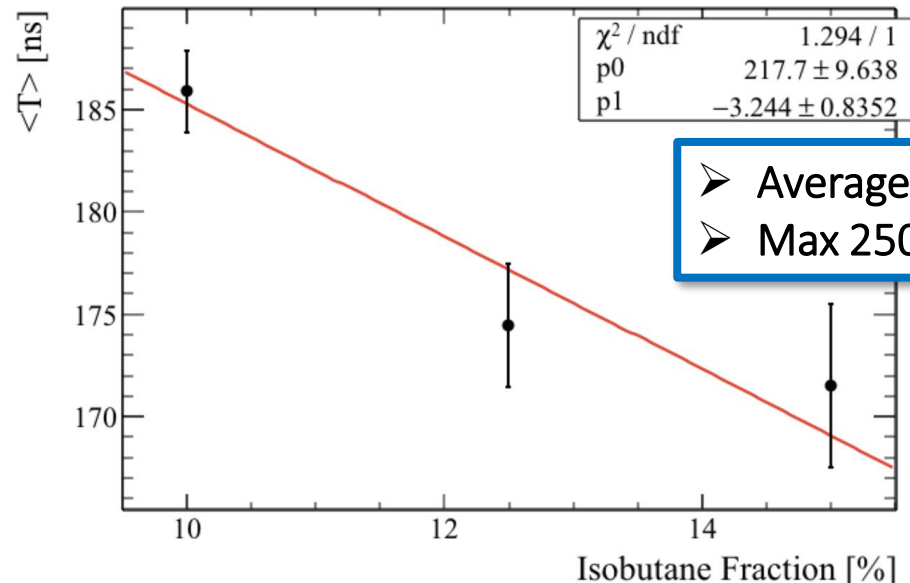
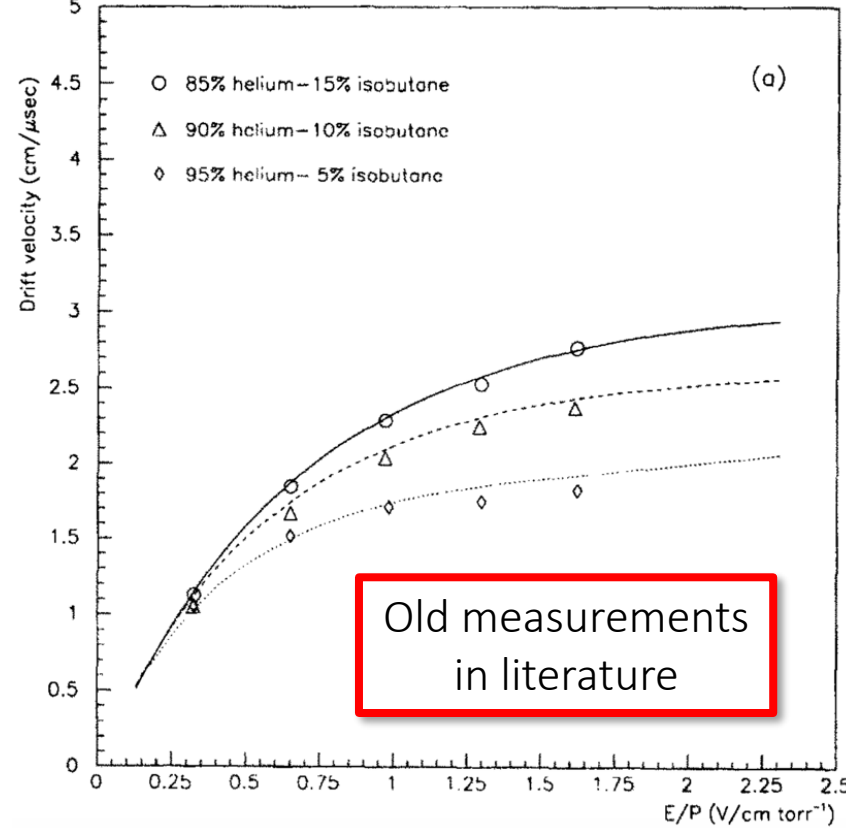
Cell inefficiency experimentally measured

- Negligible in e^+ reconstruction
 - 0.5% worsening in resolutions

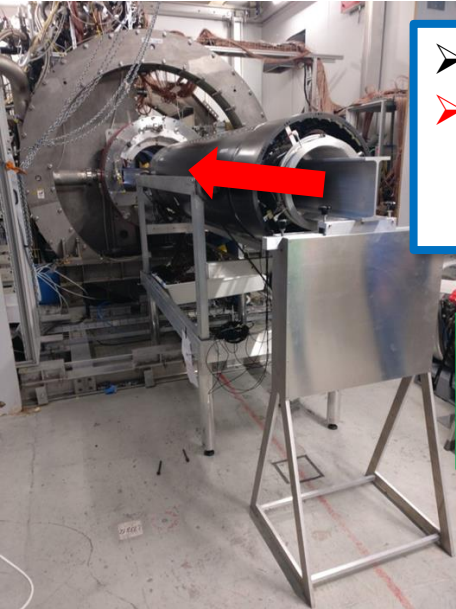
Drift velocity and time



Measurements with an auxiliary monitoring chamber



Integration into the MEG II apparatus



- CDCH inside the experimental area
- Insertion rail through the inner volume to slide CDCH inside the COBRA magnet

CDCH locked in the final position hanged to COBRA

US

DS

Some pictures from the commissioning phase at PSI

Beam line completion is the last operation (not shown here)

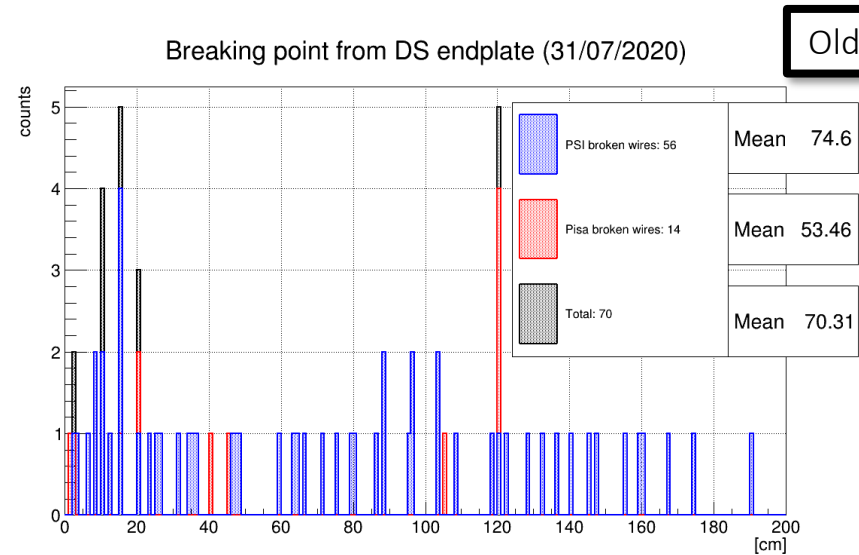
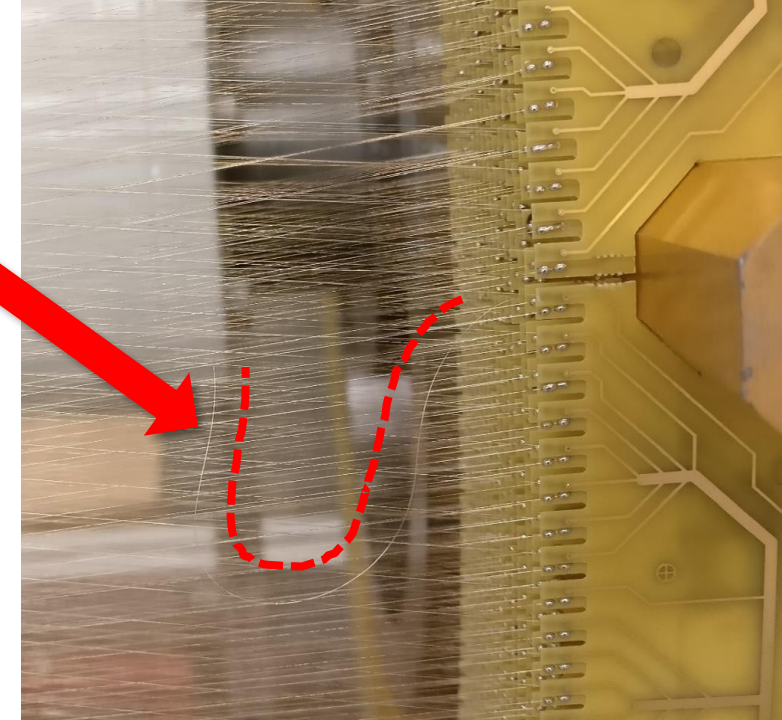
- HV + signal cabling completed for the possible 2π read out
- Gas inlet/outlet connected to the MEG II gas system
- Dry air + cooling circuits connected
- T + RH sensors connected

Investigations on wire breakages

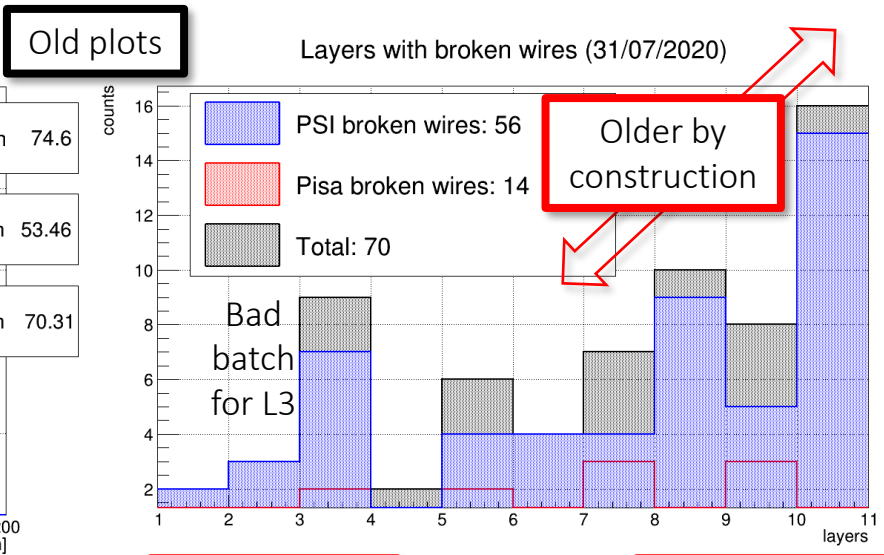
Wire breakages

- During assembly at Pisa and the final lengthening operations at PSI we experienced the breaking of aluminum wires in the chamber
 - Mainly the 40 μm cathodes were affected
 - A few 50 μm cathodes and guards
- 107 broken wires in total during CDCH life (14 at Pisa)
 - 97 broken 40 μm cathodes (90%)
- Consequent delay in construction and commissioning

Broken wire



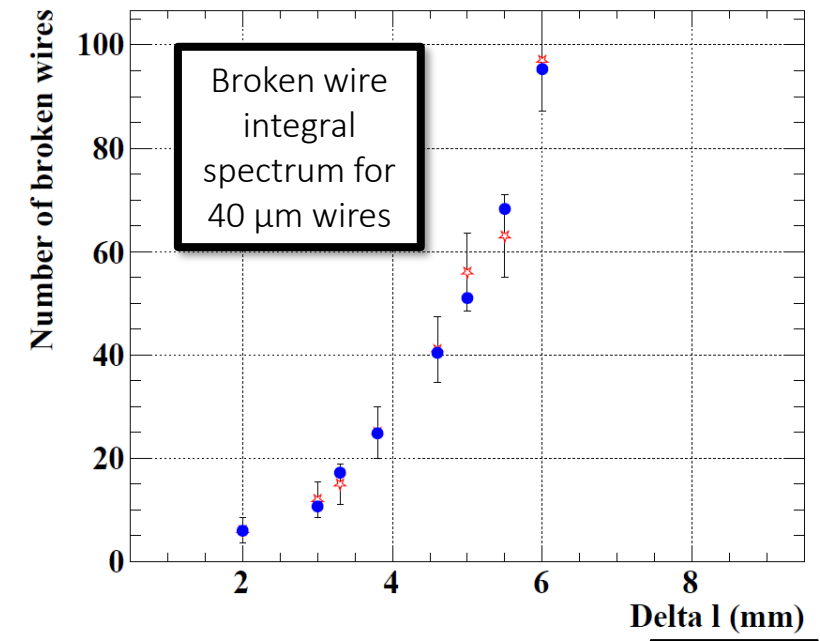
Wires length \approx 193 cm



Older by construction

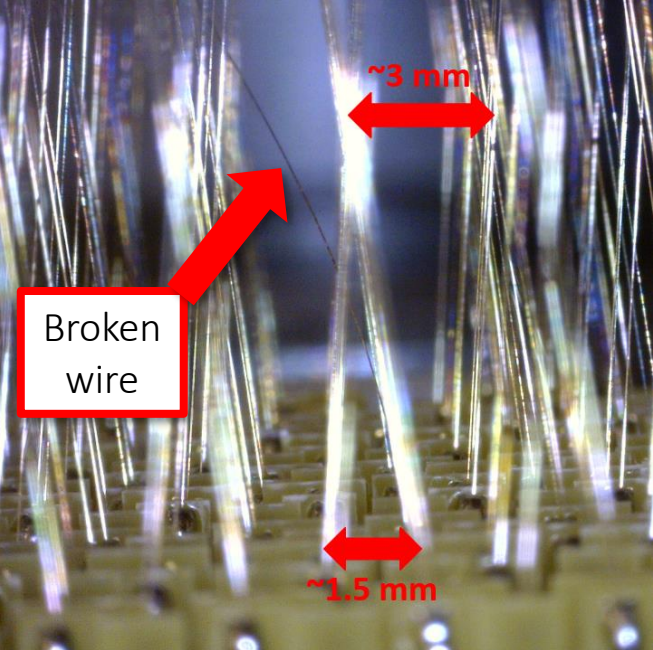
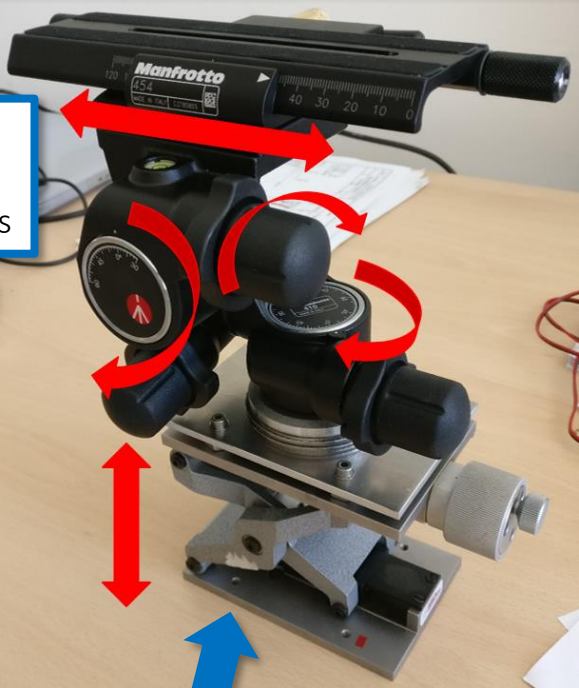
Outer layers

Inner layers



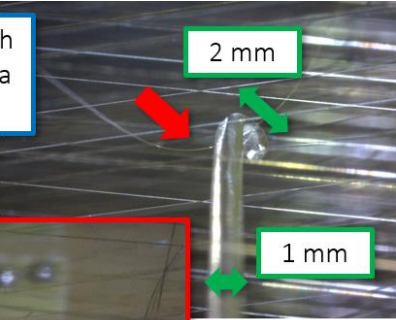
Broken wires extraction

Commercial camera mount with precision movements for all axes



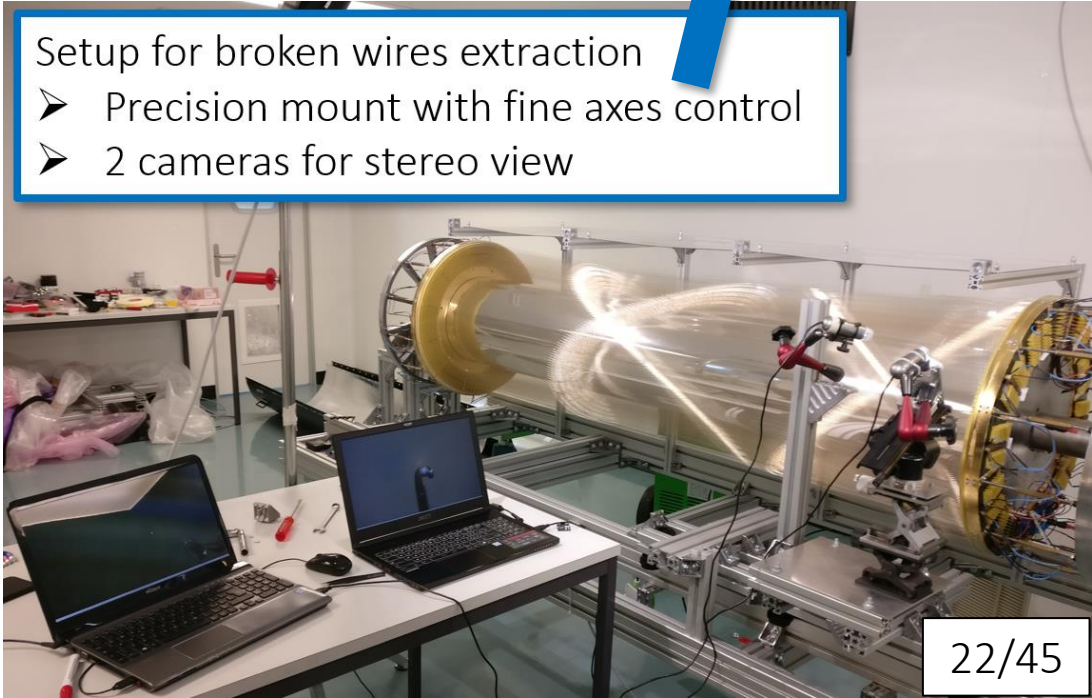
- Each broken wire piece can randomly put to ground big portion of the chamber
- They must be removed from the chamber
 - Very delicate and time-consuming operation
- We developed a safe procedure to extract the broken wires from inside CDCH
 - Exploiting the radial projective geometry given by the stereo wire configuration

Example of extraction with a broken wire hooked by a stainless steel rod

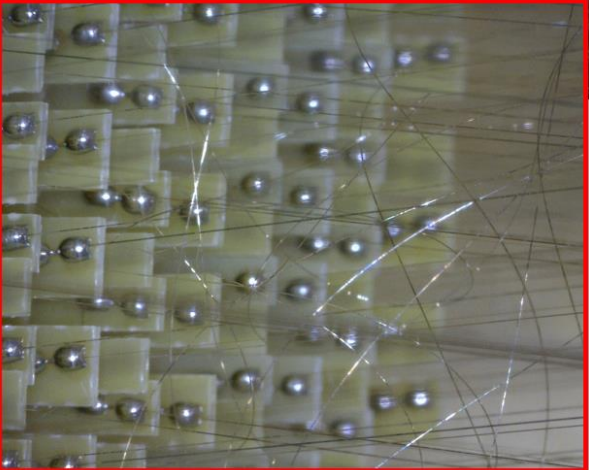


Setup for broken wires extraction

- Precision mount with fine axes control
- 2 cameras for stereo view

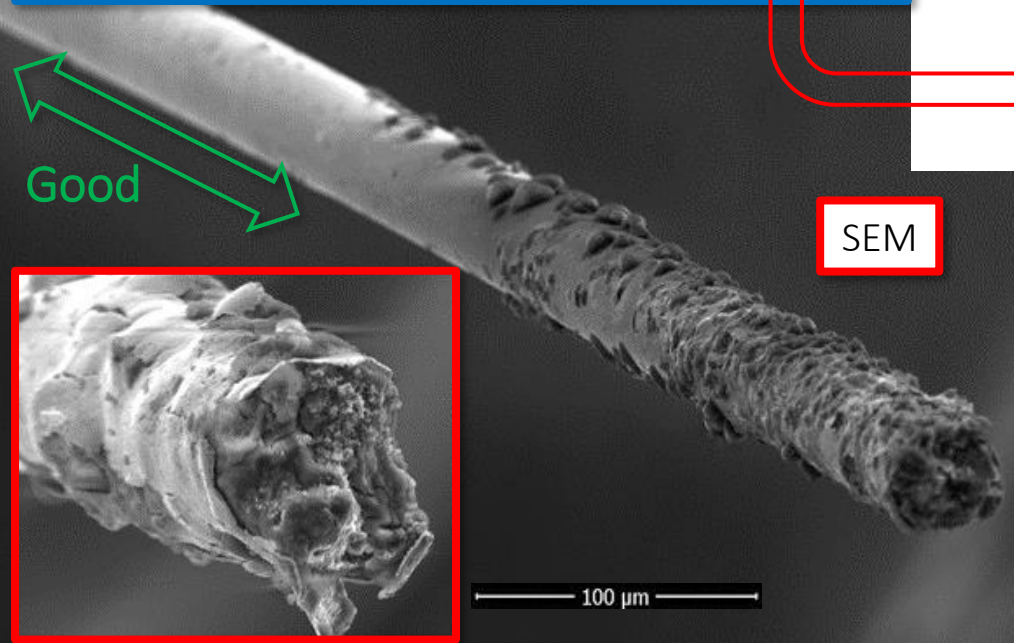
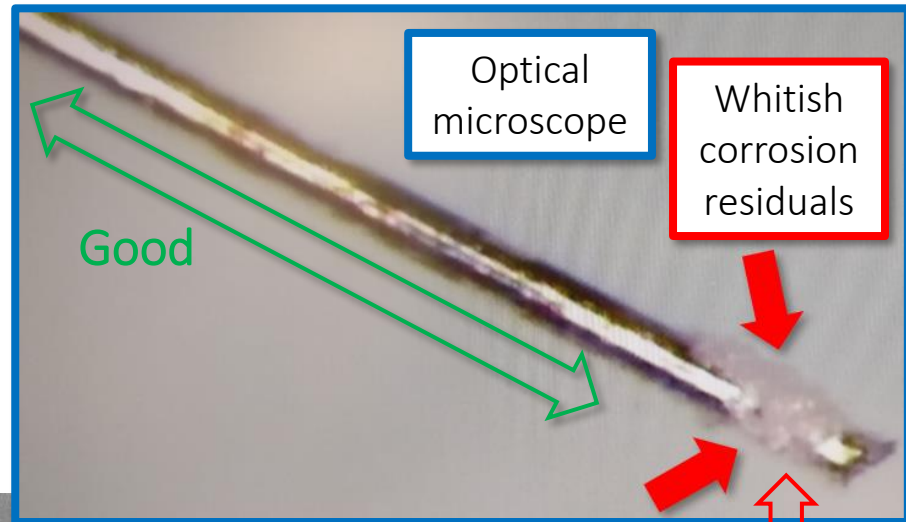


1. Enter with a small tool inside the chamber (few mm space)
2. Hook the wire piece as close as possible to the wire-PCB
3. Extract the wire segment
4. Pull it perpendicularly in the radial direction to break it at the soldering pad

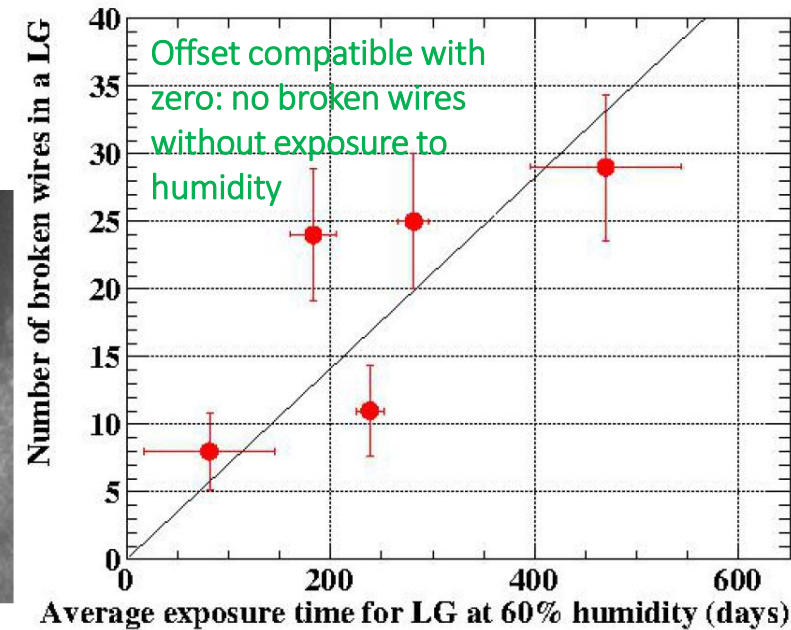
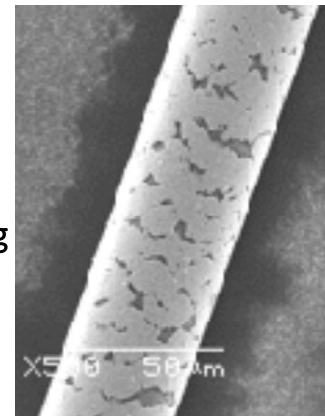


One of the worst case...

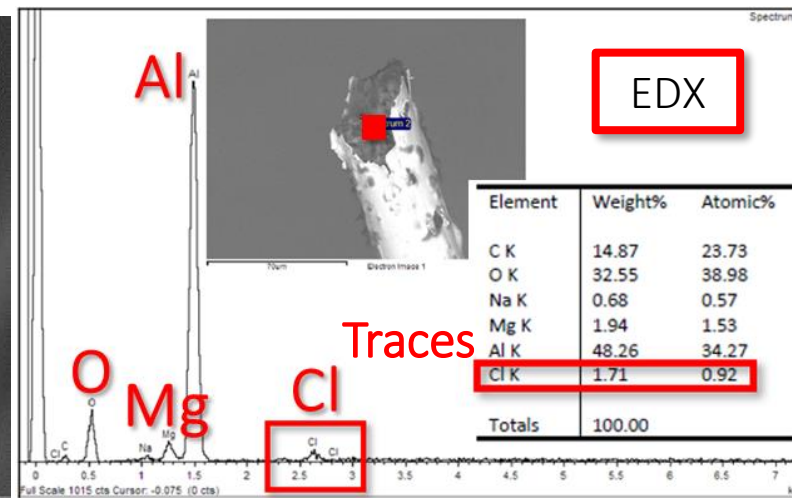
Investigations on wire breakages



- Breakings due to corrosion of the aluminum wire core
- Two hypotheses
 1. Galvanic process between Al and Ag coating
 2. Al corrosion by Cl
- Both imply **water as catalyst**
 - Air moisture condensation inside cracks in the Ag coating even at low Relative Humidity (RH) levels < 40%
 - Al oxide or hydroxide deposits

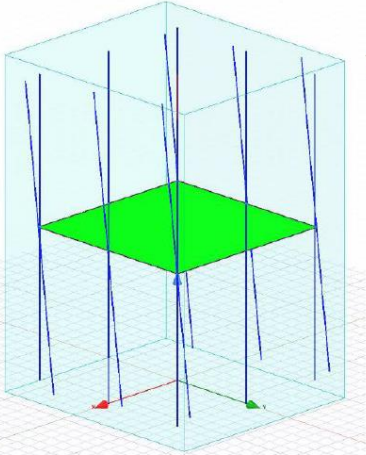


- Found a good linear correlation between number of broken wires and exposure time to humidity
- The only way to stop the corrosion is to keep the wires in an inert atmosphere
- No more broken wires due to corrosion since CDCH flushed with Nitrogen or Helium once sealed



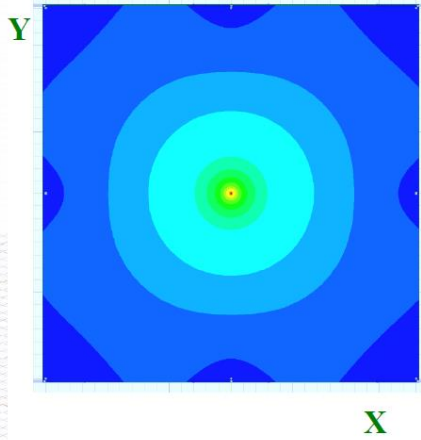
Missing wire effect

ANSYS 3D model

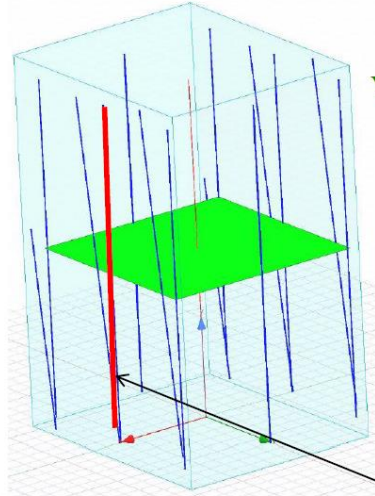


Ideal case

E field

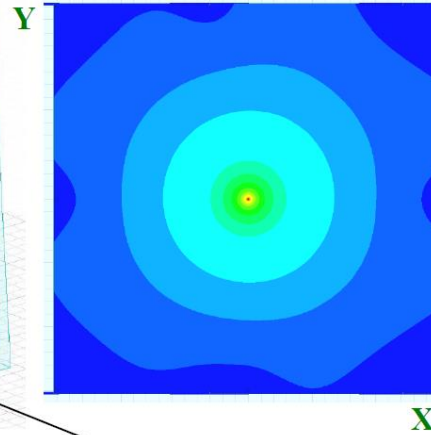


ANSYS 3D model

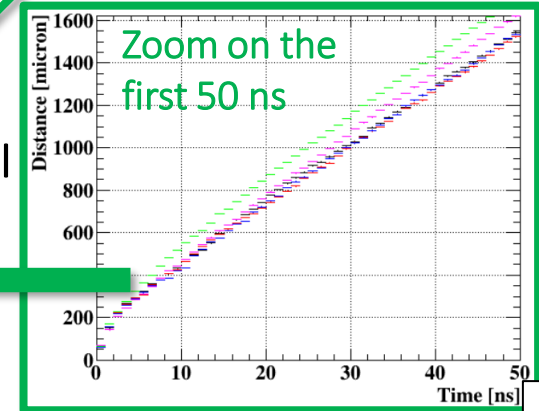
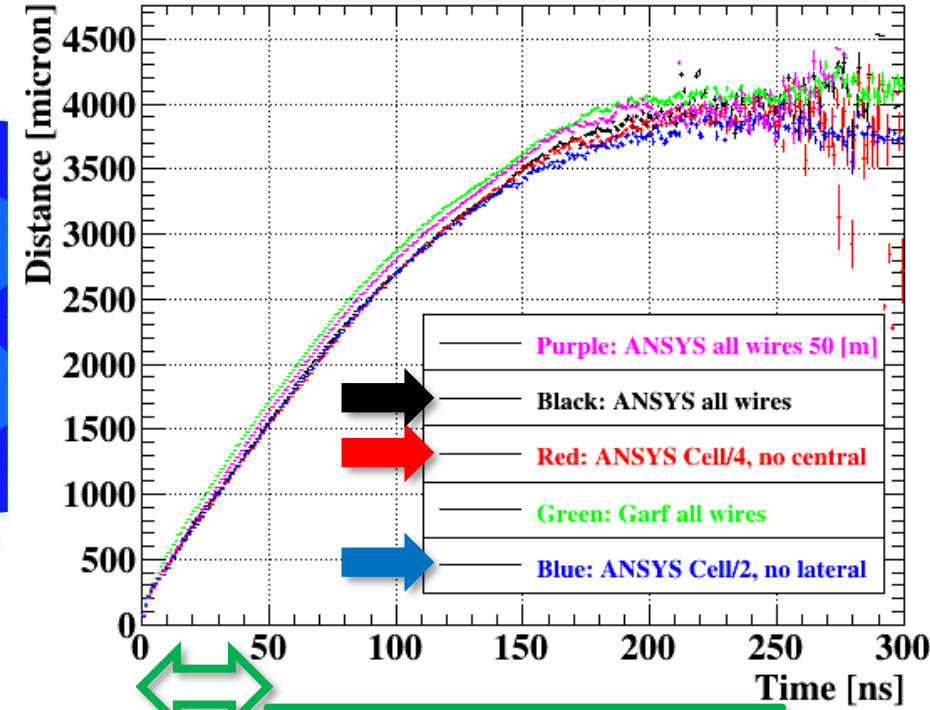


Missing wire removed

E field



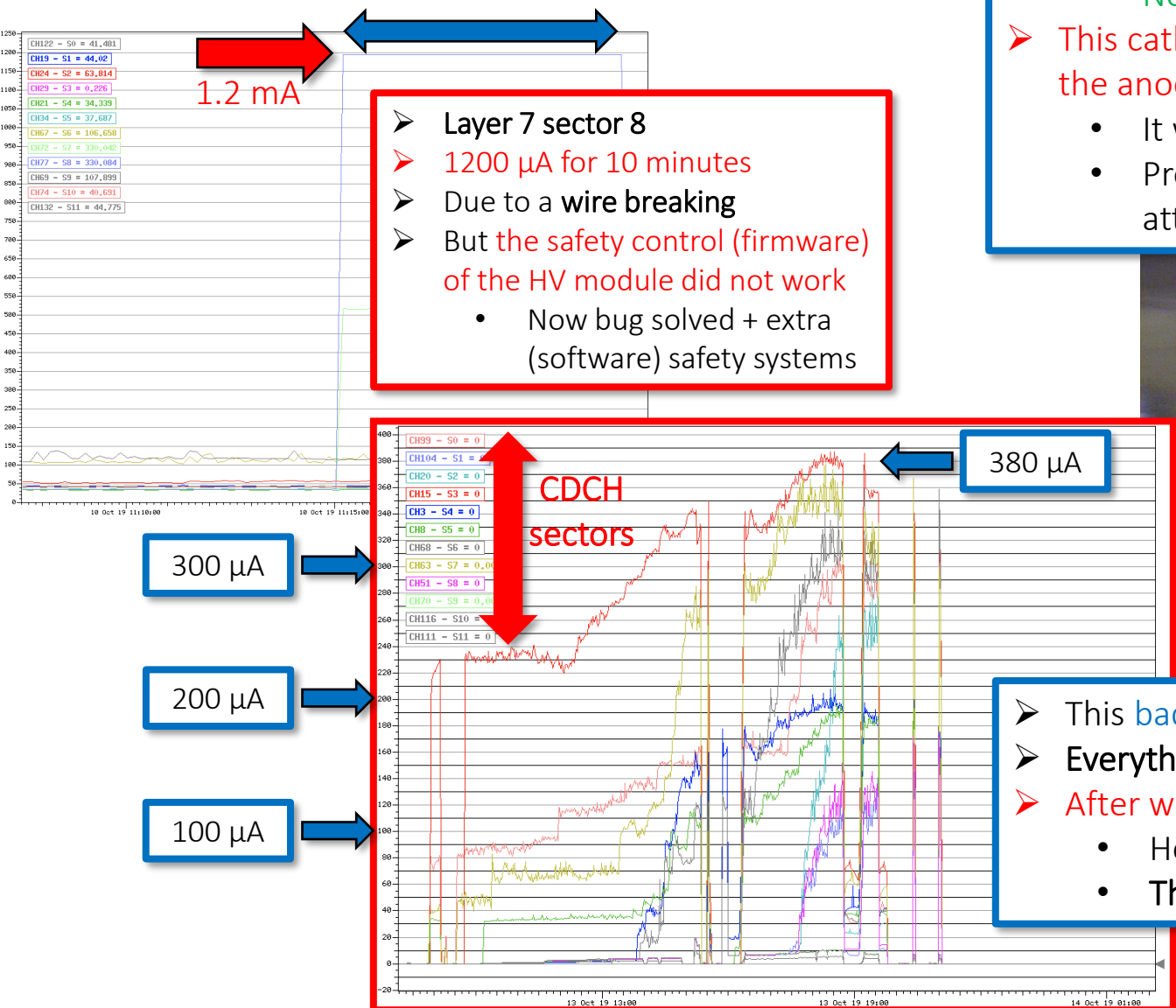
Drift distance vs. drift time relations computed with Garfield



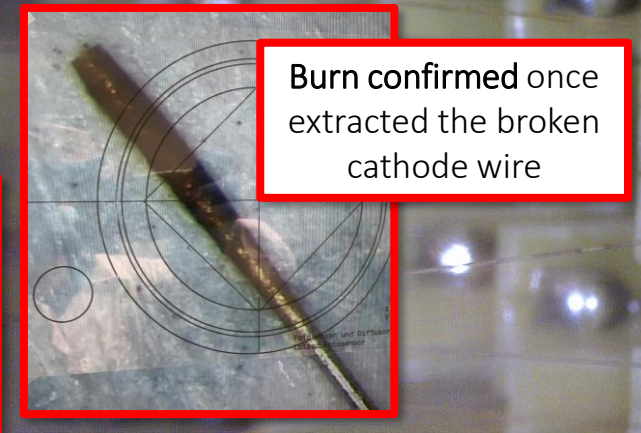
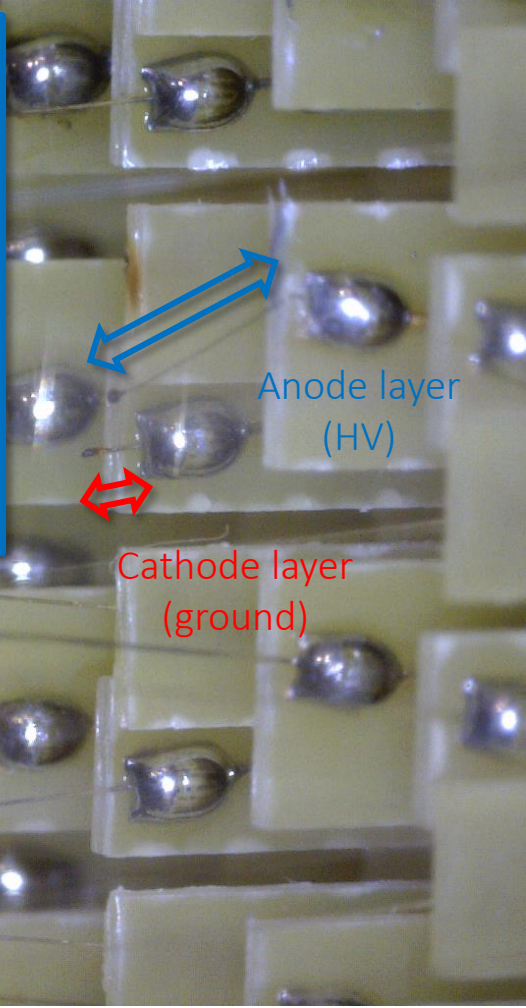
- Study the effect of a missing cathode on isochrones → e^+ reconstruction
- Used Garfield and ANSYS to simulate the electric field in a $6 \times 6 \text{ mm}^2$ representative drift cell
 - Single-hit resolution $\sigma_{hit} < 120 \mu\text{m}$
 - Difference between different curves → $\approx 10 \mu\text{m}$
- Missing wire effect negligible

Investigations on anomalous currents

Bad event in 2019



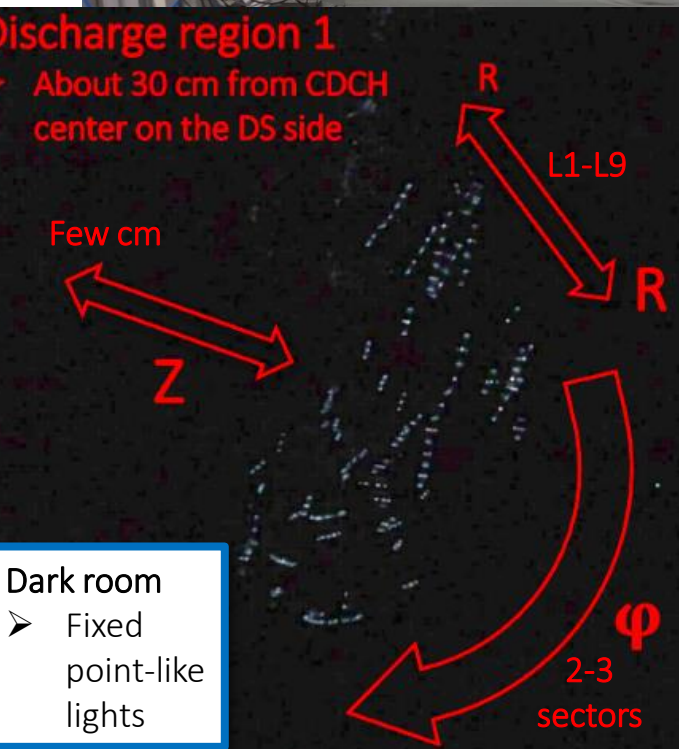
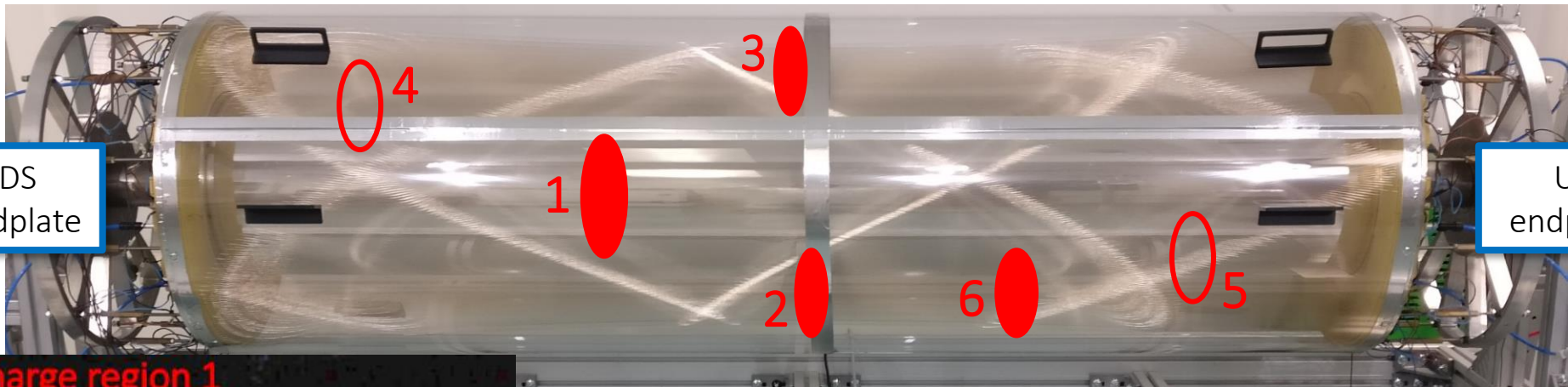
- During investigations we found **one broken cathode wire** together with a **few mm anode wire segment** pointing to it
 - Both show **burn marks** in the final portion
 - **No breaking due to corrosion**
- This cathode was broken by the **contact with the anode short segment left inside by mistake**
 - It was not spotted during commissioning
 - Probably it broke during the first attempts to remove broken wires



- This **bad event occurred during the Michel e^+ data taking with μ^+ beam**
- **Everything was good up to this moment**
- **After we experienced anomalously high currents in several sectors/layers**
 - Here an example for layer 2 at the HV working point + beam ON
 - The problem has been investigated

Two of the discharge regions

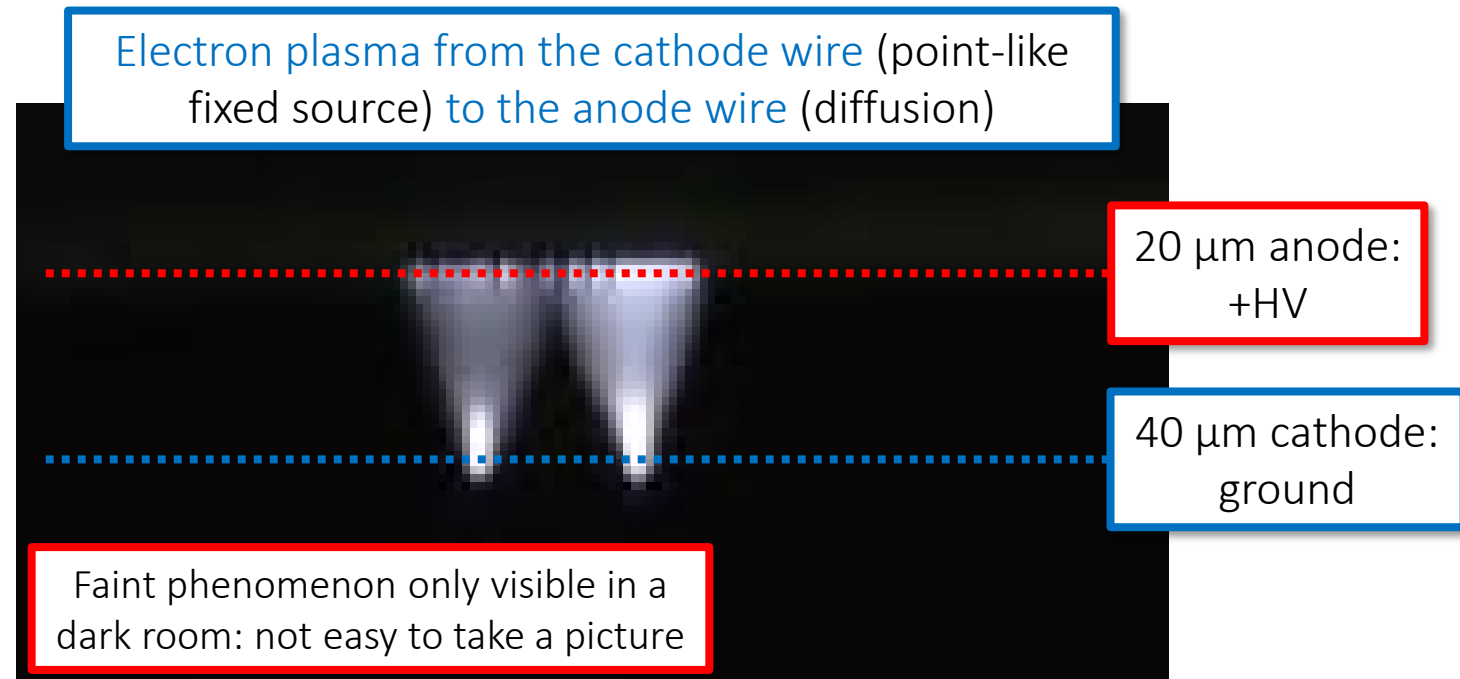
Investigations on high currents



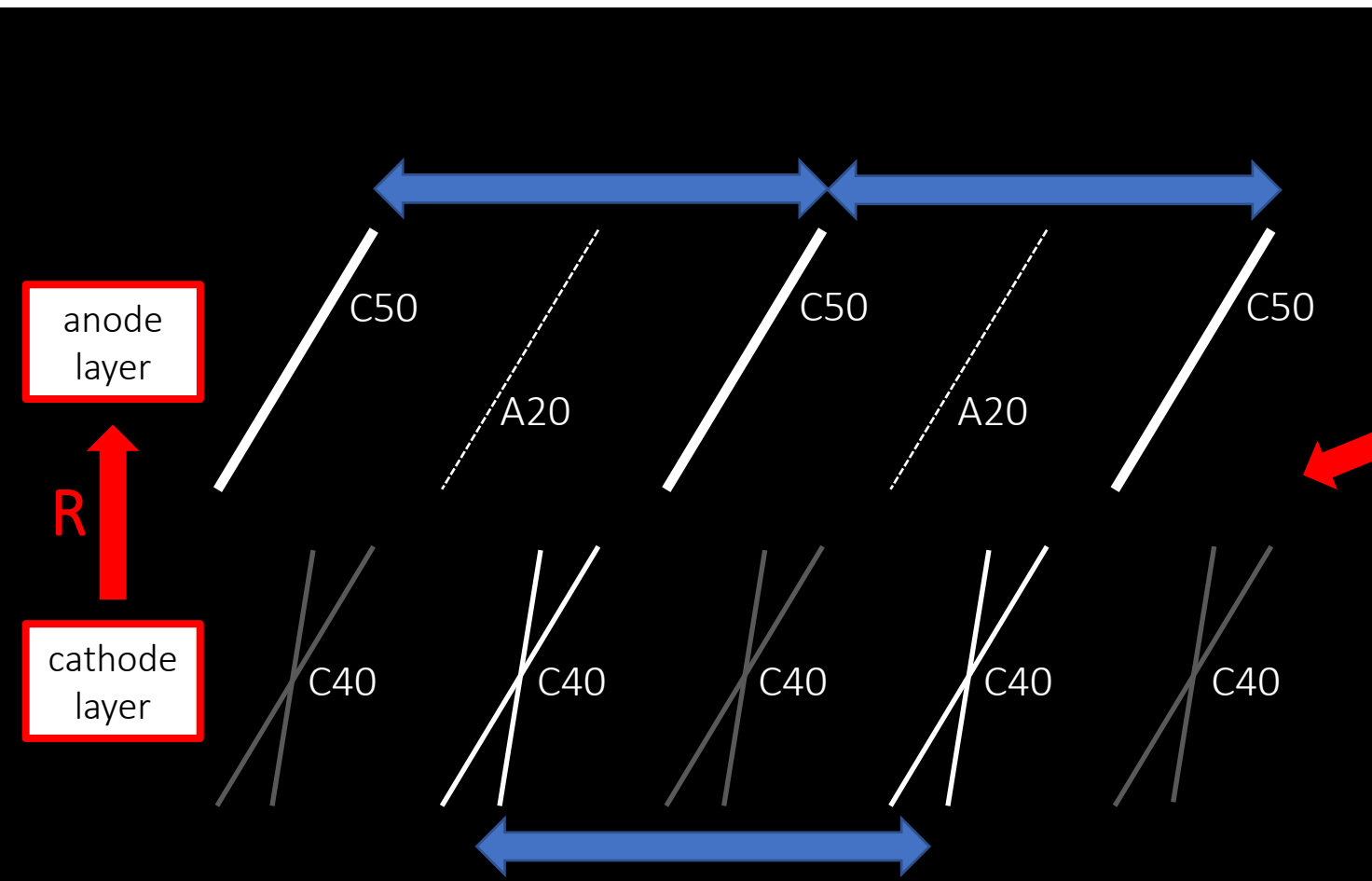
- HV tests with CDCH closed with a transparent shell and filled with the standard He:IsoB 90:10 gas mixture to spot the discharges
- We saw corona-like discharges in correspondence of 6 whitish regions
- Gas mixture optimization: different additives to the standard mixture to test the CDCH stability and try to recover the normal operation
 - Up to 5% CO₂ and 10% synthetic air (80% Nitrogen + 20% Oxygen)
 - 2000-4000 ppm of H₂O (≈10% Relative Humidity inside CDCH)
 - 1-1.5% Isopropyl alcohol
 - From 500 ppm to 2% of O₂
 - Also in combination with H₂O and Isopropyl alcohol
- Oxygen proved to be effective in reducing high currents (plasma cleaning?)
- Isopropyl alcohol crucial to keep stable the current level

Corona discharges lab tests

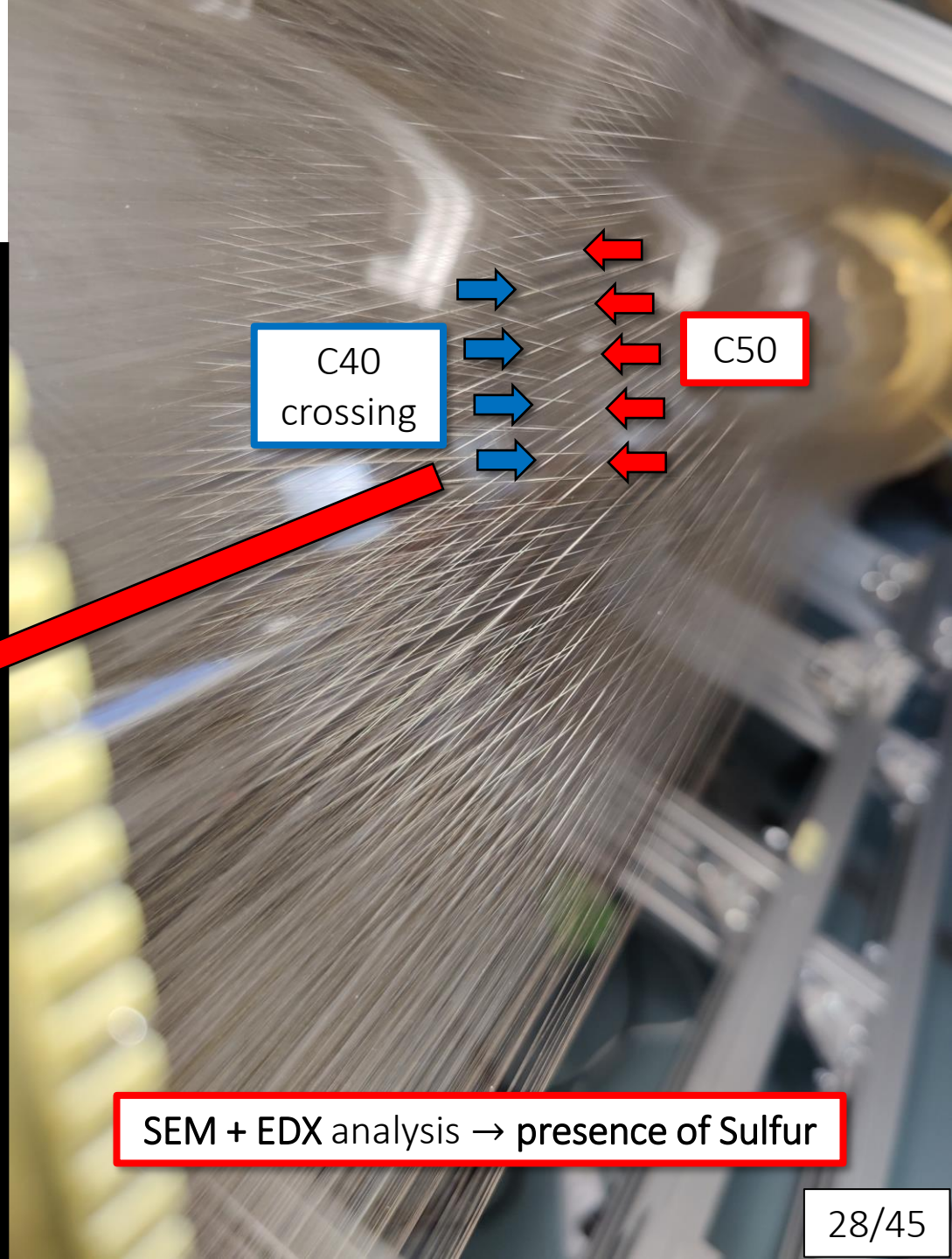
- They occurred naturally at 2300 V (100-200 μA currents) with 40 μm cathode wire diameter and brand-new wires (no damaged surface)
 - Known phenomenon: but why at 1400 V?
- White deposits seems to lower the corona discharge HV limit



Pattern in the white spots

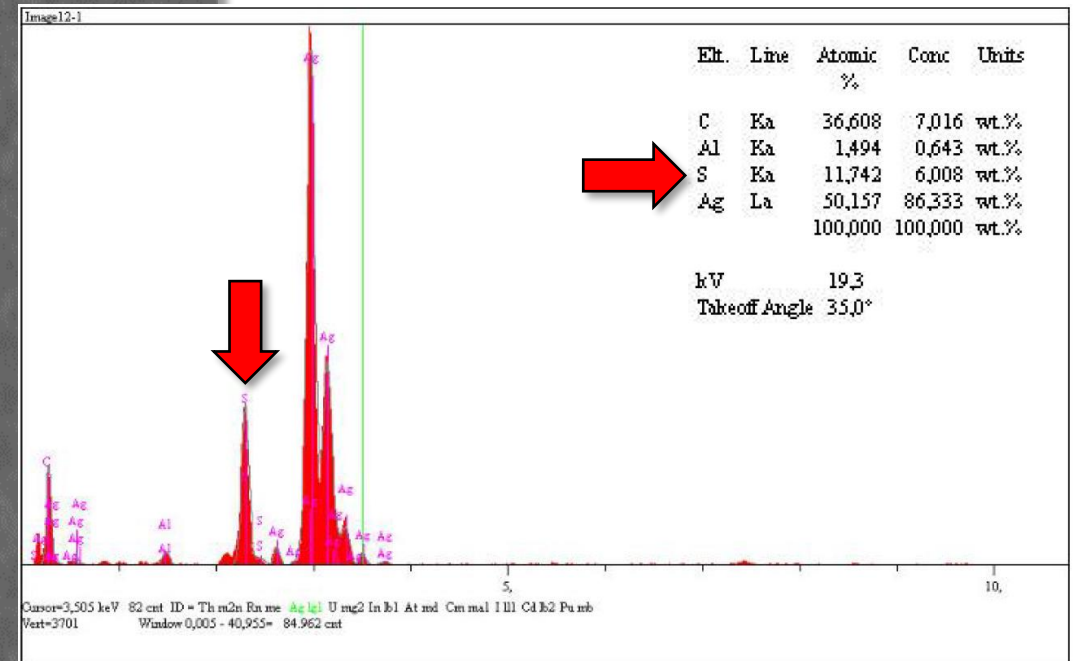
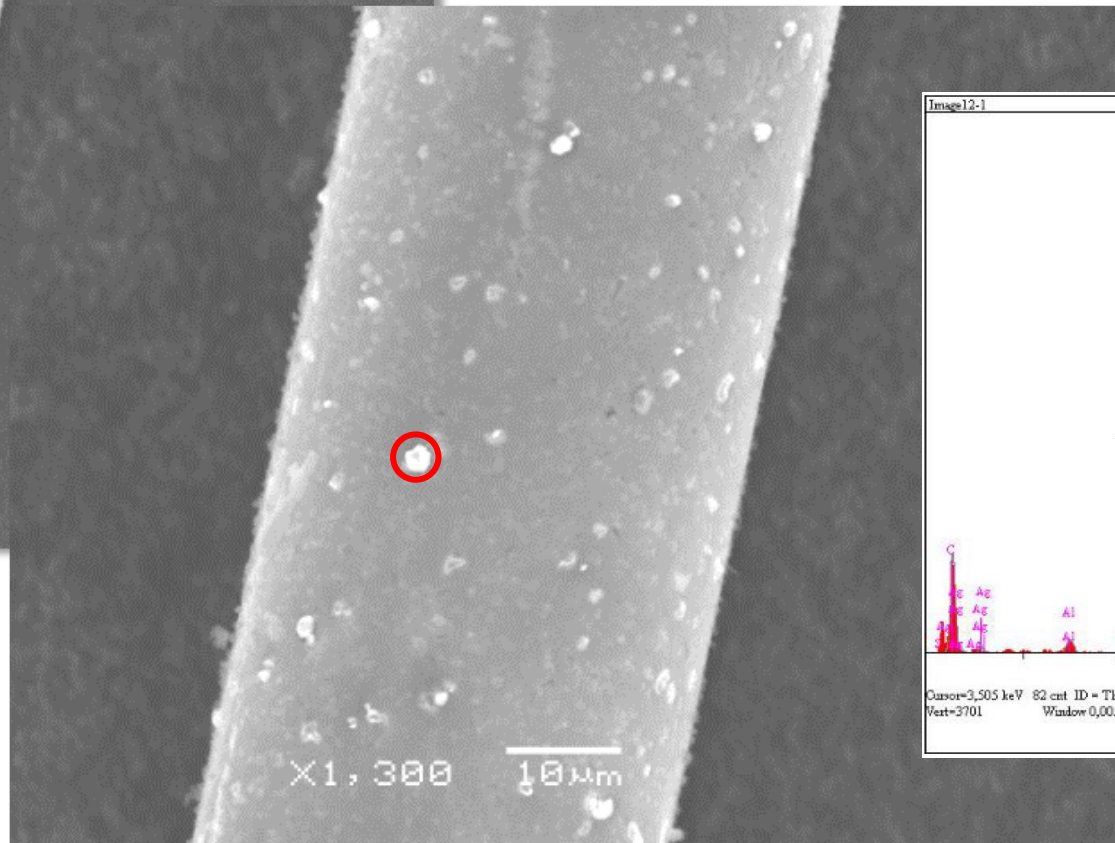
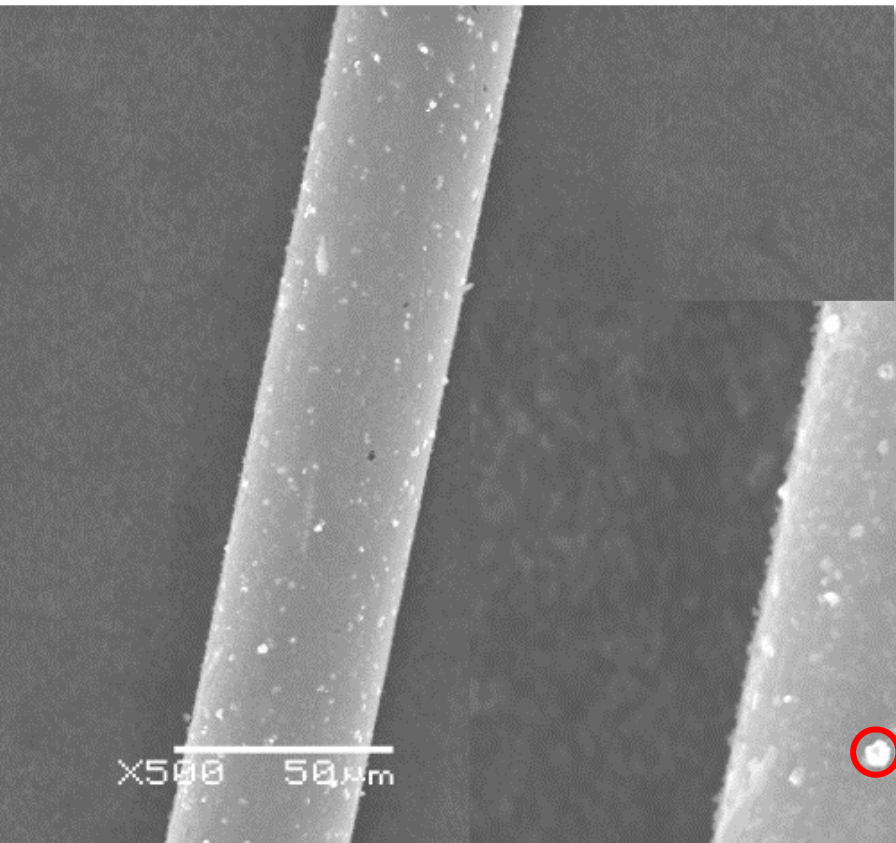


- White spot in correspondence of the 40 μm cathode wire crossing points
- The period is that of the 50 μm cathode wire



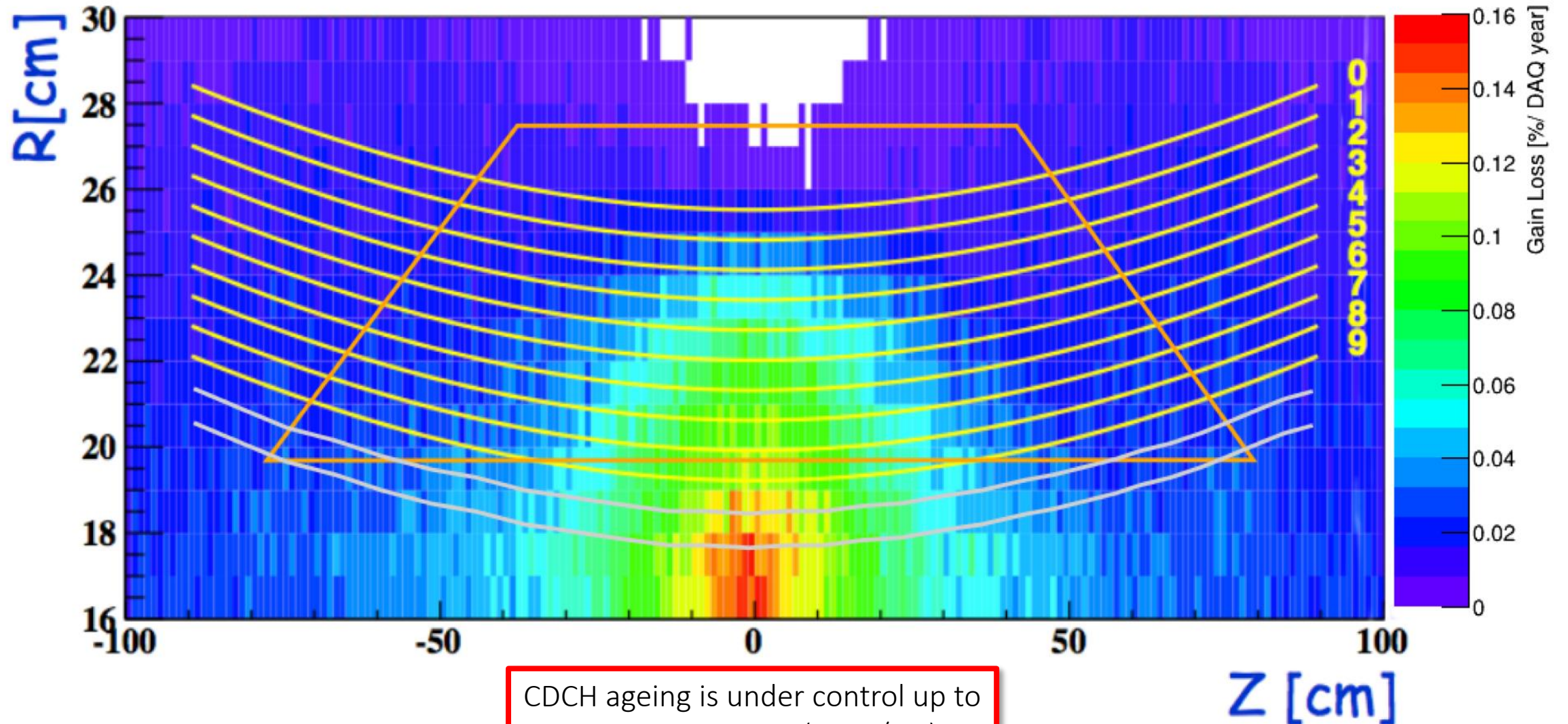
SEM + EDX analysis → presence of Sulfur

SEM + EDX analysis of the white deposit



CDCH ageing studies

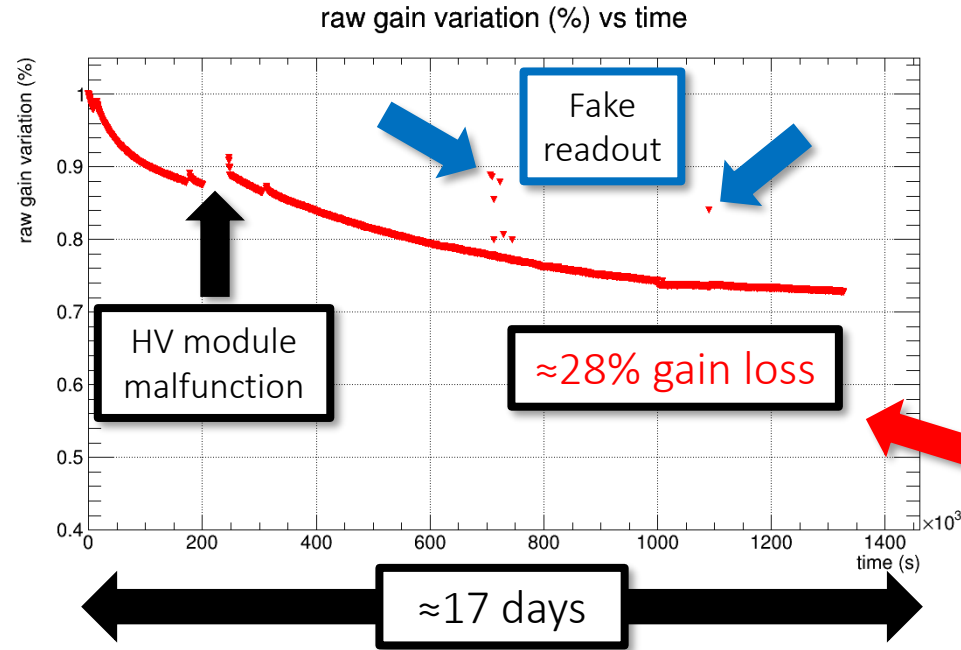
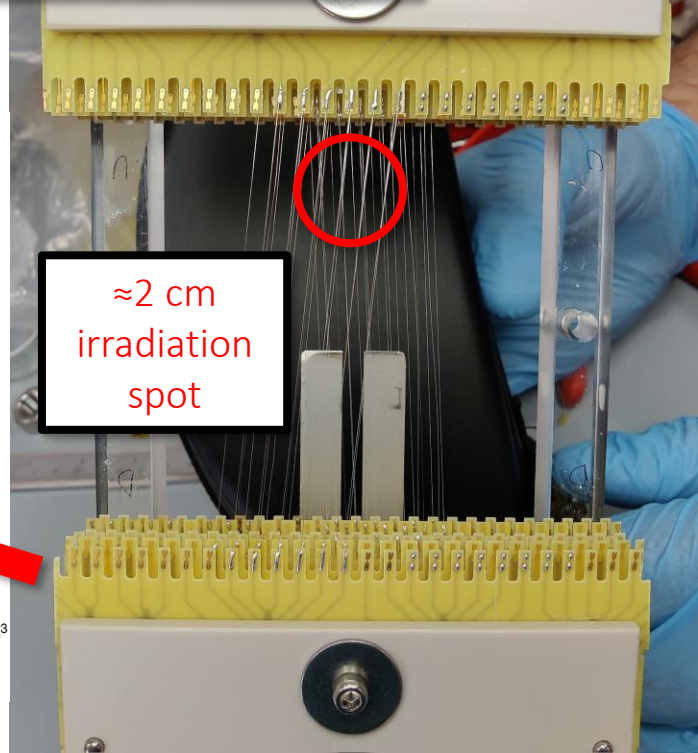
Expected gain drop per DAQ year vs. Z and R



CDCH ageing is under control up to 3 years operation (0.5 C/cm)

Ageing tests on prototypes

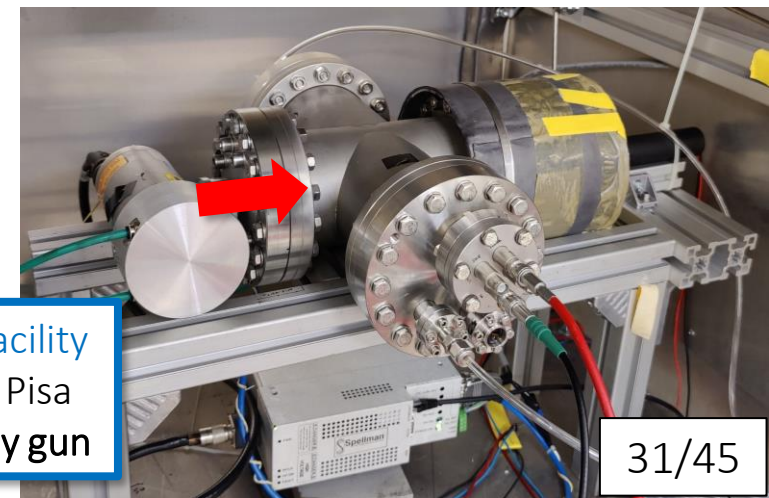
Stereo prototype with 2 layers of 3 drift cells each



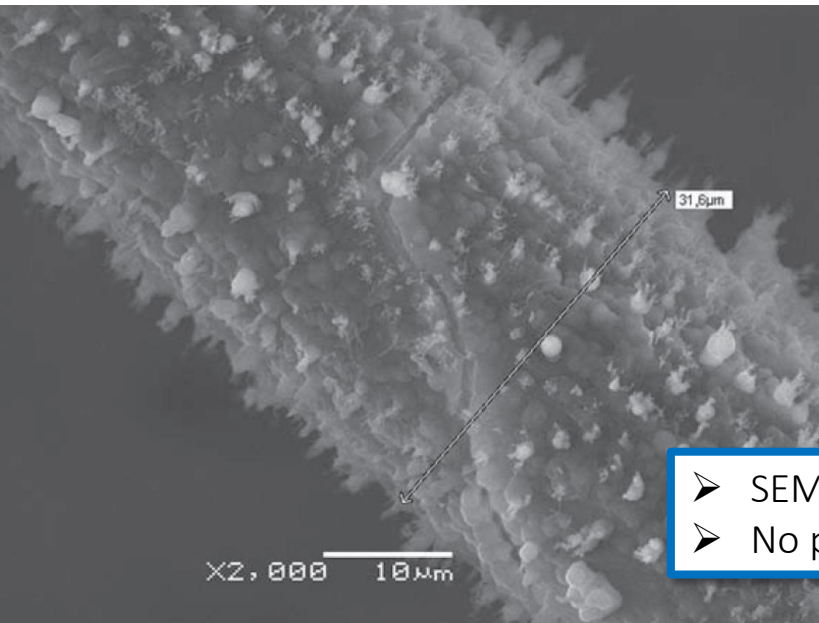
≈2 cm irradiation spot

≈17 days

- Total ageing acceleration factor $10 < A < 100$
 - Accumulated charge comparable to the total MEG II life $\approx 0.5 \text{ C/cm}$
- No issues/discharges observed



Ageing facility at INFN Pisa with X-ray gun

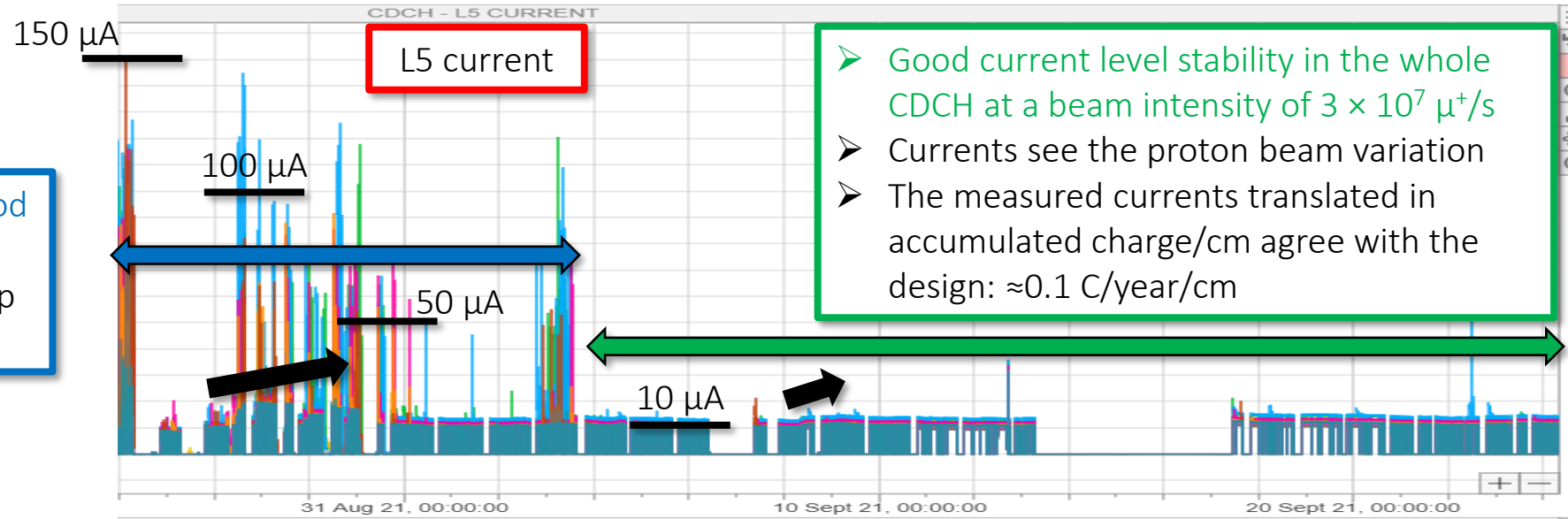


- SEM image of an aged anode wire
- No problems on cathode wires

CDCH conditioning
with μ^+ beam

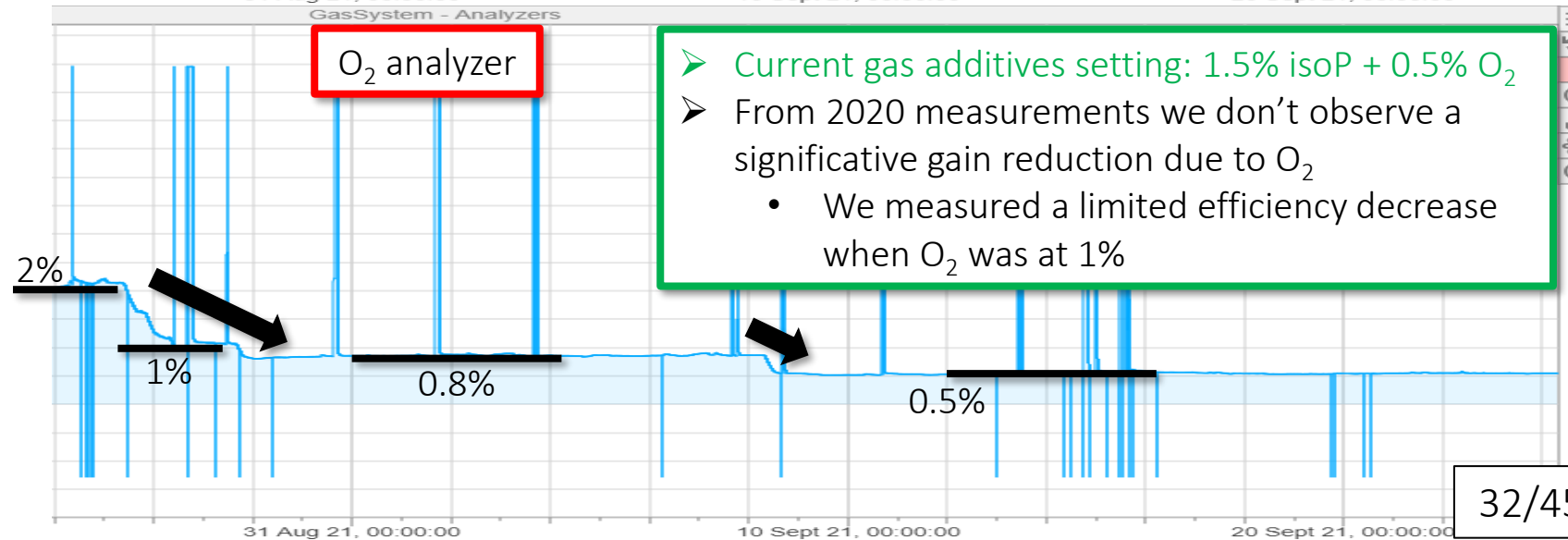
Conditioning with μ^+ beam

- Example of conditioning period with current discharges
- HV up to WP+40V to speed up the O₂ cleaning



- Good current level stability in the whole CDCH at a beam intensity of $3 \times 10^7 \mu^+/s$
- Currents see the proton beam variation
- The measured currents translated in accumulated charge/cm agree with the design: ≈ 0.1 C/year/cm

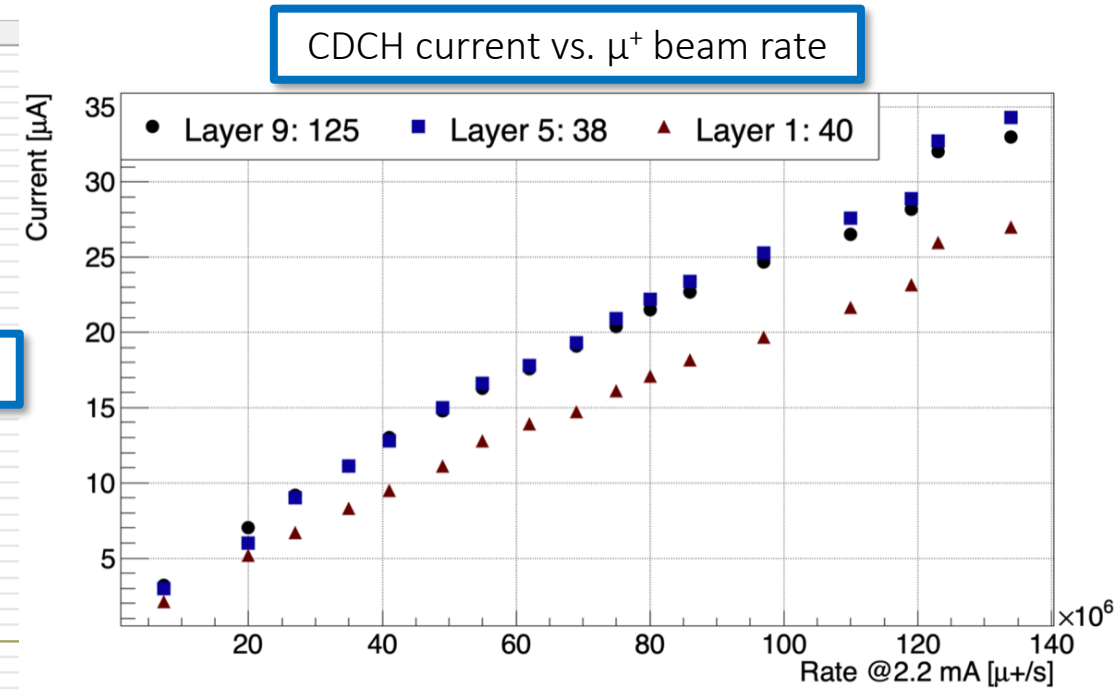
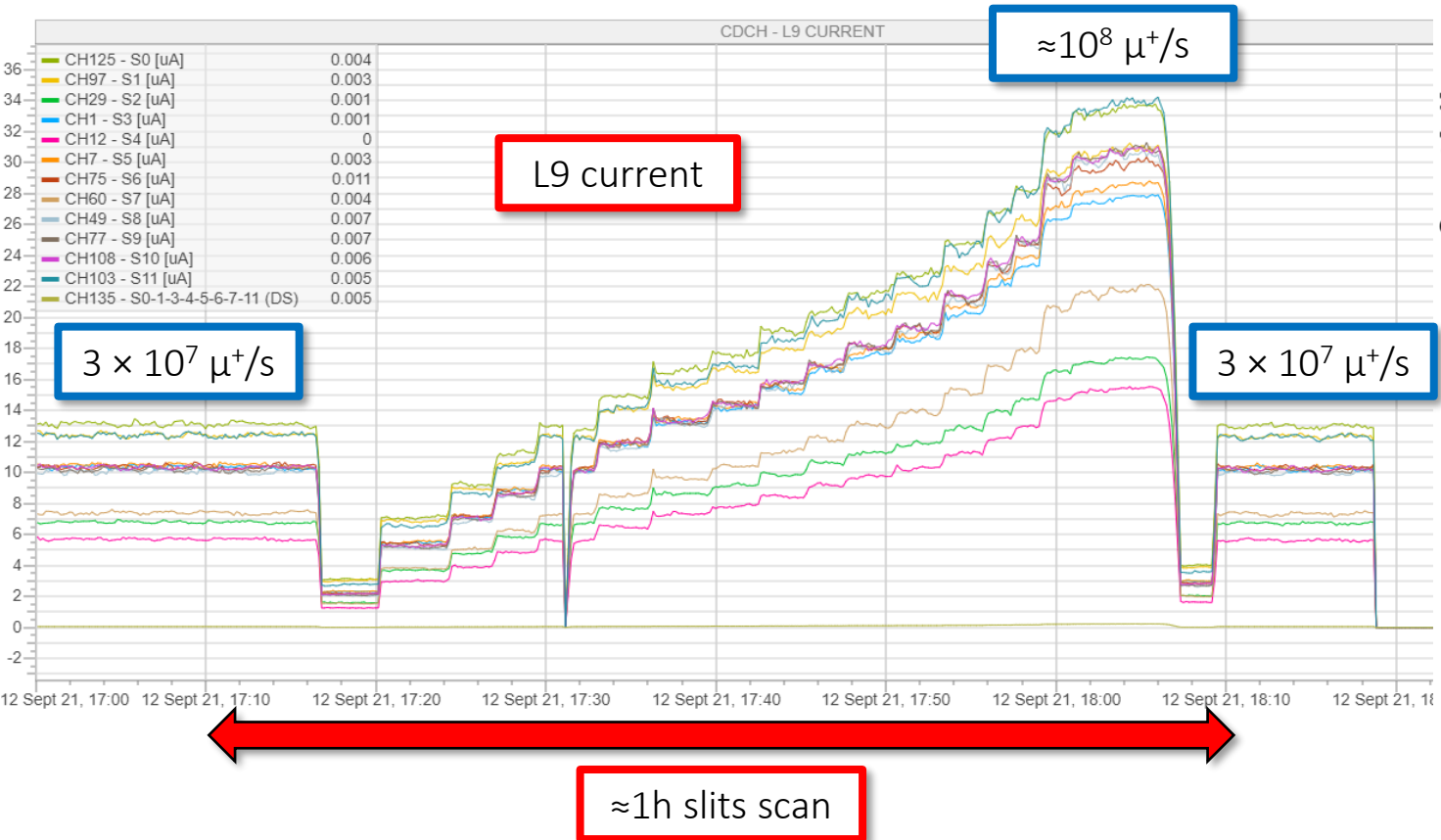
- We are very sensitive to the isopropyl alcohol concentration
- We experienced that 1-1.5% isoP concentration is crucial to keep the stability



- Current gas additives setting: 1.5% isoP + 0.5% O₂
- From 2020 measurements we don't observe a significant gain reduction due to O₂
 - We measured a limited efficiency decrease when O₂ was at 1%

CDCH currents vs. μ^+ beam intensity

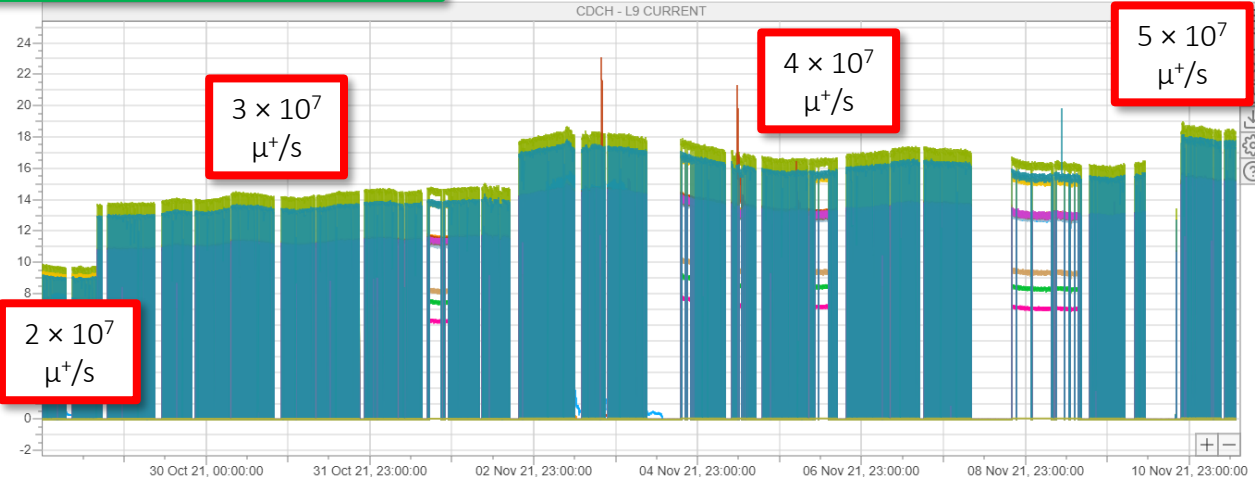
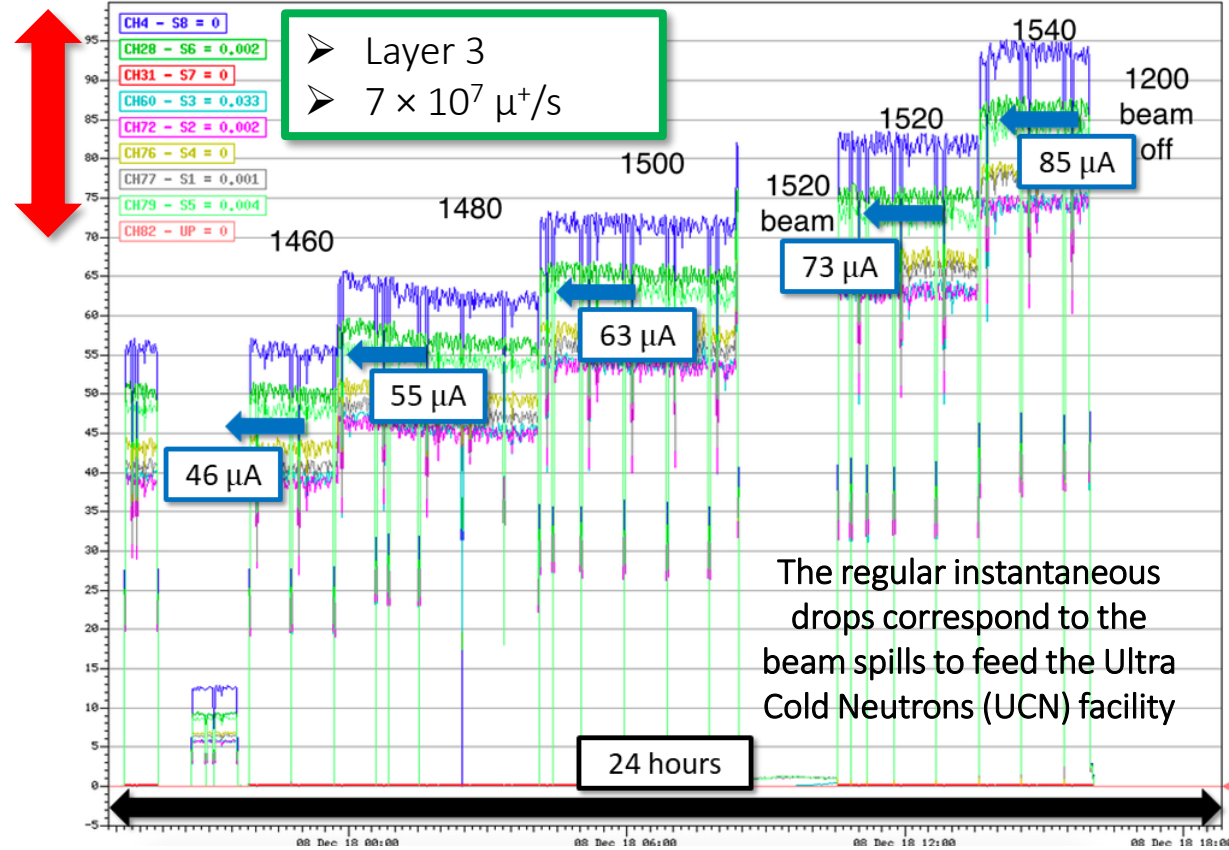
- CDCH currents followed reasonably well the beam intensity up to intensities never reached before
- Good proportionality with the μ^+ rate



Example of gain curves with CDCH stable

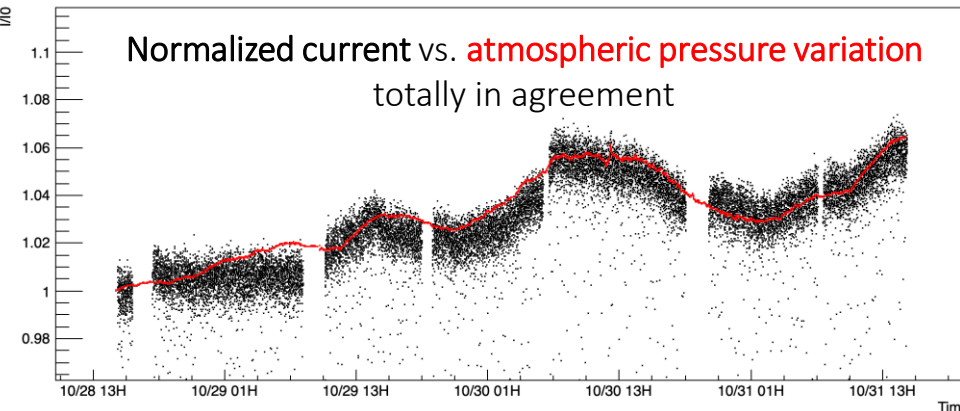
Different colors correspond to different CDCH sectors

CDCH current level vs. (HV or μ^+ beam intensity)



- Currents correctly follow the beam intensity
- Gas gain is also sensitive to the variations of the atmospheric pressure

$$\frac{\Delta G}{G} = -k \frac{\Delta P}{P}$$

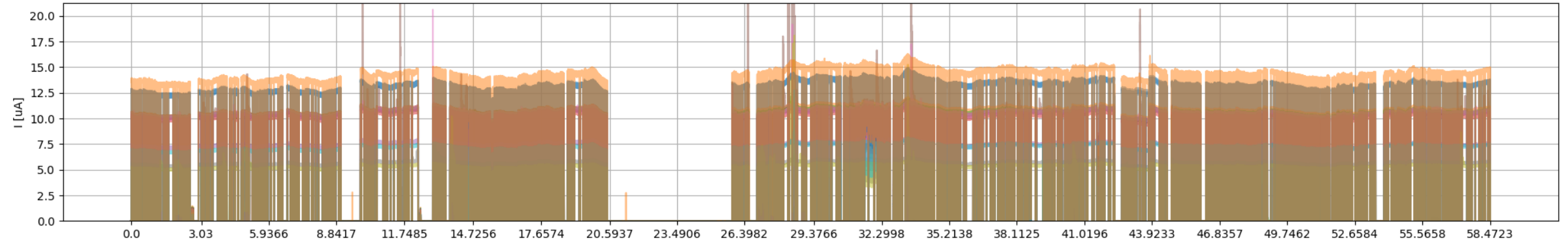


$$\frac{I}{I_0} = 1 - 5 \frac{\Delta P}{P}$$

$k = 5$

L9 normalized current vs. gas density (P, T)

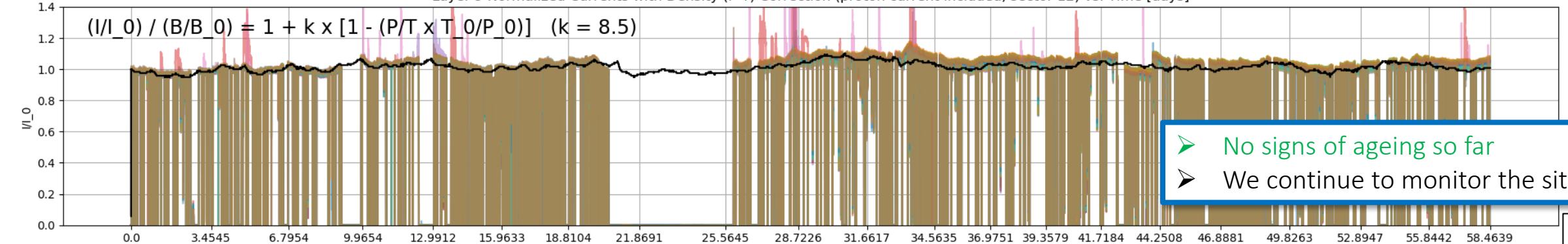
Layer 9 Currents (sector 12) vs. Time [days]



Atmospheric Pressure vs. Time [days]



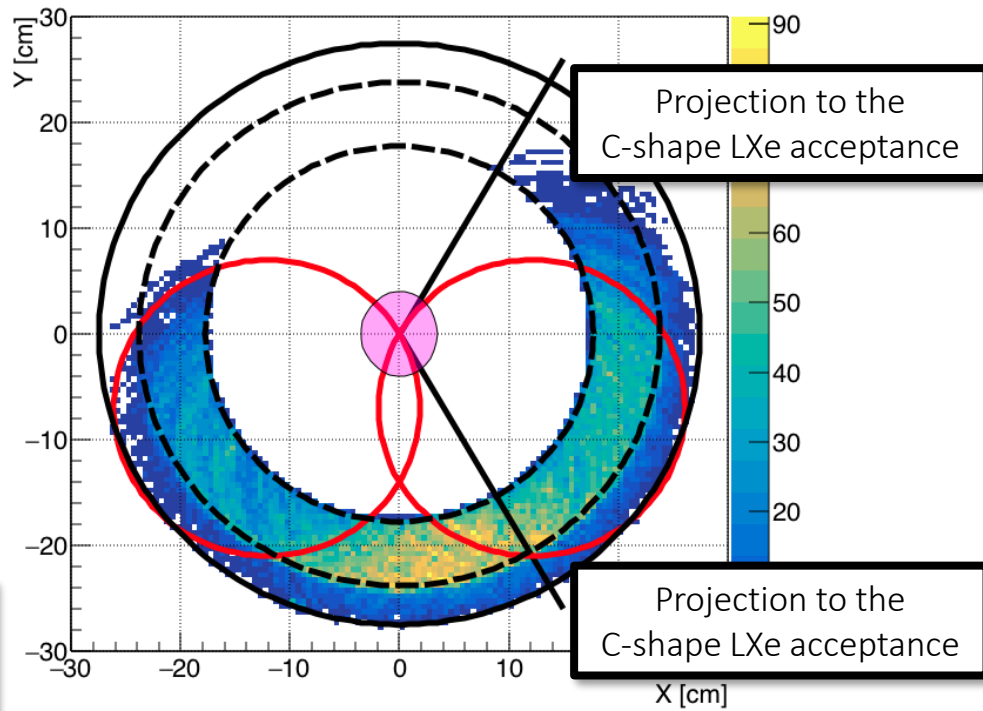
Layer 9 Normalized Currents with Density (P-T) Correction (proton current included, sector 12) vs. Time [days]



Physics data taking
(planned 2021-2026)

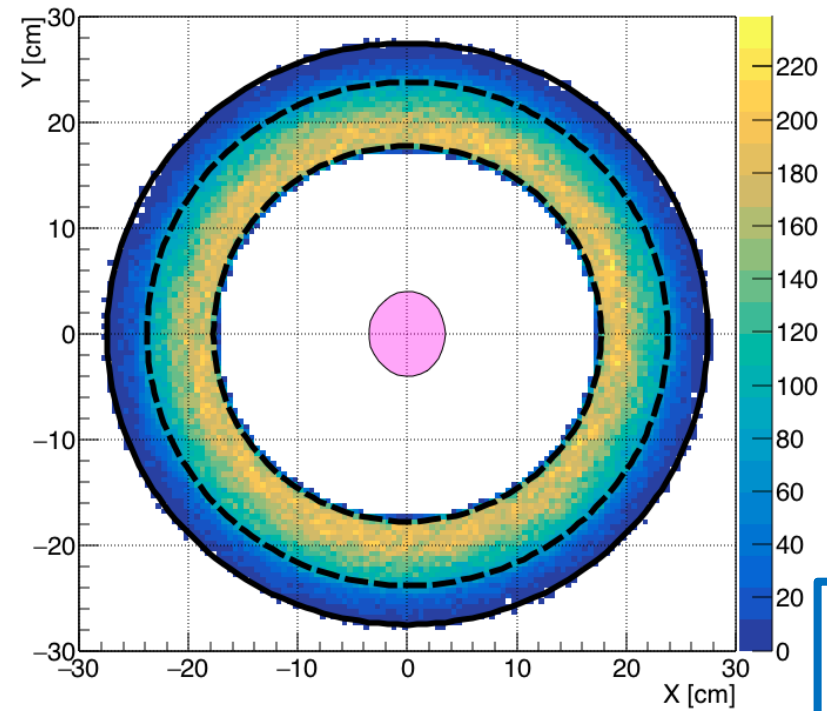
Example of CDCH occupancy from MC

XY MC Hit



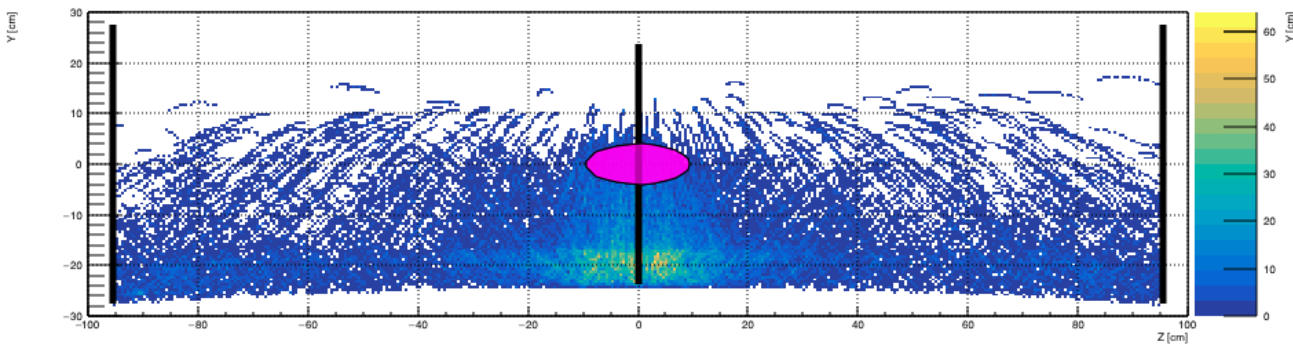
Signal
 e^+

XY MC Hit Michel

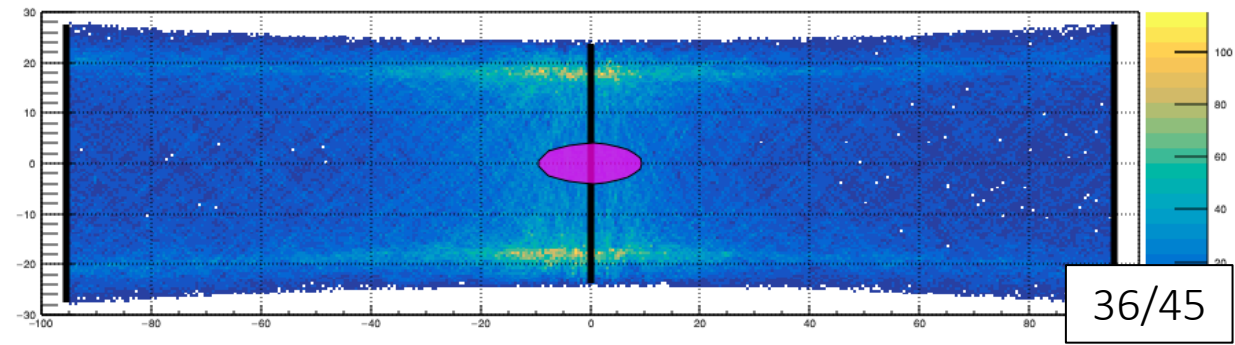


Michel
 e^+

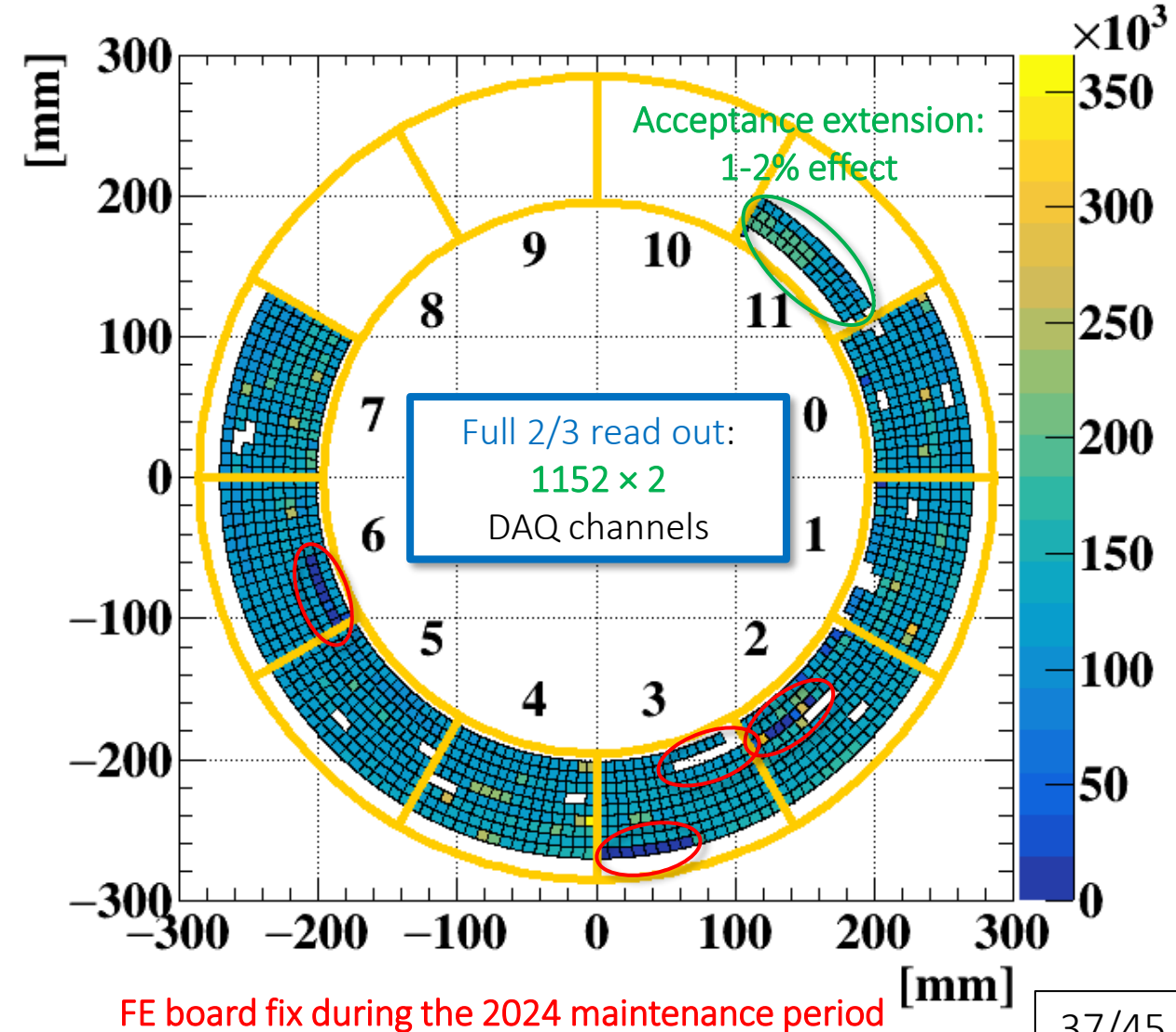
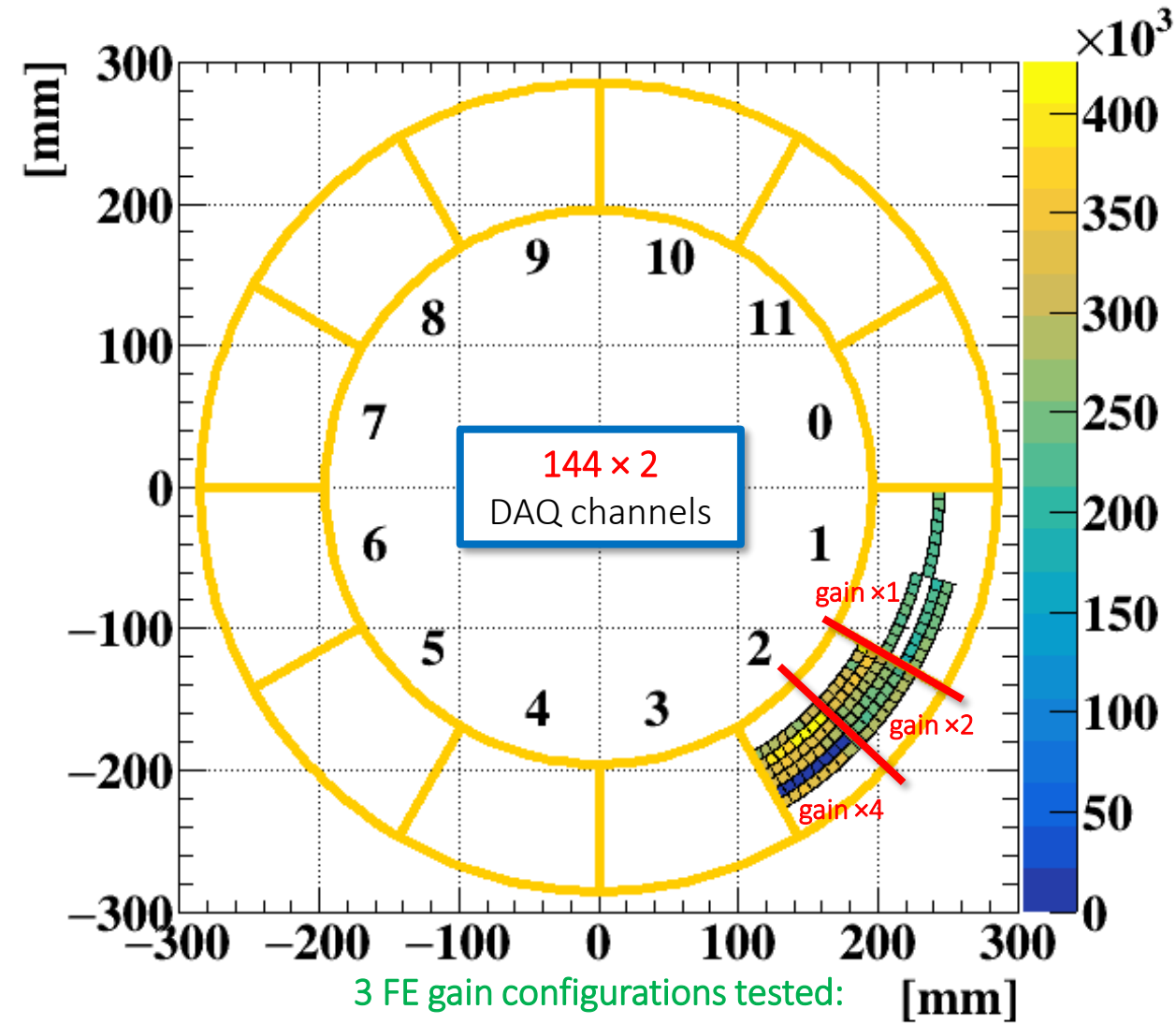
YZ MC Hit



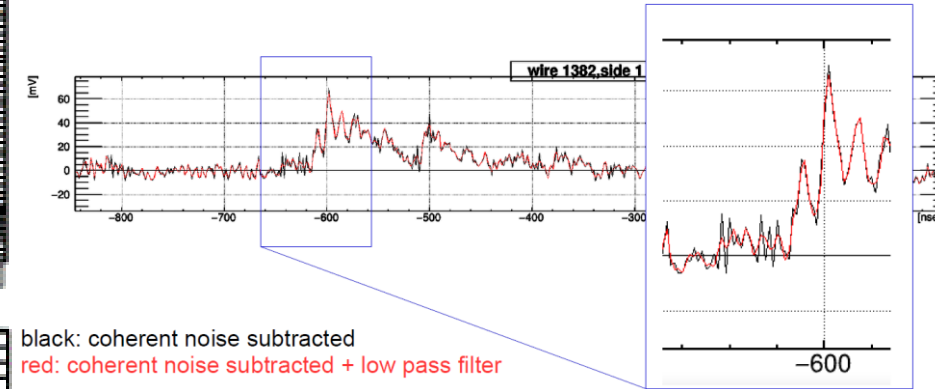
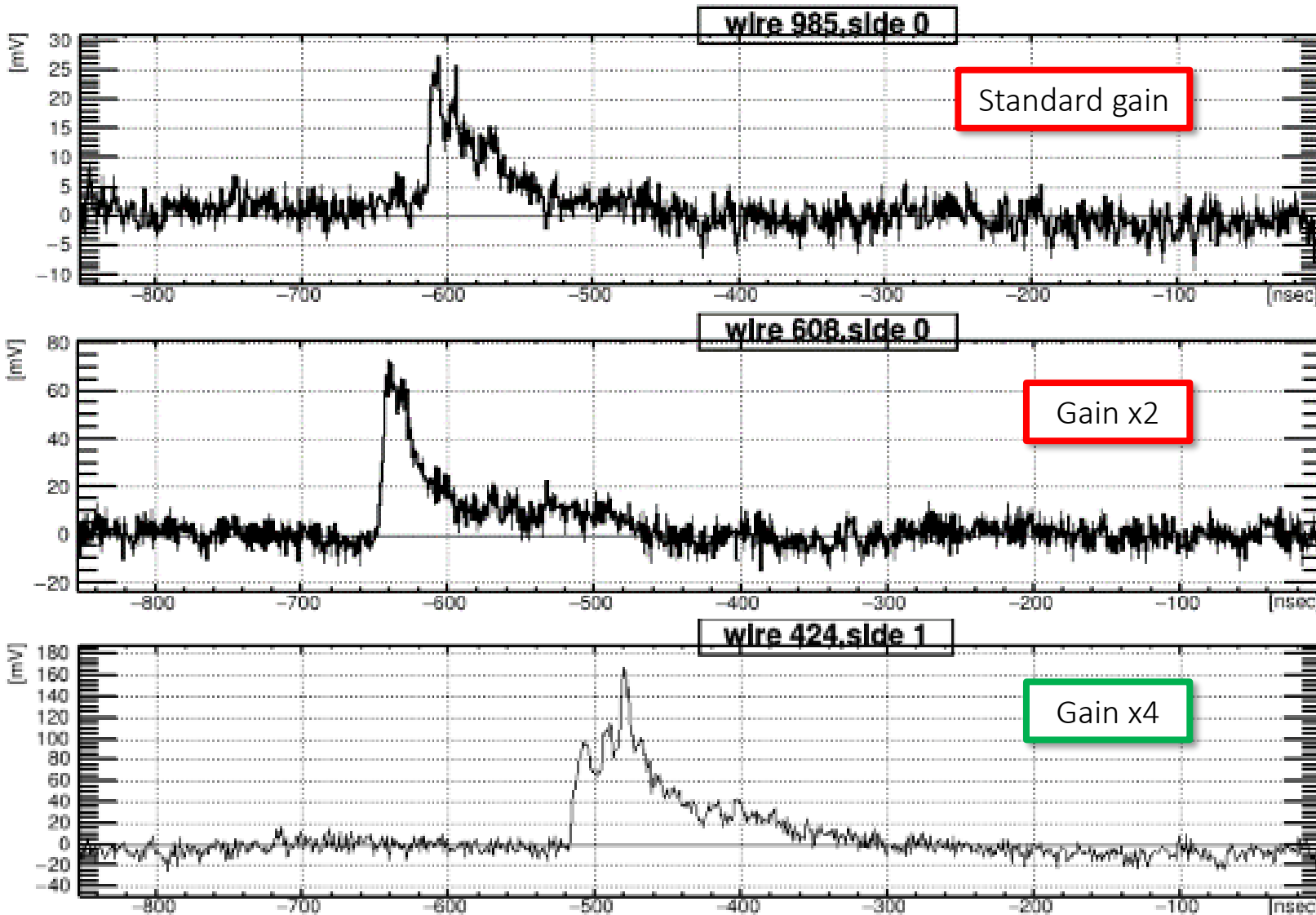
YZ MC Hit Michel



2020 vs. 2023 readout



Example of signal Waveforms

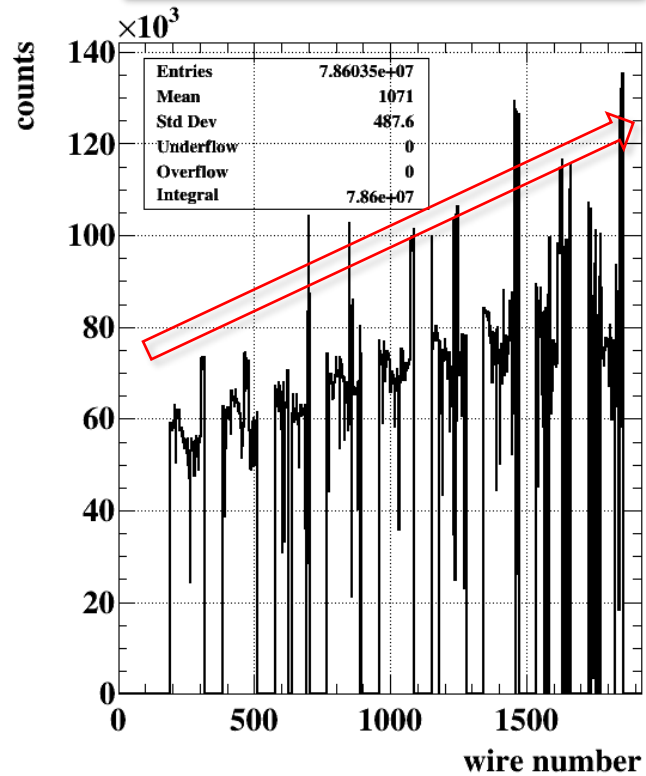


- In MEG all the signal WF is recorded
- Then a fine analysis is made offline to get the hit information
 - Timing, signal amplitude, signal integral, position
- Coherent noise subtraction + 225 MHz digital low-pass filter are applied

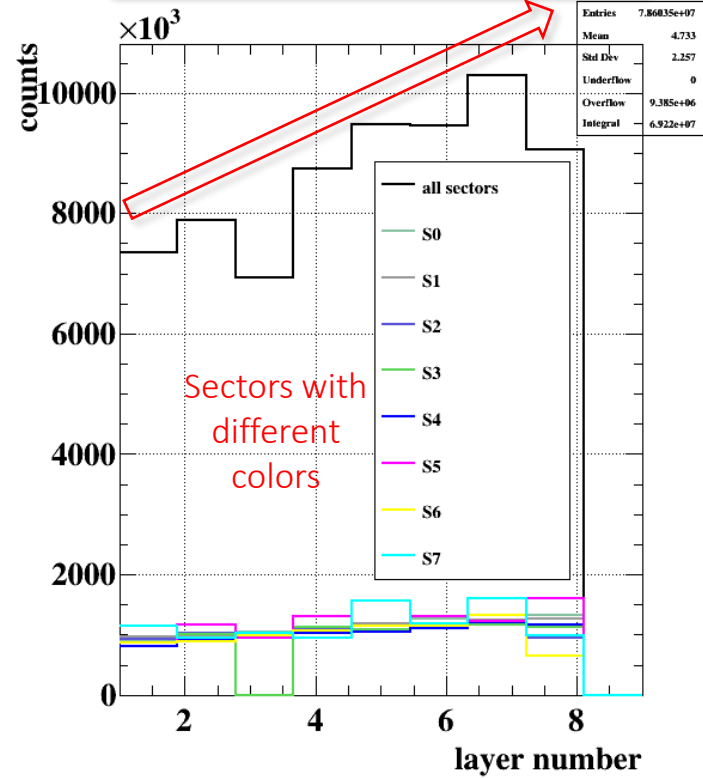
- 3 FE gain configurations tested
- Gain x4 chosen → best SNR

Some diagnostic plots from Michel e^+ data

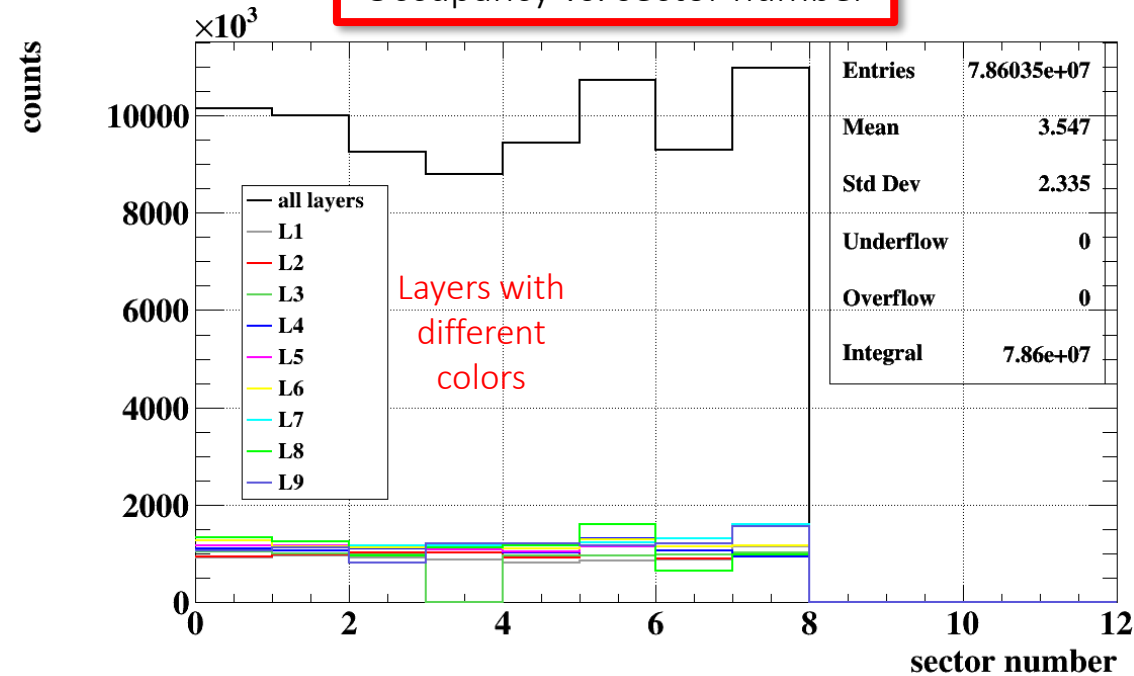
Occupancy vs. wire number



Occupancy vs. layer number



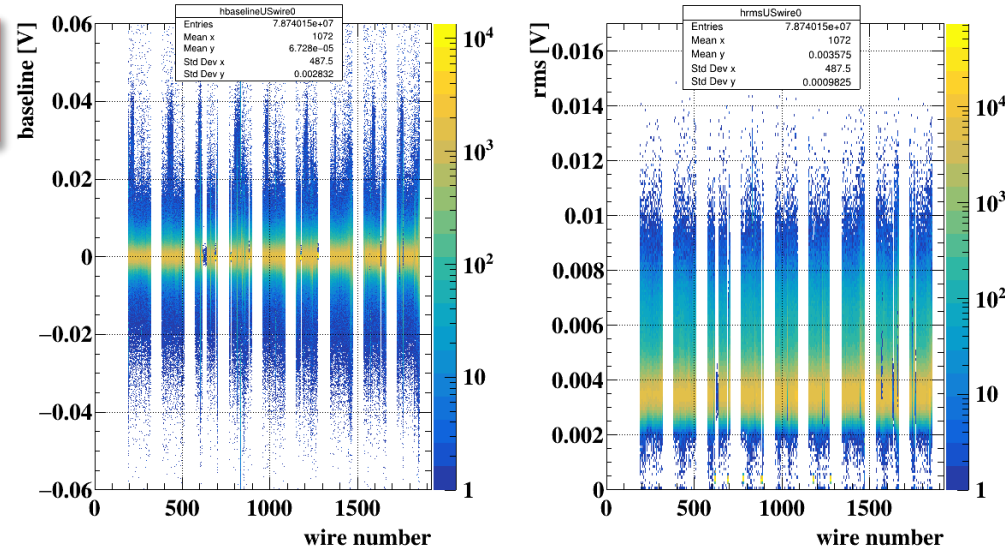
Occupancy vs. sector number



Scaling by radius as expected with Michel e^+ events

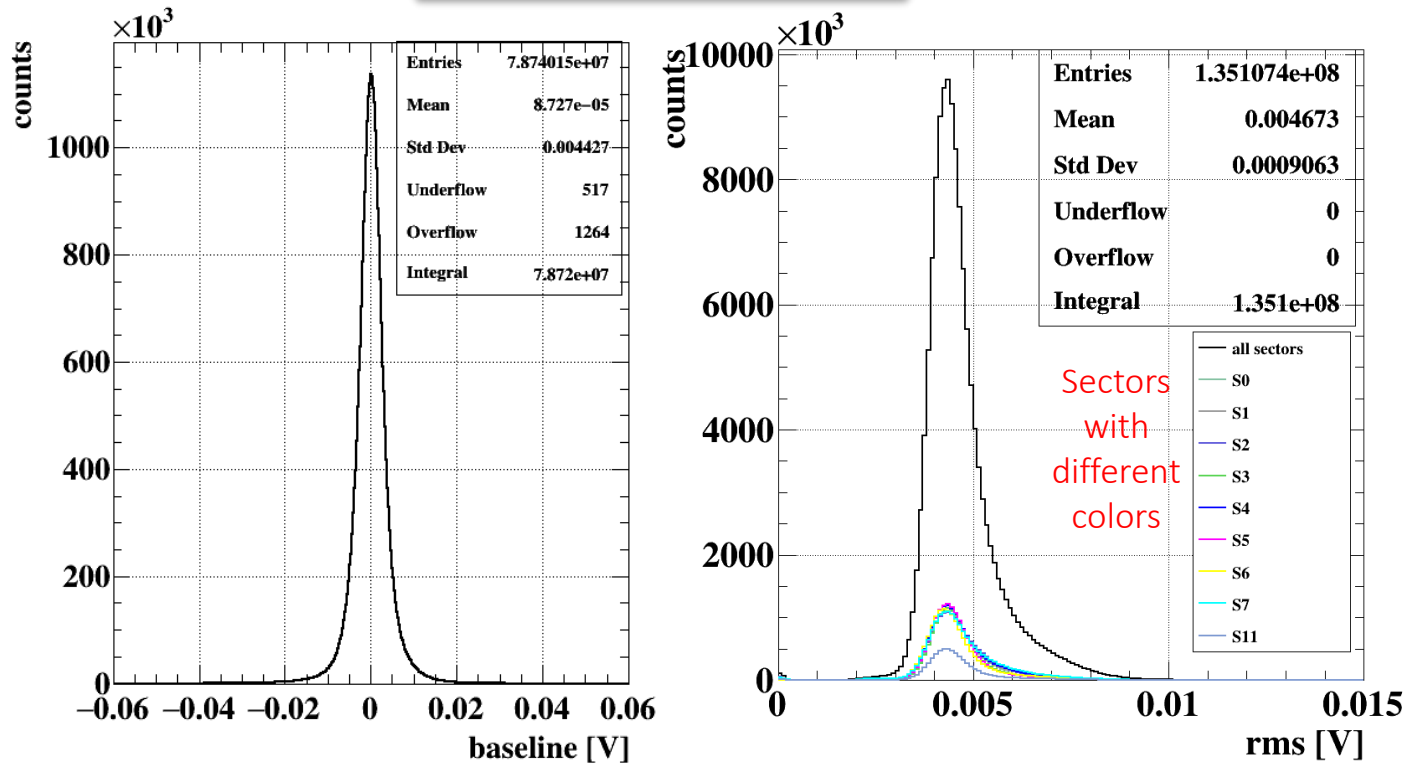
Some diagnostic plots from Michel e⁺ data

Baseline US wire by wire



RMS US wire by wire

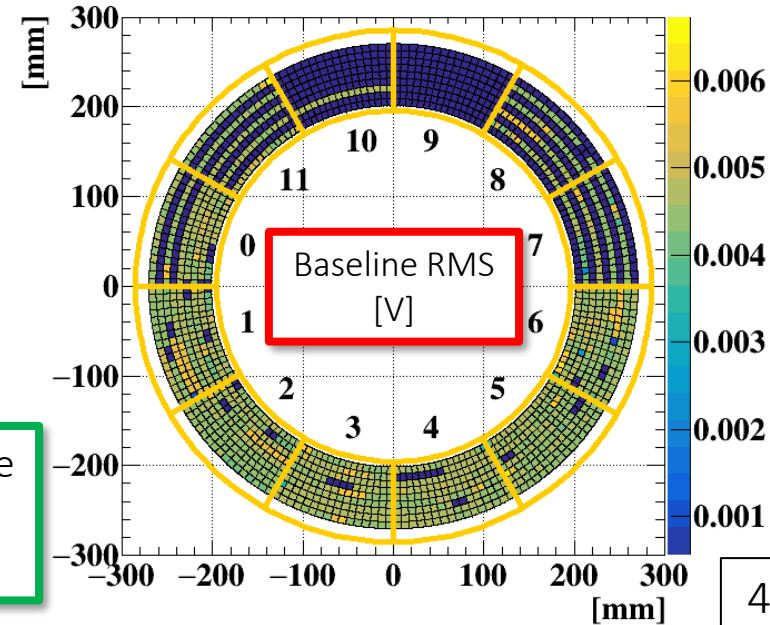
Baseline and RMS levels



Sectors with different colors

Noise situation is under control

Good noise level at <4.5 mV>



Some diagnostic plots from Michel e^+ data

US signal amplitude

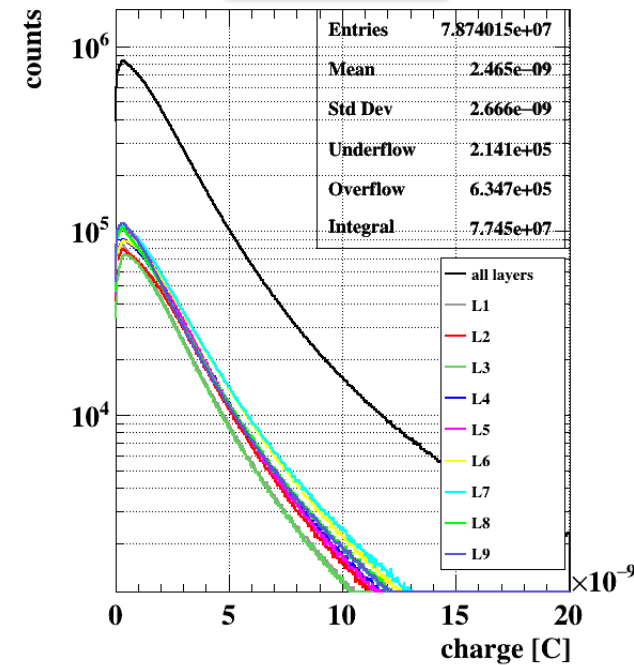
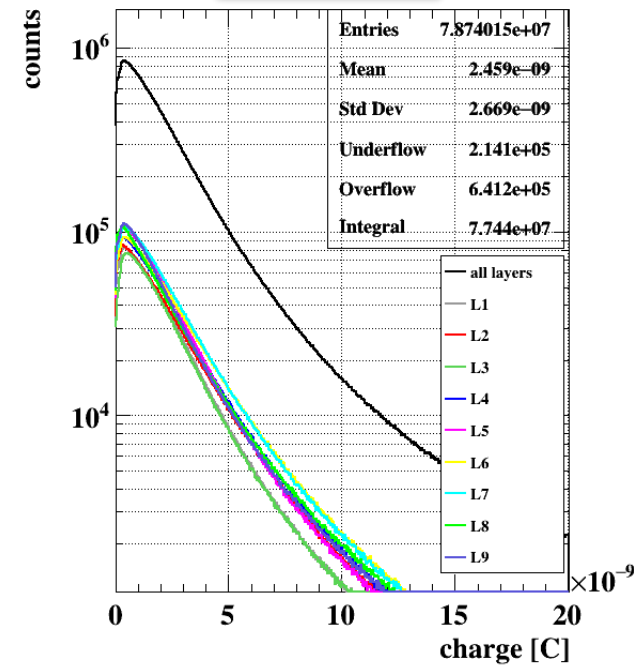
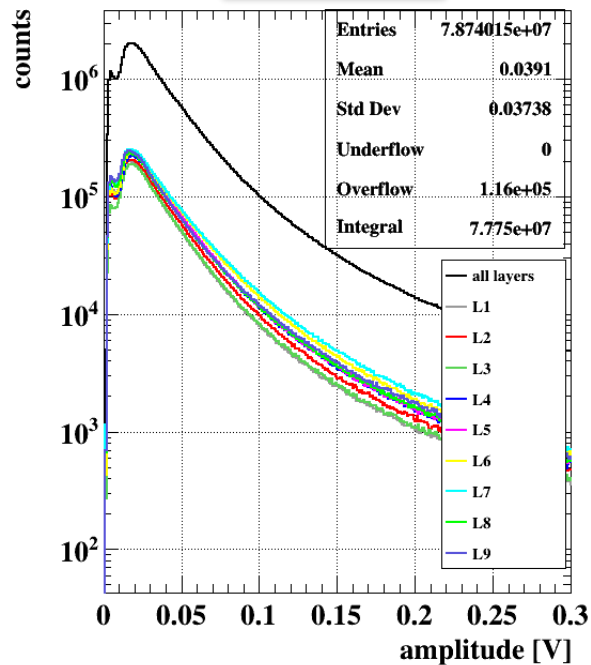
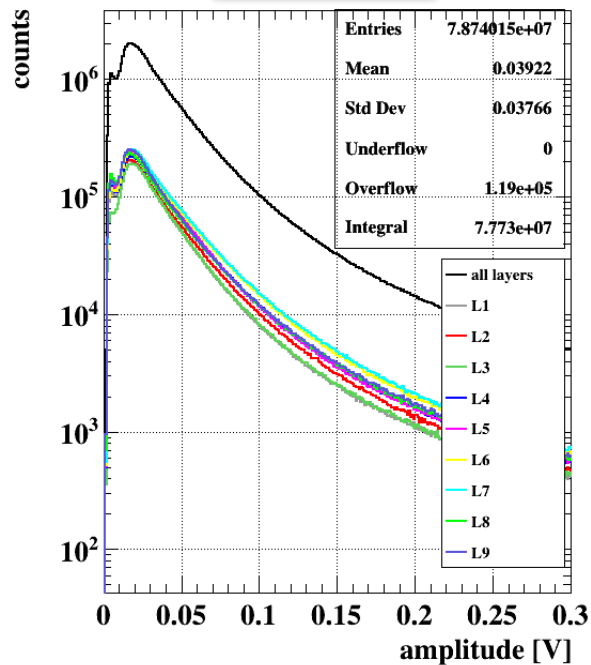
Layers with different colors

DS signal amplitude

US signal charge

Layers with different colors

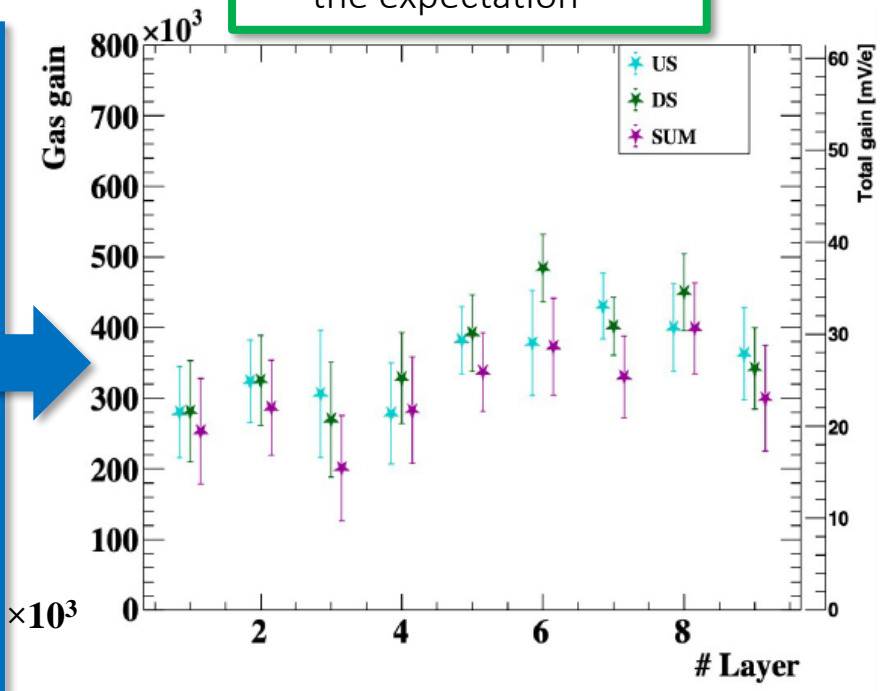
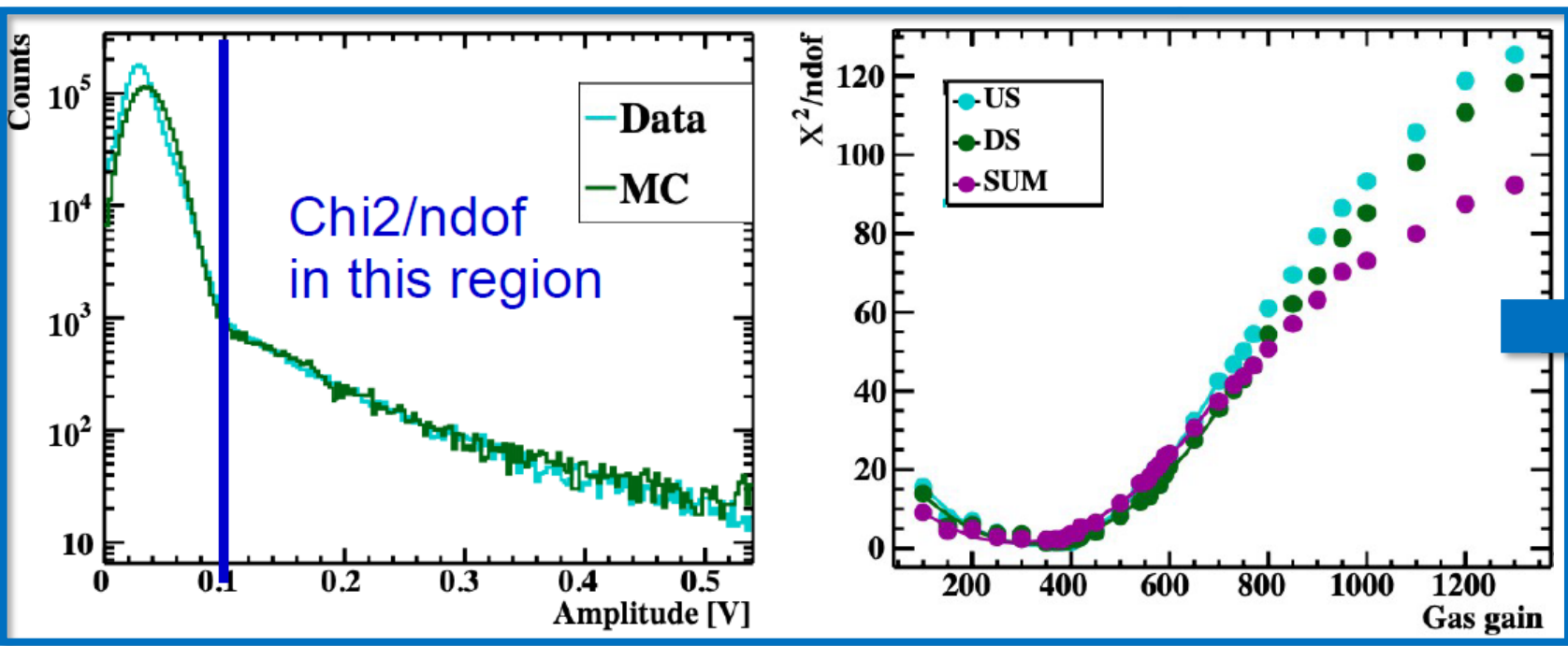
DS signal charge



- Good uniformity of the **signal amplitude** between layers
- 10 V scaling of the HV works well

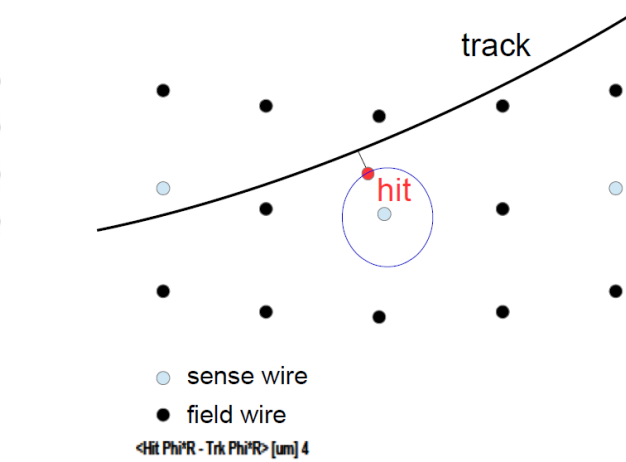
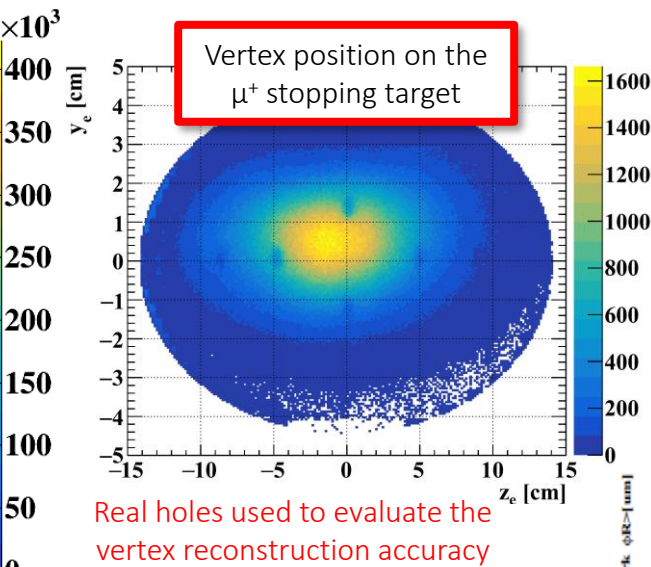
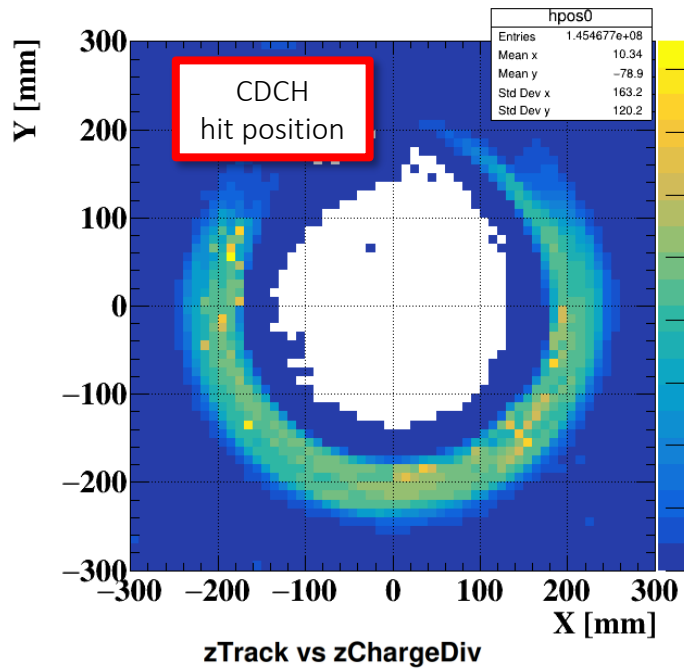
Gas gain measurement

- 2021 measurement
- Gas gain = $(2\div 4) \times 10^5$ in agreement with the expectation

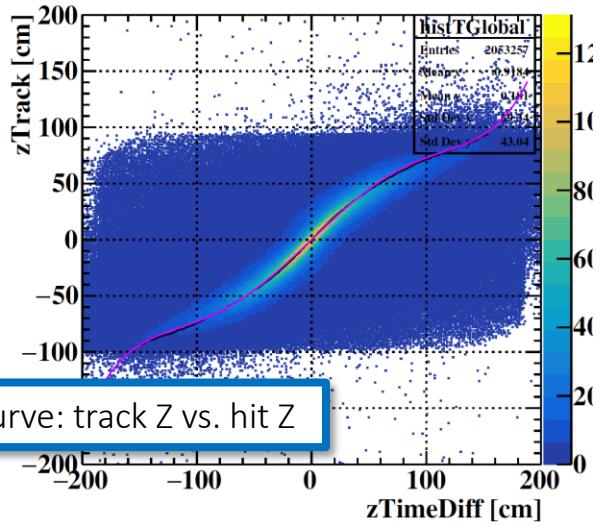
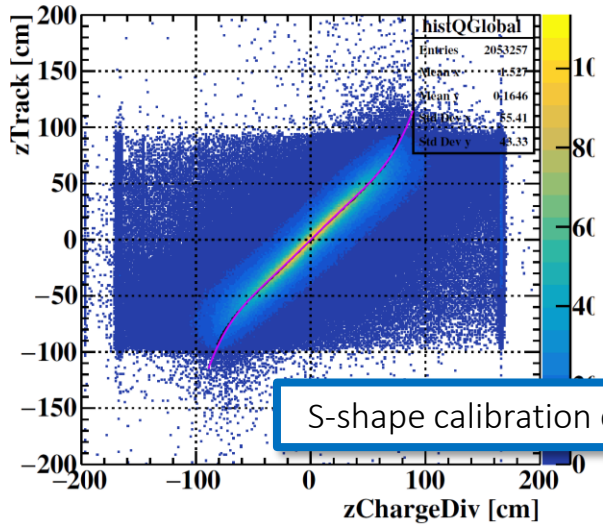


- Signal amplitude distribution from Cosmic Ray events: clean environment
- The only parameter to be tuned in MC to reproduce data is the **Total gain = Gas gain × FE gain**
- FE gain measured to be **0.120 mV/fC**
 - FE response to real single-electron drift chamber signals produced by laser ionization on a prototype
- Gas gain = Total gain / FE gain

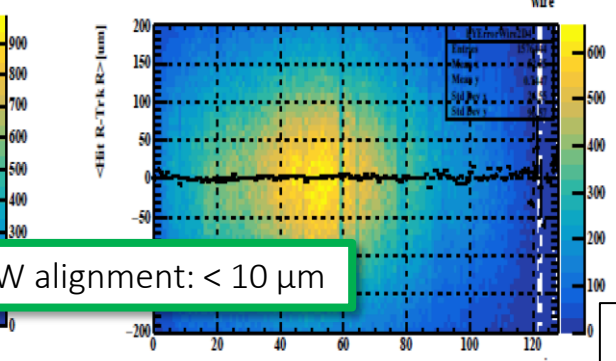
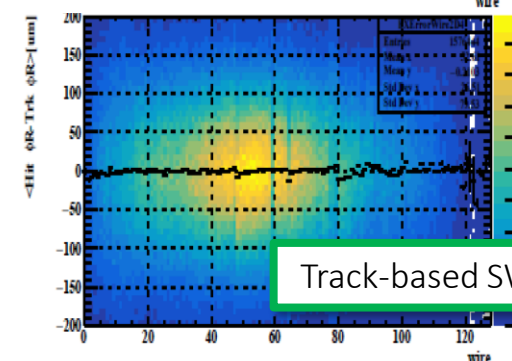
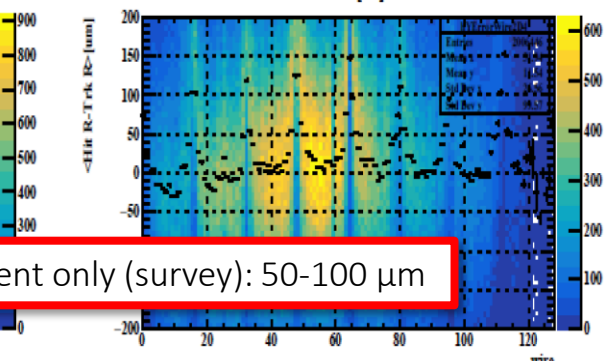
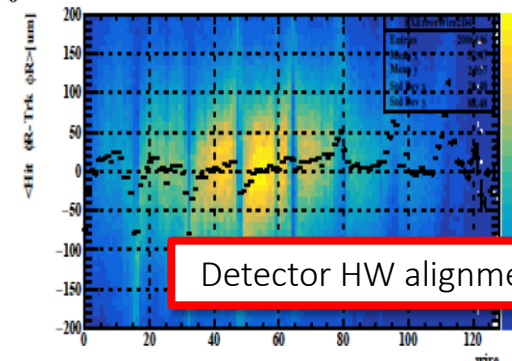
Hit reconstruction and resolution



Hit-track residual give a measurement of how misalignments, single-hit resolution and other systematics (B field) combine to determine the reconstruction performance



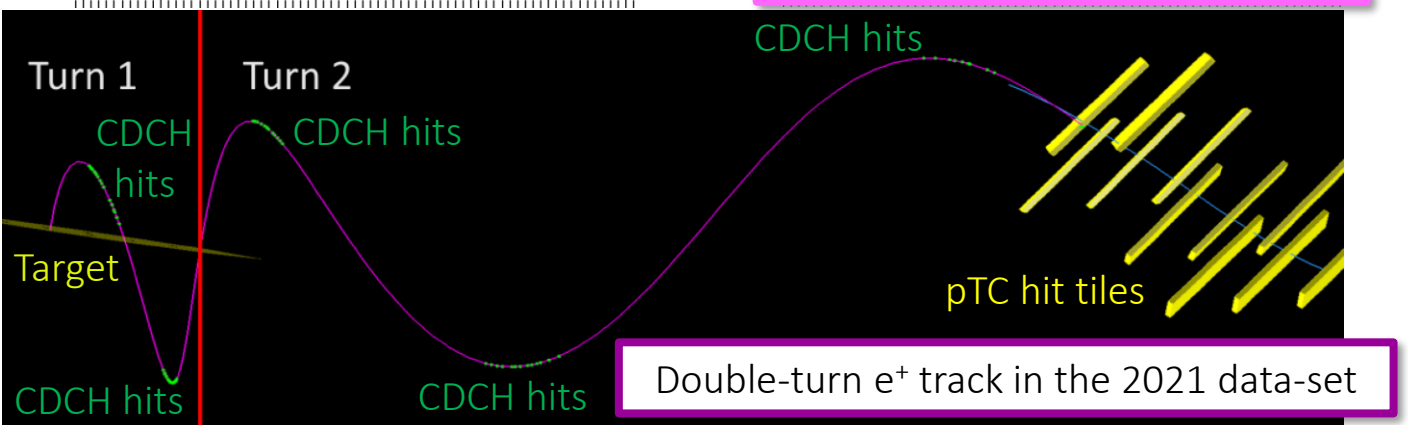
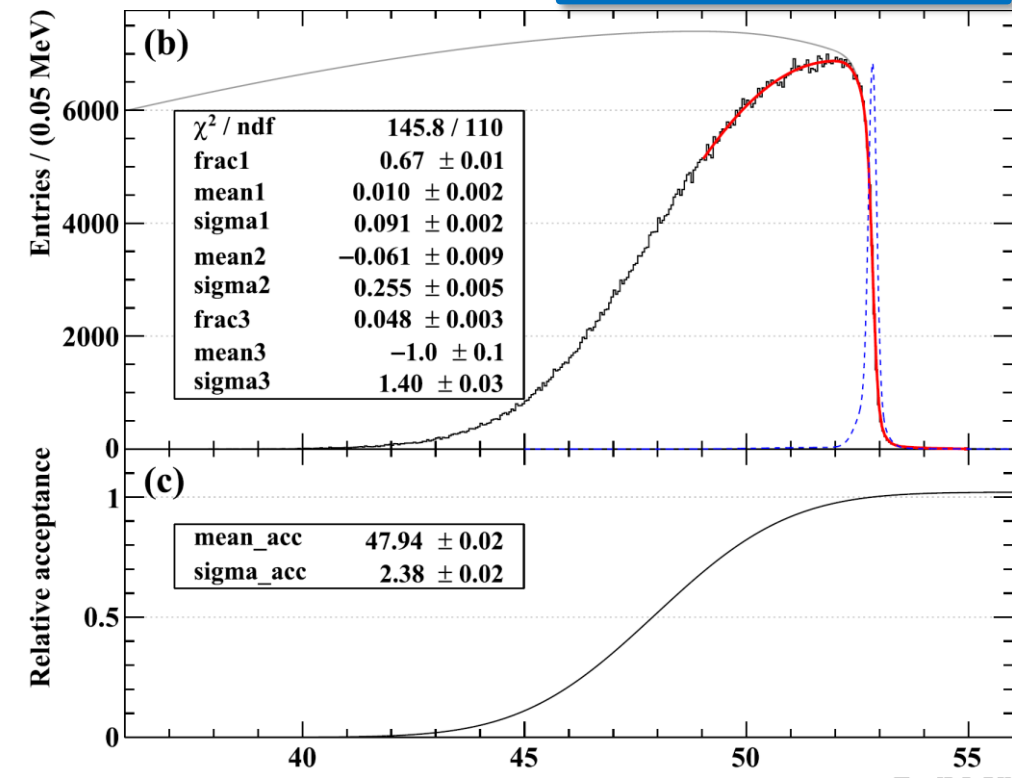
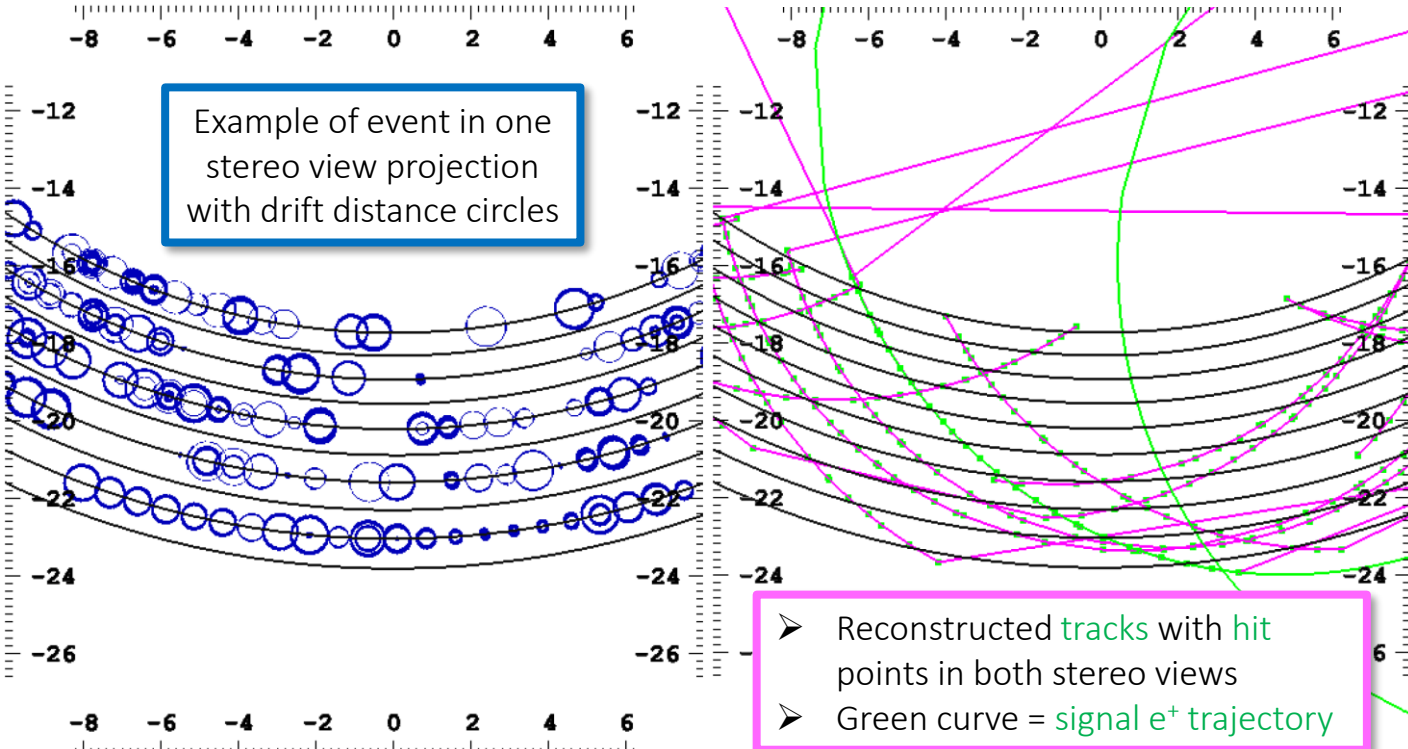
S-shape calibration curve: track Z vs. hit Z



$3 \times 10^7 \mu^+/s$

$$\text{PDF}(p) = [\text{PDF}_{\text{THEORY}}(p) \times \text{Acceptance}(p)] \otimes \text{Resolution}_{\text{TRIPLE-GAUSSIAN}}(\Delta p)$$

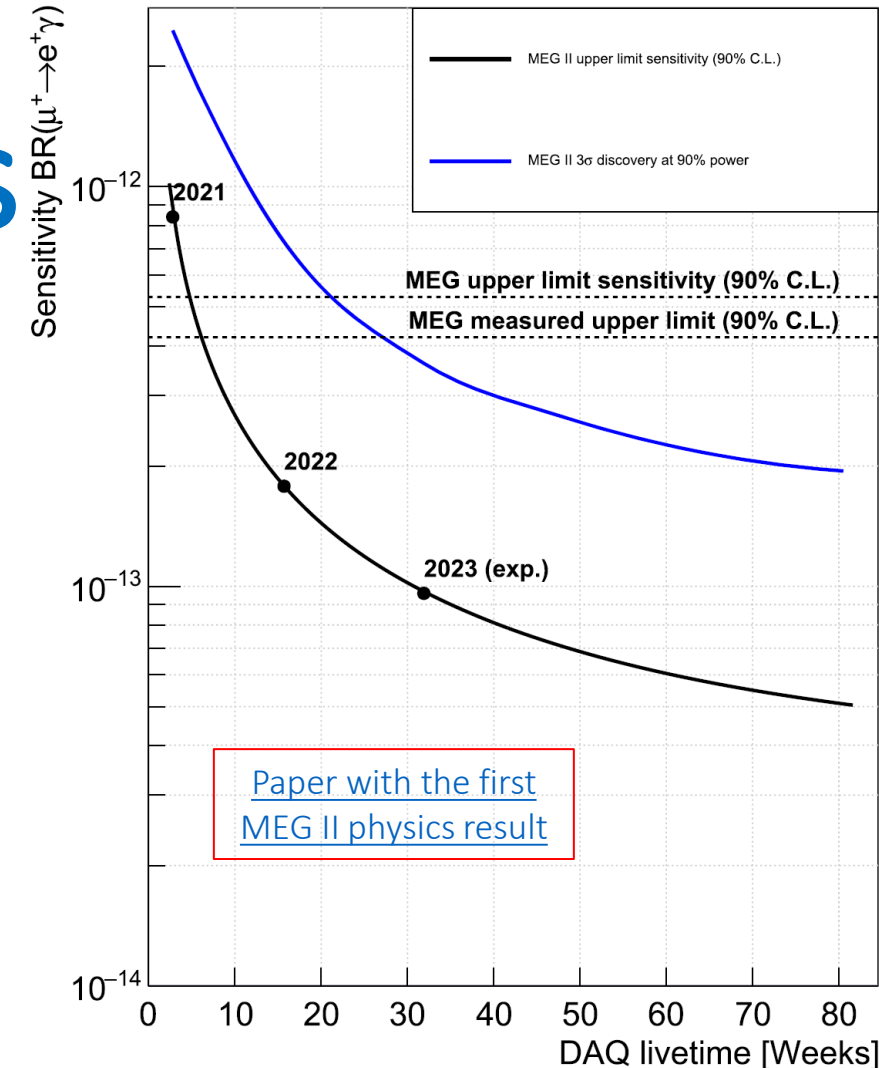
Tracking and Momentum resolution



e^+ variable	Foreseen	Achieved
ΔE_e (keV)	100	91
$\Delta\theta_e, \Delta\phi_e$ (mrad)	6.7, 3.7	7.2, 4.1
$\Delta Z, \Delta Y$ (at target, mm)	1.6, 0.7	2.0, 0.7
ε_e (%)	65	67

Conclusions and prospects

- The [new drift chamber CDCH of the MEG II experiment](#) has been presented
 - **Full azimuthal coverage** around the stopping target
 - **Extremely low material budget**: minimization of MCS and γ background
 - **High granularity**: 1728 drift cells few mm wide in $\Delta R \approx 8$ cm active region
 - Improve angular and momentum resolutions of the e^+ kinematic variables
 - **Stereo design** concept, [modular construction](#), [light and reliable mechanics](#)
- Despite the **COVID-19 situation** we were able to perform the [2020 and 2021 commissioning of all the MEG II subdetectors](#) and the [experiment started the physics data taking in 2021](#)
 - Some **results from 2021-2023 data** have been presented (full data taking 2021-2026)
 - Data analysis and continuous developments ongoing
- **Problems along the path**
 - **Corrosion and breakage of 107 aluminum wires in presence of 40-65% humidity level**
 - Especially **40 μm wires** (90%) proved to be prone to corrosion
 - Problem fully cured by keeping CDCH in dry atmosphere
 - **Anomalously high currents experienced**
 - Probably triggered by a [bad event during the 2019 engineering run](#)
 - CDCH operation recovered by using additives (**0.5% O_2 + 1.5% Isopropyl alcohol**) to the standard $\text{He}:\text{iC}_4\text{H}_{10}$ 90:10 gas mixture
- **Beyond $\mu^+ \rightarrow e^+\gamma$: the X(17) boson search**
 - Atomki collaboration (2016): [excess in the angular distribution of the Internal Pair Creation \(IPC\) in the \${}^7\text{Li}\(p, e^+e^-\){}^8\text{Be}\$ nuclear reaction](#)
 - Possible interpretation with a [new physics boson mediator](#) with mass expected around 17 MeV: $p N \rightarrow N'^* \rightarrow N' (X \rightarrow) e^+e^-$
 - MEG II has all the ingredients (CW accelerator + Spectrometer) to repeat the measurement \rightarrow **data unblinding soon**

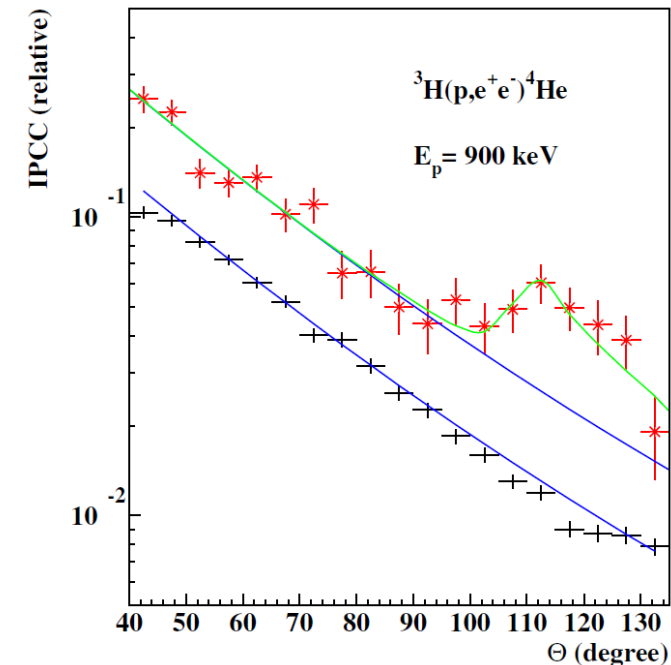
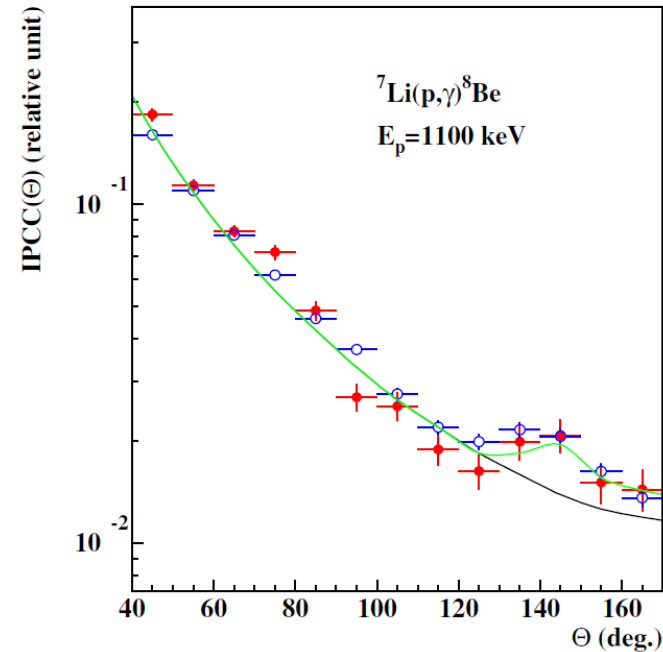


**THANKS
FOR YOUR ATTENTION**

BACK-UP SLIDES

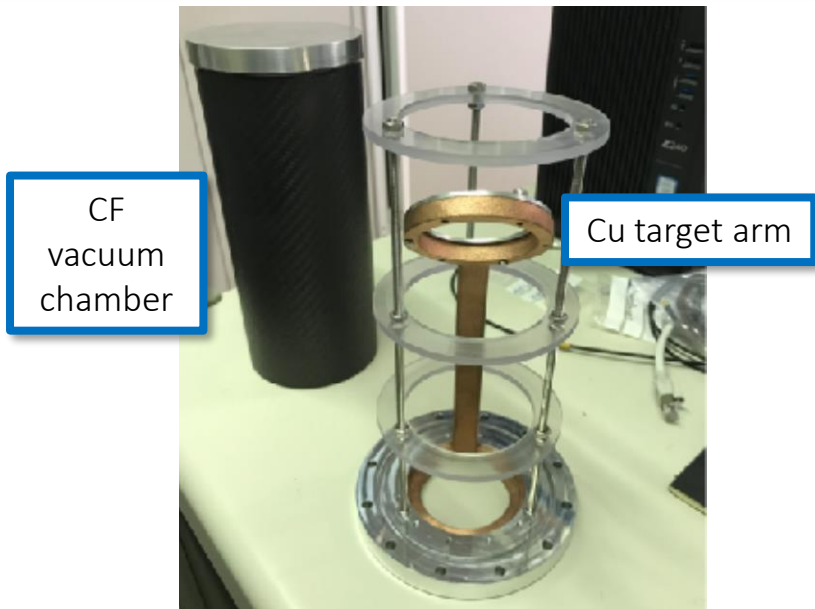
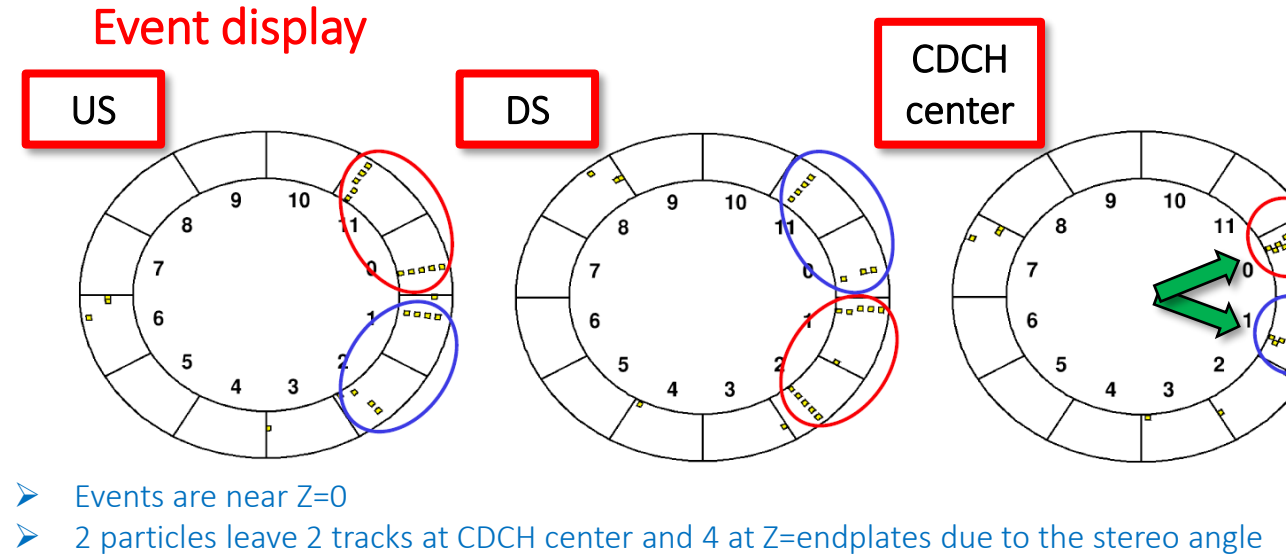
Beyond $\mu^+ \rightarrow e^+ \gamma$: the X(17) boson search

- In 2016 the Atomki collaboration measured an [excess in the angular distribution of the Internal Pair Creation \(IPC\) in the \${}^7\text{Li}\(p, e^+e^-\){}^8\text{Be}\$ nuclear reaction](#)
 - This anomaly was confirmed by further measurements
 - [\${}^3\text{H}\(p, e^+e^-\){}^4\text{He}\$ reaction](#)
 - Possible interpretation
 - [Production of a new physics boson mediator of a fifth fundamental force that describes the interaction between dark and ordinary matter](#)
- $$p N \rightarrow N'^* \rightarrow N' (X \rightarrow) e^+e^-$$
- Its mass is expected to be 17 MeV \rightarrow X(17)
 - An independent experiment could confirm or not this results
 - [Artifact of the detector geometry](#)???
 - MEG II has all the ingredients to repeat the Atomki measurement
 - CW proton accelerator (used for LXe detector calibrations)
 - CDCH for e^+e^- measurement
 - pTC as trigger
 - B field \rightarrow e^+e^- invariant mass with CDCH + COBRA magnet

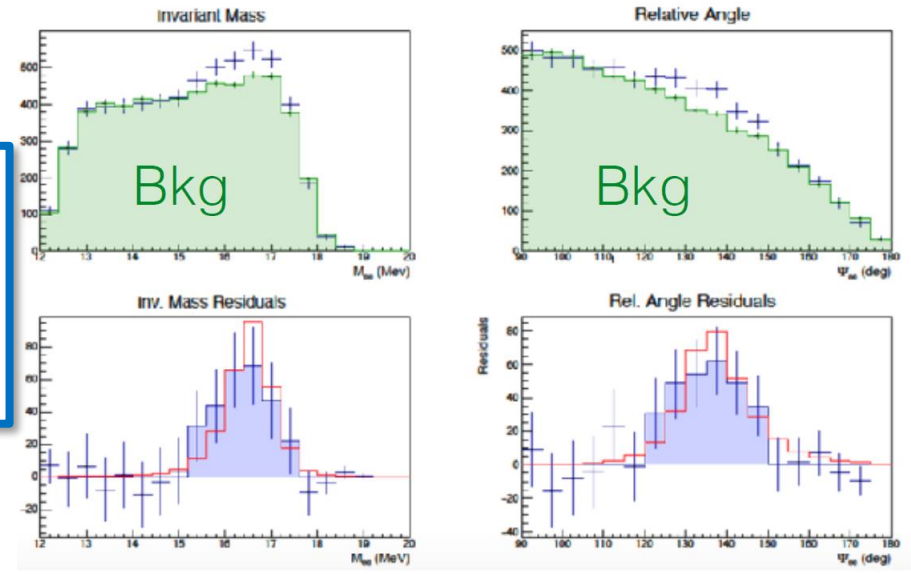


First test with CDCH and B field OFF

- CW Li(p, γ)Be reaction with e^+e^- pairs from γ conversion (likely in the CW beamline)
- First test with an existing aluminum vacuum chamber
- For the final measurement to minimize the MCS and achieve a better resolution the CW target region was re-design
 - The new setup consists of a 10 μm thick Li_2O layer on a 25 μm thick Cu substrate
 - Connection to the CW beamline by means of a Cu arm
 - Both structures are placed in a CF vacuum chamber



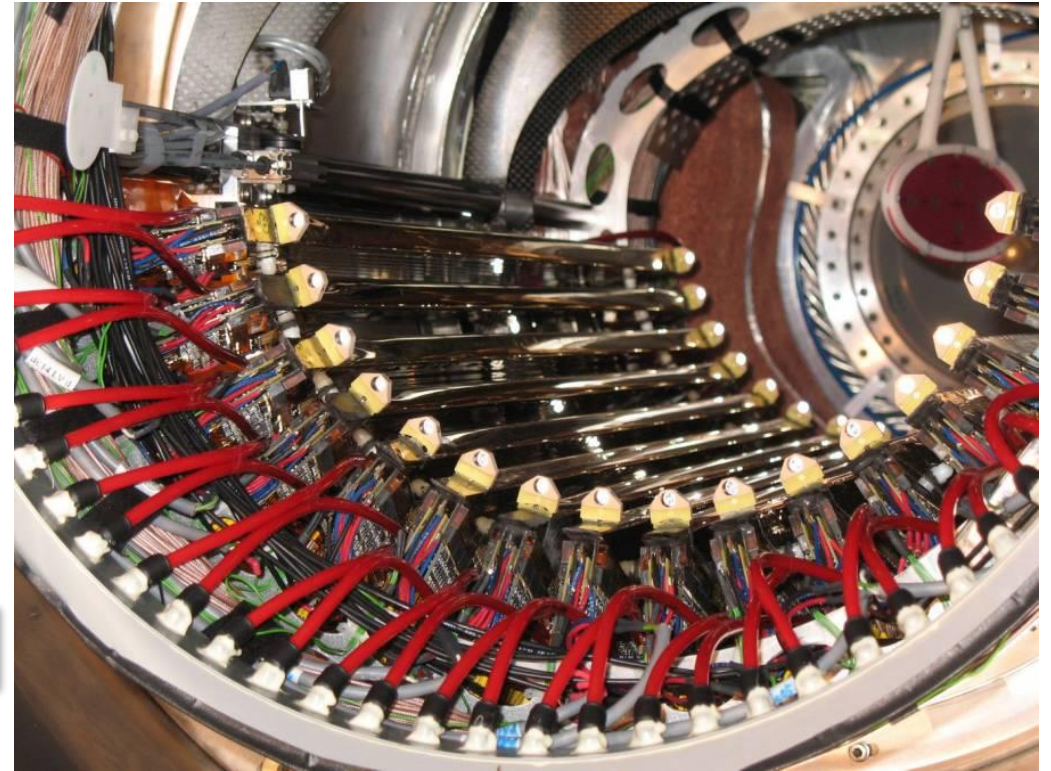
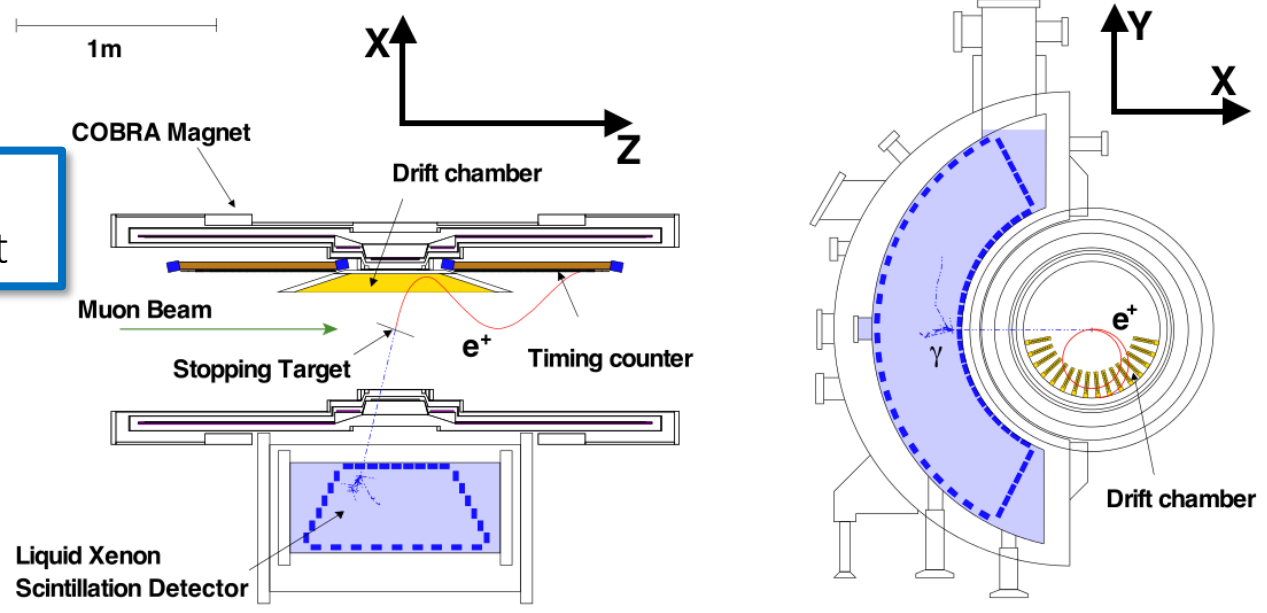
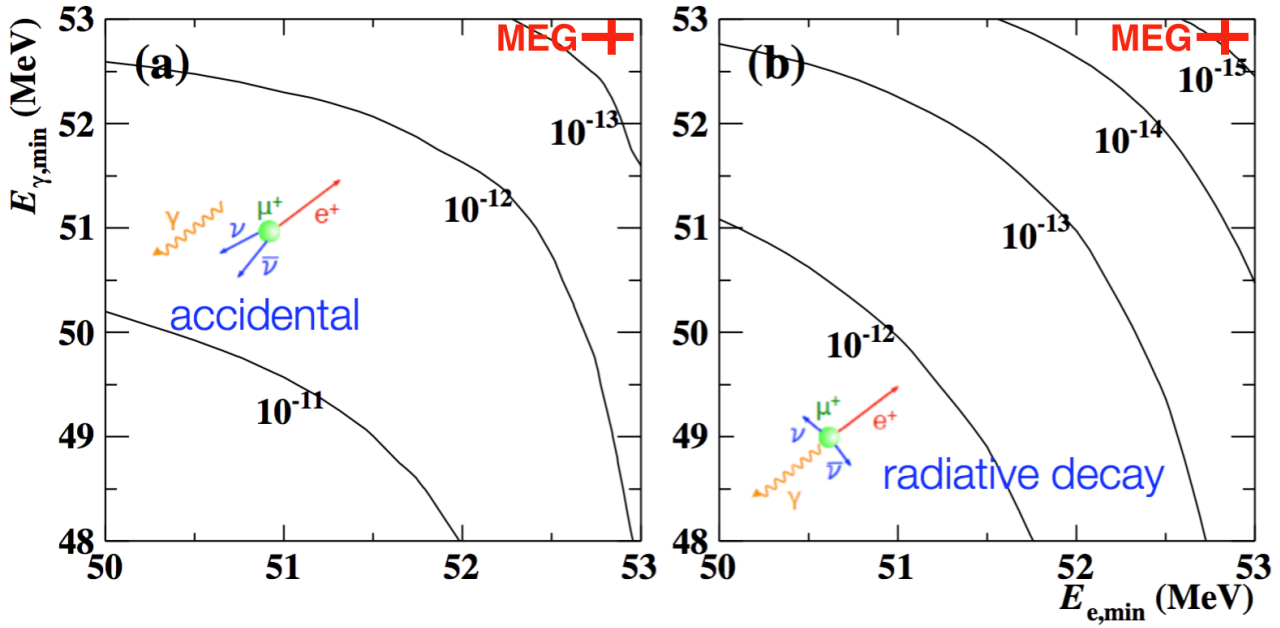
MC studies shows that a 5 σ significance can be achieved in order few weeks



MEG

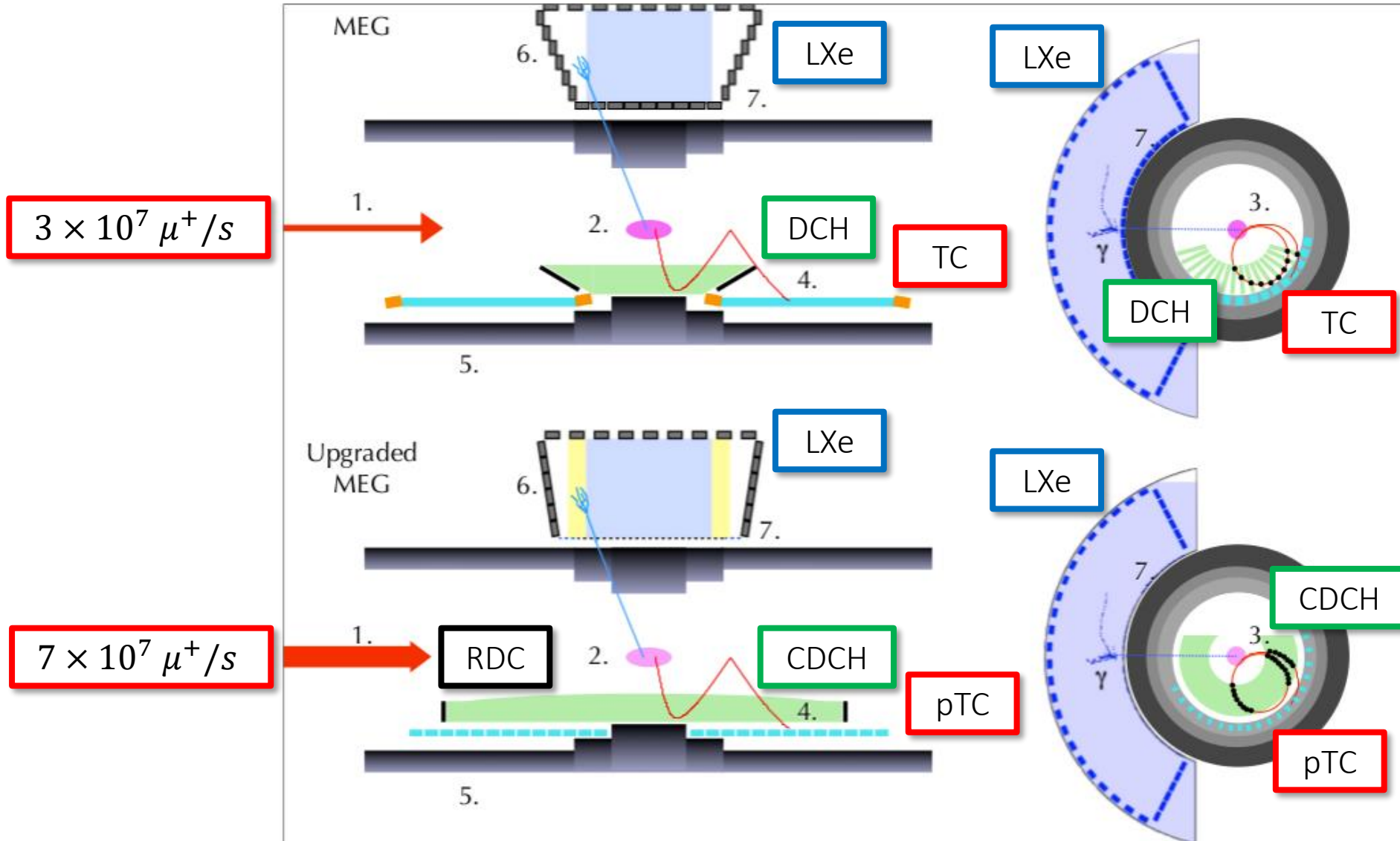
The MEG experiment

Backgrounds

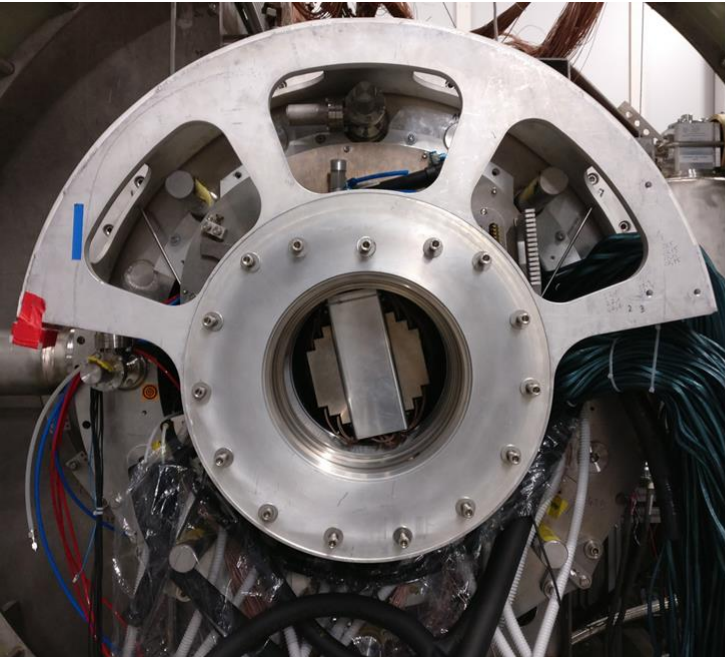


DCH

MEG vs. MEG II



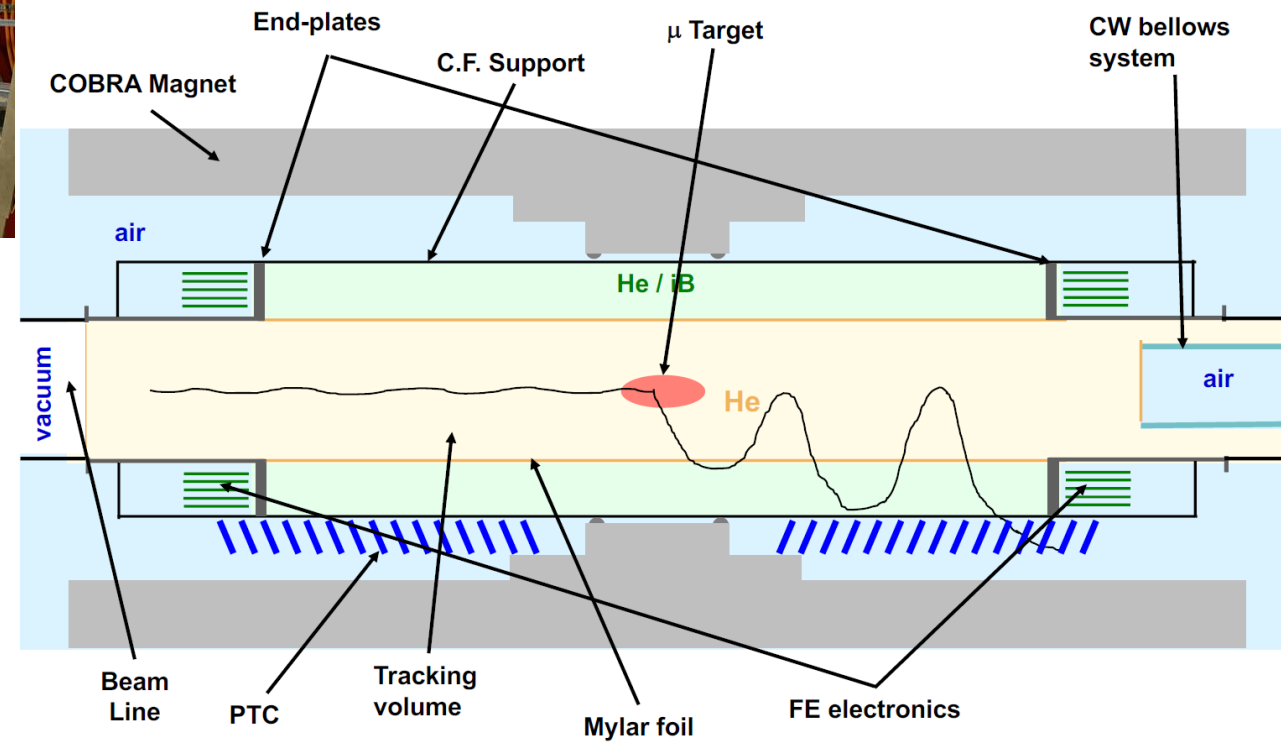
MEG II beam line



RDC



BTS



MEG upgrade motivations

- 2009-2011 data analysis: $BR(\mu^+ \rightarrow e^+\gamma) < 5.7 \times 10^{-13}$ (90% C. L.) Phys. Rev. Lett. 110, 201801 (2013)
 - 36% improvement with the final MEG result
 - Statistics increased by more than a factor 2: $N_\mu^{2009-2011} \approx 3.5 \times 10^{14} \rightarrow N_\mu^{2009-2013} \approx 7.5 \times 10^{14}$
- The MEG sensitivity does not increase linearly with the amount of data taking anymore
 - Limited by the resolutions on the measurement of the kinematic variables of the two decay products
- Upgrade (MEG II) of the experimental apparatus designed and presently in the commissioning phase at PSI

Variable	Design (MEG)	Obtained (MEG)	Current (MEG II)
ΔE_e (keV)	200	380	100
$\Delta\theta_e, \Delta\varphi_e$ (mrad)	5, 5	9, 9	6.7, 6.7
Efficiency _e (%)	90	30	65
ΔE_γ (%)	1.2	1.7	1.7
$\Delta\text{Position}_\gamma$ (mm)	4	5	2.4
$\Delta t_{e\gamma}$ (ps)	65	120	70
Efficiency _γ (%)	> 40	60	70

Positron variables

- Obtained with high statistics full Monte Carlo simulations of the MEG II experimental apparatus
- Using the currently updated reconstruction algorithms
 - Still margin for improvements

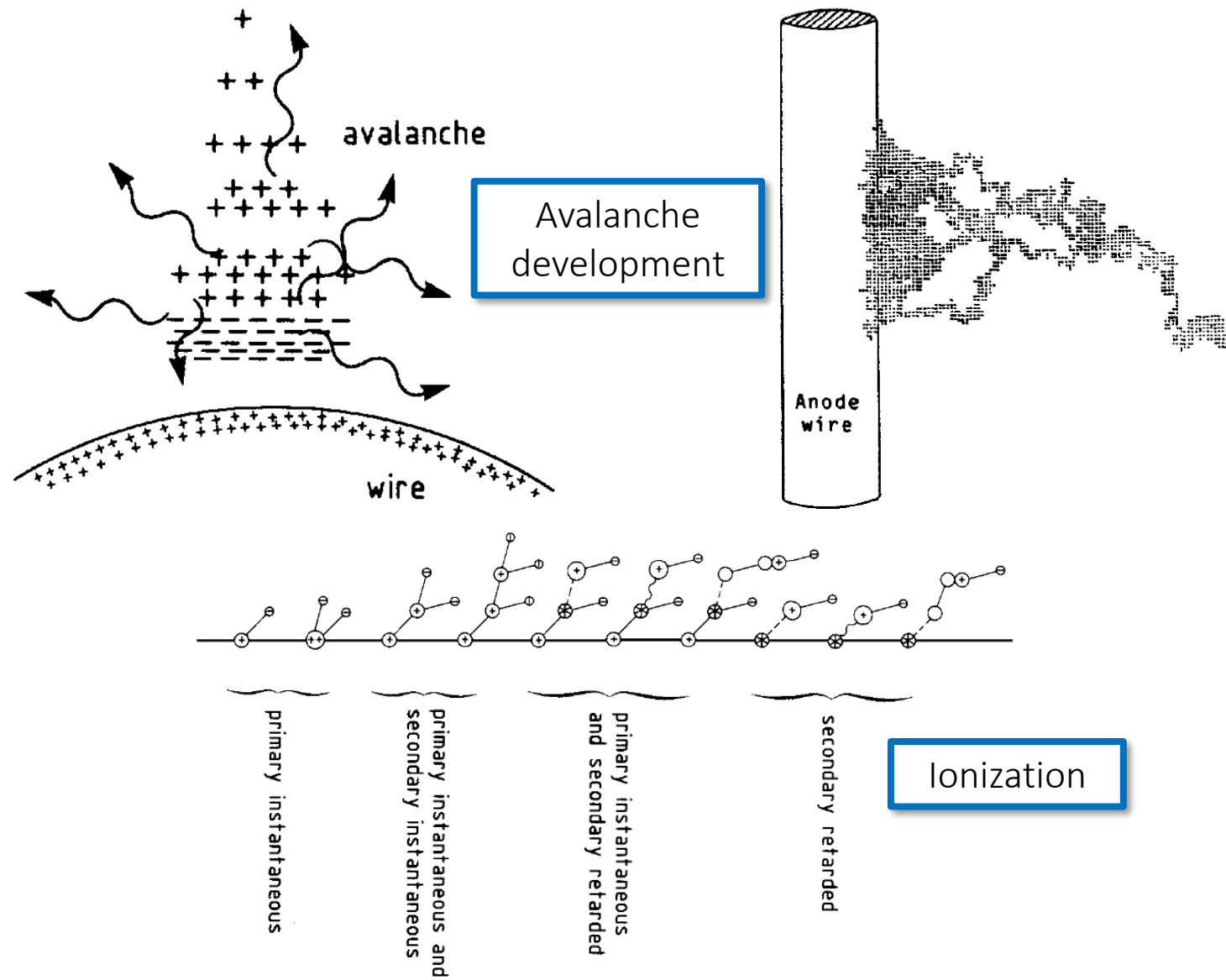
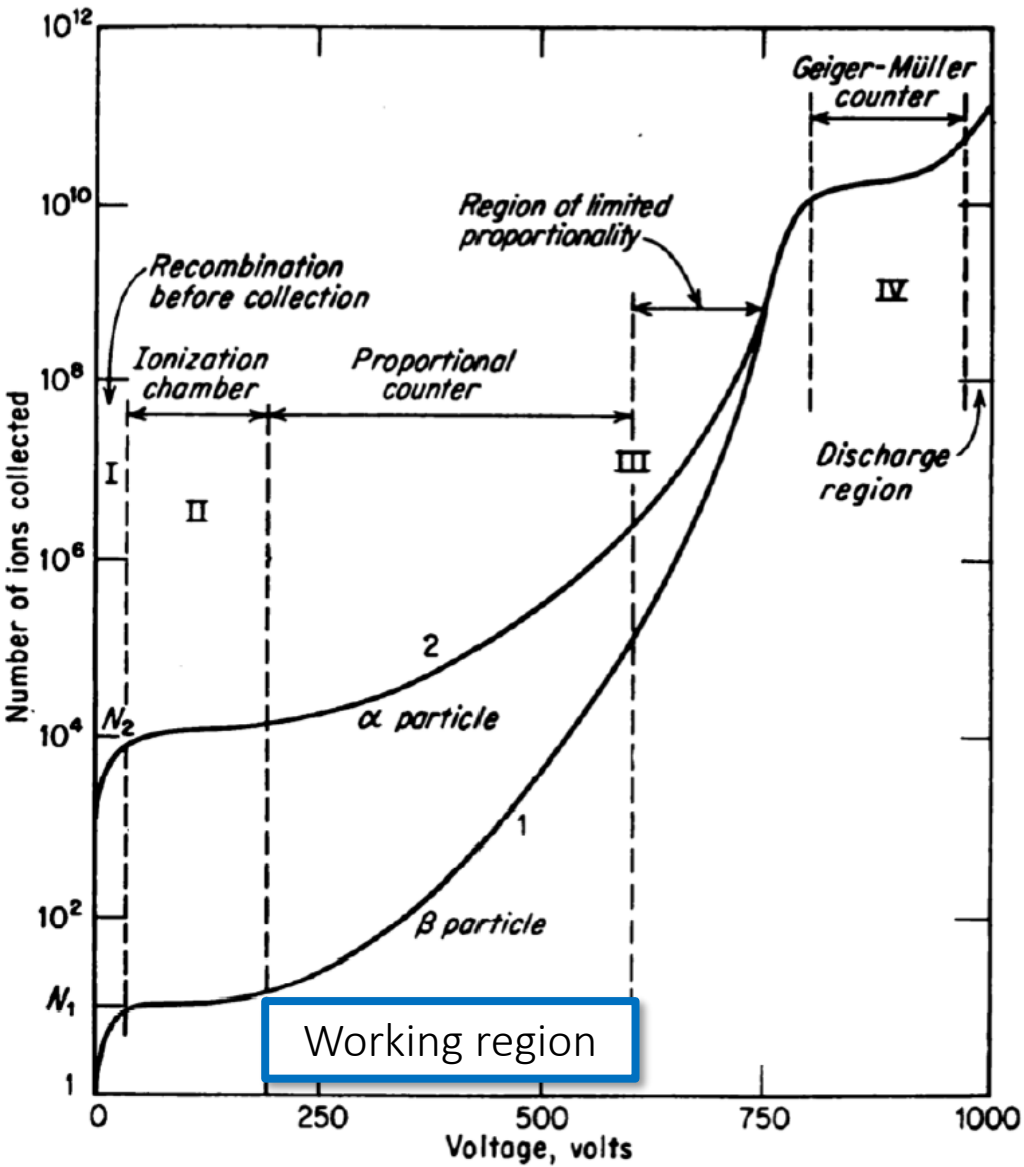
Cell inefficiency studies

- To understand the effect of such cell inefficiency in L9 and L8 we performed simulation studies with 100k signal + Michel events and the currently updated reconstruction algorithms
 - By killing the inefficient cells found with the last HV test
 - Inefficient = safety HV point not reached
 - Effects are negligible

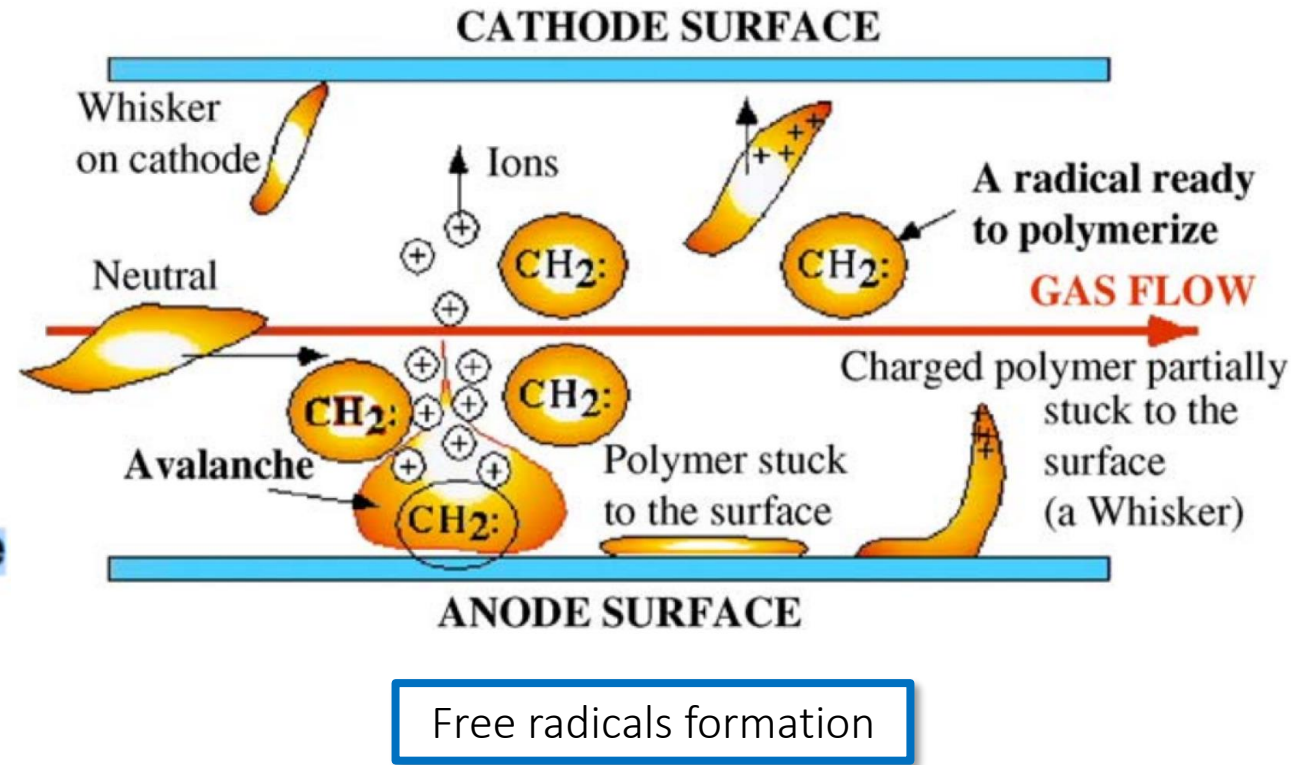
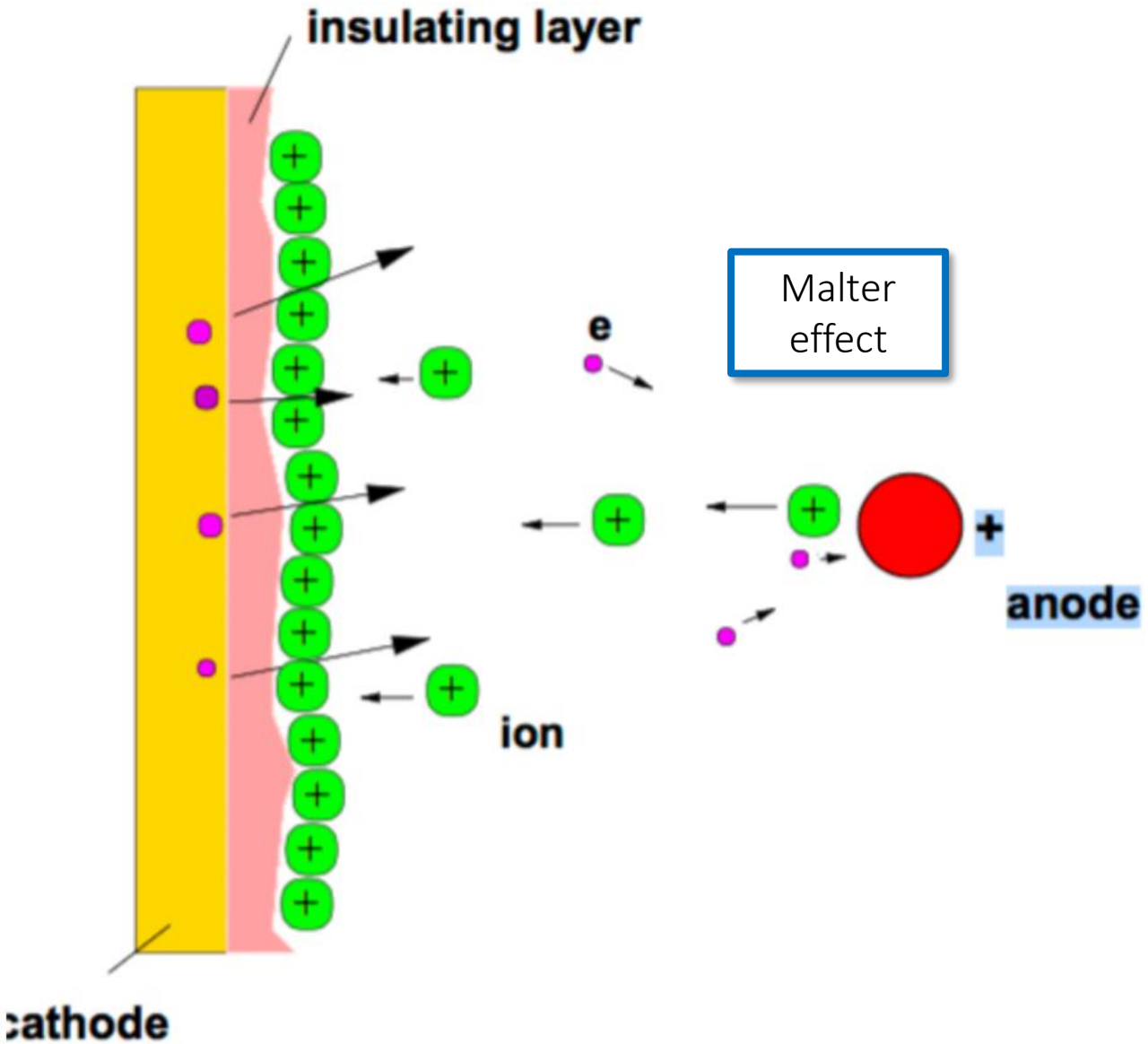
EFFICIENCY	$\epsilon_{\text{CDCH}} (\%) \pm 0.2\%$ (single hits)	$\epsilon_{e^+} (\%) \pm 0.2\%$
standard	75.8	63.4
usable wires	74.6	62.6

RESOLUTIONS	$\sigma_{\theta}/\text{RMS}_{\theta}$ (mrad) ± 0.03	$\sigma_{\phi}/\text{RMS}_{\phi}$ (mrad) ± 0.03	σ_p/RMS_p (keV) ± 0.4	σ_z/RMS_z (mm) ± 0.006	σ_y/RMS_y (mm) ± 0.006
standard	6.217/6.876	5.766 /6.514	87.5/103.6	1.379/1.590	0.728/0.828
usable wires	6.221/6.879 +0.04%	5.822/6.585 +1%	88.0/103.9 +0.3%	1.384/1.601 +0.7%	0.736/0.837 +1%

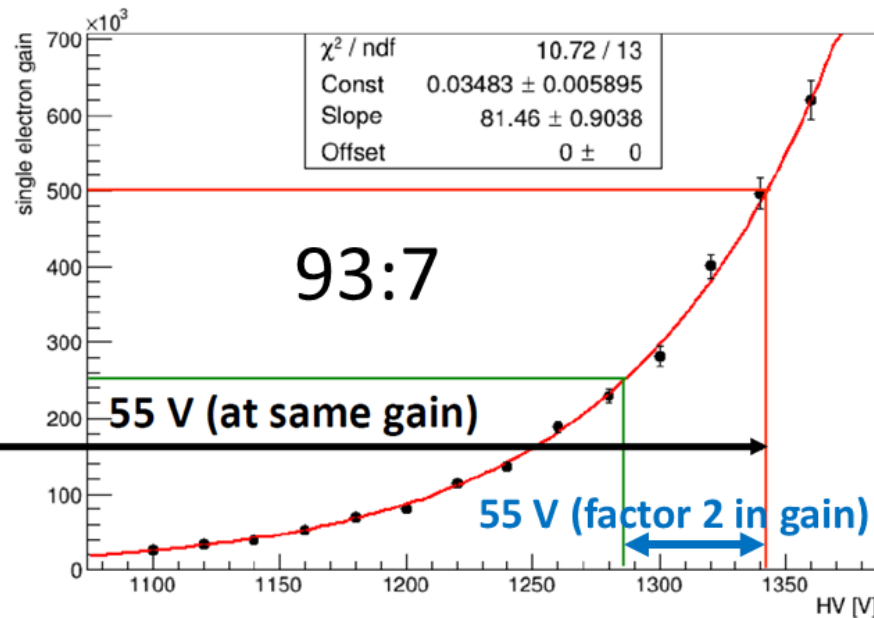
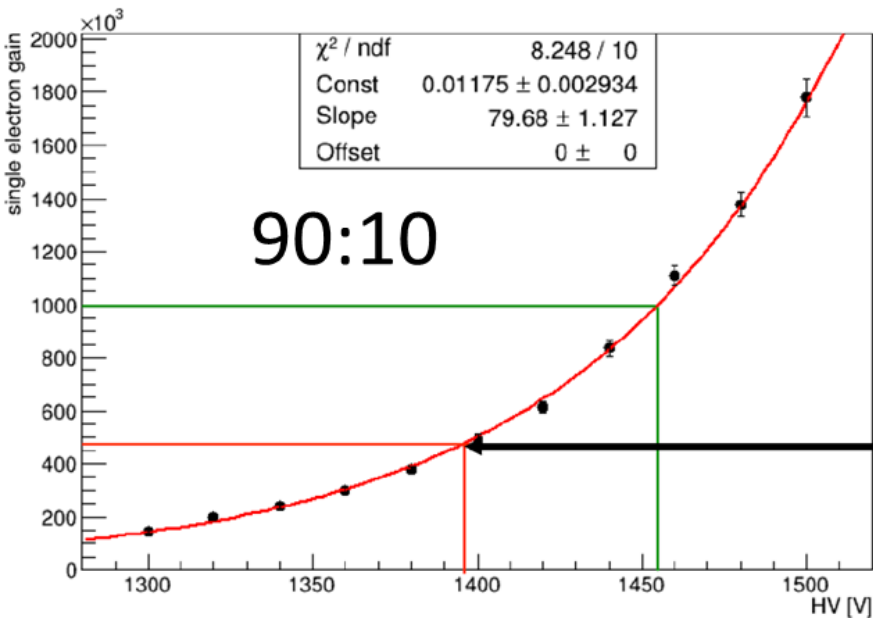
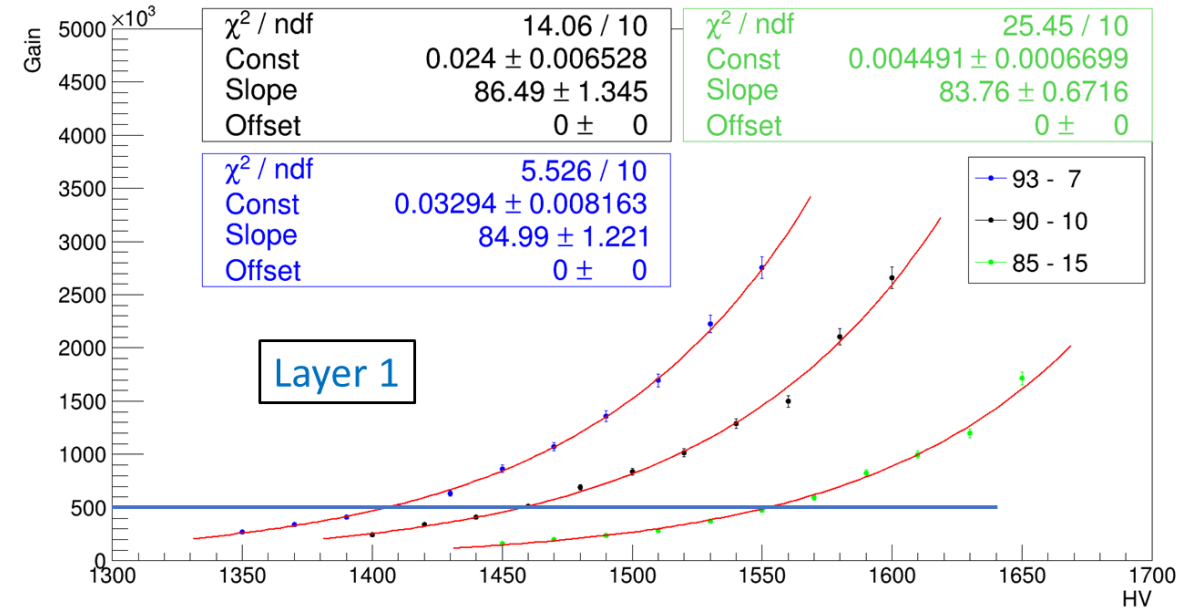
Drift chambers working



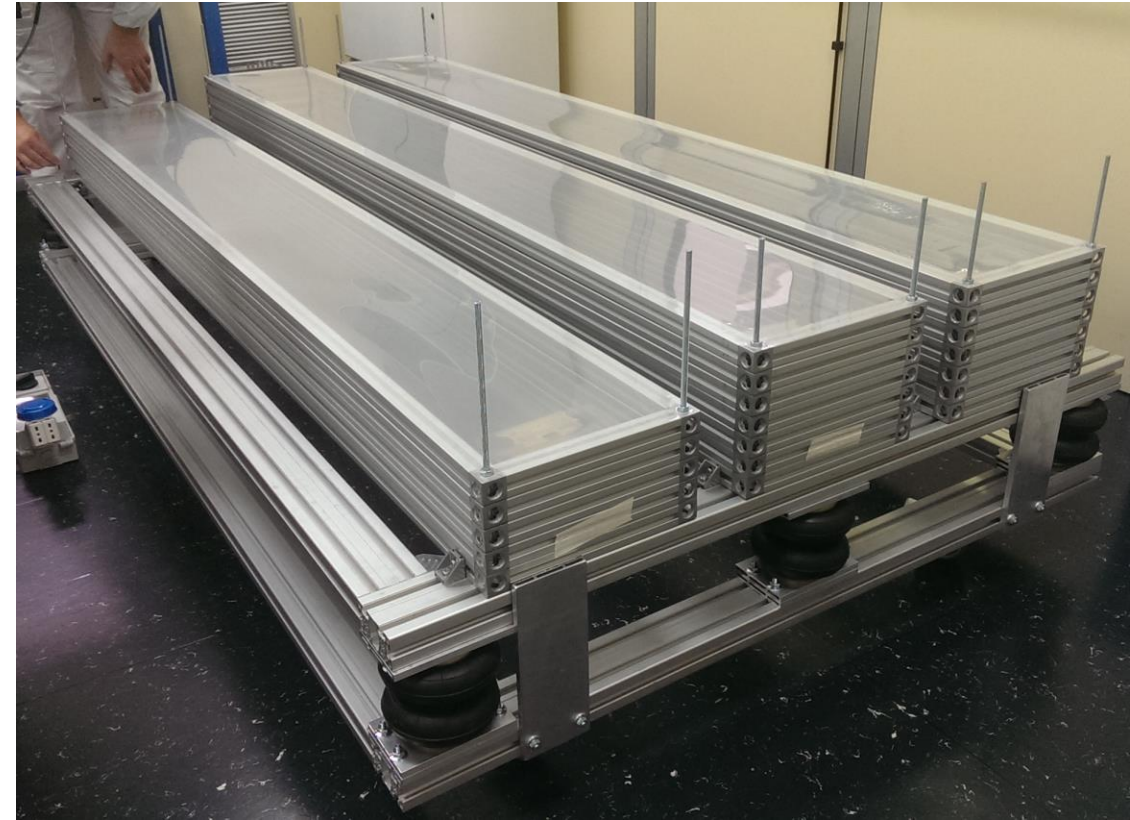
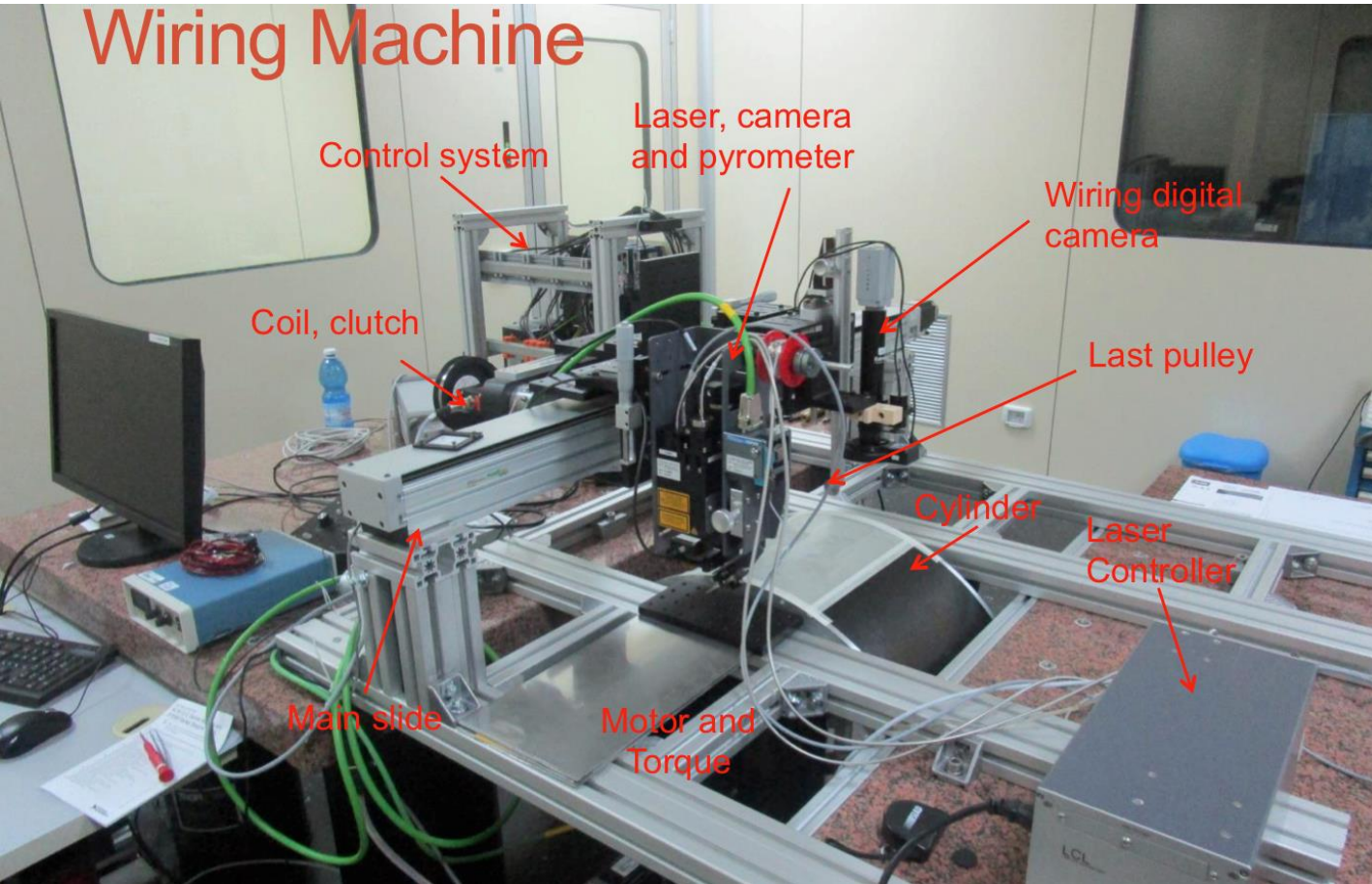
Malter effect and free radicals



Simulated gain curves



Wiring machine

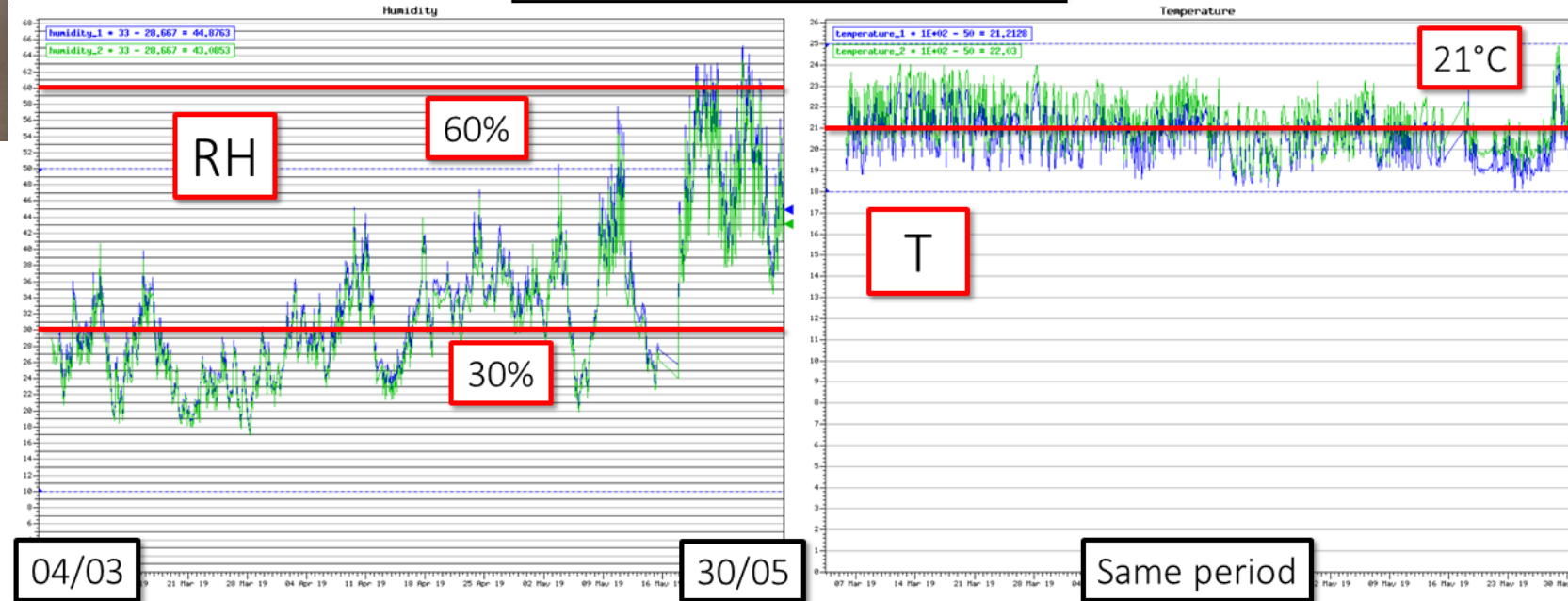
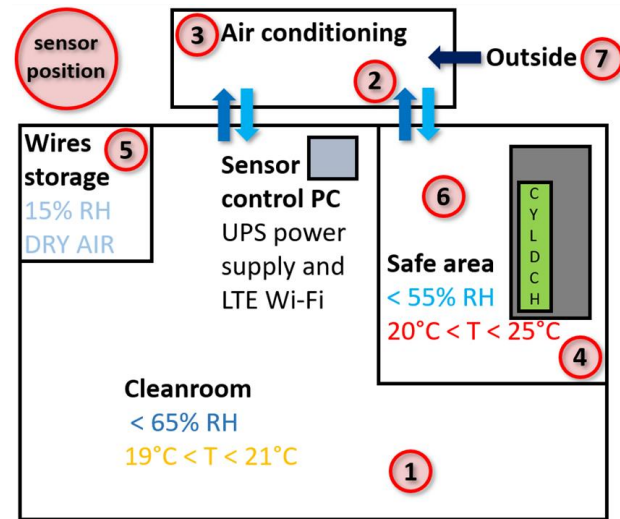


Transport trays +
dumping structure

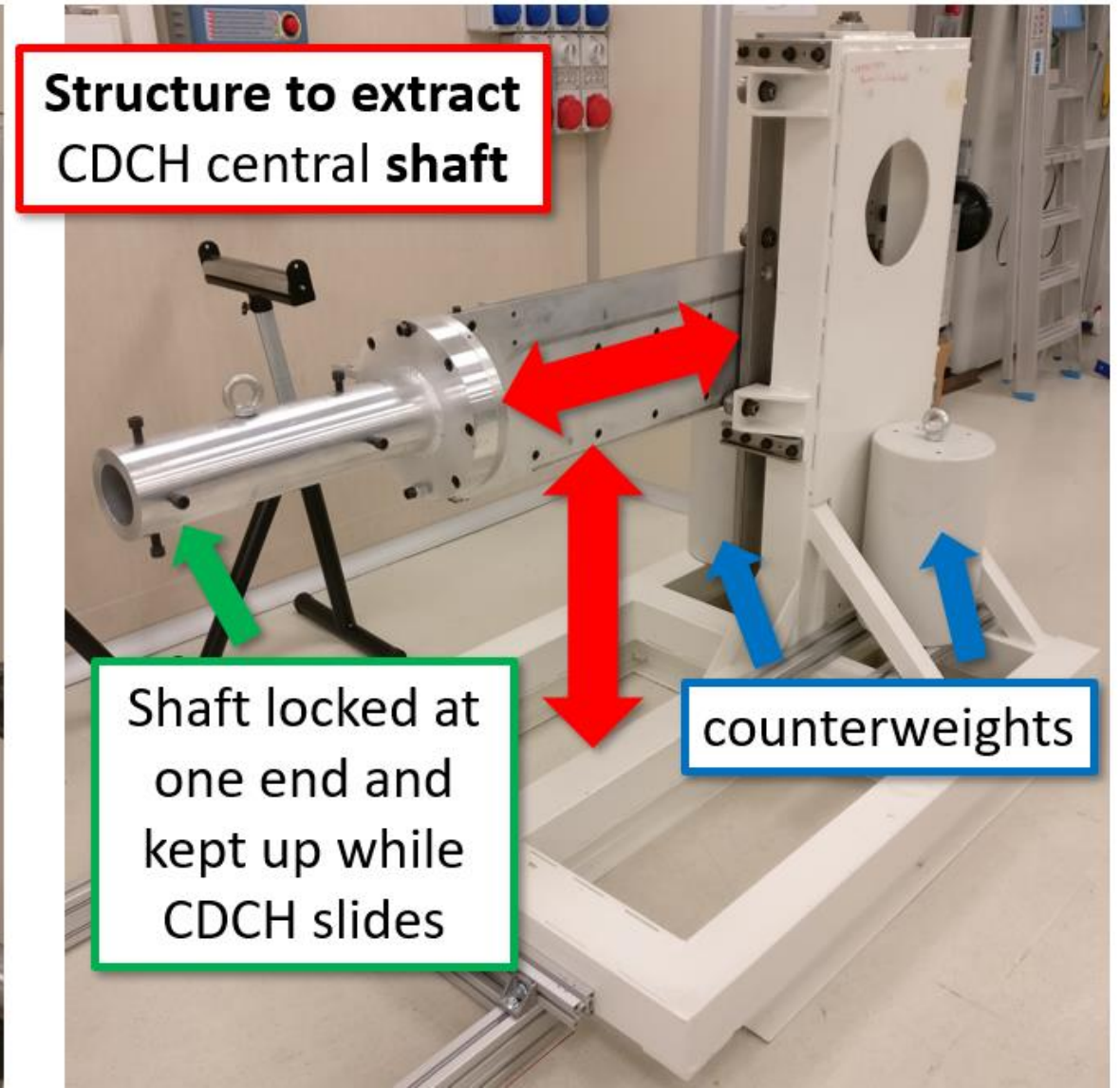
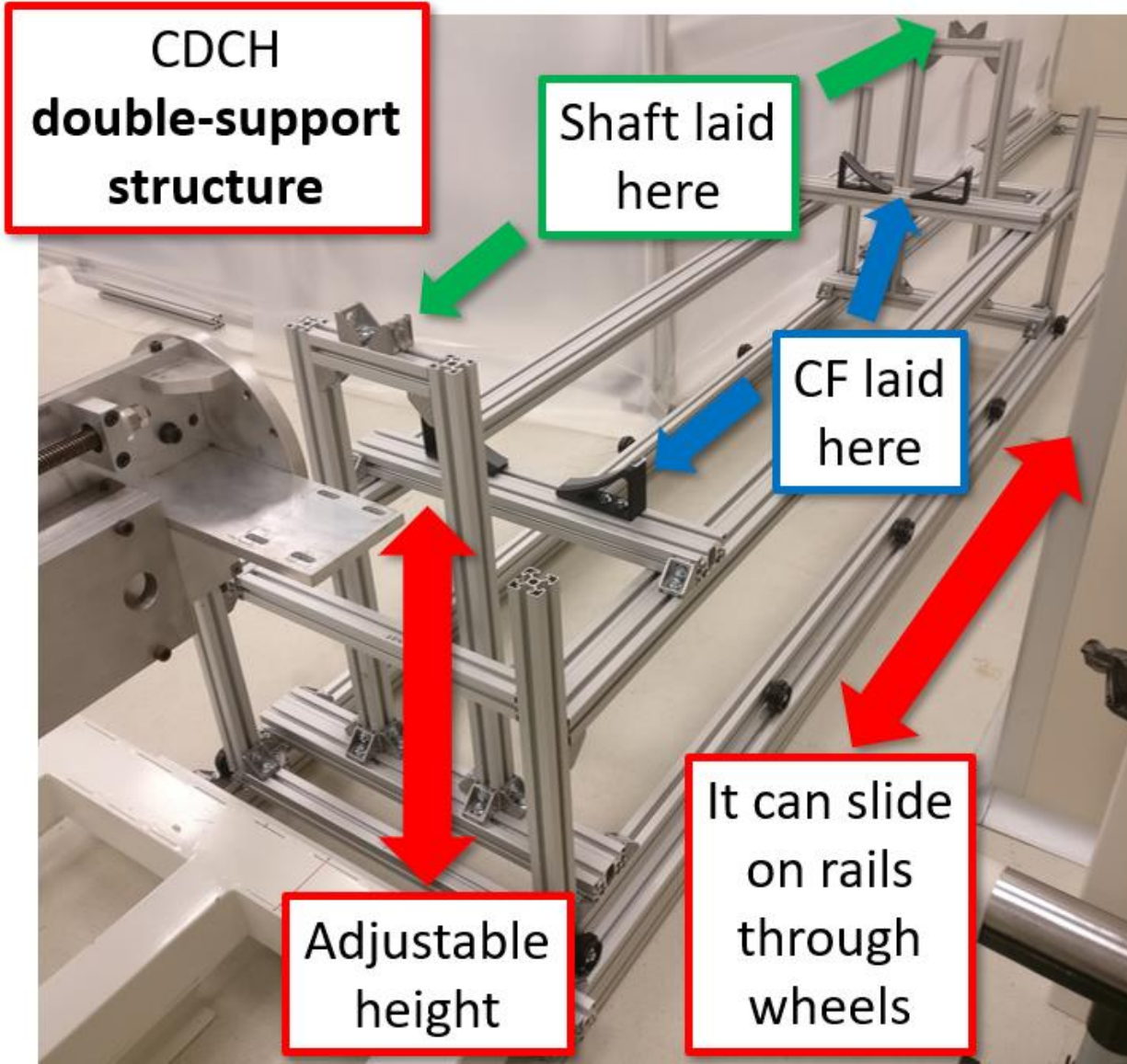
Environmental condition monitoring



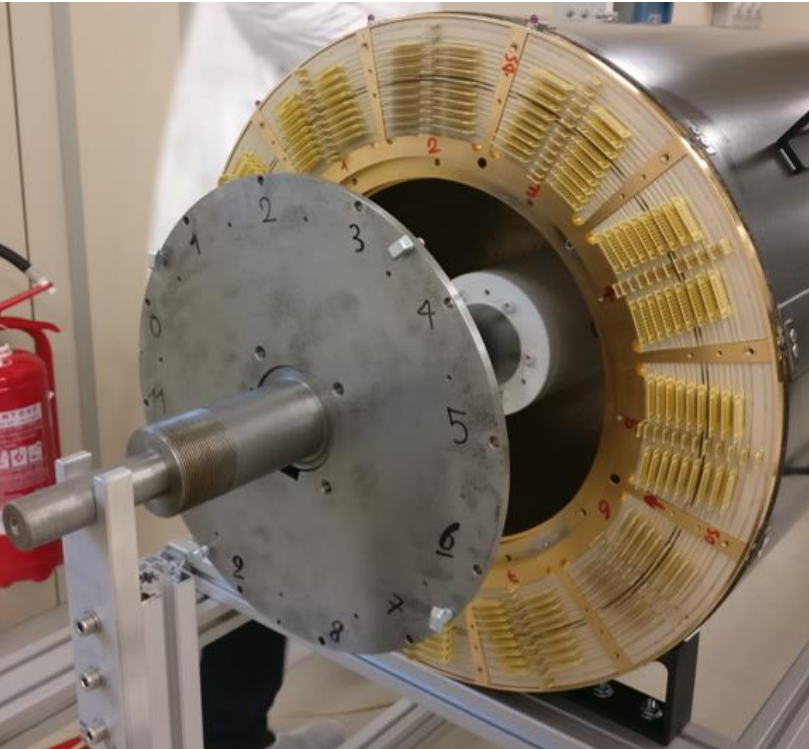
CDCH assembly inside



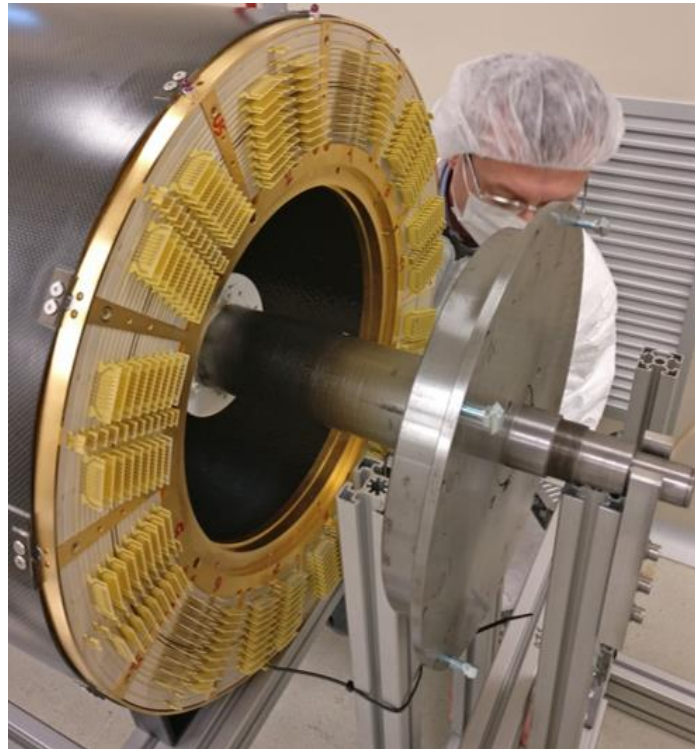
Auxiliary tools



CF + shaft



CDCH-shaft
decoupling

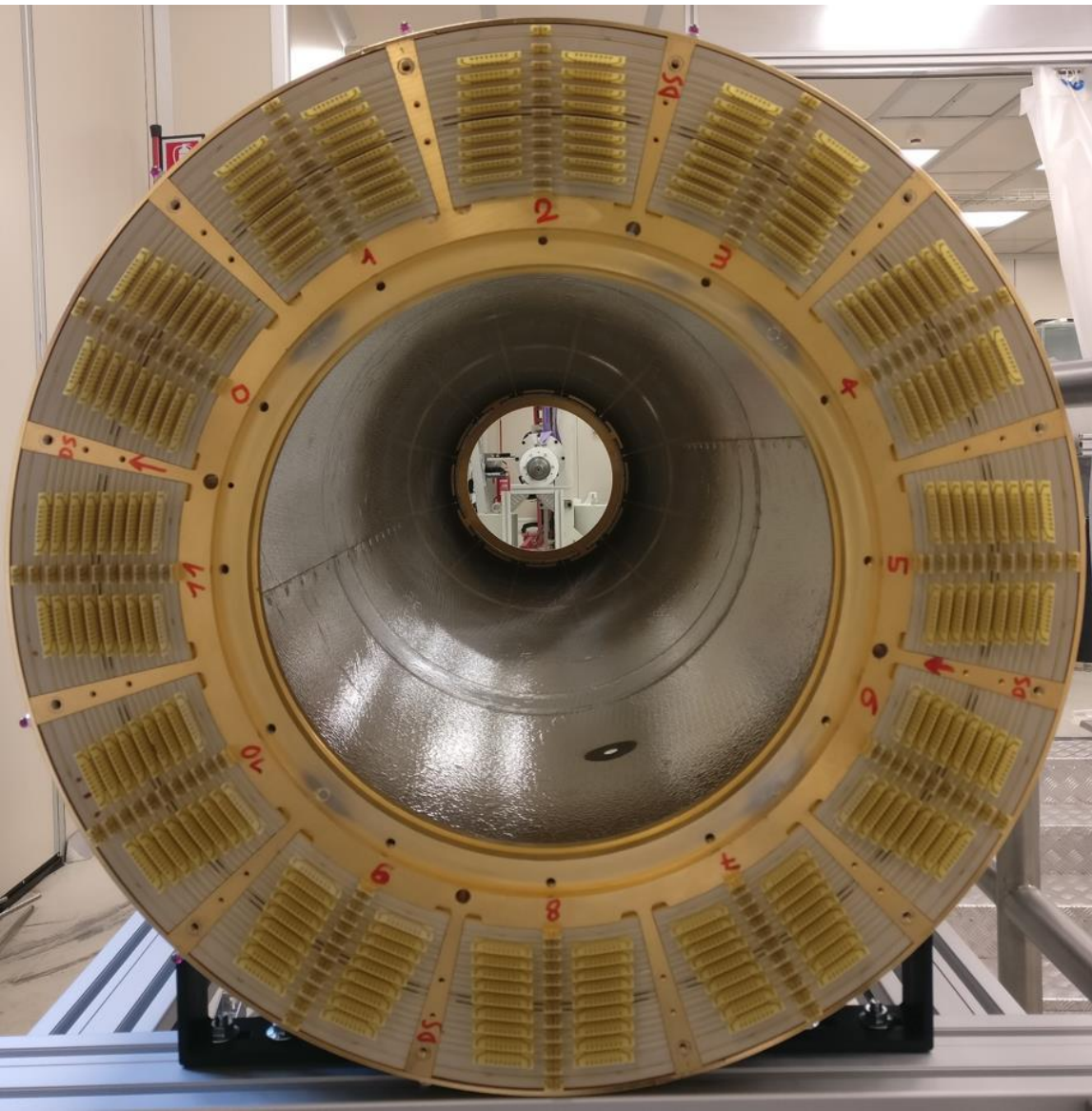


CF half-cylinders



Al foil in the
inner faces

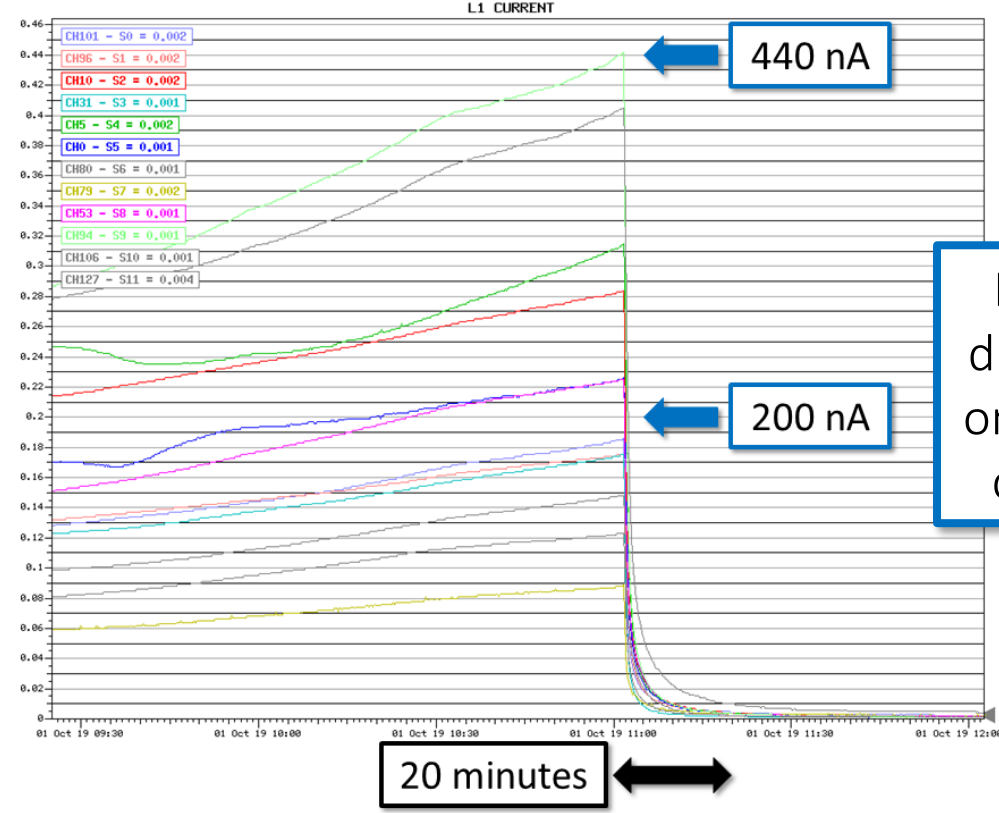
Wireless chamber



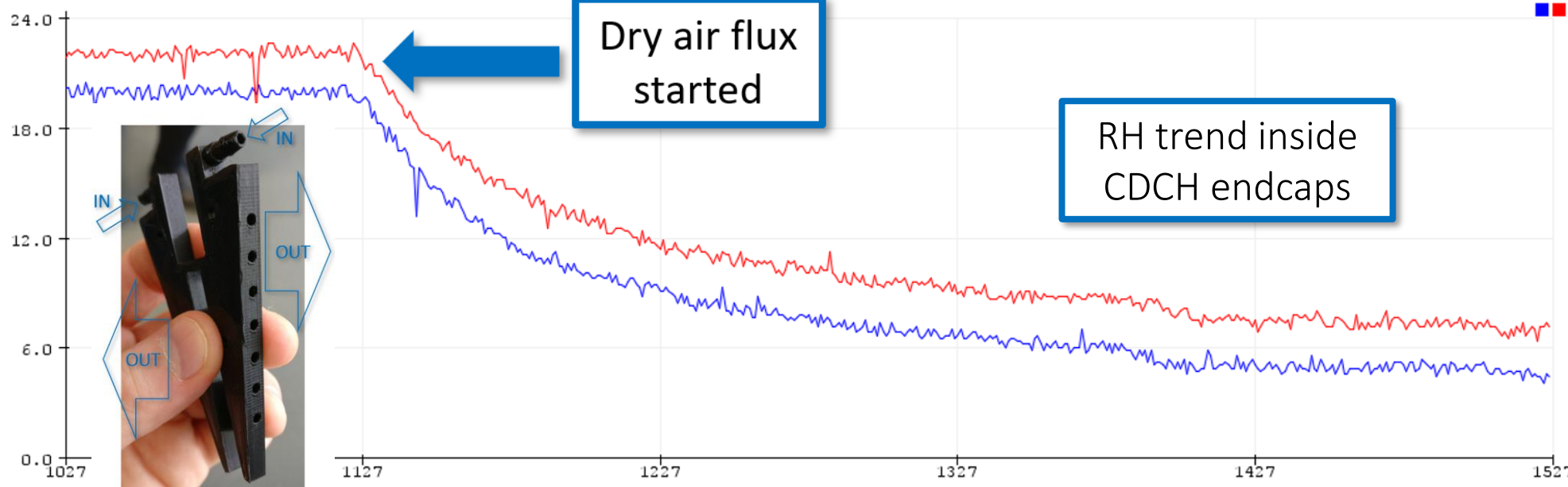
T and RH sensors



T sensors



Effect of dry air flux on residual currents



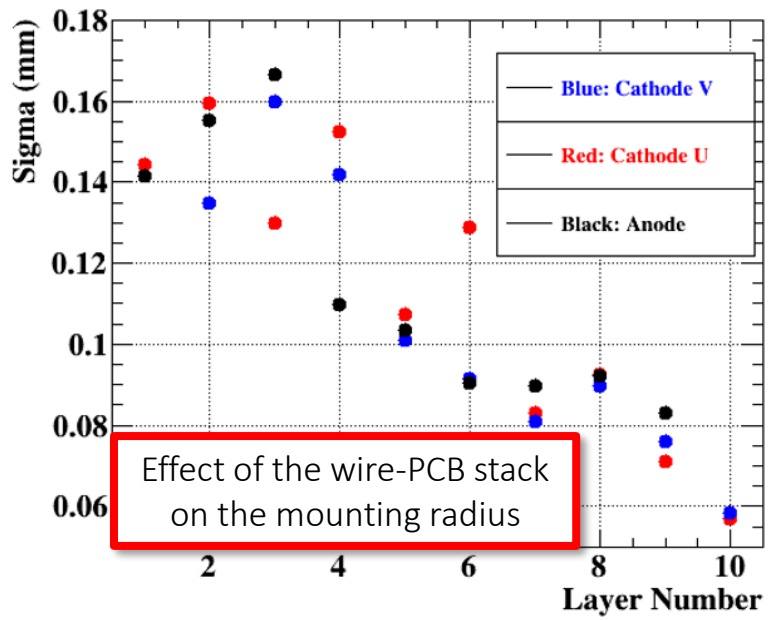
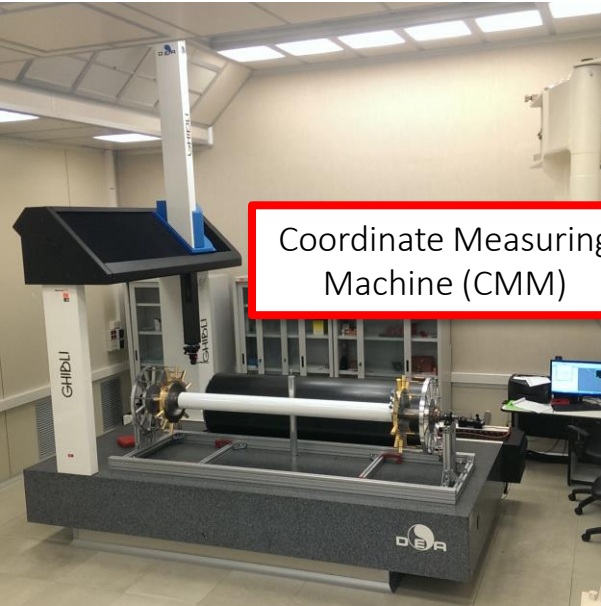
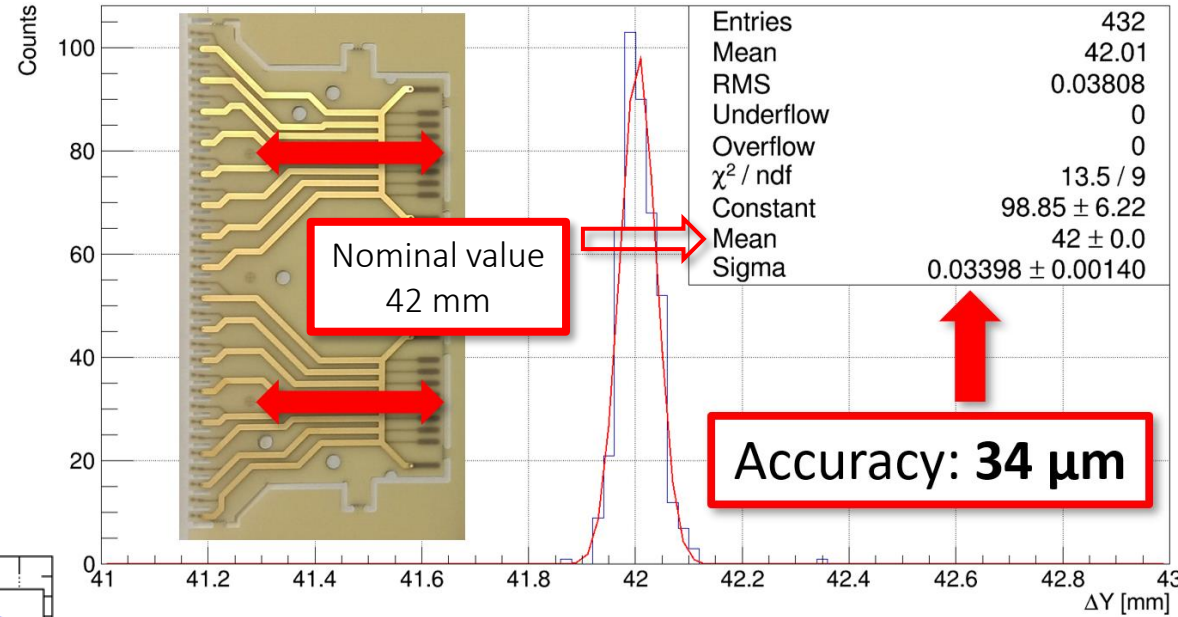
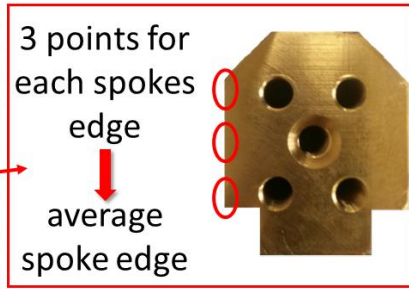
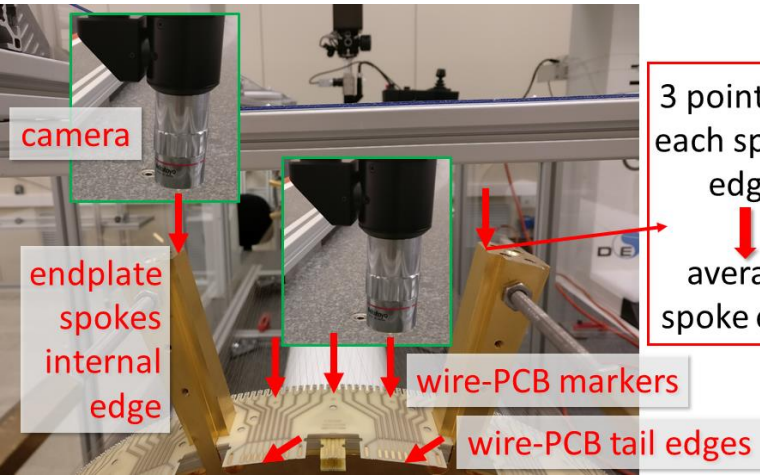
Last activities in the cleanroom



- Structural shaft extraction
- Inner extensions mounting
- ThreeBond sealing

CDCH flushed with **synthetic air**
when no activities in the cleanroom

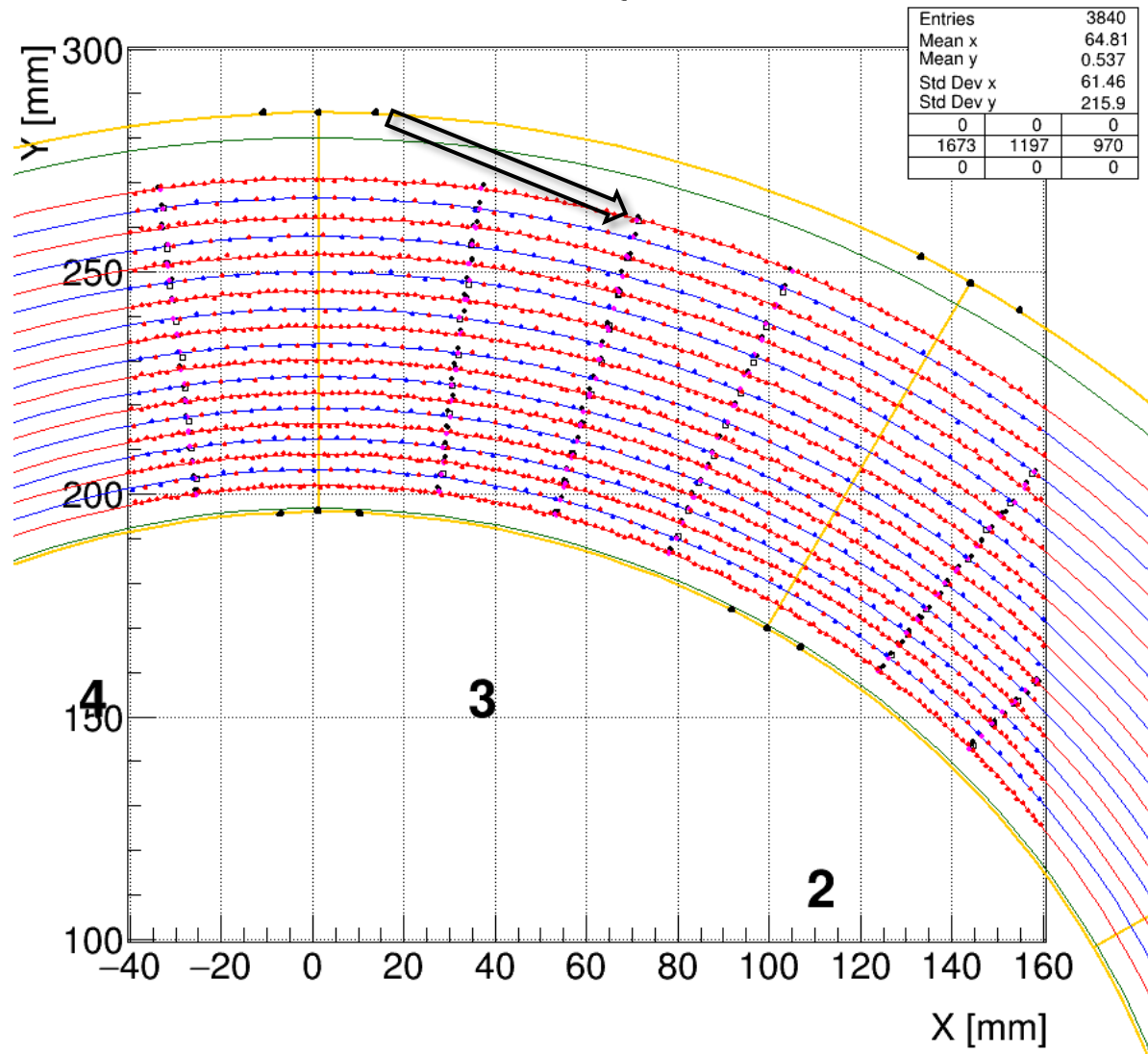
Local reference frame on each sector



Accuracy of the optical measurements performed during the CDCH assembly phase

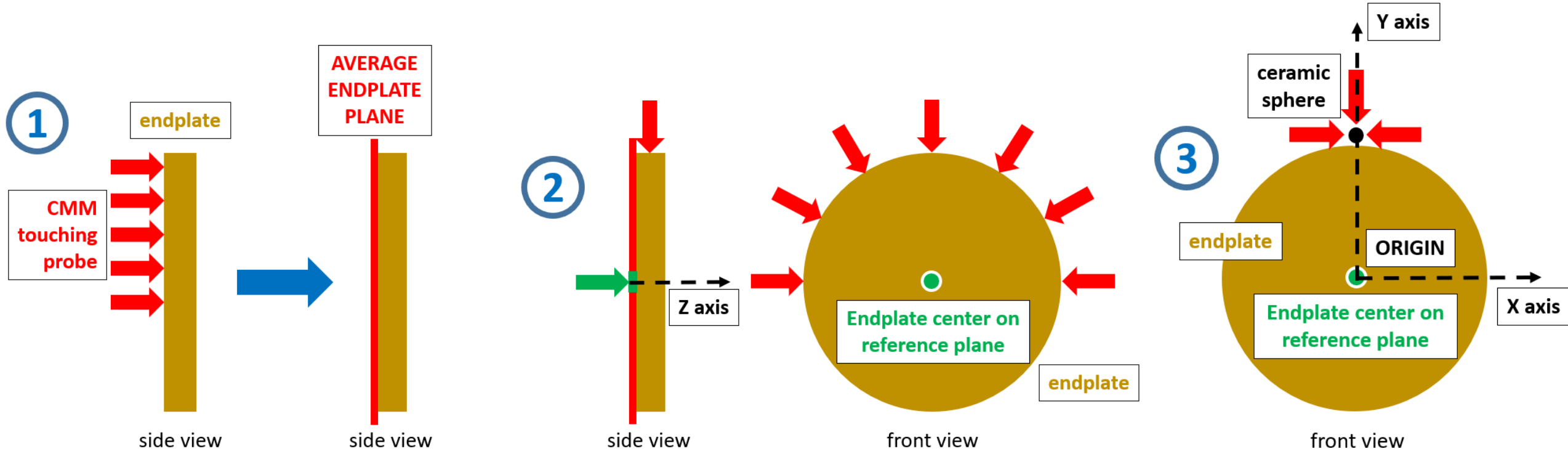
Local → global reference frame

US endplate



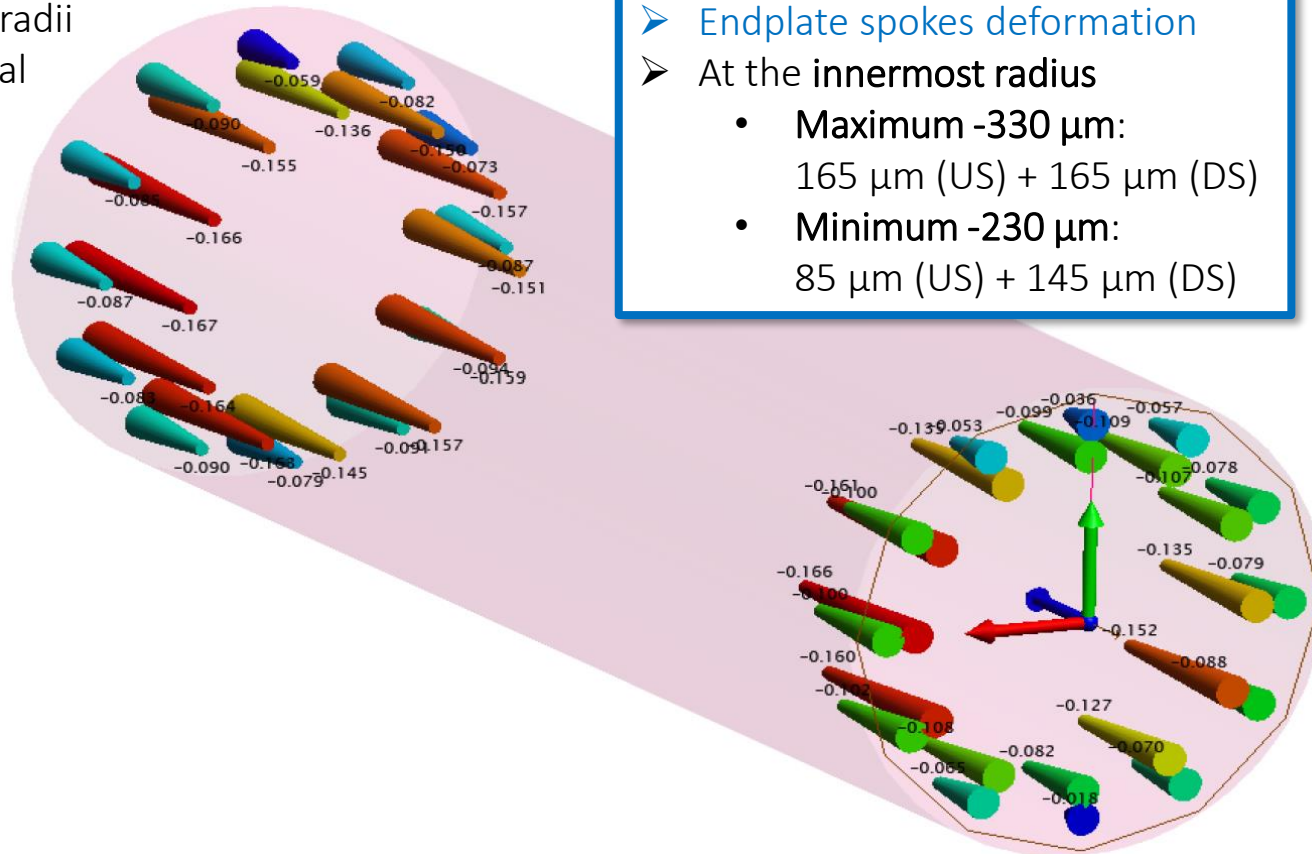
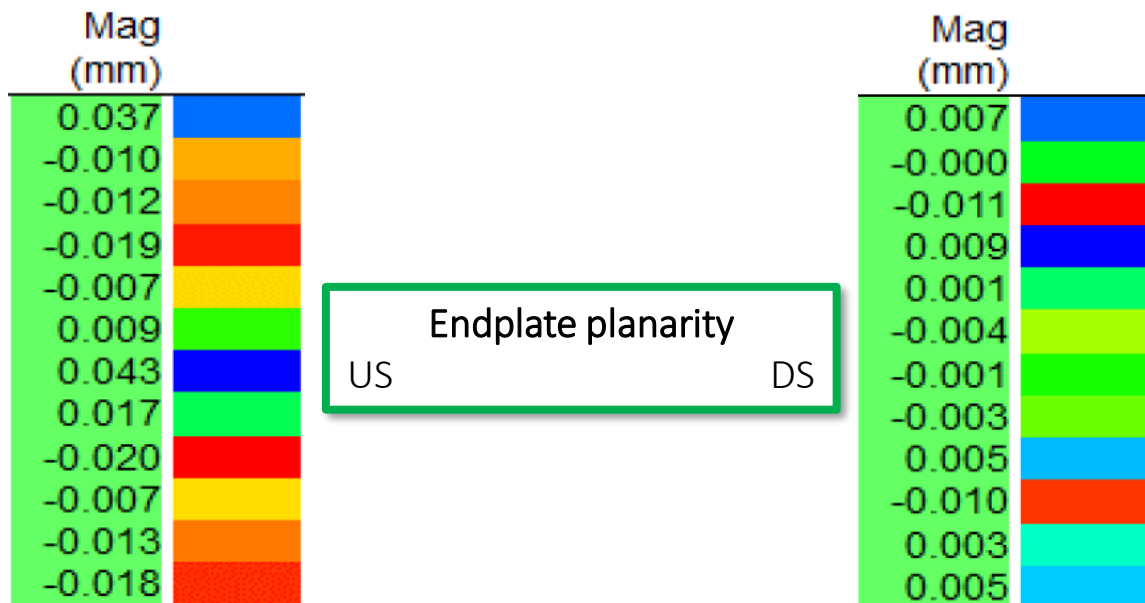
- The local reference frame on each sector is then transferred to the global CDCH reference frame considering the nominal values of the endplate mechanical features
 - In particular exploiting the measured edges of each spokes...
↓
 - ...we place the central reference marker of each wire-PCBs in the endplate reference frame...
↓
 - ...then we place the soldering pads in the endplate reference frame based on the CAD files of each wire-PCBs
- The US and DS endplates are treated independently
 - Once computed the suspension points of all the wires we create the wire vector by connecting the corresponding end points

CDCH reference frame



Geometry survey measurement

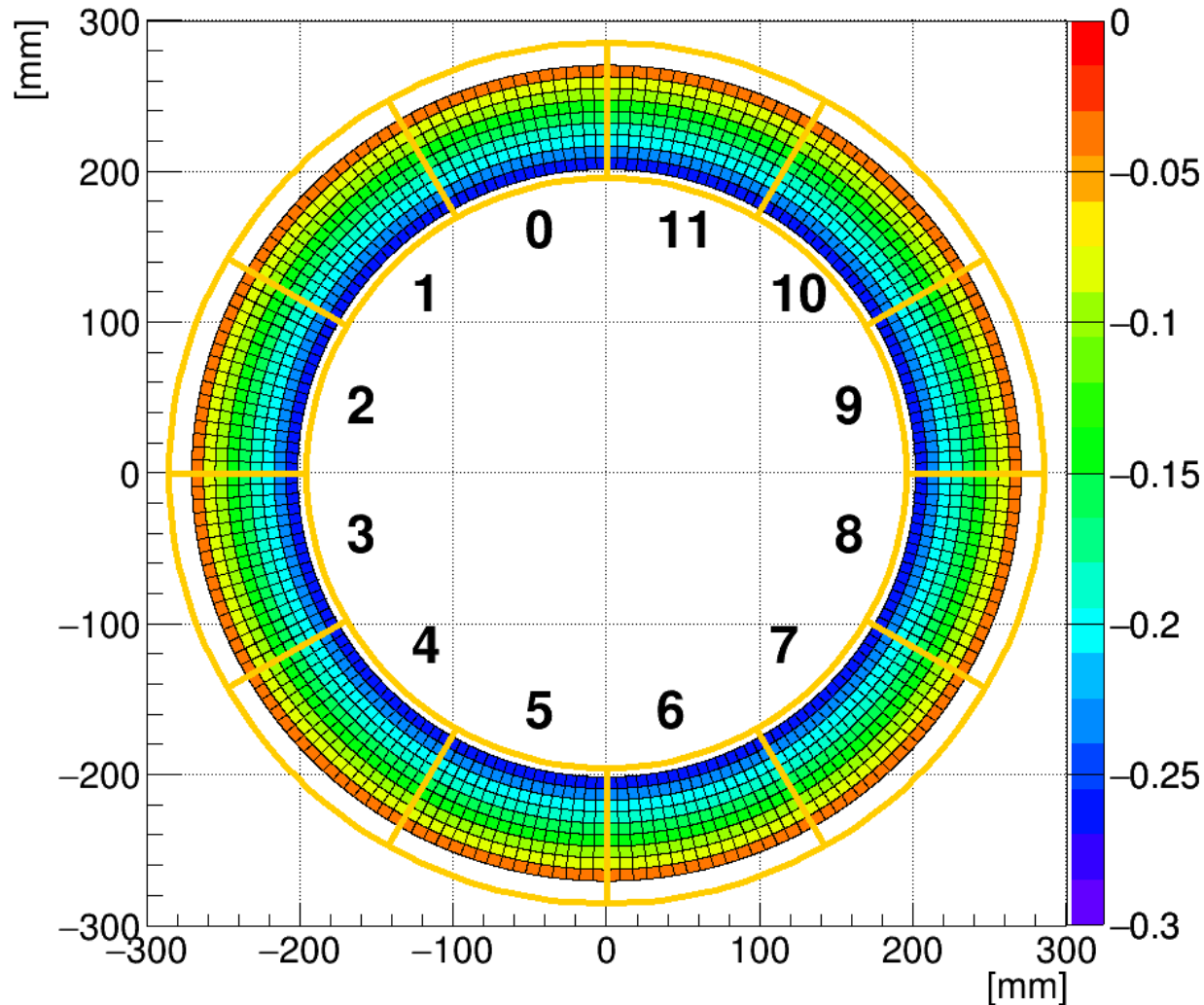
- Alignment of the endplates at a very good level < 65 μm
- Endplates are kept at the correct distance with the external CF support structure
 - We have a Z deformation toward CDCH center going to inner radii
 - Smaller cells going to inner radii \rightarrow electrostatic stability critical
- The final working length has been experimentally set



- Endplate spokes deformation
- At the innermost radius
 - **Maximum -330 μm :**
165 μm (US) + 165 μm (DS)
 - **Minimum -230 μm :**
85 μm (US) + 145 μm (DS)

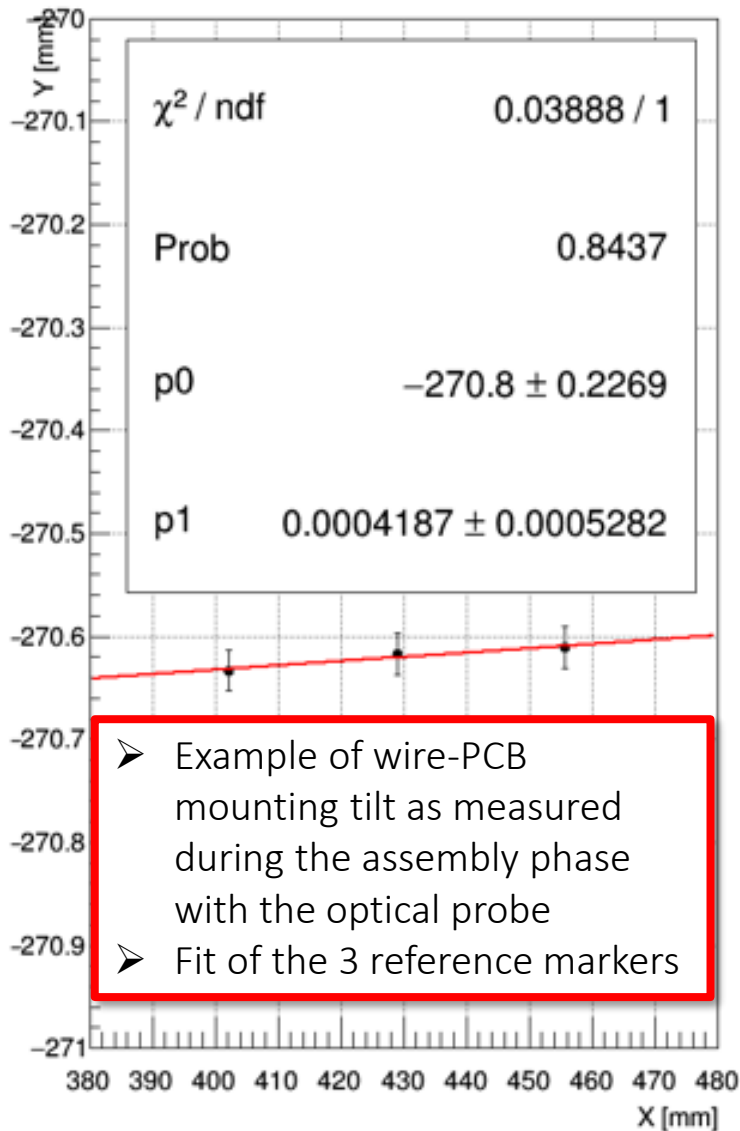
Radial deformation of the endplate spokes

Radial spoke deformations: average anode length variation per layer (US endplate)



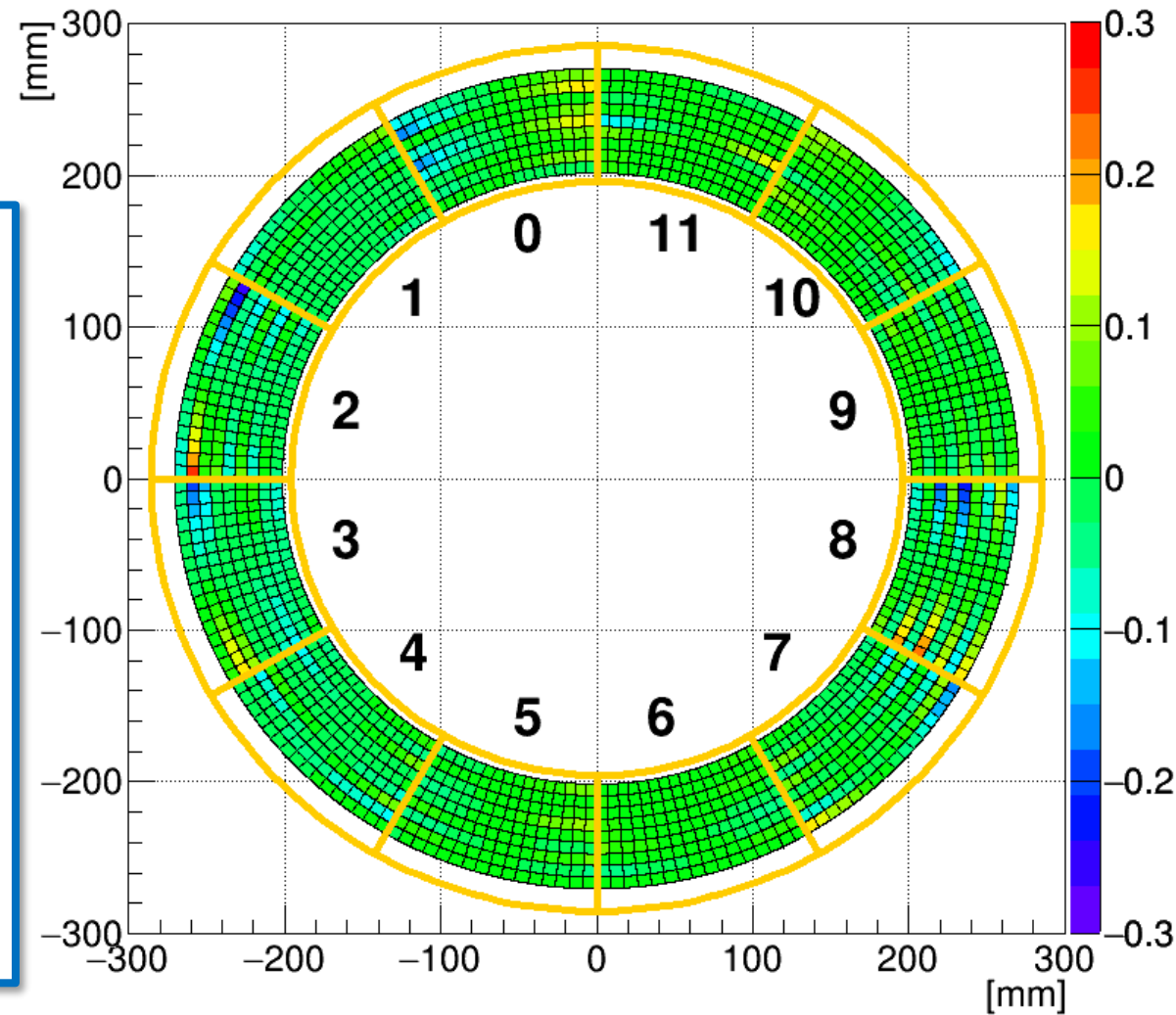
- Average effect of the US + DS radial deformation of the spokes on the anode wires length
- The radial deformation of the endplate spokes enters as a Z correction of the wire suspension point
 - Each US and DS sector is treated independently
 - Then the single corrections are combined → effect on the wires length

Wire-PCB mounting tilt



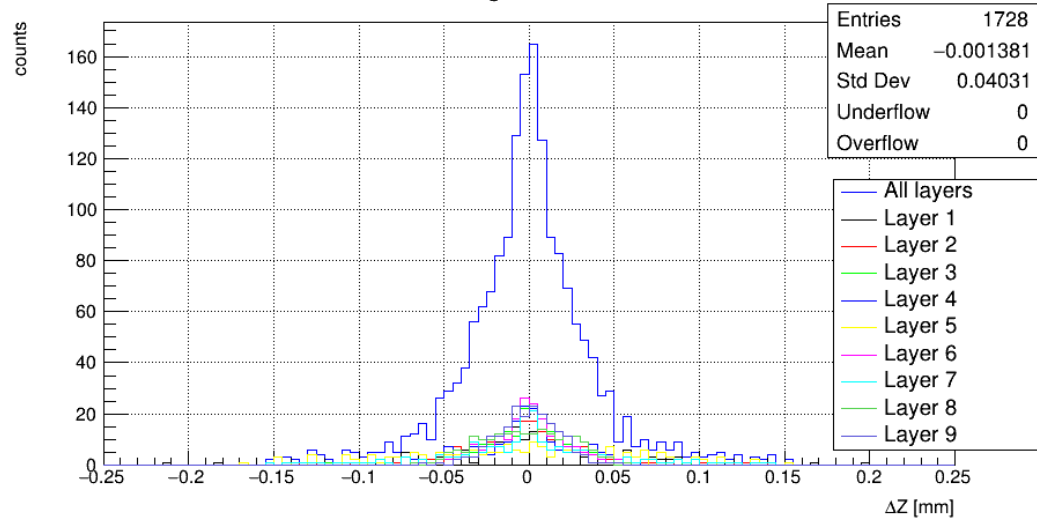
- Effect of the US + DS wire-PCB mounting tilt on the anode wires length
- The wire-PCB mounting tilt enters as a Z correction of the wire suspension point
 - The correction is computed for all the US and DS soldering pads independently
 - Then the single corrections are combined → effect on the wires length

Wire-PCB mounting tilt: anode length variation per layer (US endplate)

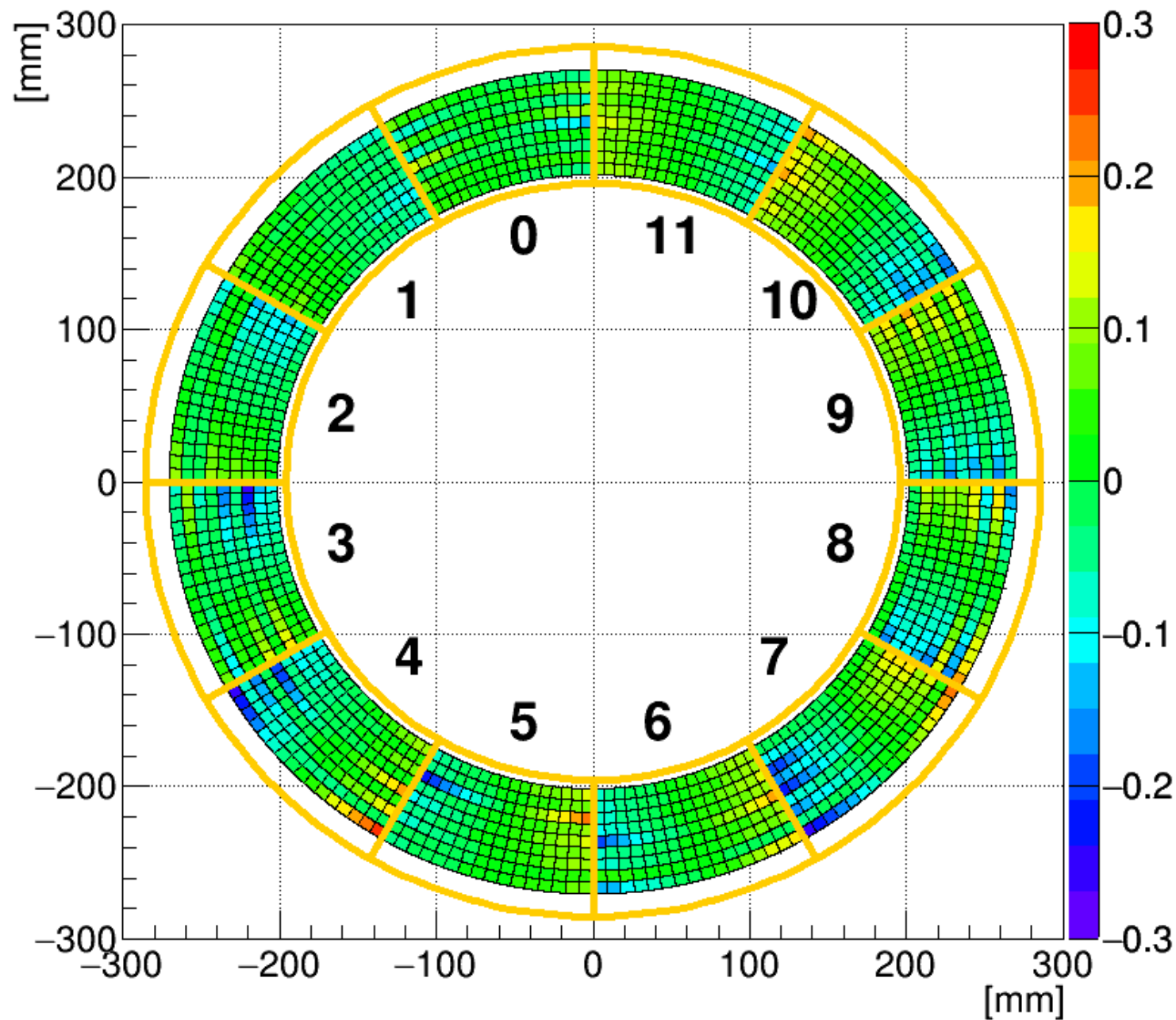
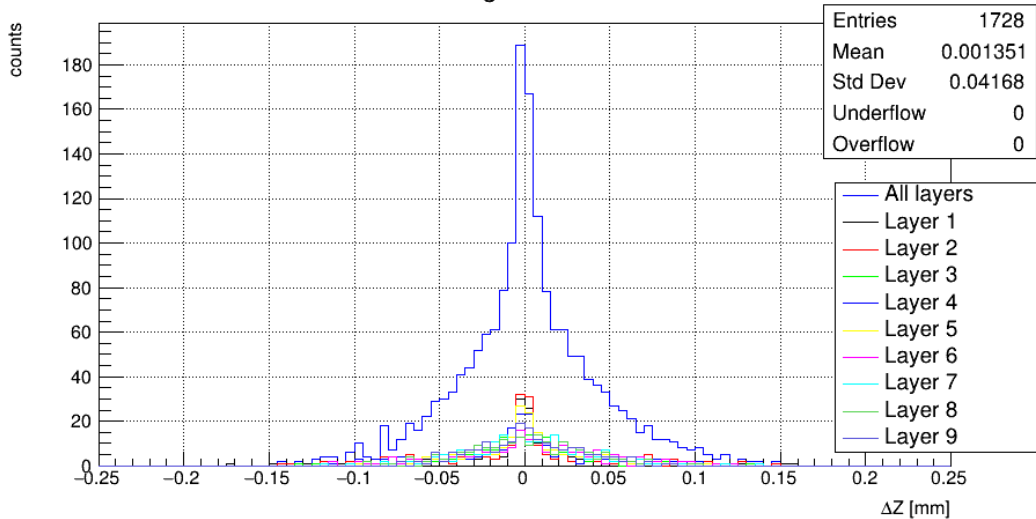


Wire-PCB mounting tilt: anode length variation per layer (US endplate)

US wire-PCB mounting tilt: Z correction for anodes

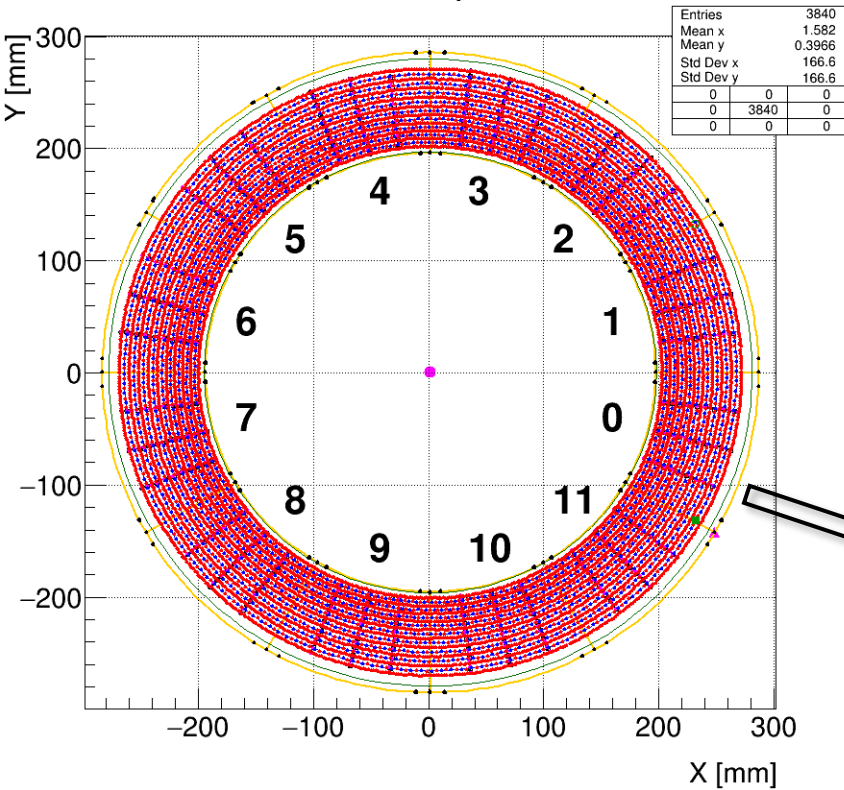


DS wire-PCB mounting tilt: Z correction for anodes

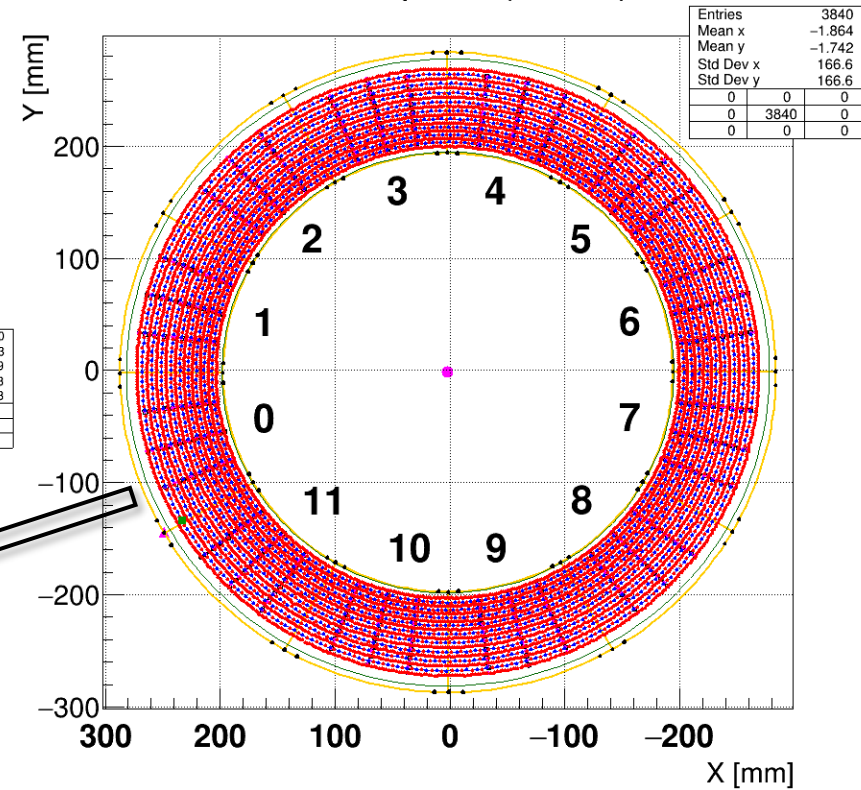


Wire positions

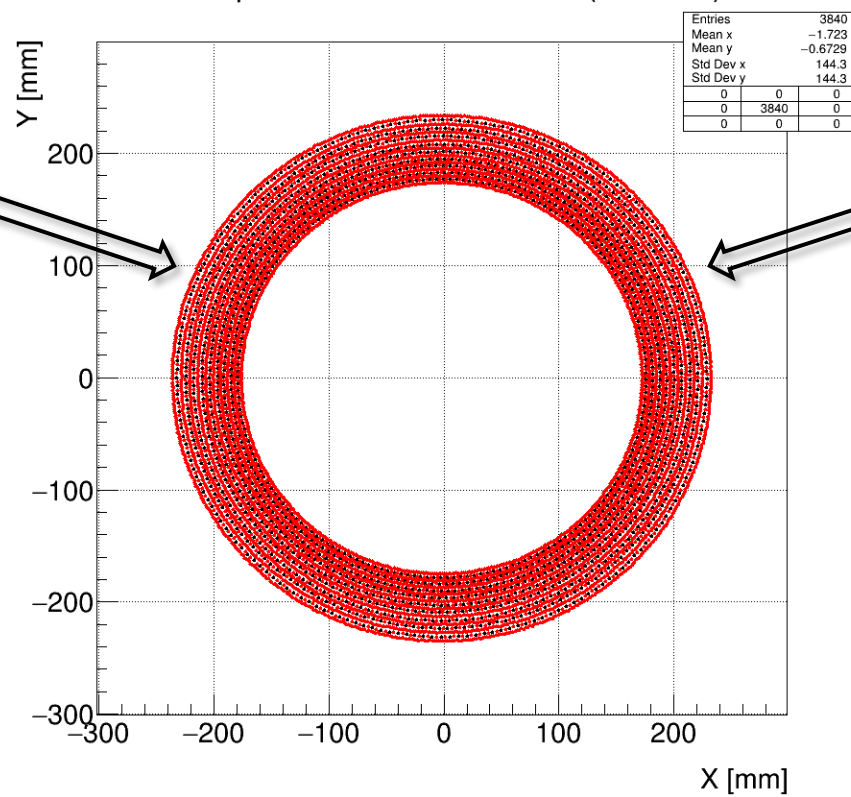
US endplate



DS endplate (mirror)

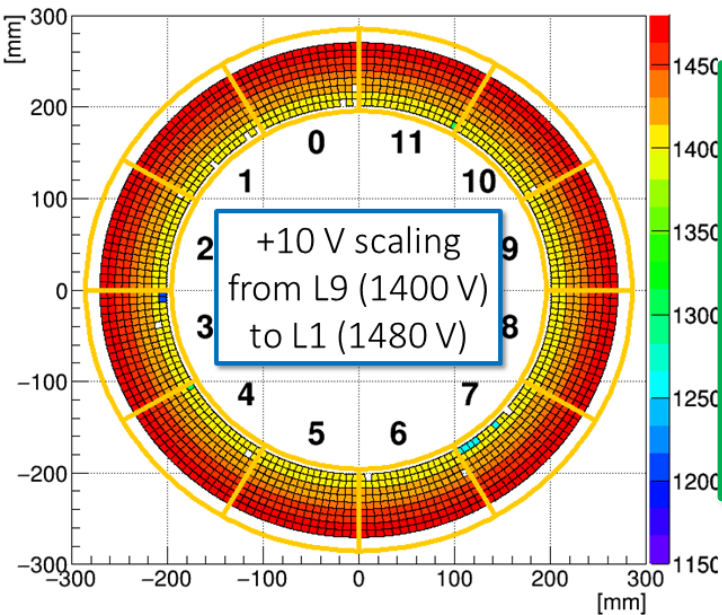


Wire position at CDCH center (from US)



Working length

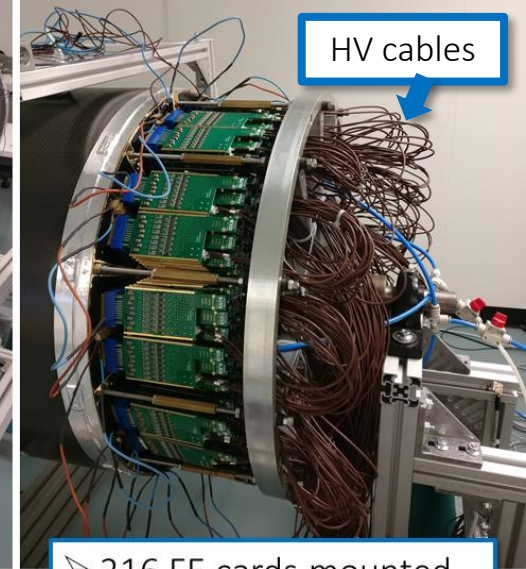
HV map working point (US endplate)



Some pictures from the commissioning phase at PSI



- CDCH temporarily sealed with CF + Al tape
- Nitrogen flux



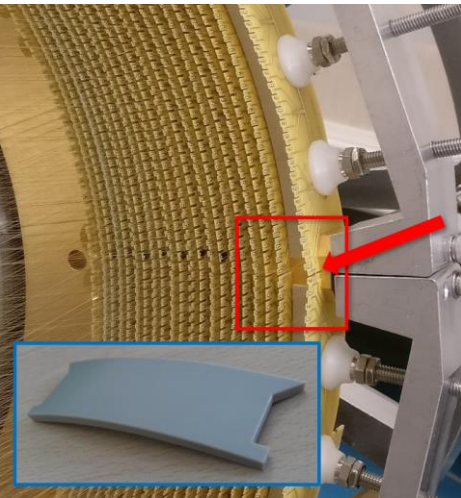
- 216 FE cards mounted on the US side

HV cables

- Cell inefficiency experimentally measured
 - Negligible in e^+ reconstruction
 - 0.5% worsening in resolutions
 - Tests with high statistics full MC

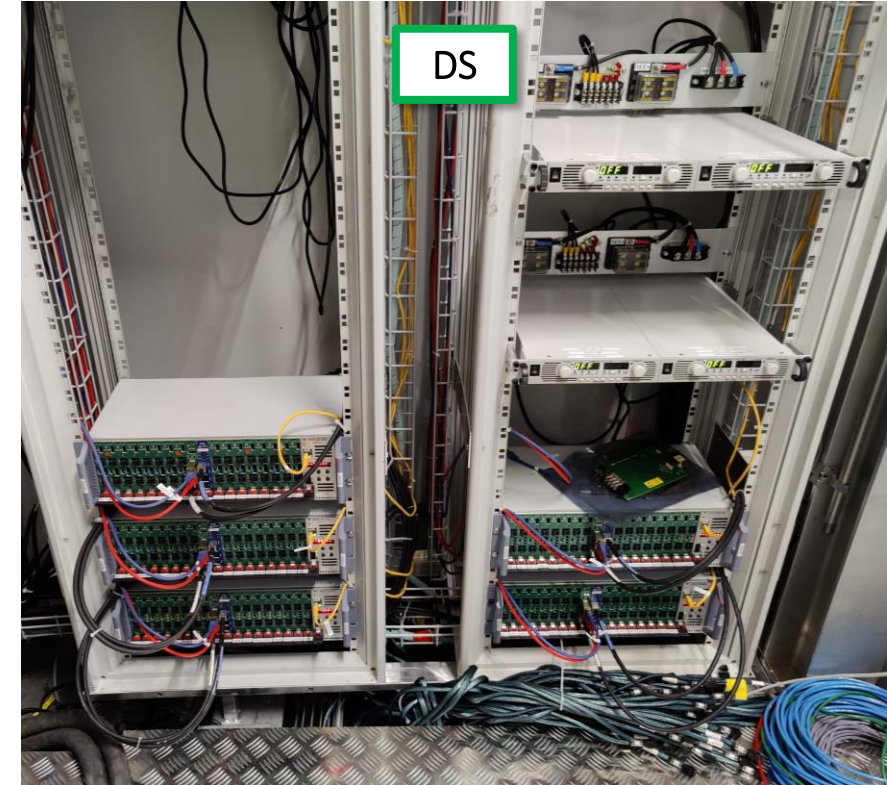
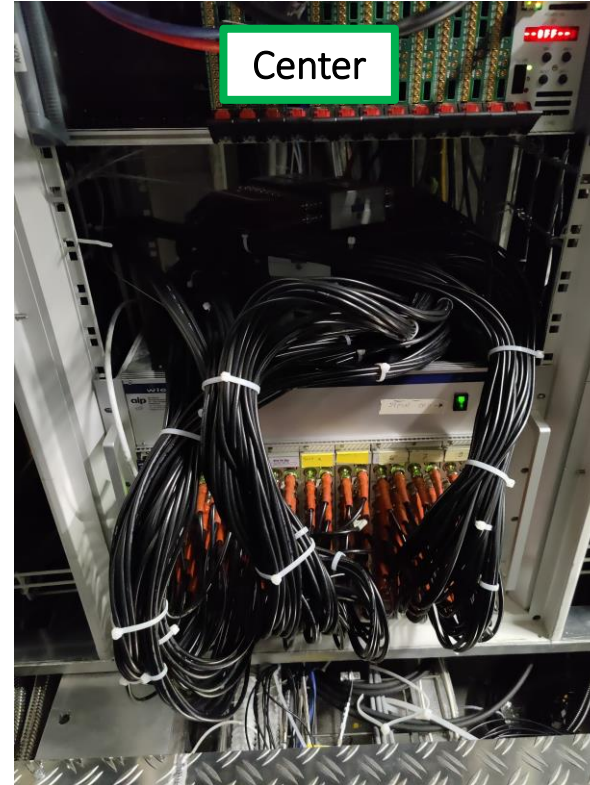
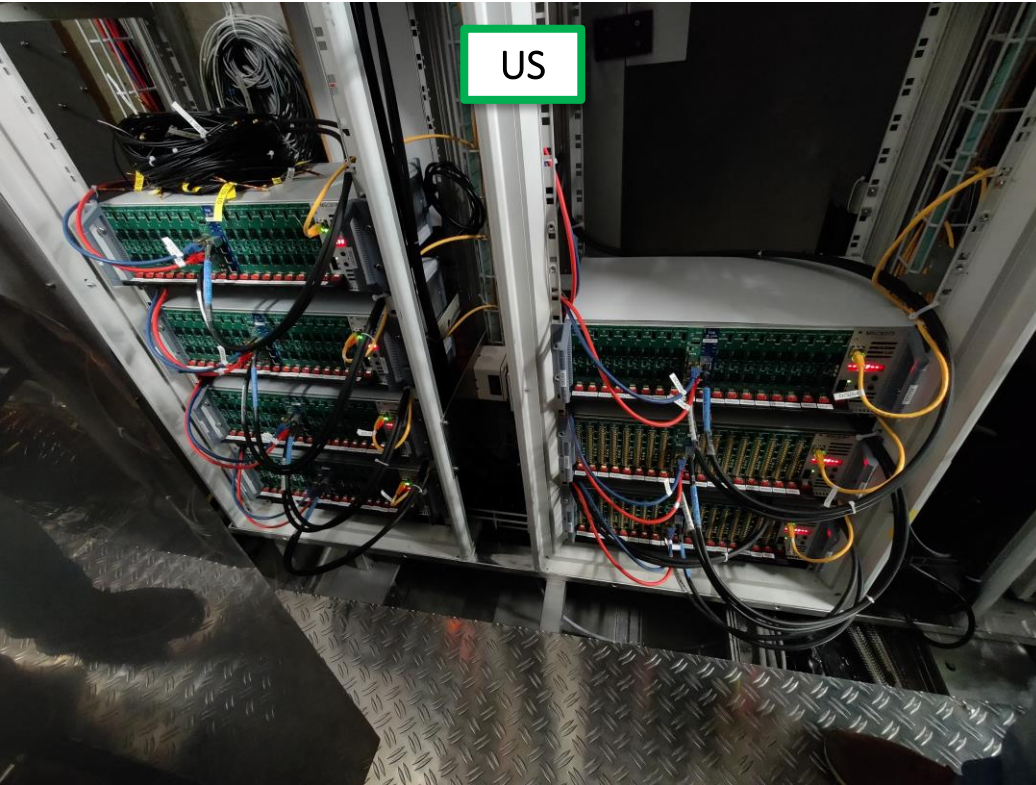
Final CDCH length experimentally found through systematic HV tests at different lengths/wires elongations

- Tests performed in 2019 and 2020 at PSI inside a cleanroom
- CDCH length adjusted through geometry survey campaigns with a laser tracker (20 μm accuracy)
- Final length set to +5.2 mm of wires elongation
 - 65% of the elastic limit



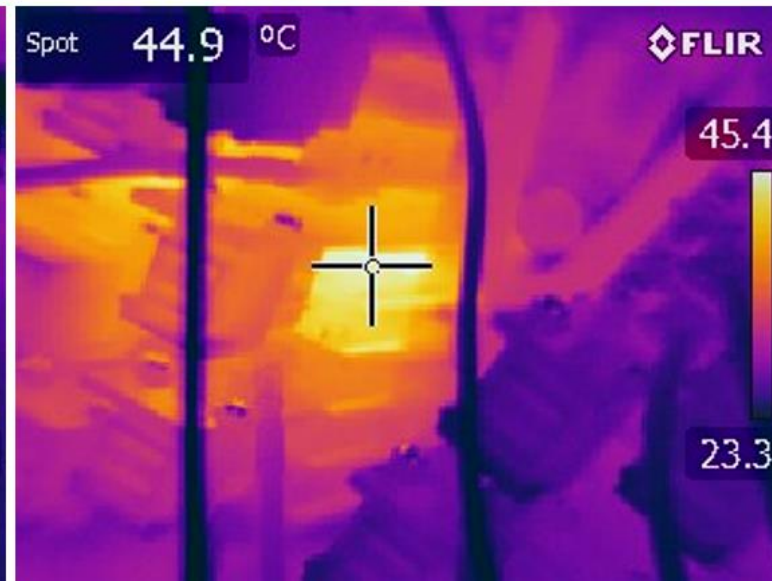
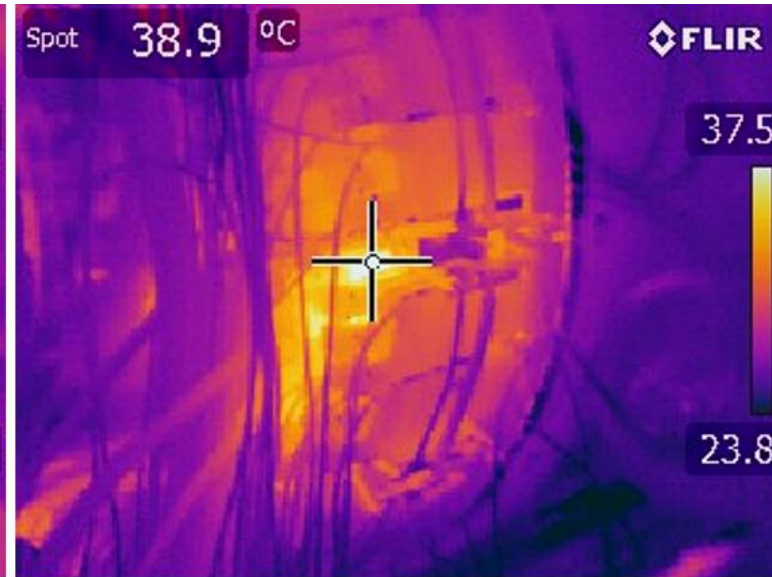
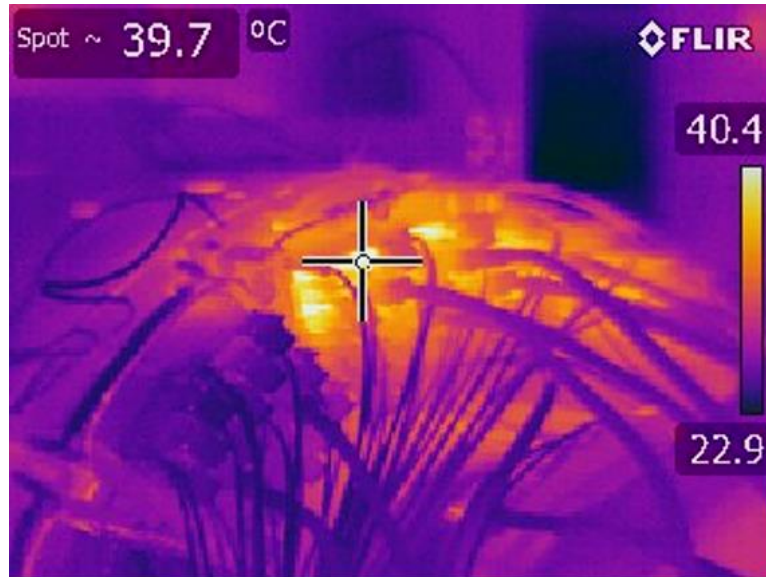
- Some drift cells at the border between 2 adjacent sectors presented electrostatic instability
 - Due to wire-PCB geometry
 - Once the PEEK spacers are mounted the correct circular shape is expected to be recovered
 - But sometimes deformations $O(\text{a few hundred } \mu\text{m})$ remain causing electrostatic instabilities
 - HV kept at lower values for the involved cells

Status of the electronics racks



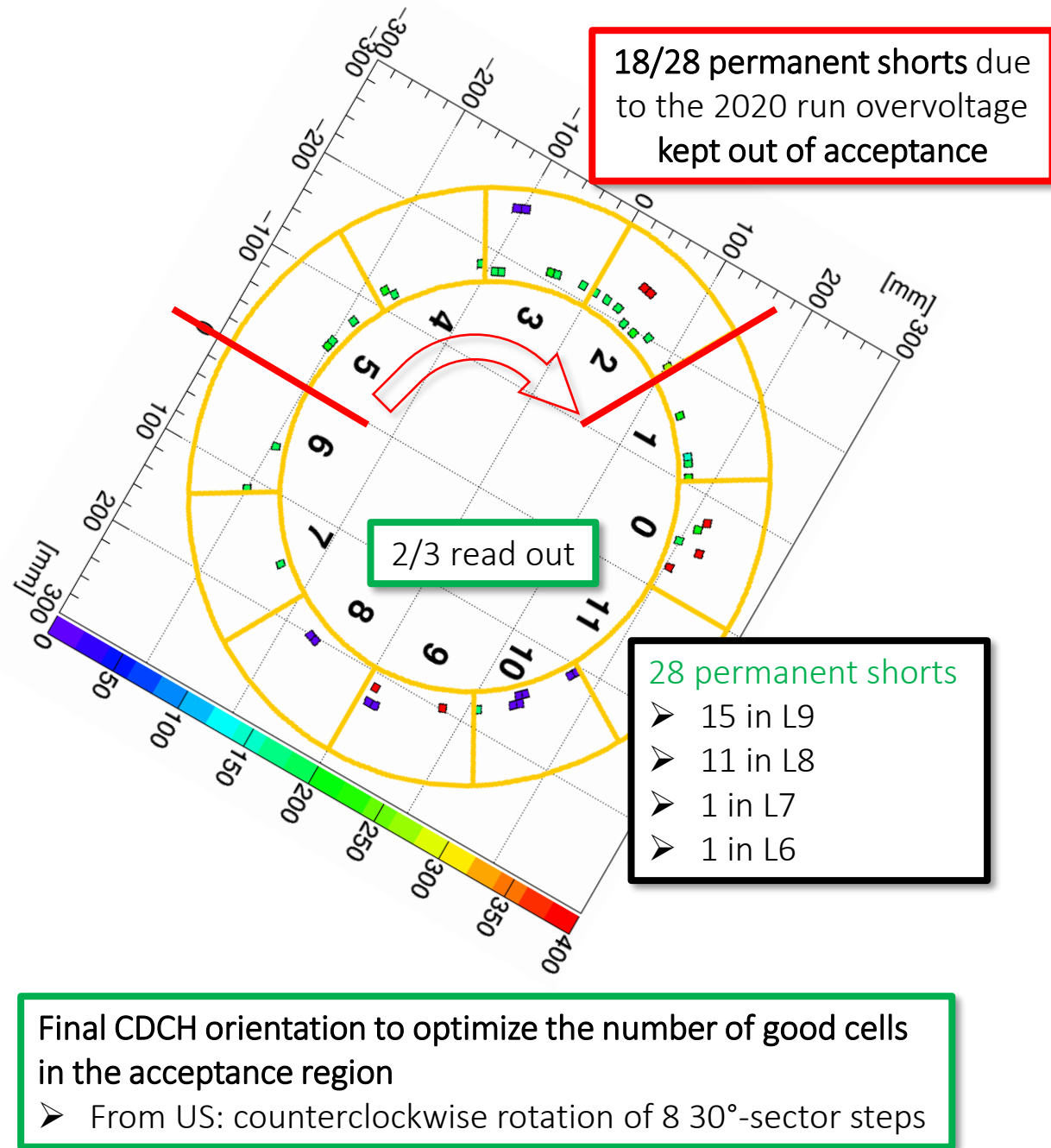
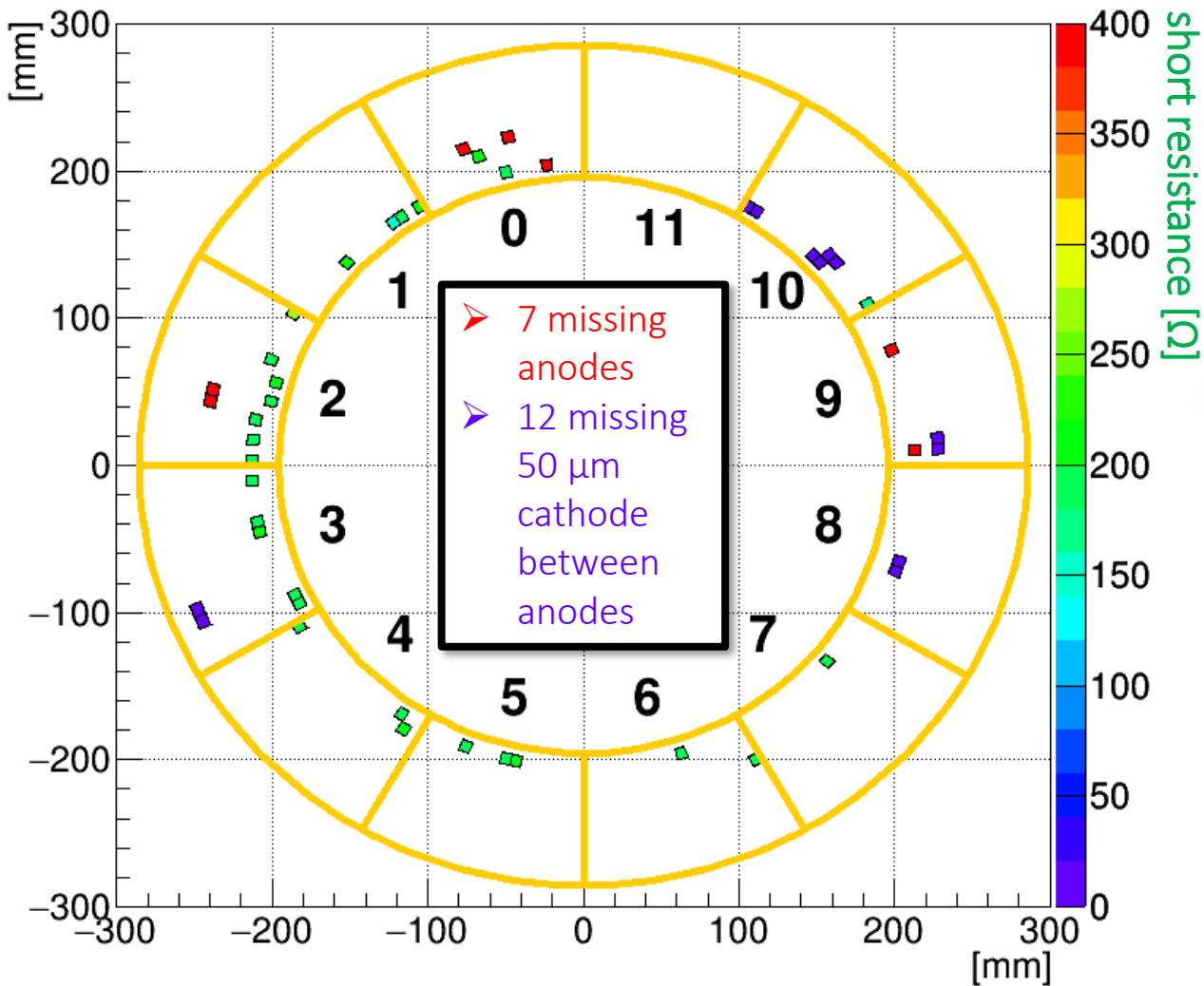
- 5 WDB crates per side (12+1 WDBs with T input per side to monitor the temperature of the FE holders)
- LV modules installed and successfully tested
- HV crate installed in the final position and successfully tested

Thermal camera photos with FE ON

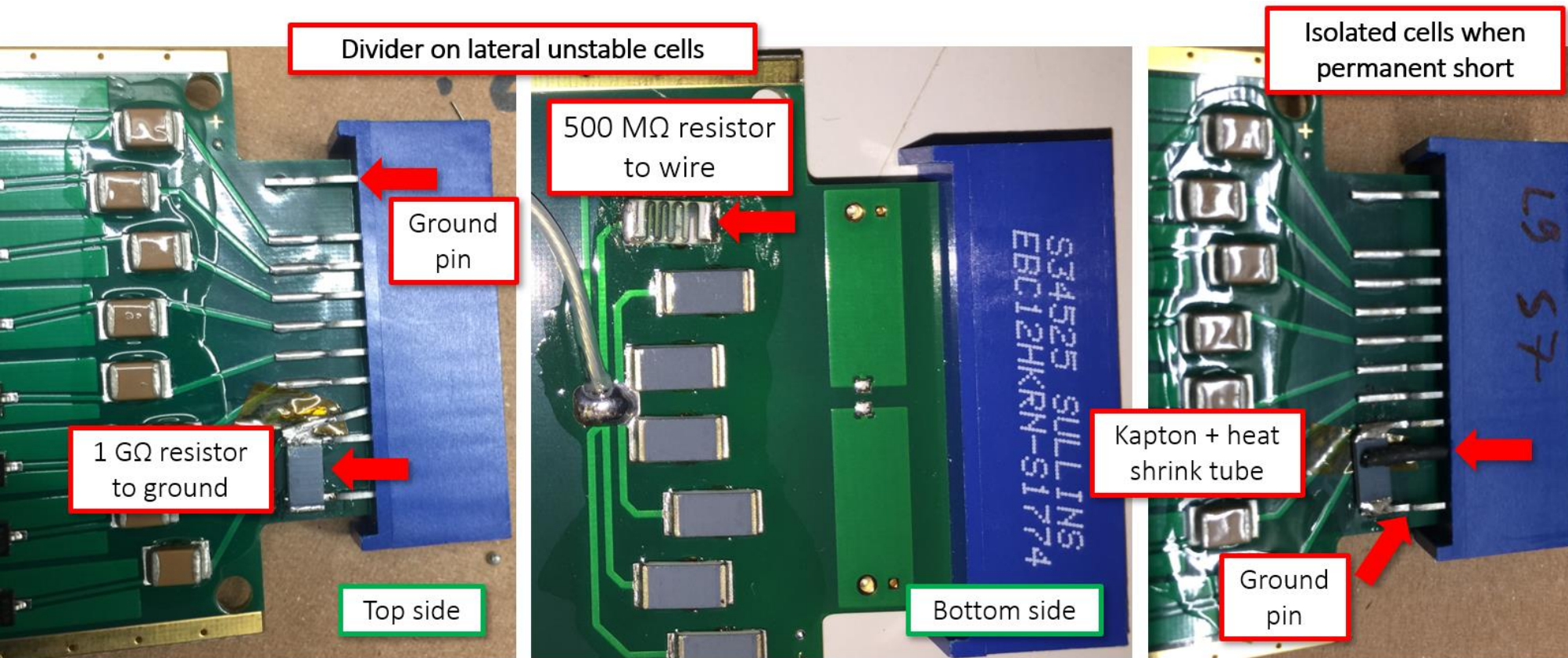


Current endplate map

Endplate map (US) 23/04/2021



FE boards re-working

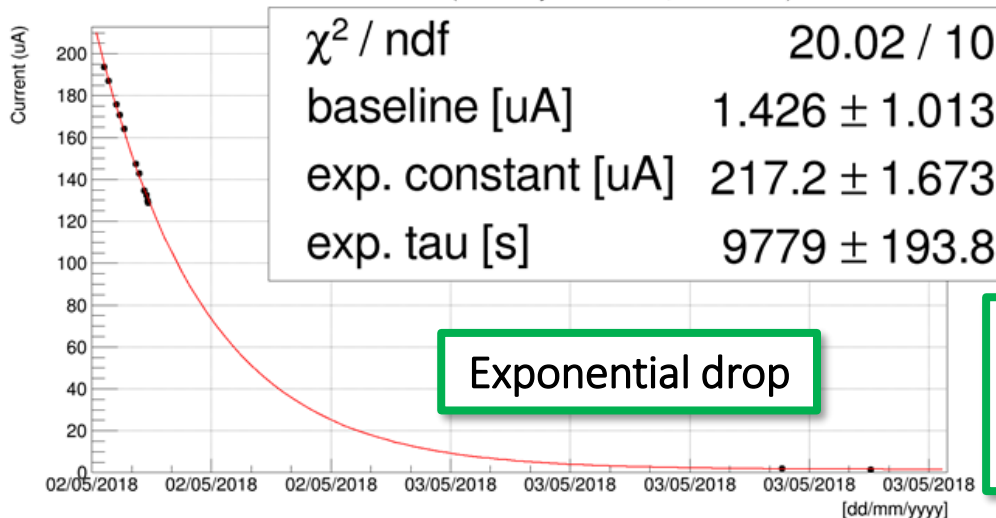


HV conditioning and gas monitoring

Example of HV conditioning at the first power up (here at 700 V)

- Residual currents drawn by the HV channels to correctly polarize the dielectric materials of the endplates

Residual Current for Channel 0 (inner 4 layers: 8 boards, 64 channels) Sector 1

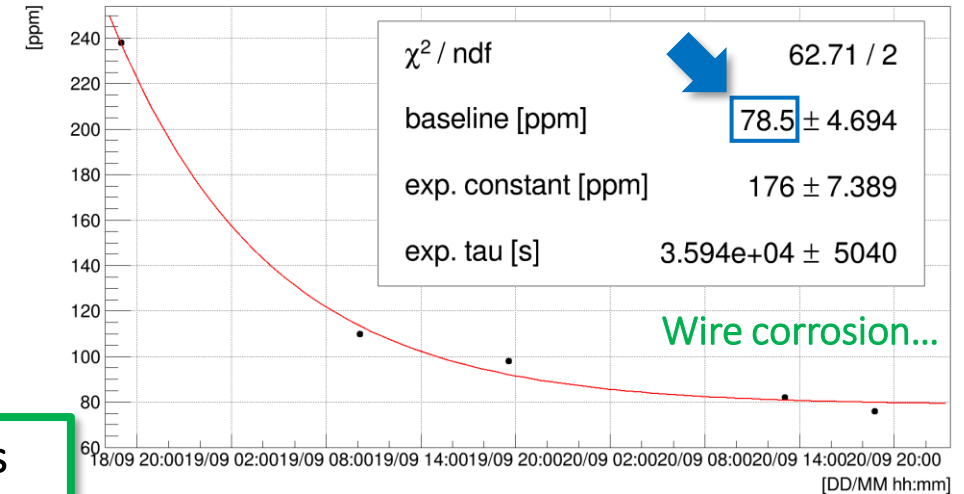


Exponential drop

Residual current of about 10 nA/cell after about 3 hours

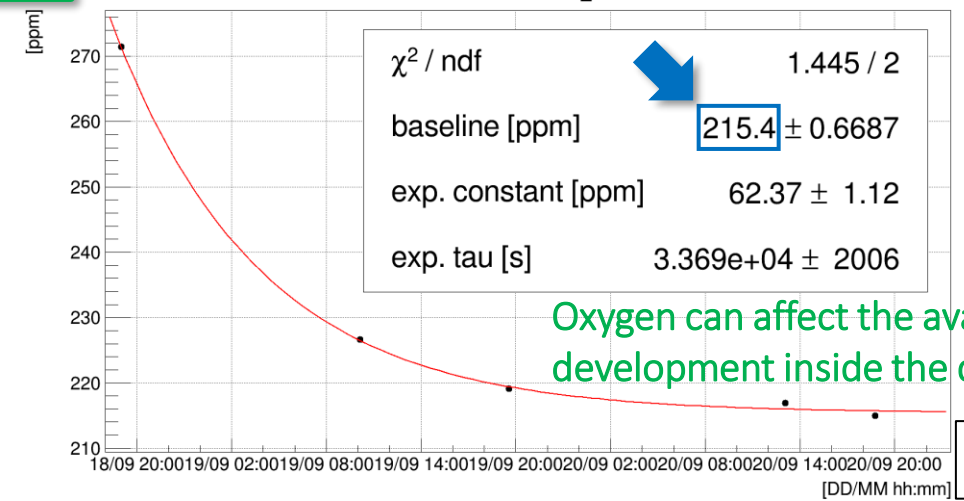
$\tau \approx 9$ hours after starting the gas flux

Outlet gas analyzer: H₂O contamination



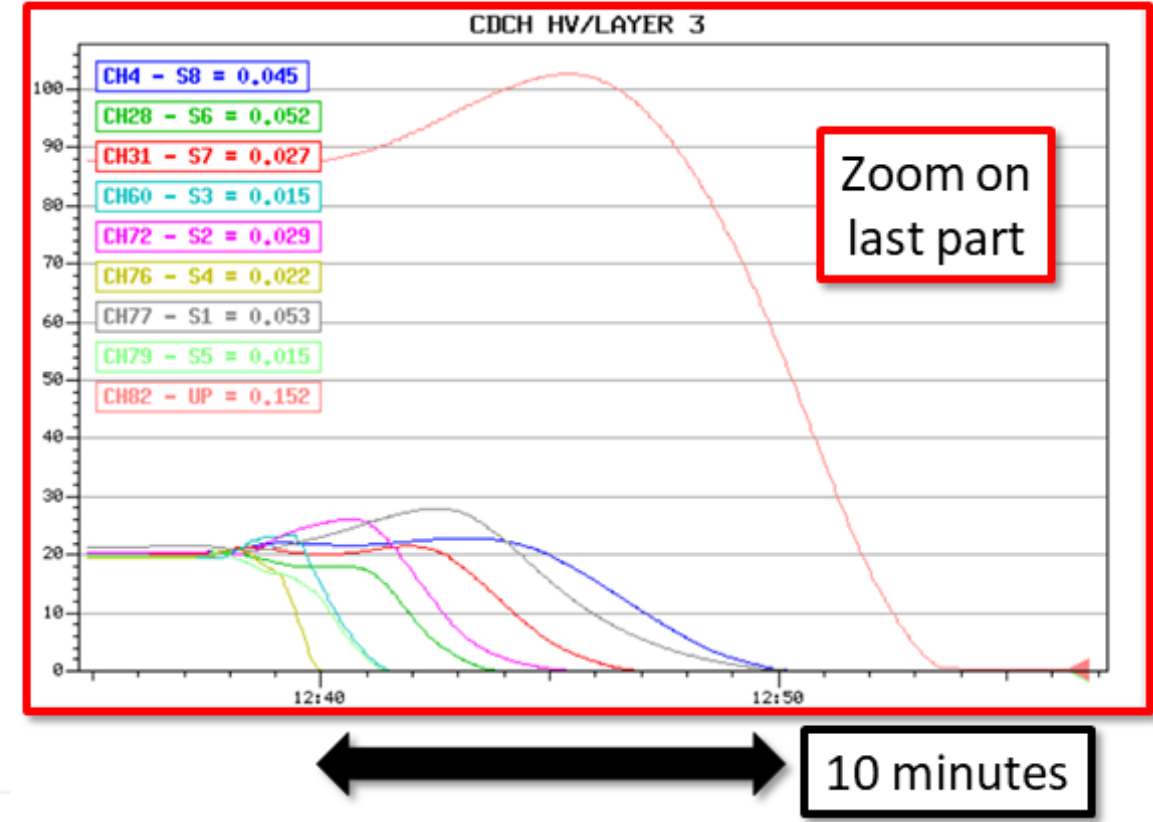
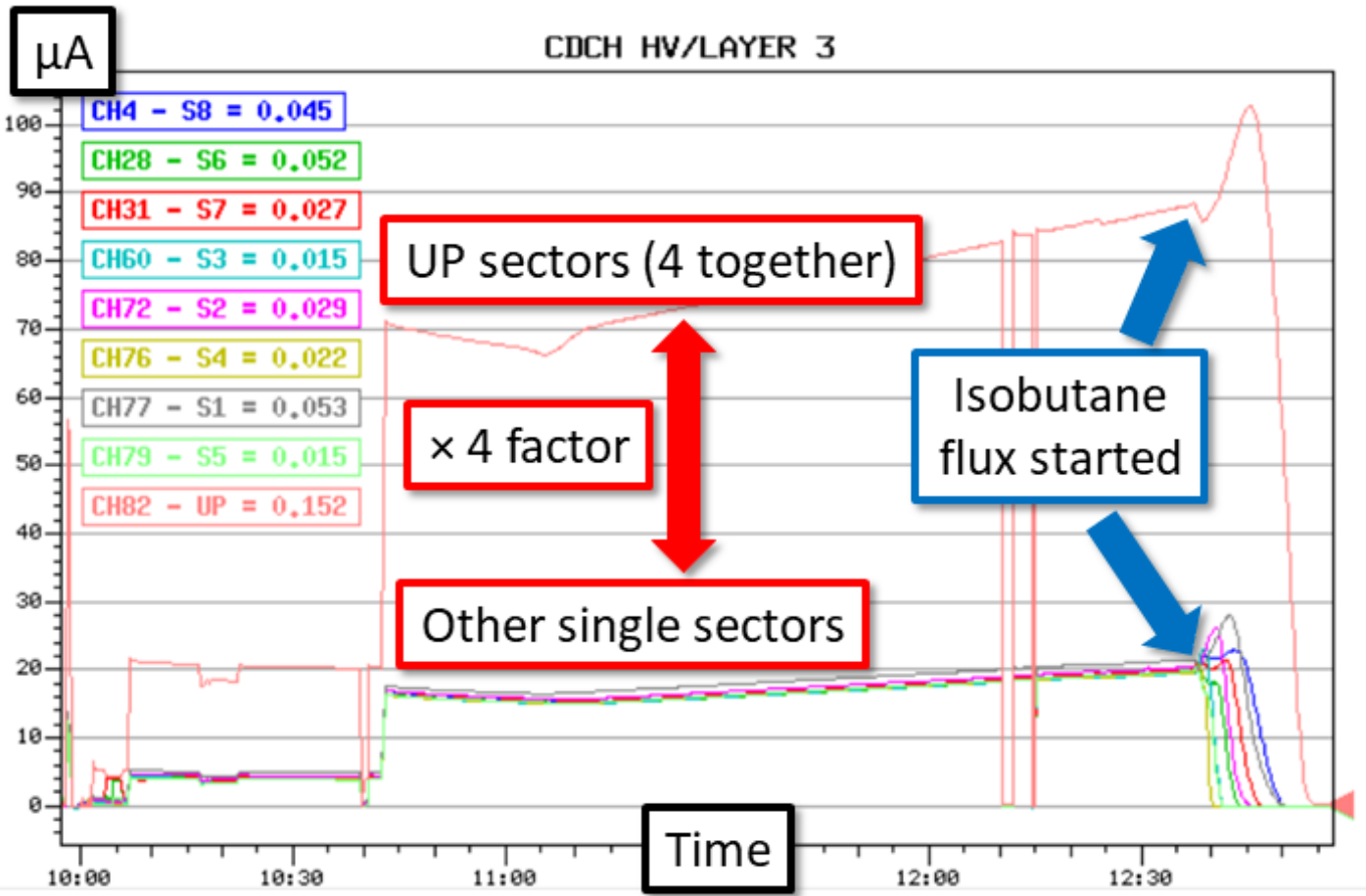
Wire corrosion...

Outlet gas analyzer: O₂ contamination



Oxygen can affect the avalanche development inside the drift cell

Isobutane addition above 500 V



CRC bars

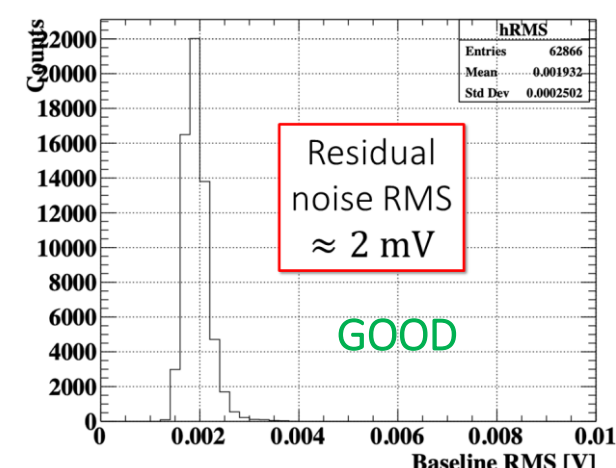
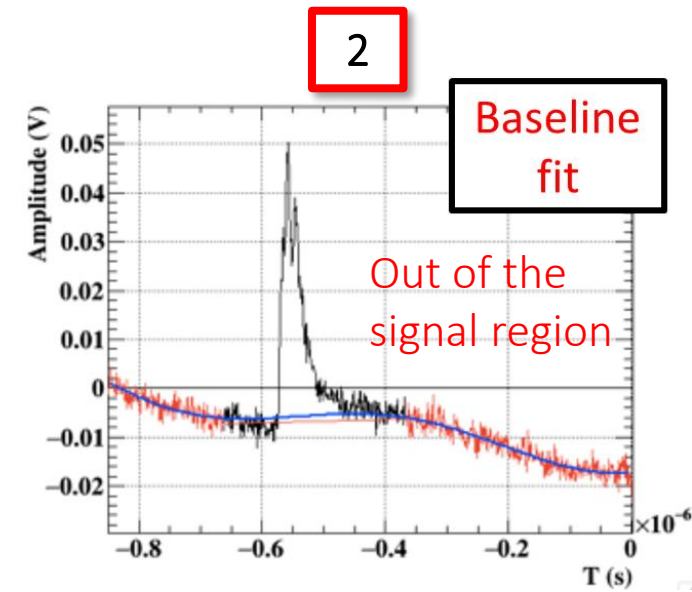
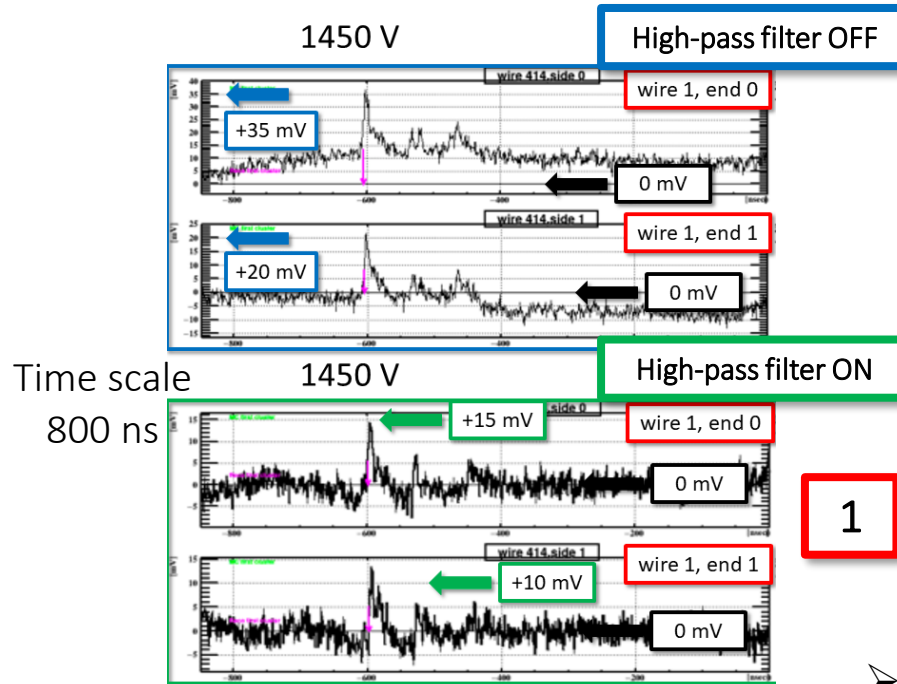
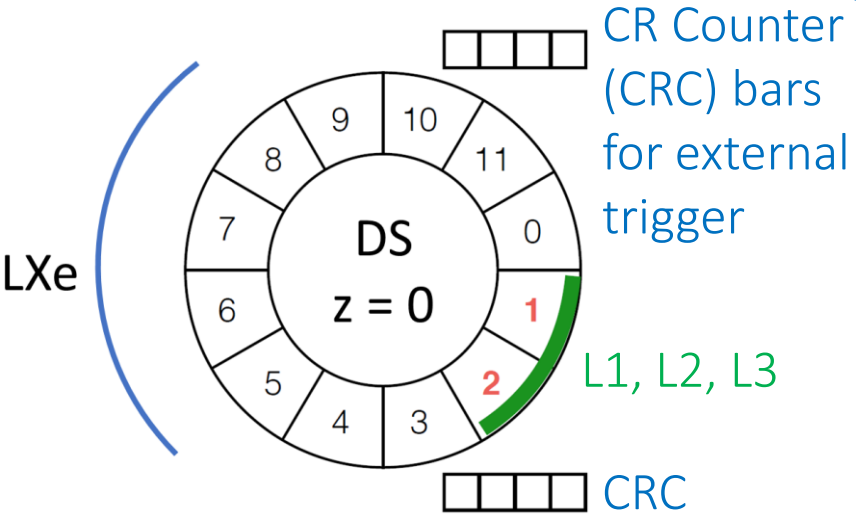


Above
COBRA



Below
COBRA

Read out configuration and noise

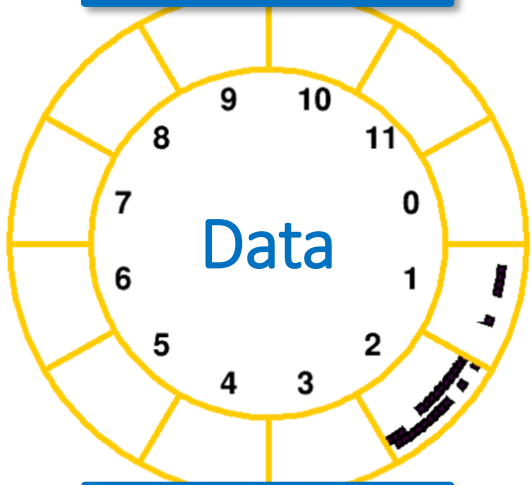


- Only 192 DAQ channels available for 2018 and 2019 runs
- HV scan performed with
 - Cosmic Rays (CR) for gain calibration purposes in a clean environment
 - Michel e^+ with μ^+ beam at different intensities (pTC trigger)

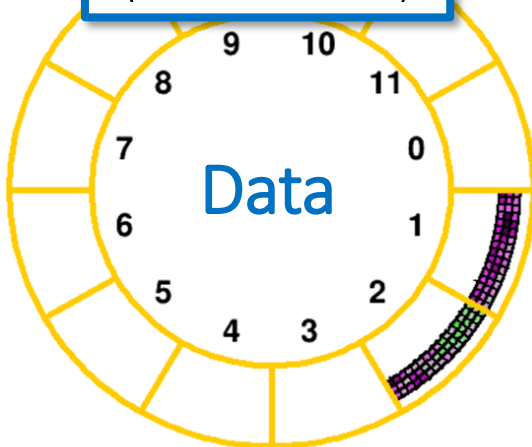
- Typical signal waveforms (WF)
- Low frequency (\sim MHz) noise
- Origin found
- No baseline oscillation with the final version of the DAQ boards
- Temporary solution
 1. High-pass filter
 2. Baseline subtraction

CR (3 layers)

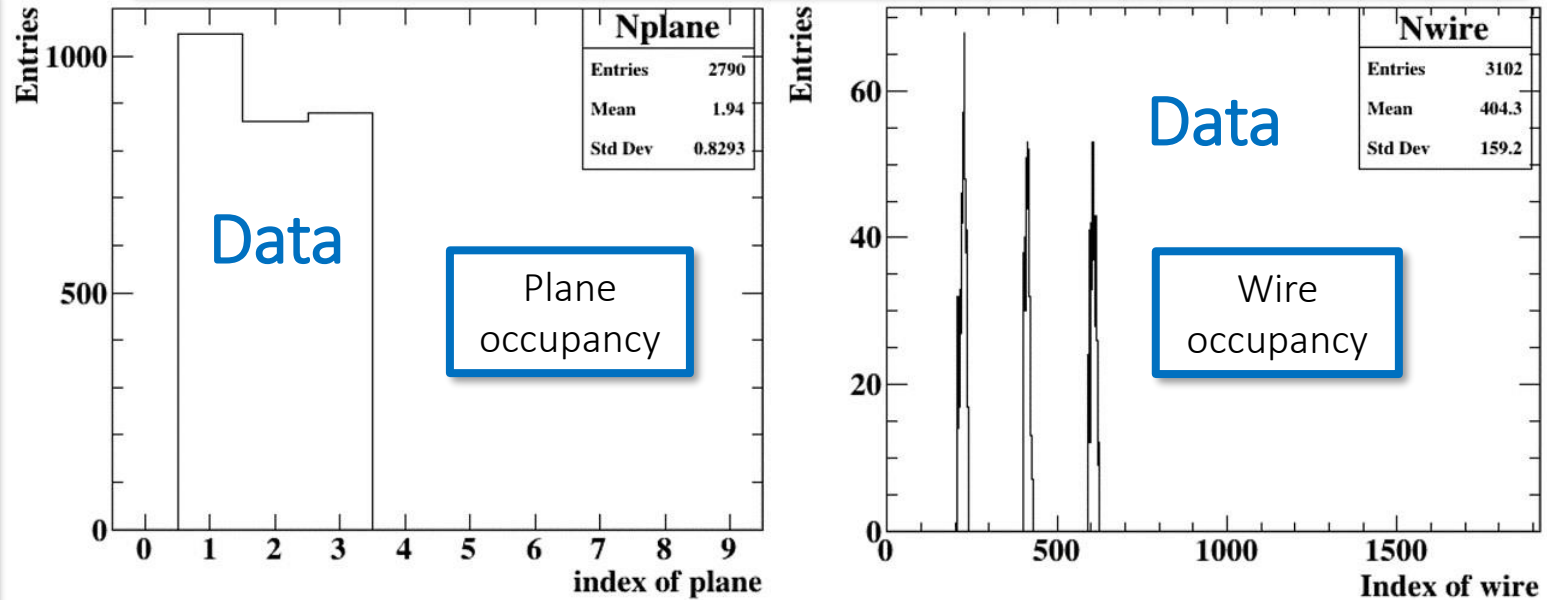
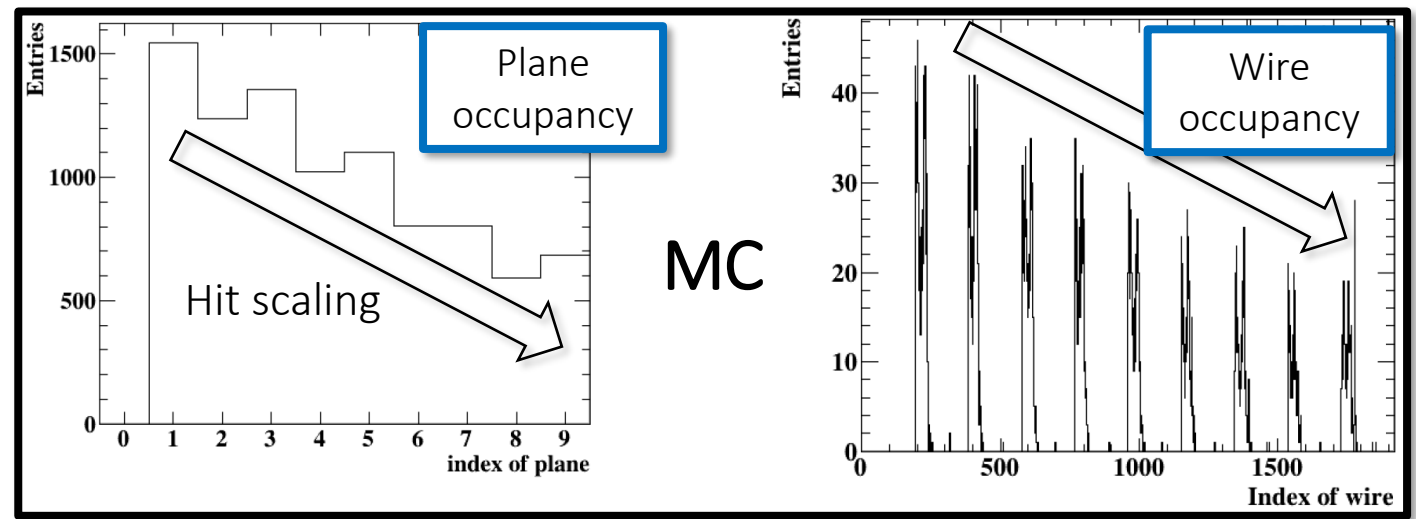
Event display



Occupancy (1000 events)



- L1, L2, L3 at 1500 V
- One drift cell has a hit if the WF exceeds a predefined threshold
- Typically $\times 5$ the RMS of the noise baseline

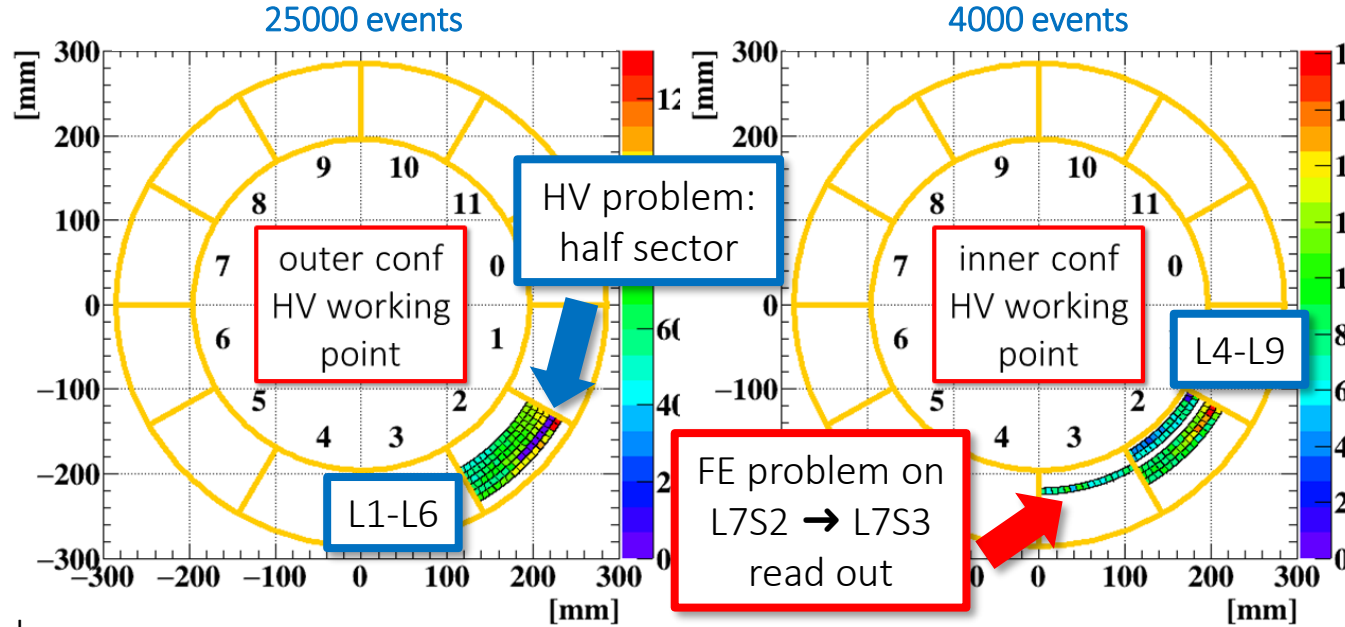
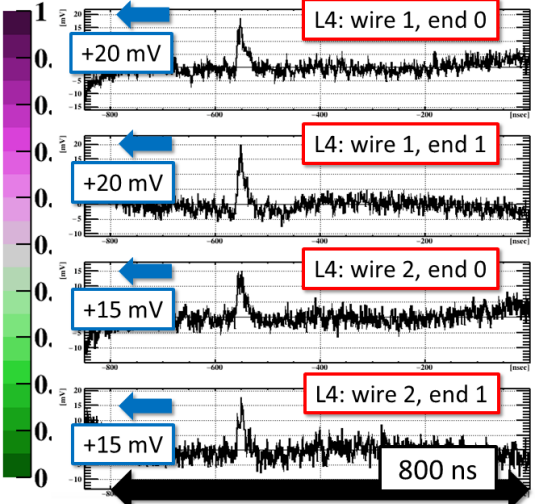
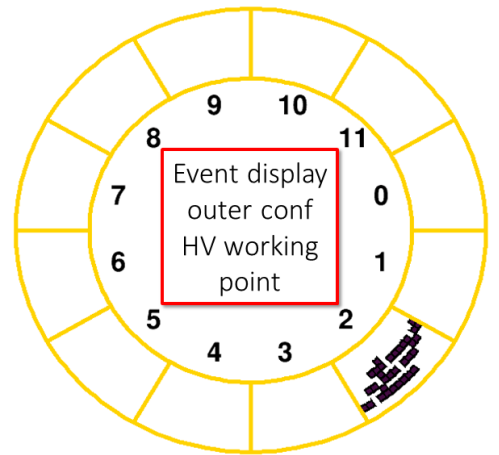
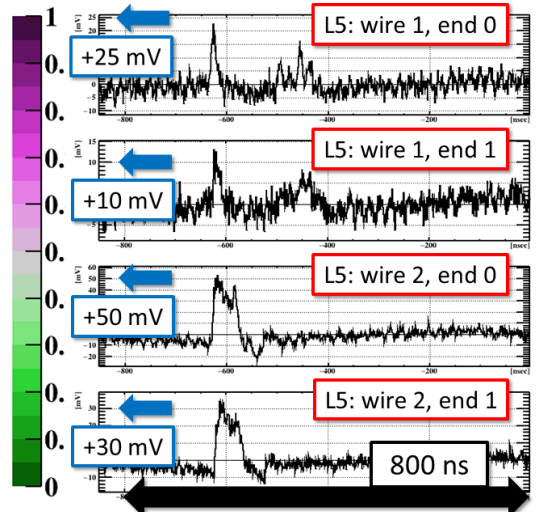
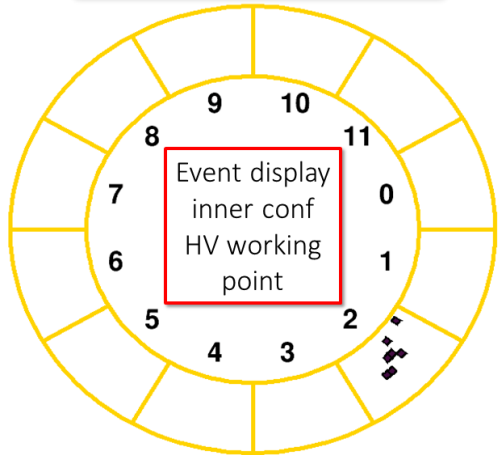


- Example of online event display for a single CR event and occupancy plots
- Agreement with Monte Carlo (MC) simulation

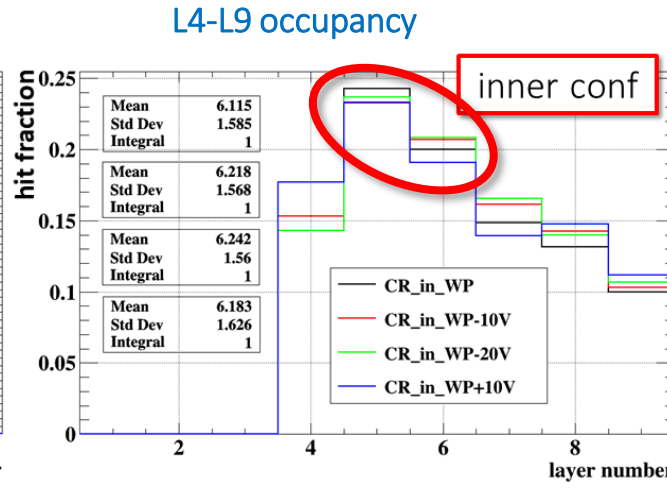
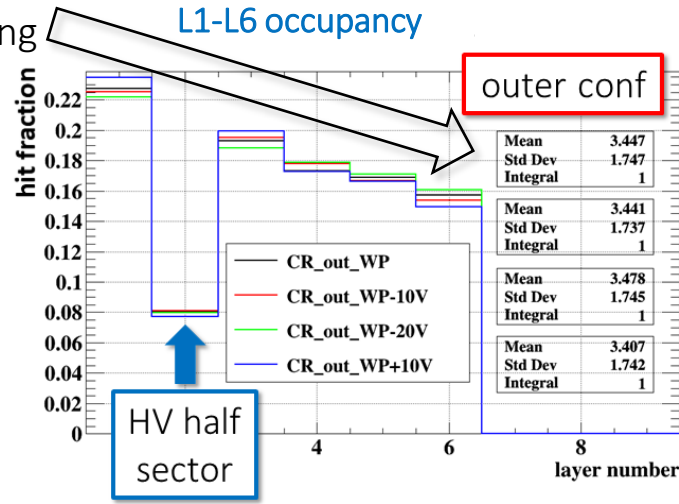
CR (6 layers)

- HV configurations
1. Working Point
 2. WP - 10 V
 3. WP - 20 V
 4. WP + 10 V

Event display

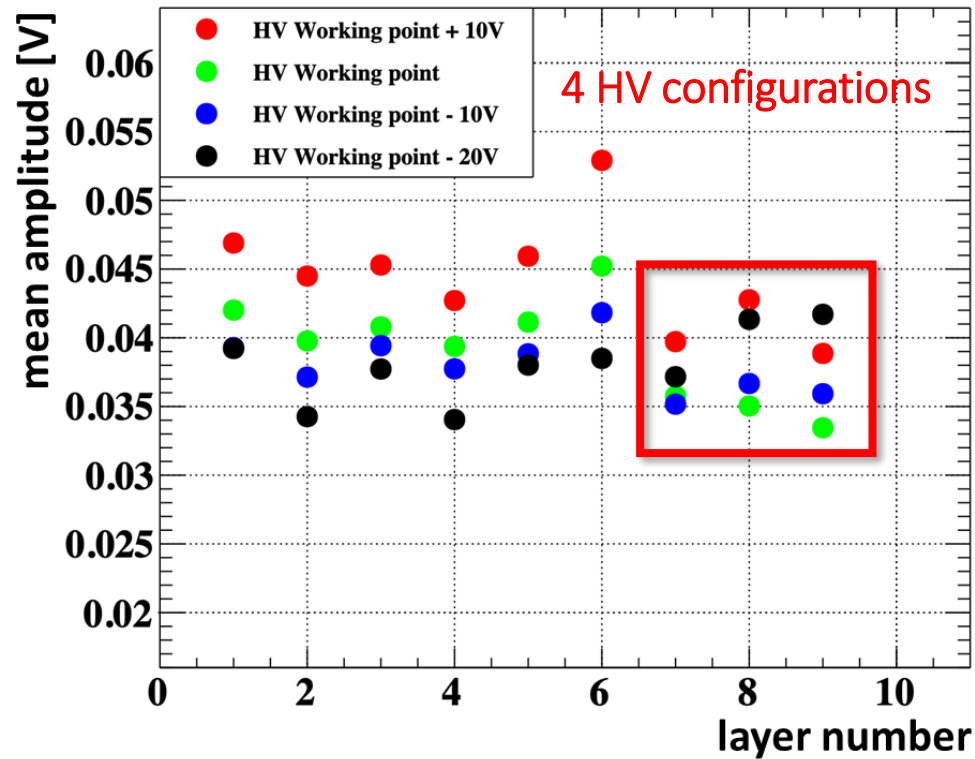


Expected hit scaling

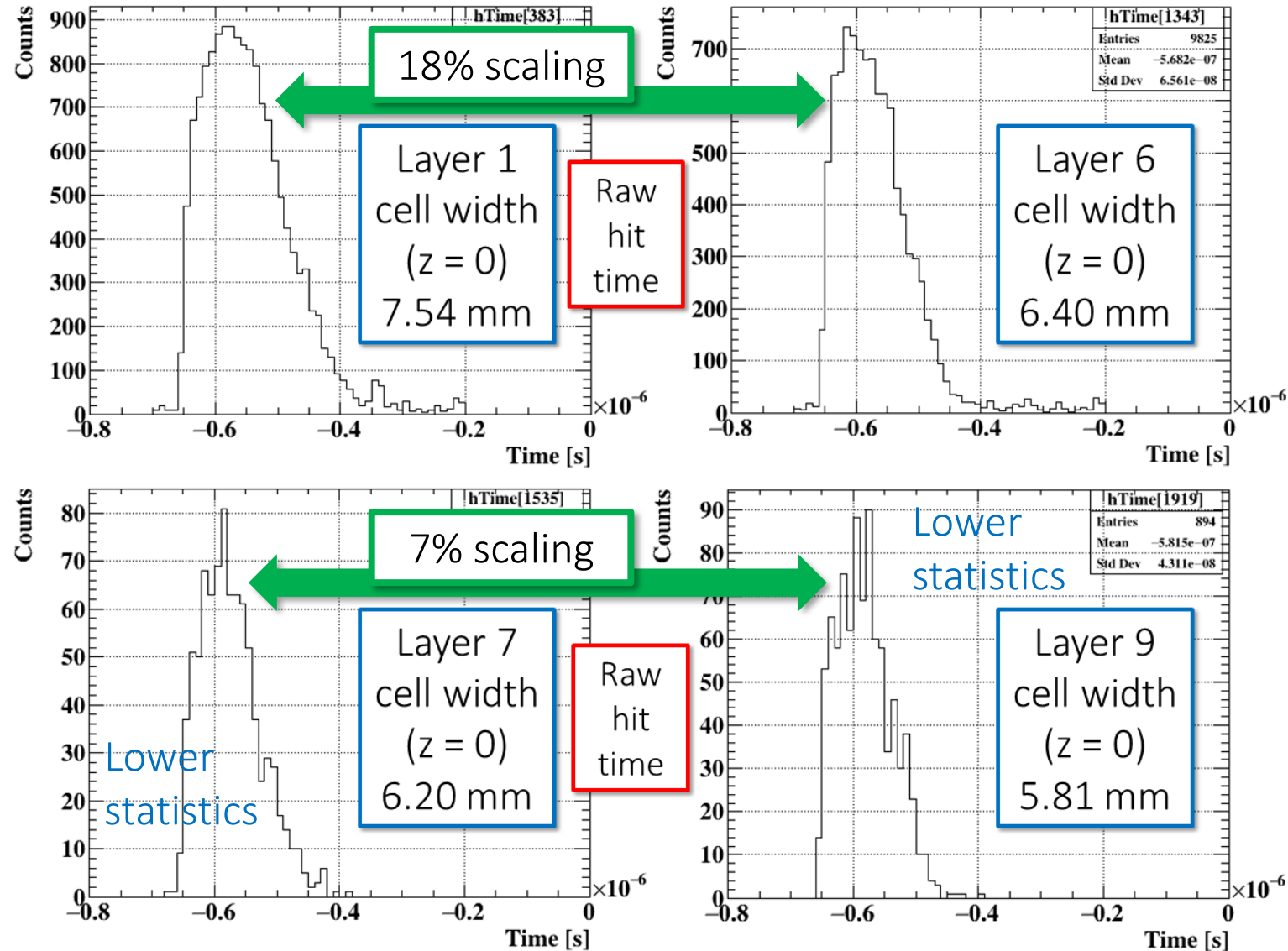


- Outer configuration: expected hit scaling from outer to inner layers
- Inner configuration: L5 and L6 result more efficient than L4
 - HV tuning needed to compensate for inefficiencies

CR (9 layers)

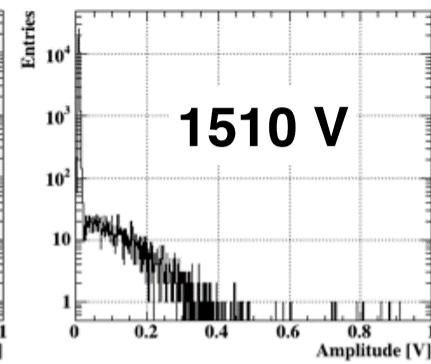
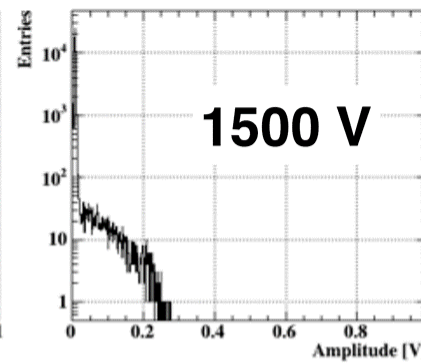
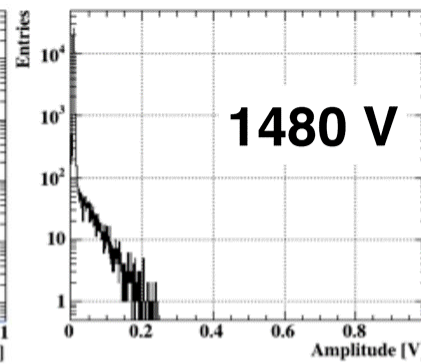
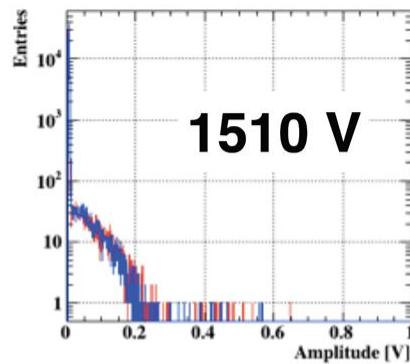
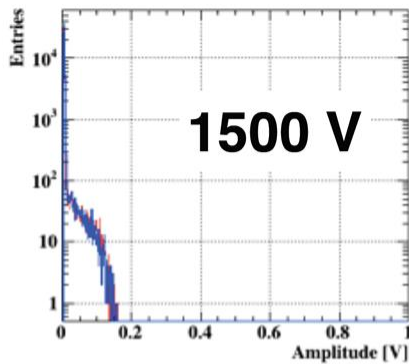
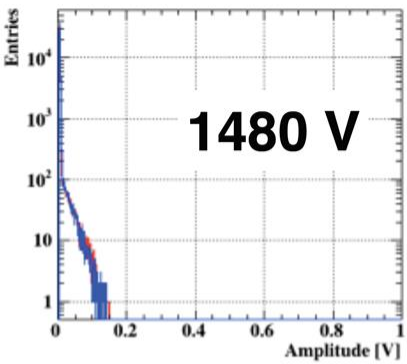


- First comparison among signals belonging to every layer
- HV tuning needed to equalize the gain
 - Especially for the 3 inner layers where the WP seems worse than other HV configurations

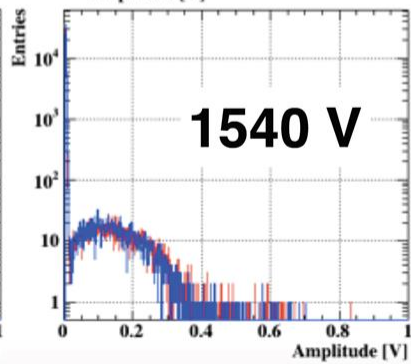
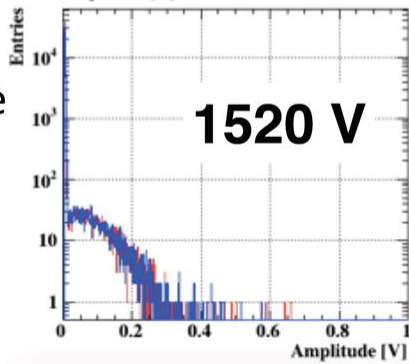


The width of the time distributions is directly correlated with the cell dimensions

Amplitude distributions vs. HV

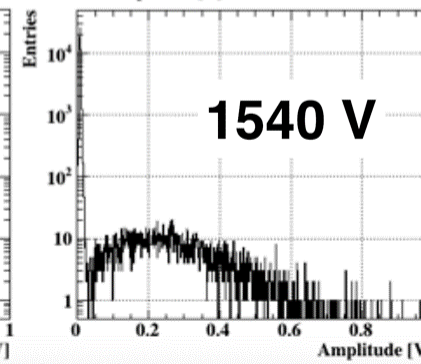
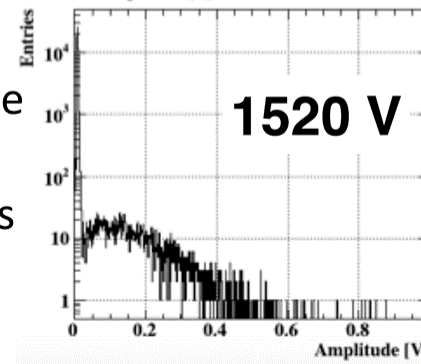


Amplitude with high-pass filter



US
DS

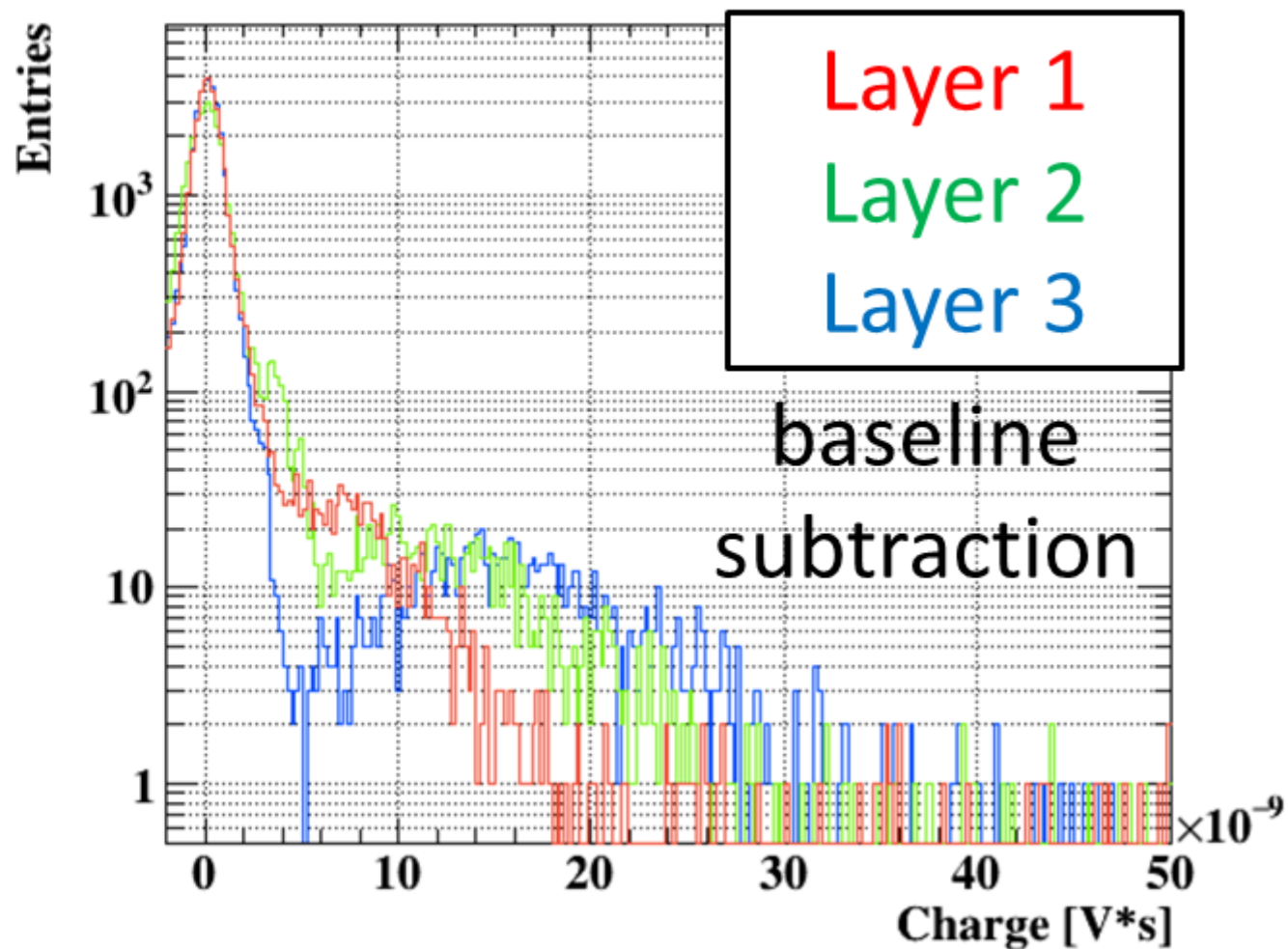
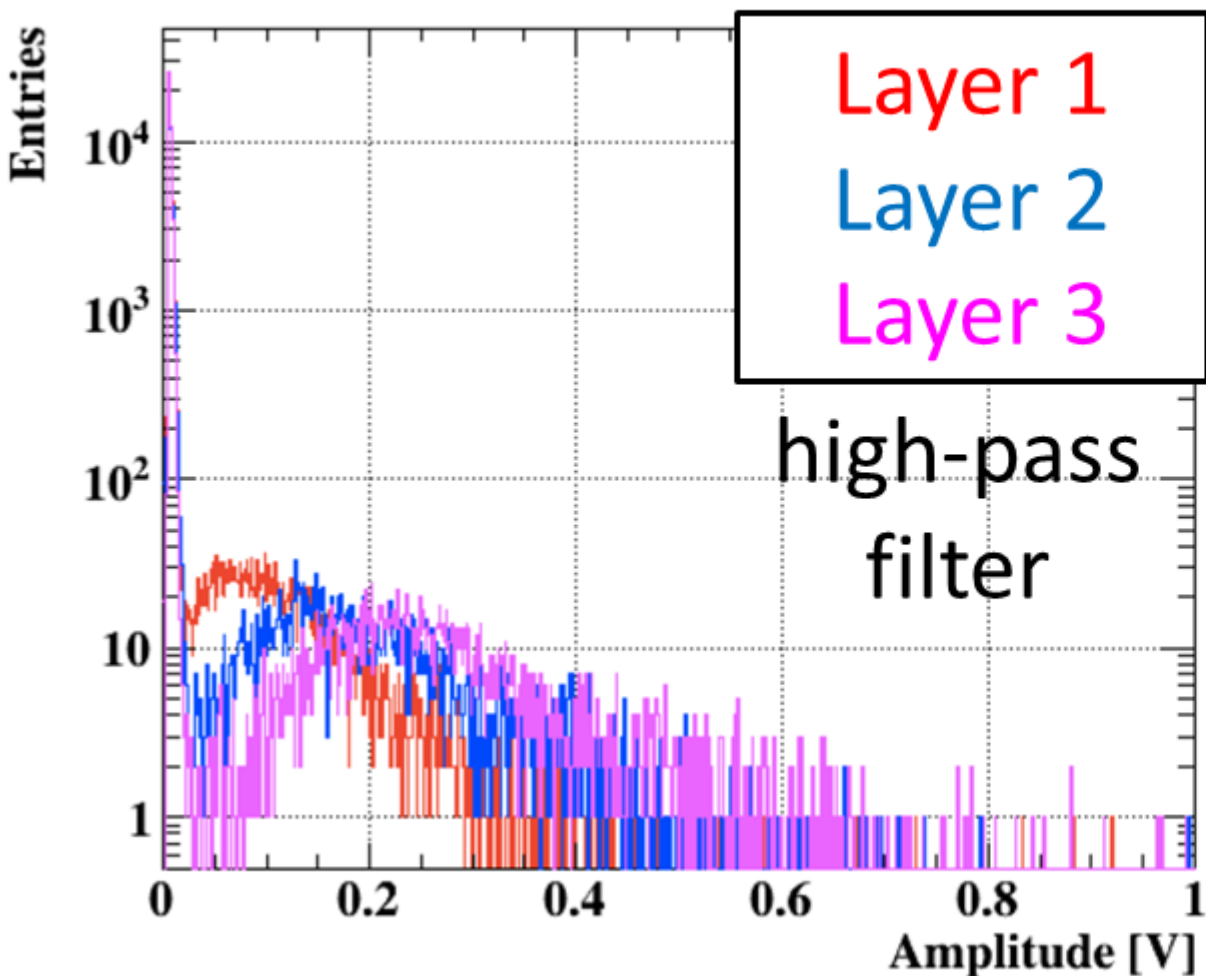
Amplitude with high-pass filter



US
+
DS

Amplitude and charge vs. layers

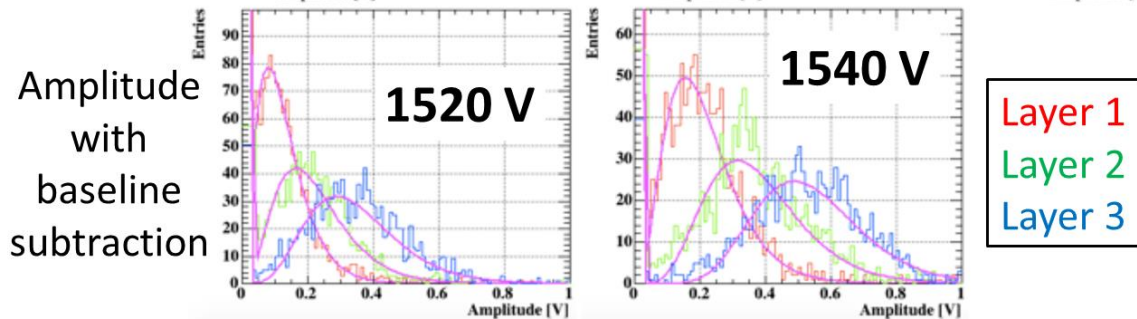
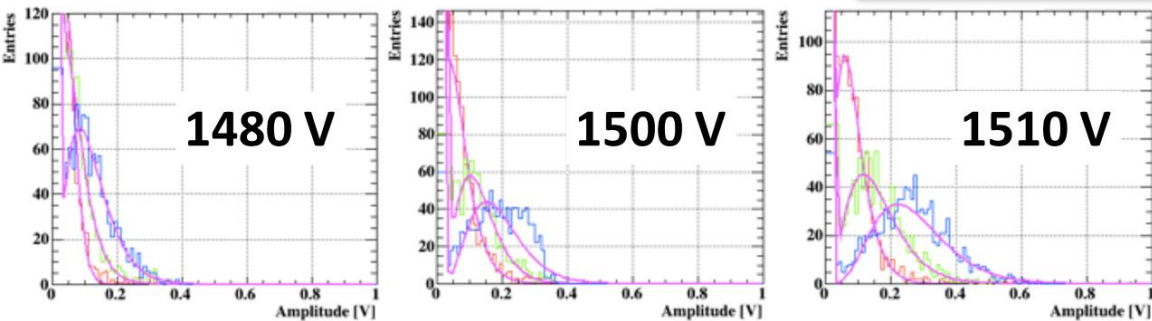
US + DS 1540 V



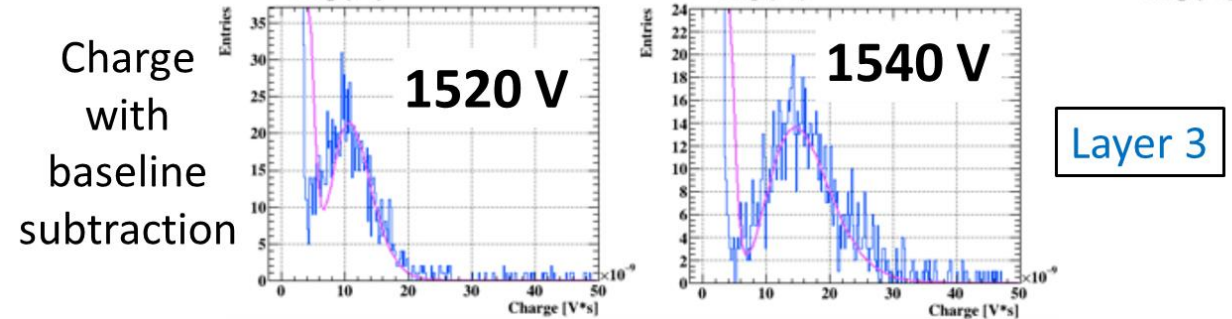
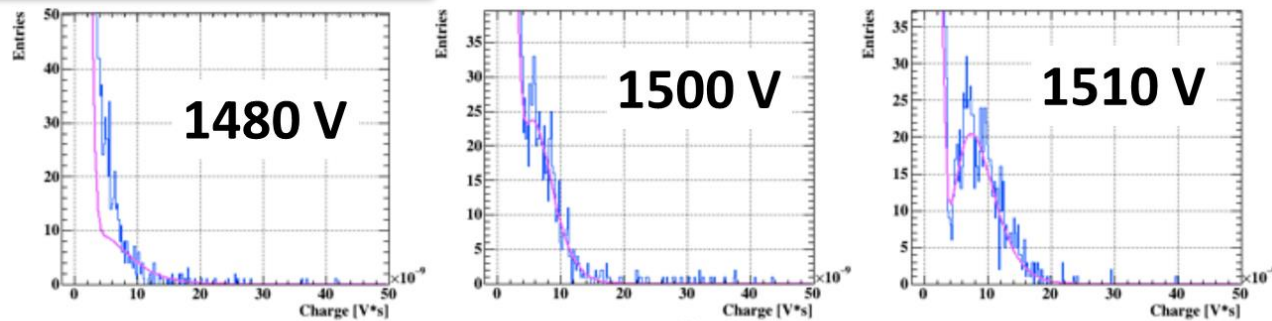
HV scan with CR

- Distributions of the **signal amplitude and charge** (signal integral) **as a function of the HV applied**
- Fit with a **gaussian pedestal + Pólya distribution for signal** (typical shape from the avalanche statistics)
 - The mean amplitude and thus the separation from pedestal increase as the HV is set to higher values
 - Same for the mean charge
 - The mean amplitude (at fixed HV) is higher for L3 than L1 given the higher gain for inner layers (smaller cells)
- These plots will be used to extract the first gain estimate

Same HV values applied to L1, L2, L3



Amplitude with baseline subtraction

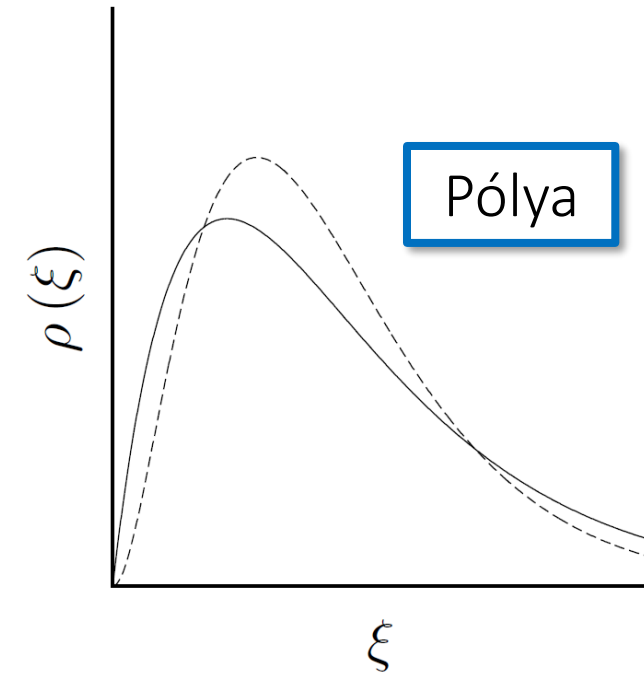
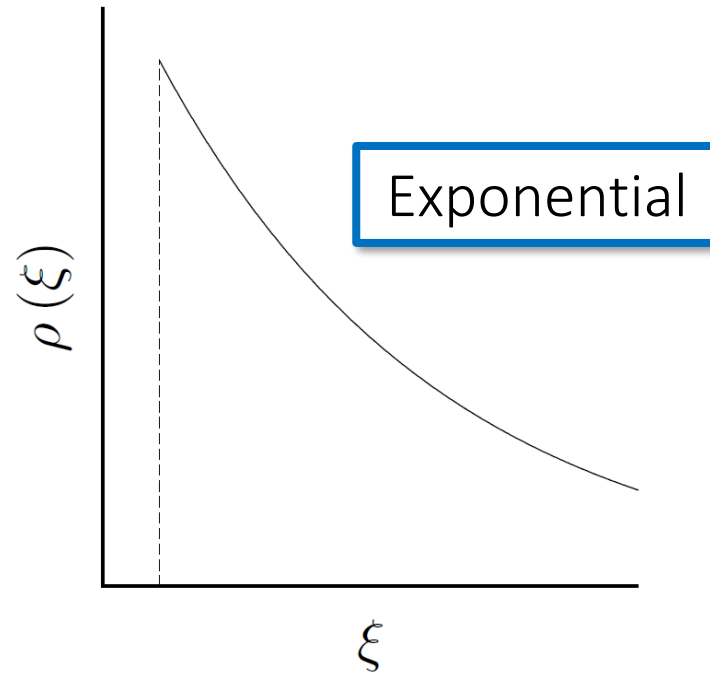


Charge with baseline subtraction

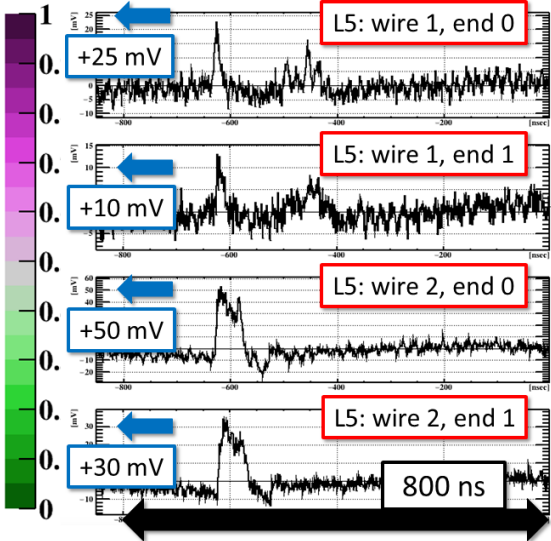
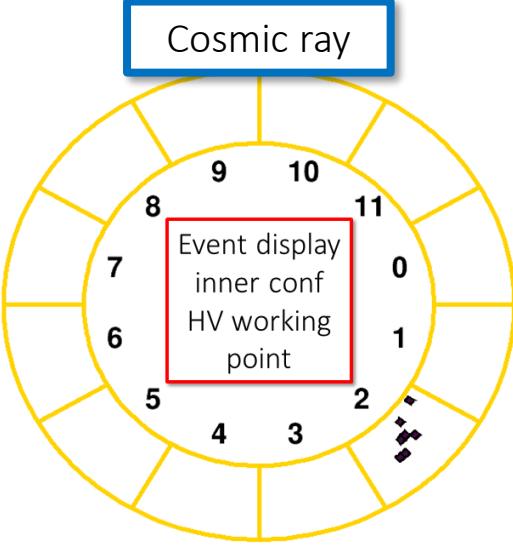
Pólya distribution

$$\bar{n}P_n = \frac{(1 + \theta)^{(1+\theta)}}{\Gamma(1 + \theta)} \left(\frac{n}{\bar{n}}\right)^\theta e^{-(1+\theta)n/\bar{n}}$$

- The Pólya distribution is a model for the shape of avalanche size at high gain
- θ is the so-called Pólya parameter
 - It changes the shape of the curve

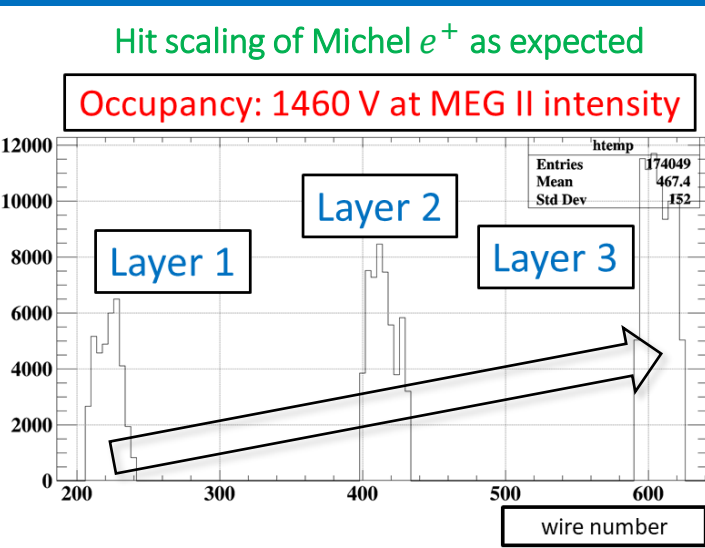
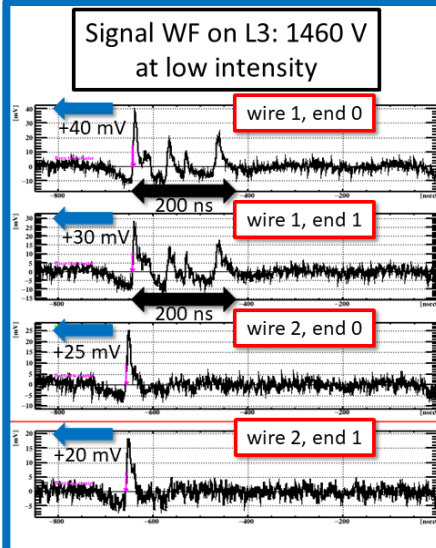
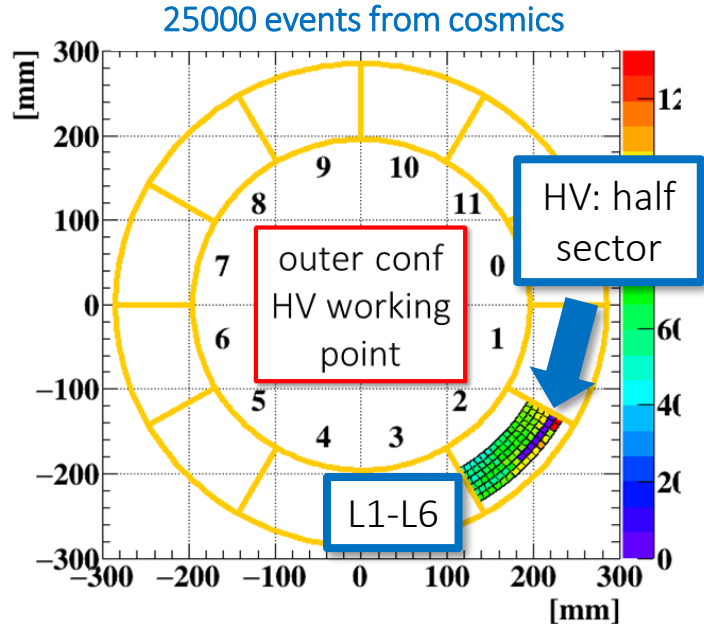


First collected data

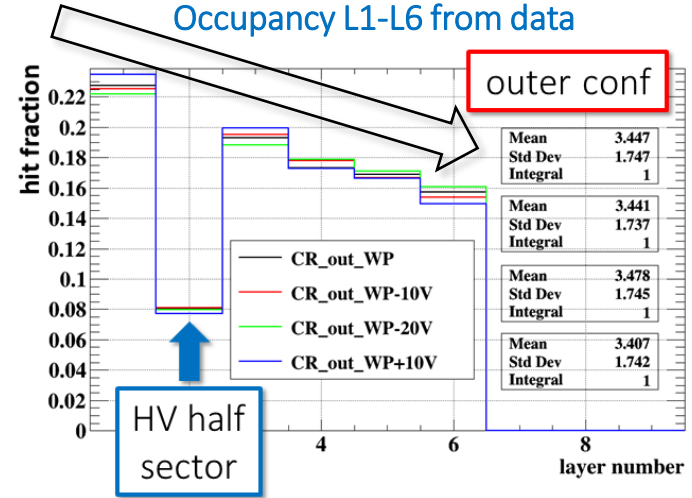


Only a limited number of DAQ channels is available

- 192 in 2018 and 2019
 - 6 layers in one sector
 - Inner configuration (L4-L9)
 - Outer configuration (L1-L6)
- 256 in 2020
 - Data taking ongoing
- Expected full read out in 2021



μ^+ beam



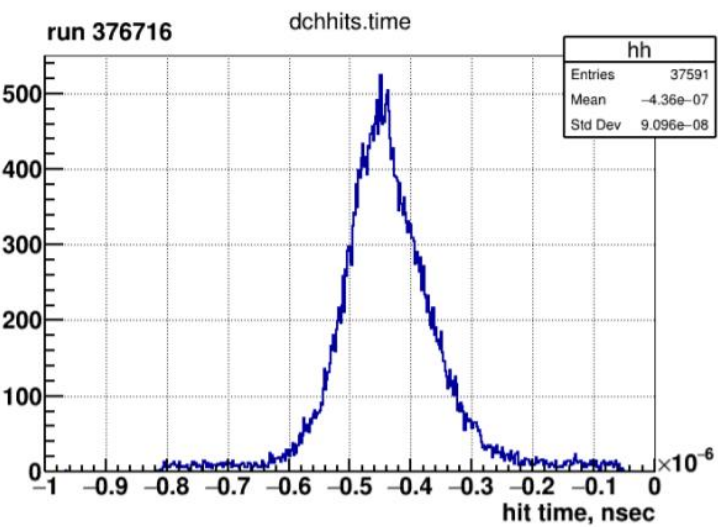
- Hit scaling as expected from the outer layer (L1) to the inner layer (L9)
- Different HV configurations tested around the working point

Data collection without μ^+ beam and B field

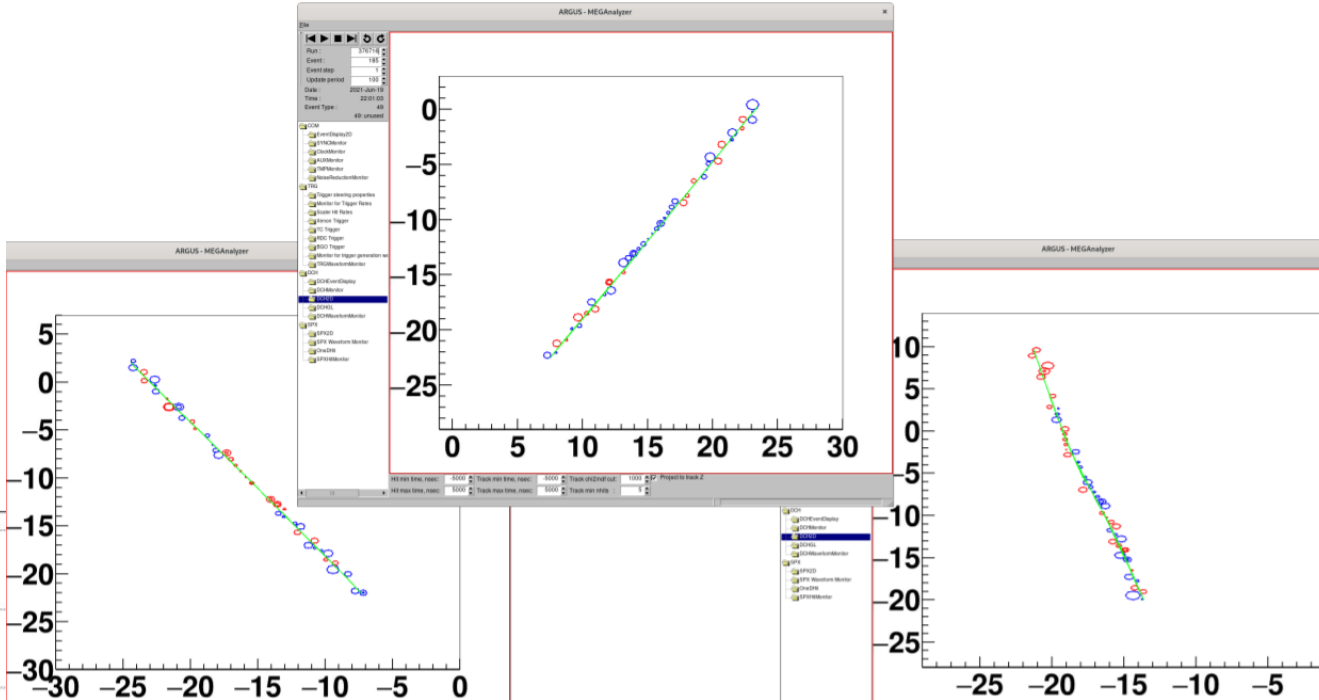
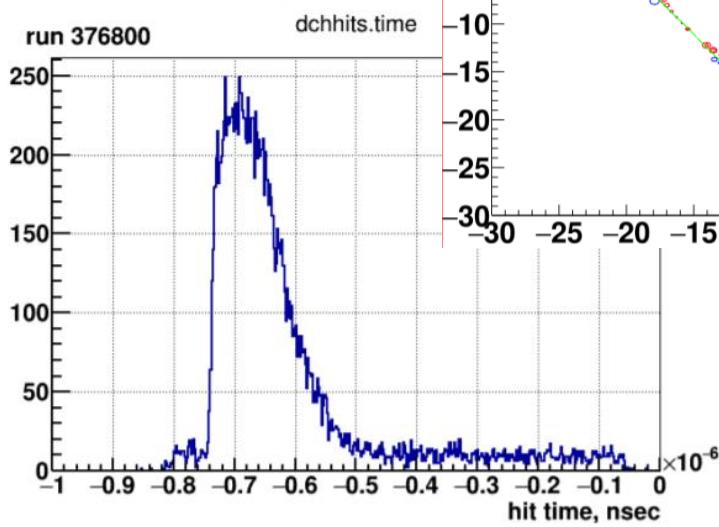
Self triggered events

- Cosmic muons
 - CRC trigger
 - CDCH self-trigger (2&2 or 2|2 multiplicity)
 - Thanks to the trigger group
- Plots by Fedor

Self triggered CDCH



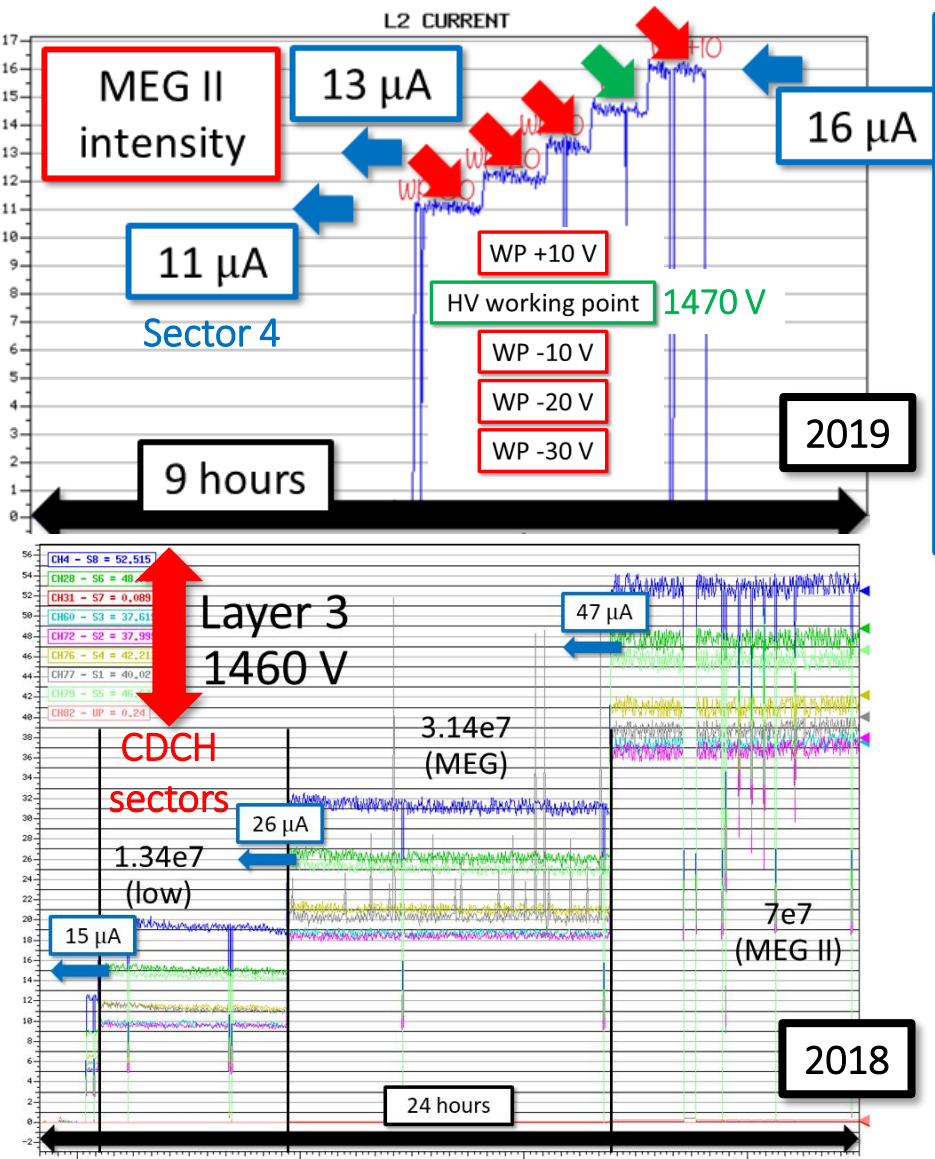
CRC runs



Self TRG: 1k events/3-4 minutes
 CRC : 1k events/23 minutes

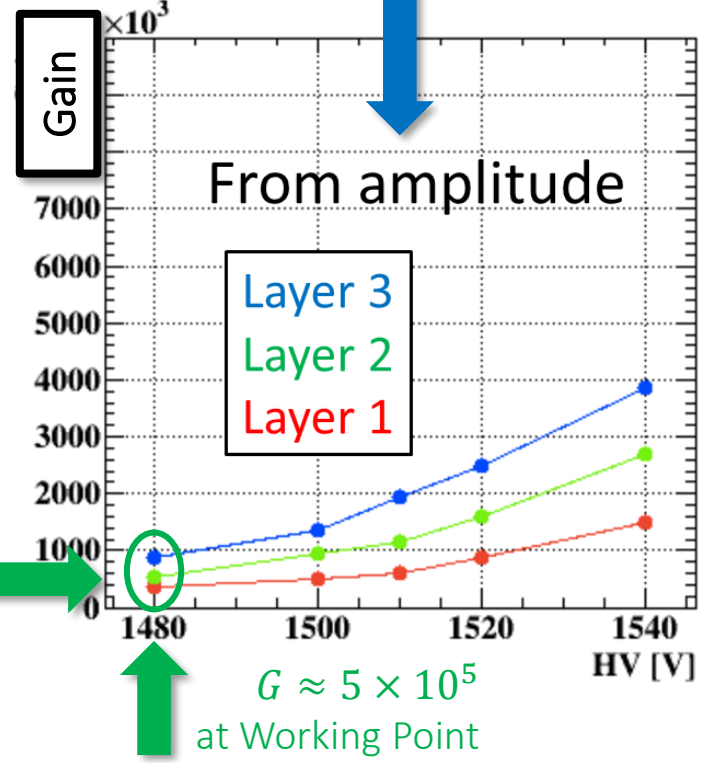
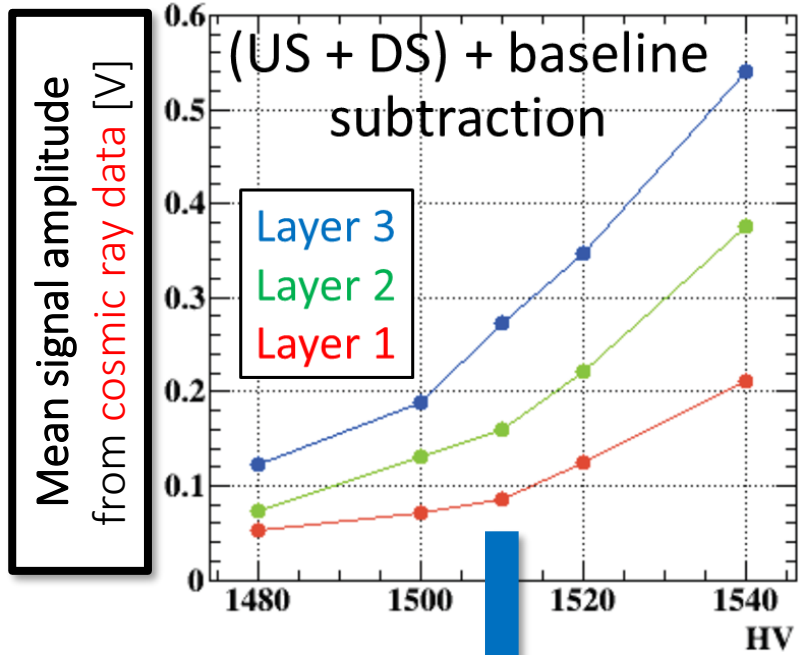
Self triggered runs: T0 can be roughly estimated as minimal hit time in event
 CRC runs: T0 can be taken very precisely from CRC counters

First gain studies



- Example of gain curves for L2 and L3
 - Currents drawn by the HV channels with μ^+ beam at different intensities
- ~ exponential behaviour in the current value with the HV increase as expected from simulations

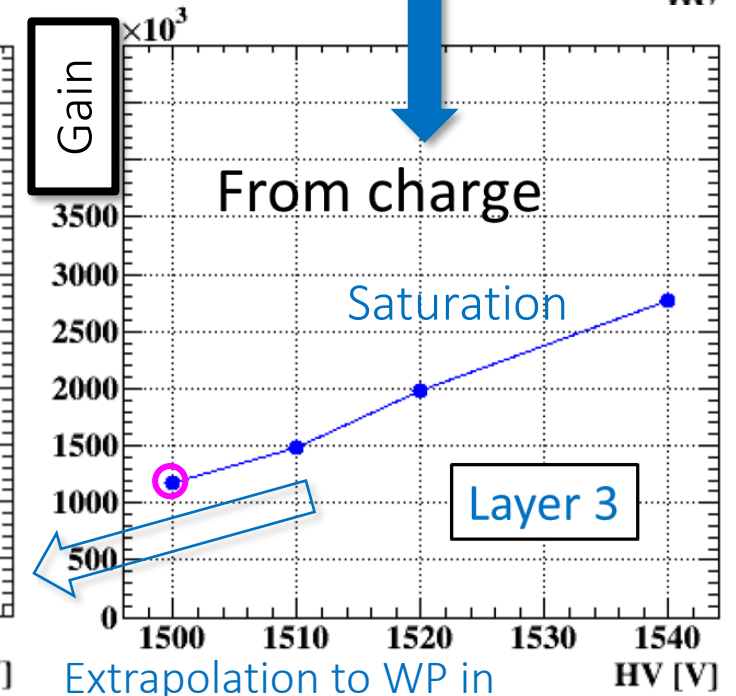
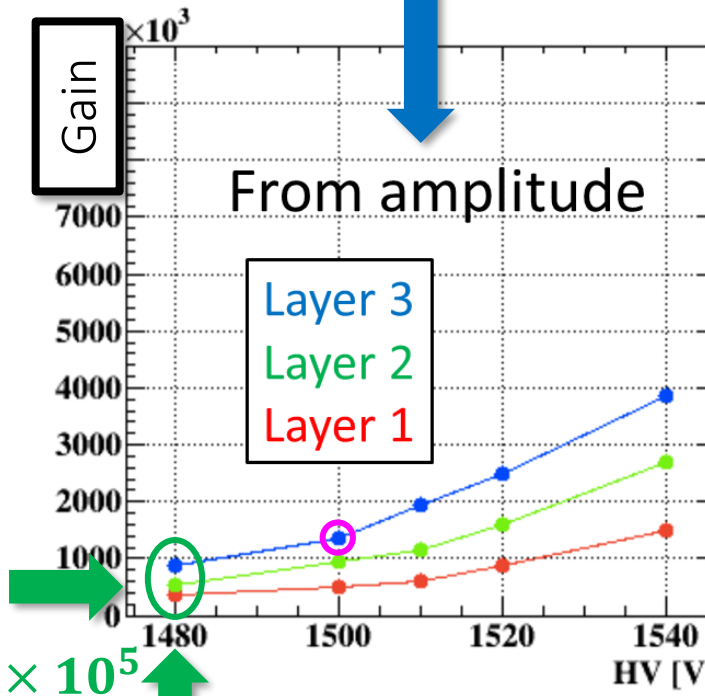
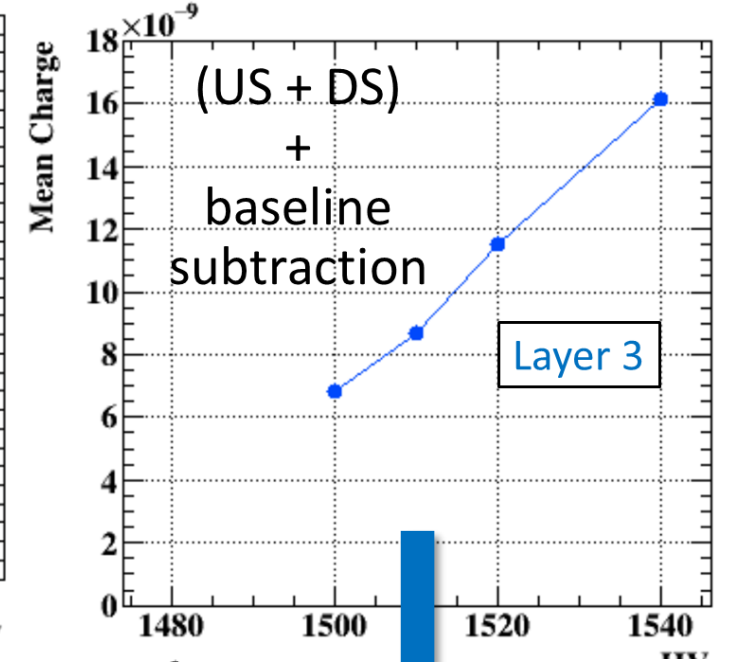
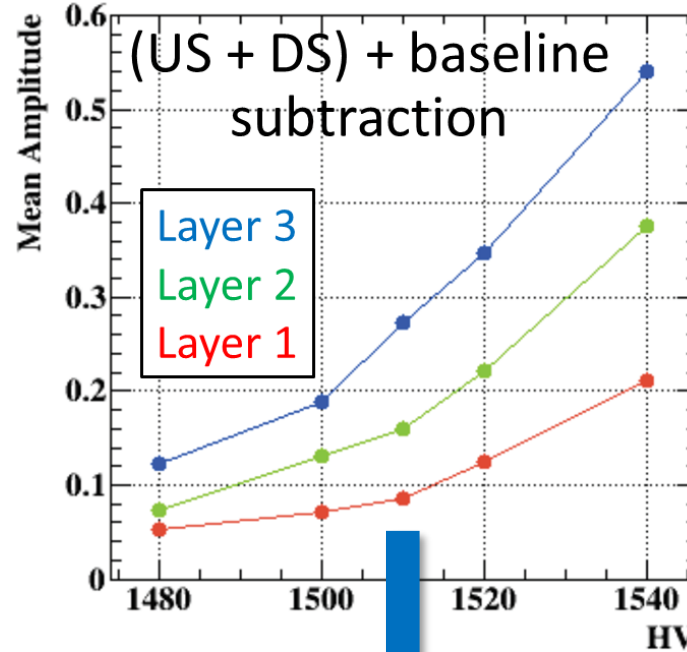
- The mean amplitude from cosmic ray data are converted into the effective gas gain G
- By means of simulations of the ionization clusters and the response of the FE amplification stage
 - Calibrated gain curves in agreement with simulations



Gain studies

The mean amplitude and charge from cosmic ray data are converted into the effective gas gain G

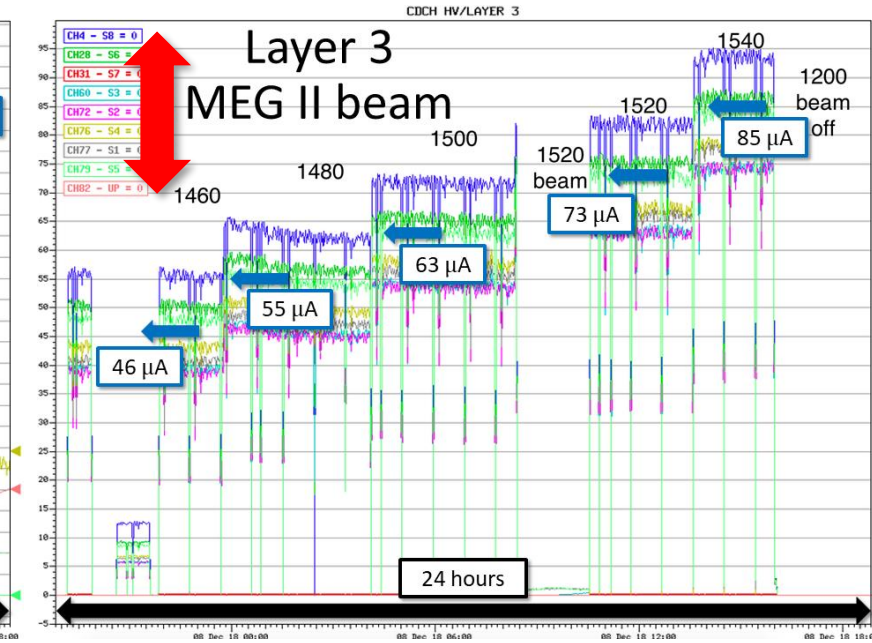
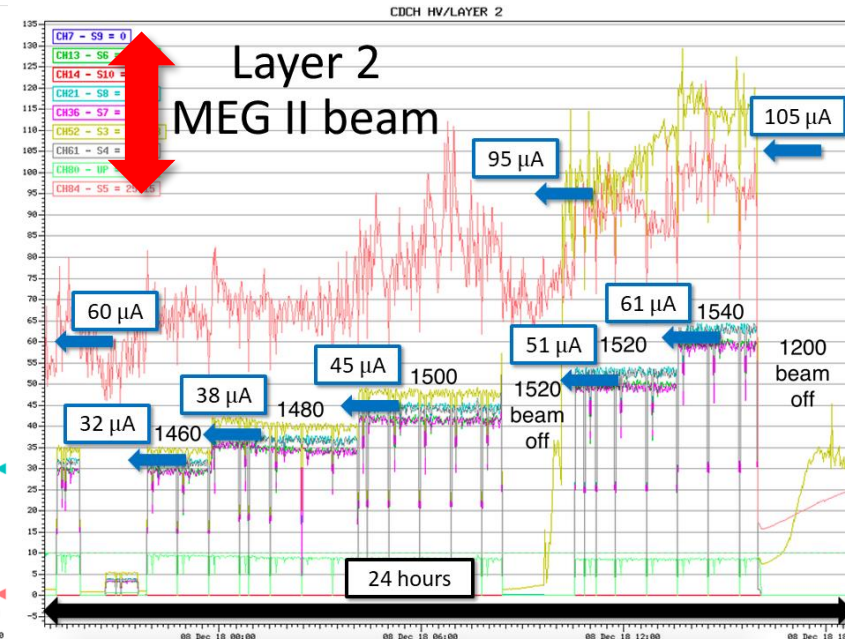
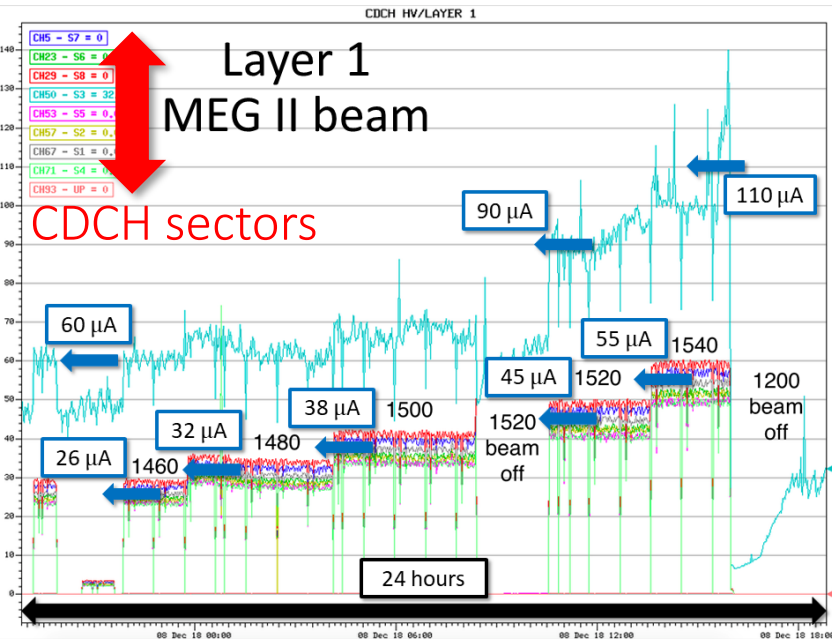
- By means of simulations of the ionization clusters and the response of the FE amplification stage
- Calibrated gain curves in agreement with simulations



$G \approx 5 \times 10^5$
at Working Point

Extrapolation to WP in agreement with simulations

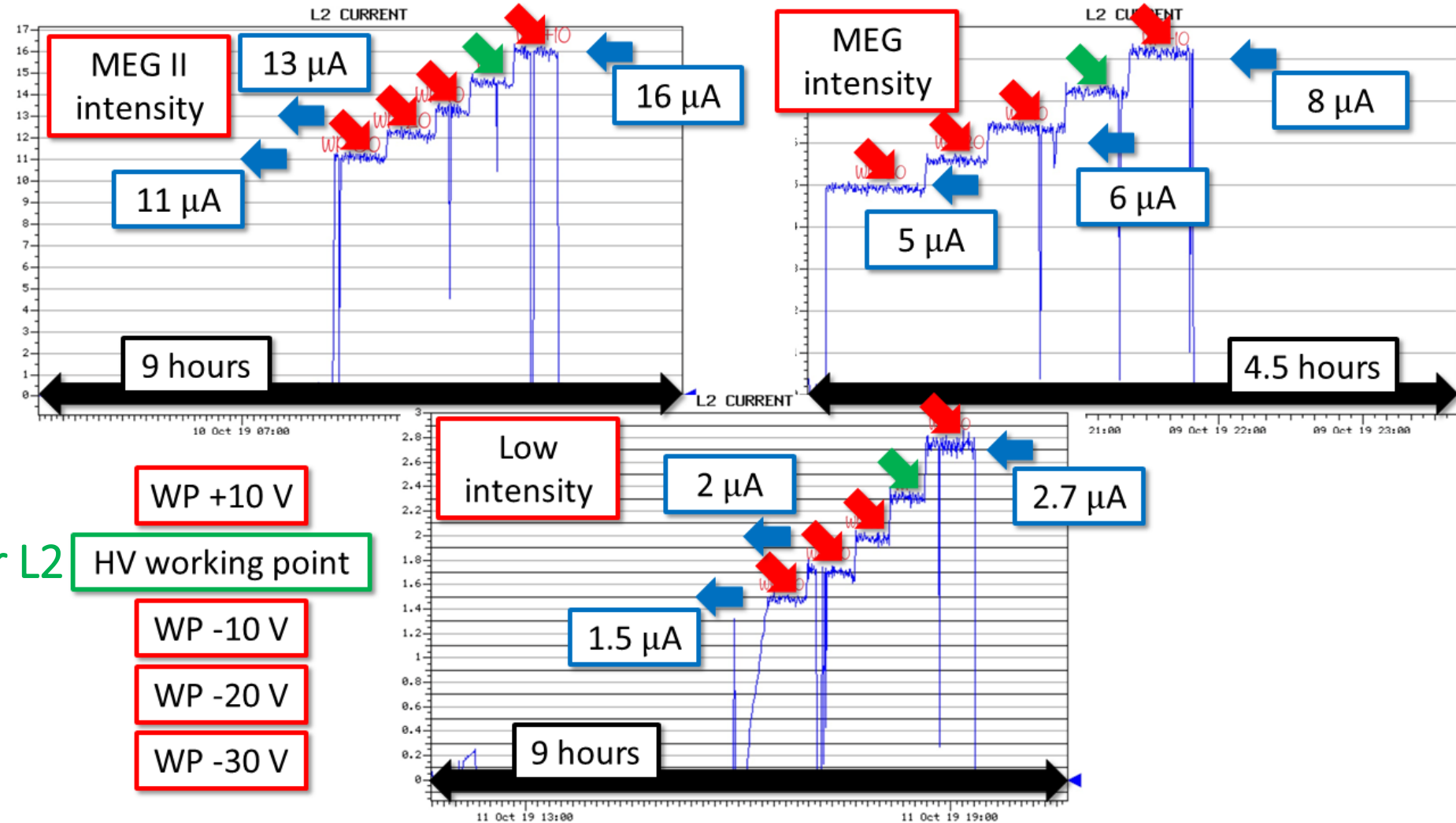
HV scan with μ^+ beam



- Gain curves as a function of the HV applied to L1, L2, L3
- ~ exponential behaviour with the HV increase as expected from simulations
- The regular instantaneous drops correspond to the beam spills to feed the Ultra Cold Neutrons (UCN) facility
- Same anomalous high current values in L1S3 and L2S5
 - L2S3 started later
- More investigations needed

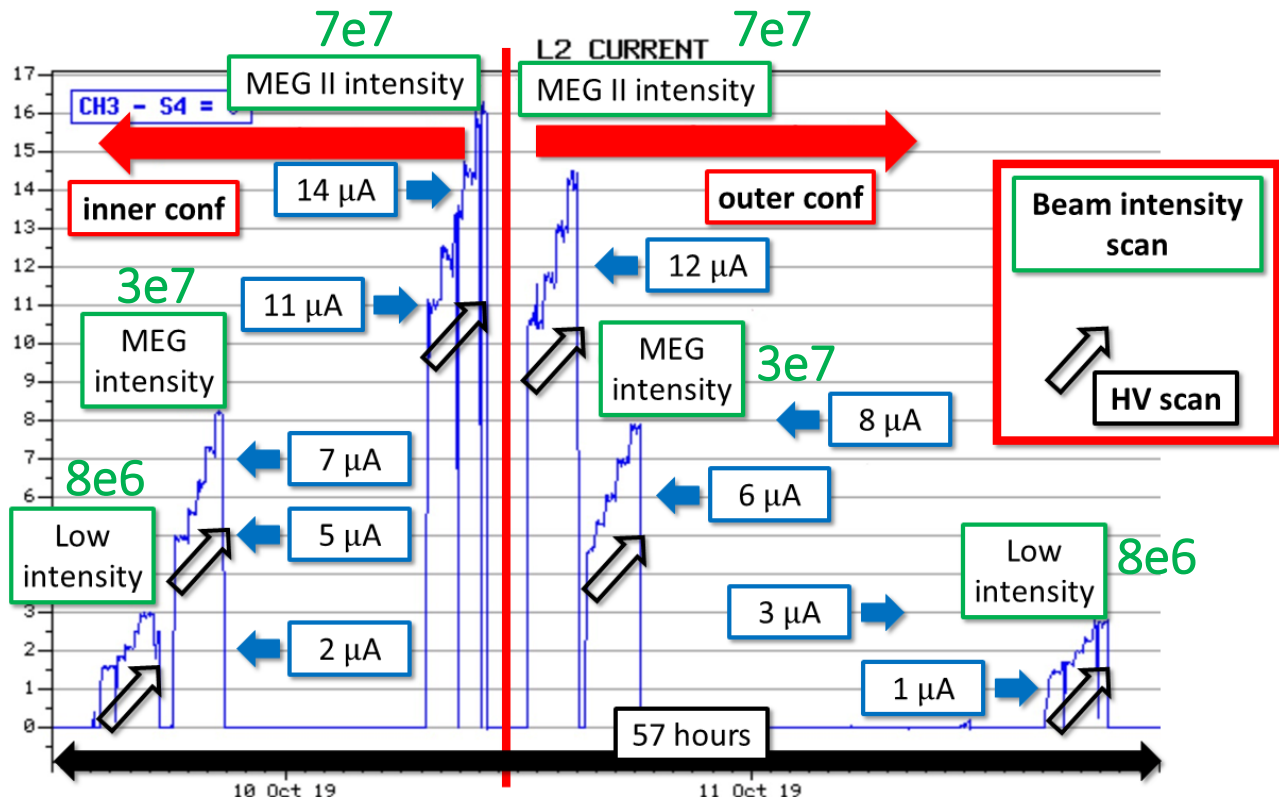
HV scan with μ^+ beam

- Example gain curves for L2
- ~ exponential behaviour with the HV increase as expected



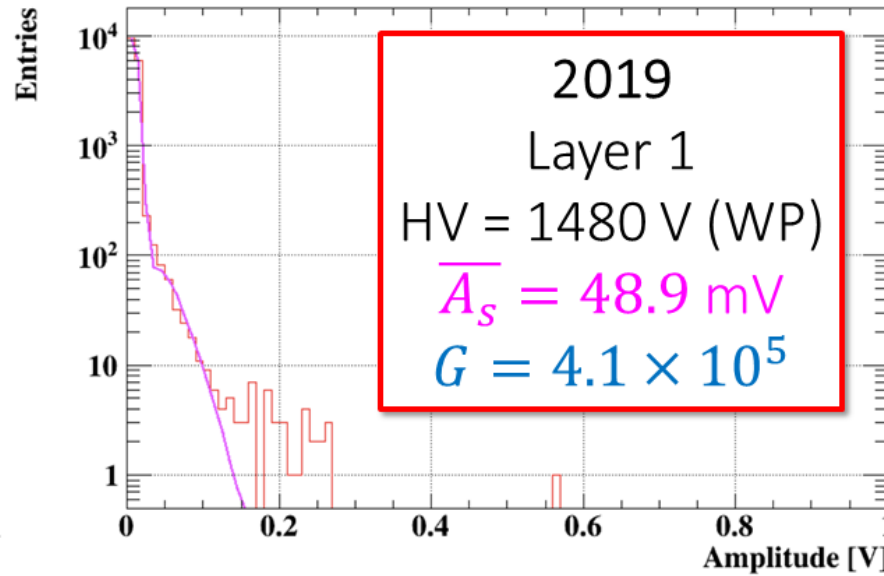
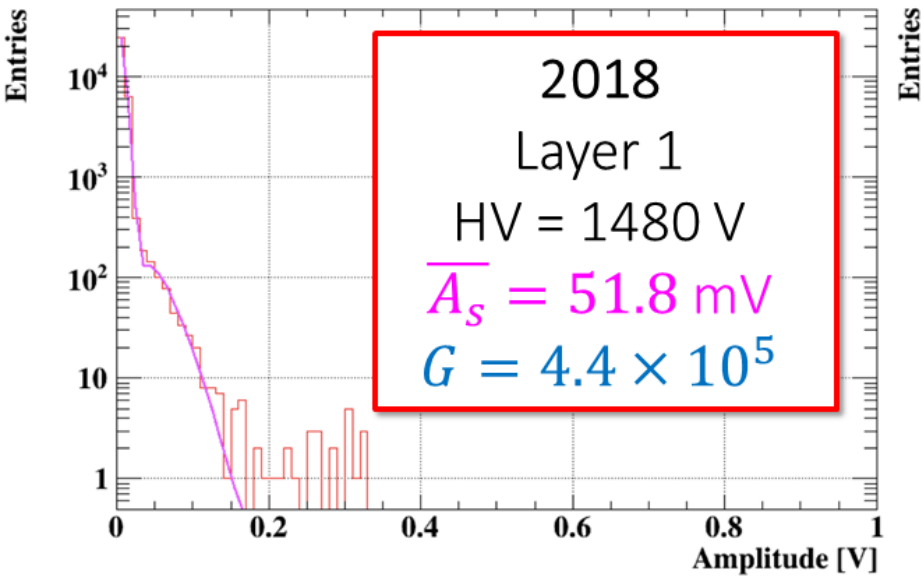
1470 V for L2 HV working point

μ^+ beam

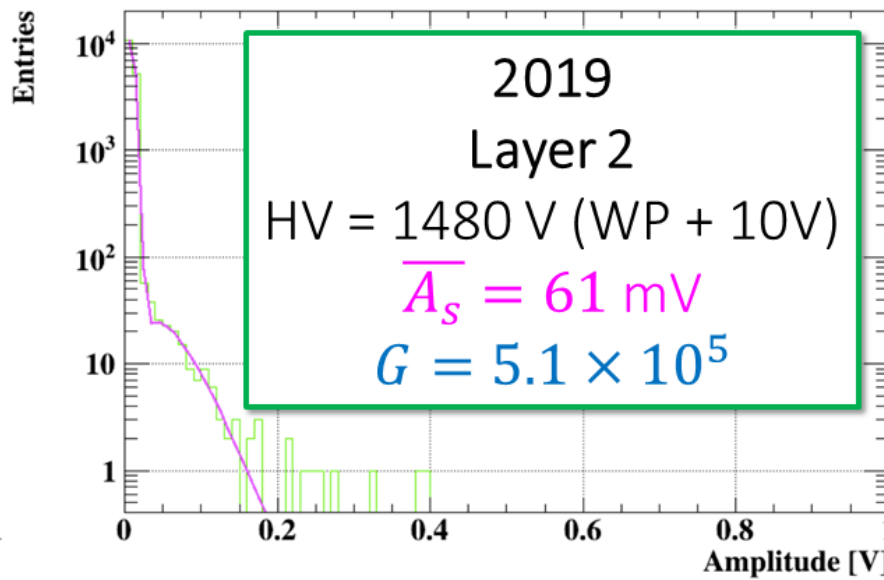
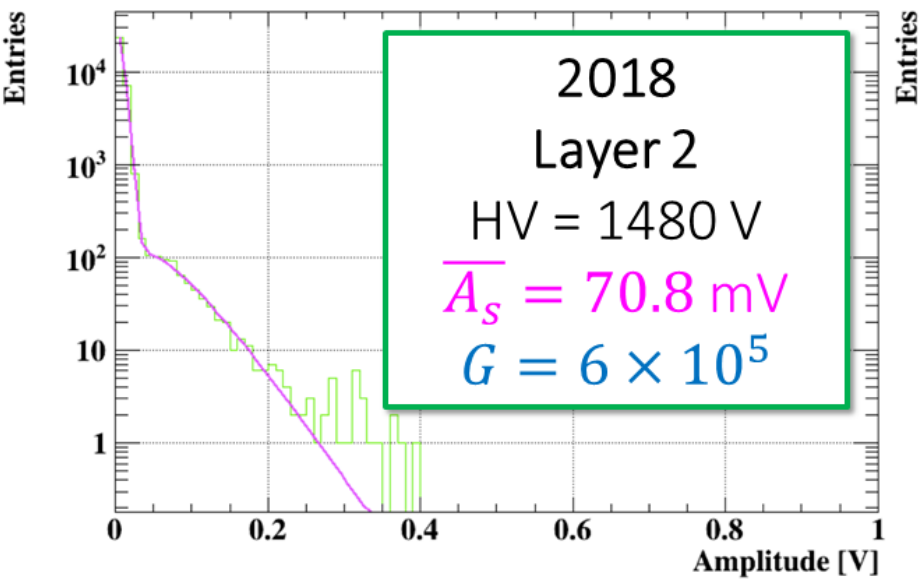


- μ^+ beam intensity scan
 - Example gain curves for L2
- Linear proportionality as a function of the beam flux

2018-2019 gain comparison



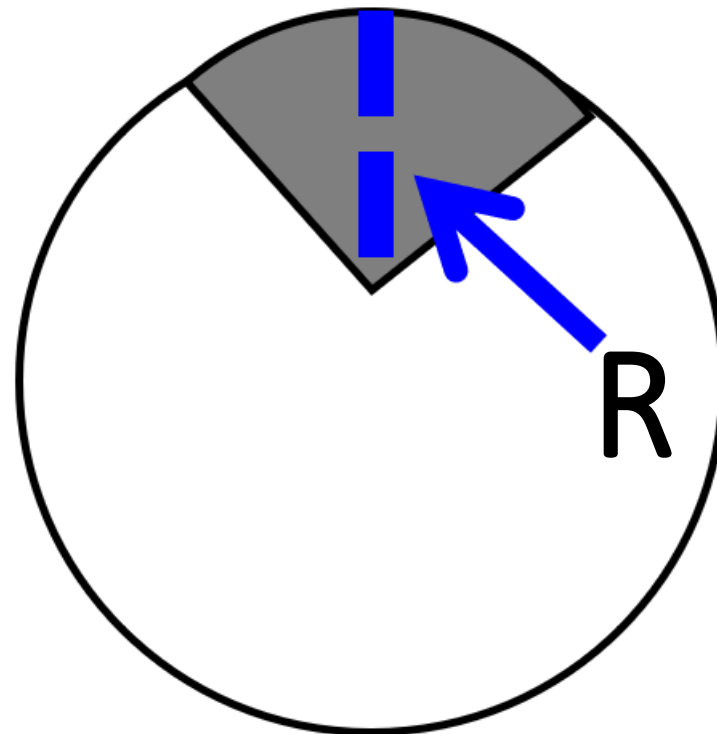
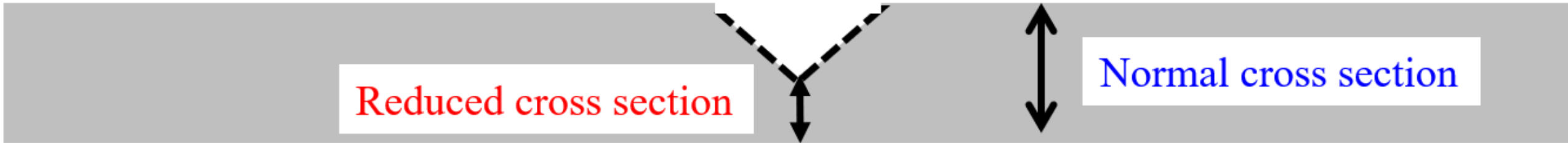
Preliminary



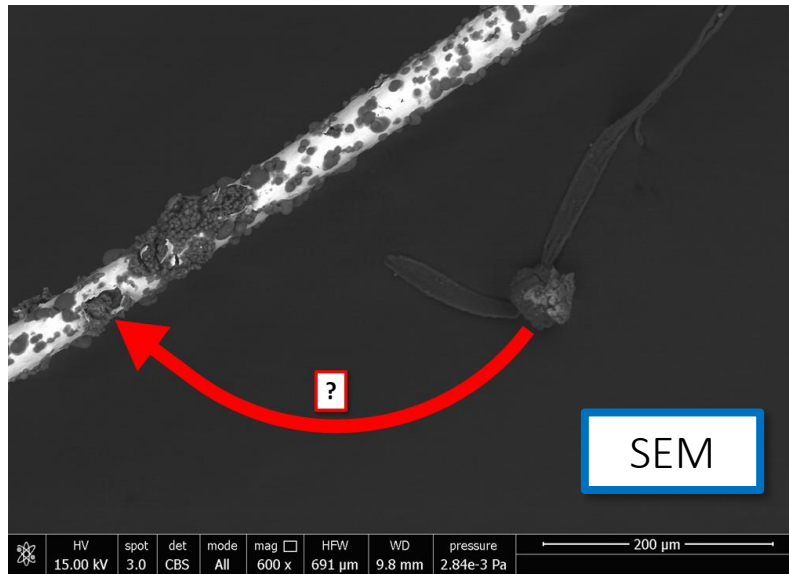
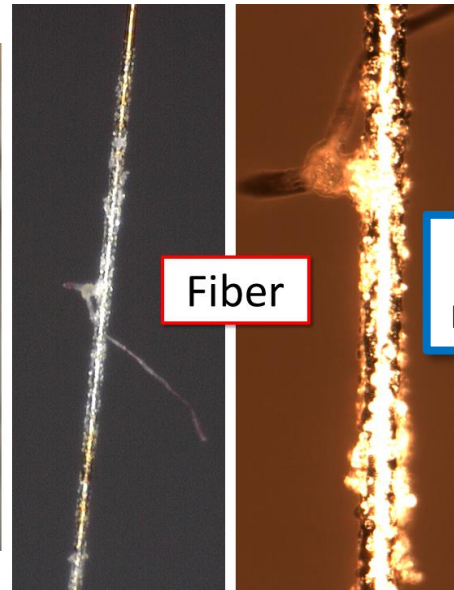
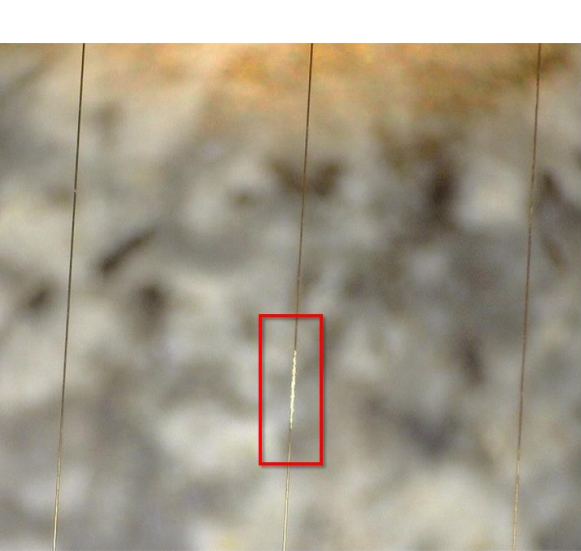
HV tuning by 10 V/layer
fundamental to obtain
the gain equalization
among different layers

➤ Due to the variable cell
dimensions as a
function of the radius

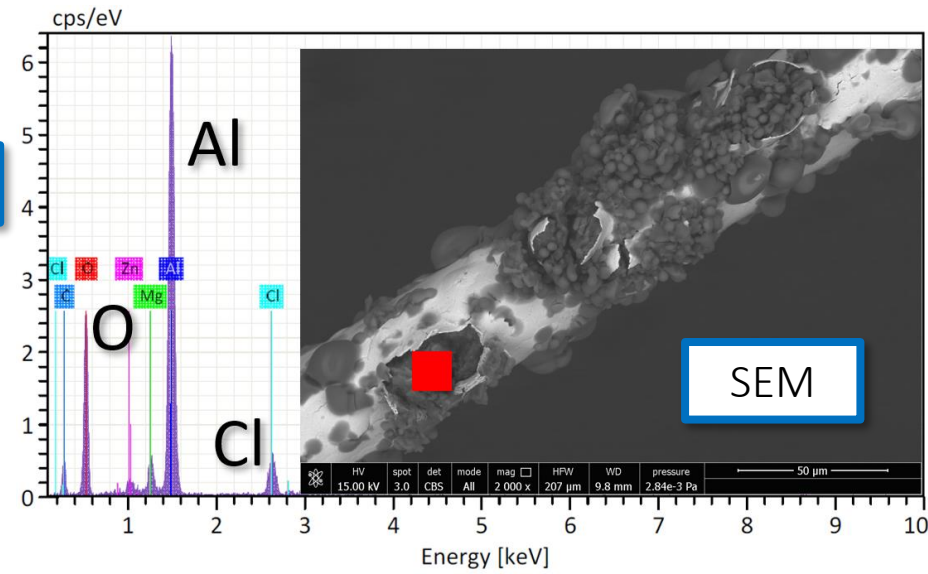
Wire core thinning due to corrosion



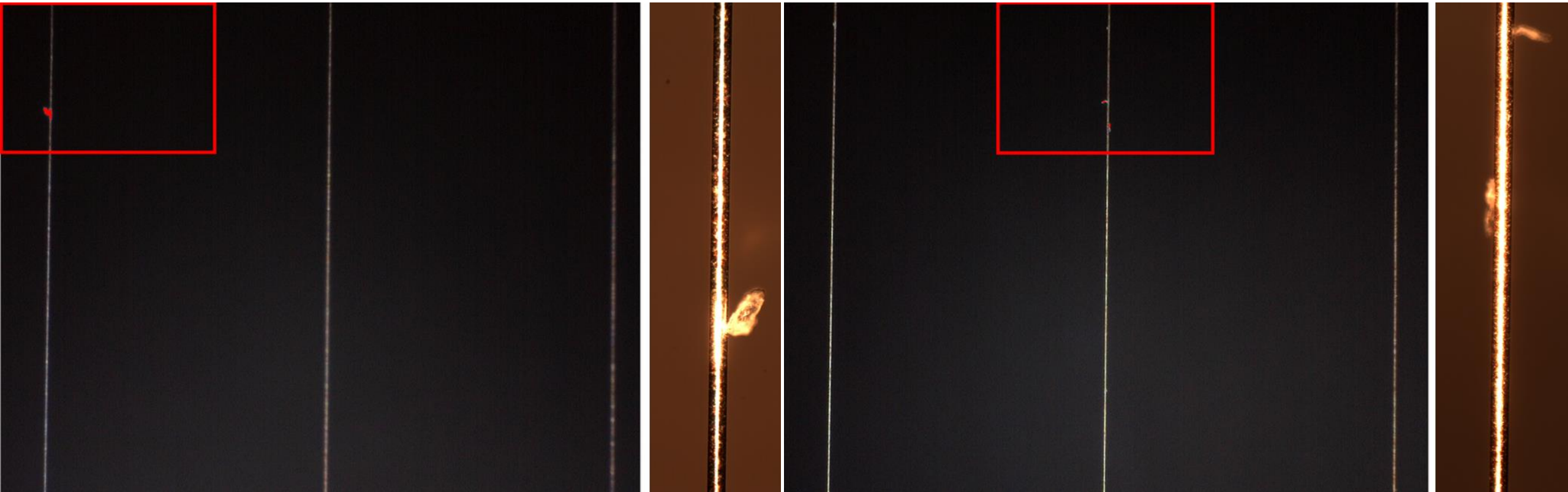
White spot on a wire due to a fiber



EDX

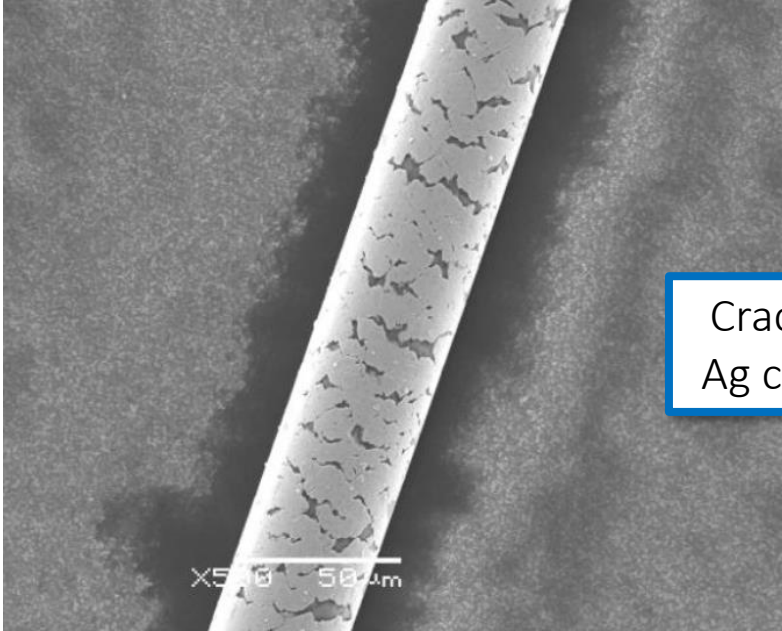
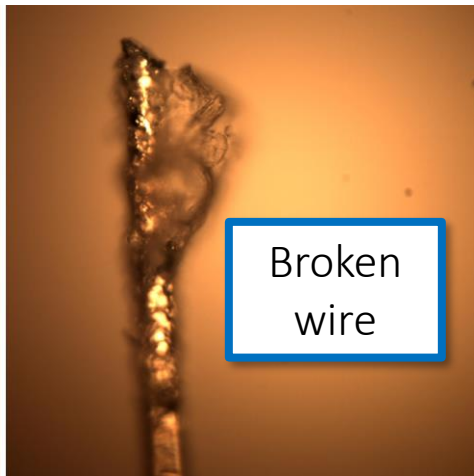
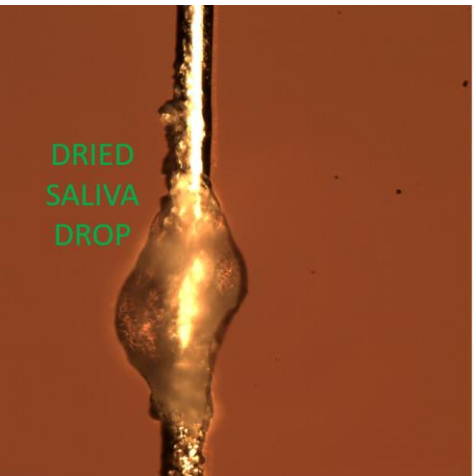


Automatic detection of wires defects

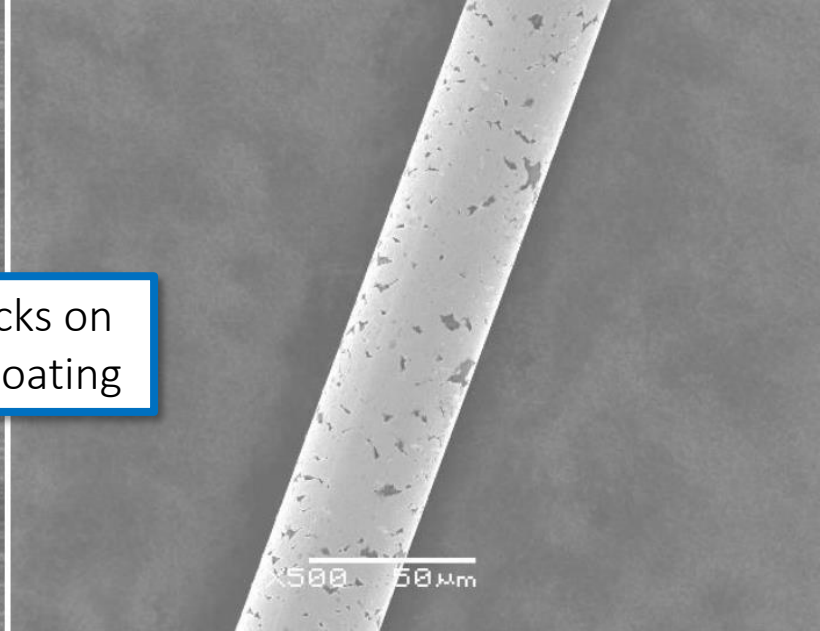


Pattern recognition exploiting the
MathWorks Image Processing Toolbox
(MATLAB)

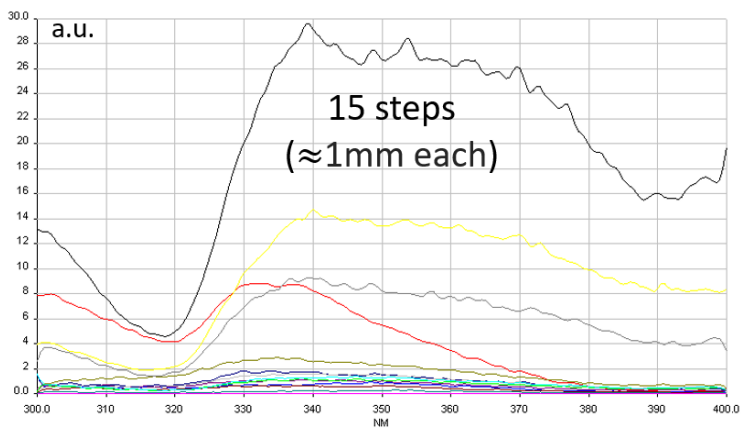
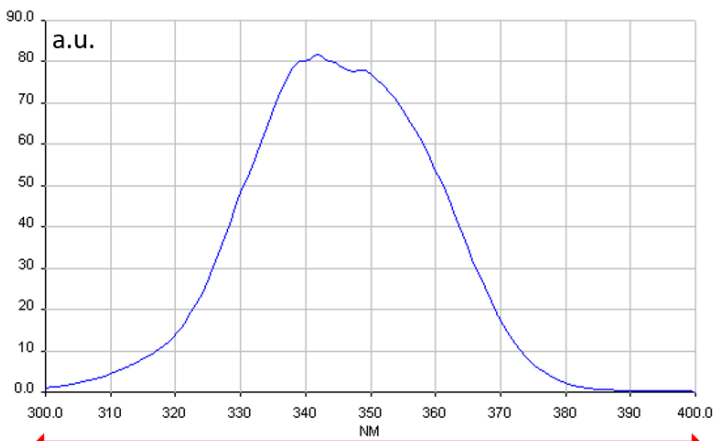
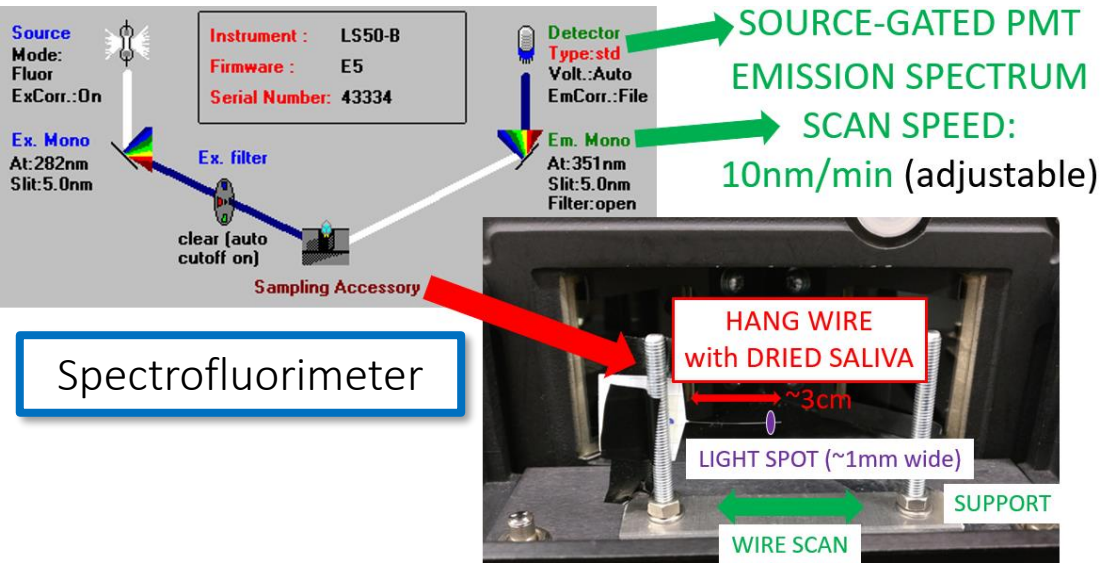
Saliva on wires



Cracks on Ag coating



Fluorescence spectrum of ≈ 3 mm saliva deposit on wire



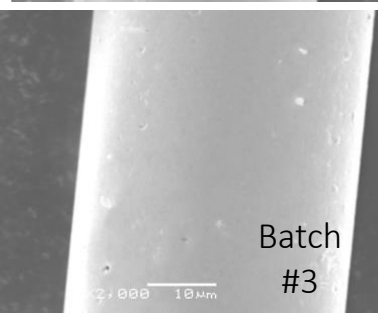
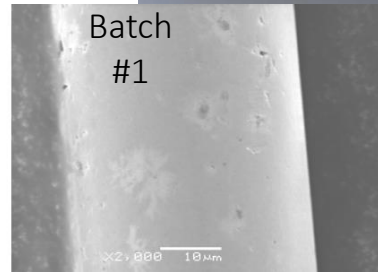
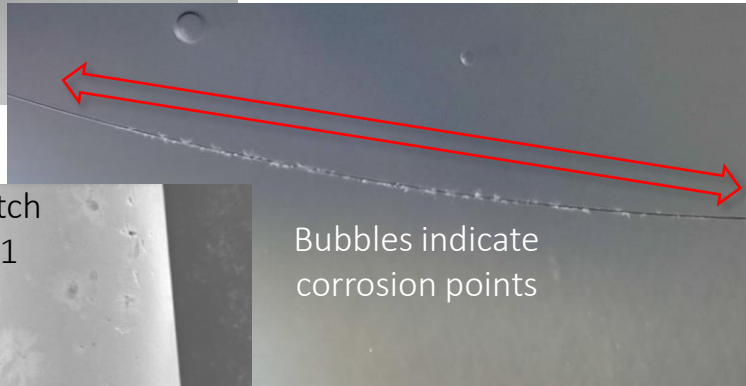
EMISSION SPECTRUM SCAN RANGE: 300÷400nm (adjustable)

Al(Ag) wires: CDCH vs. CDCH2

CDCH: 40 μm (75.5%) + 50 μm (24.5%) Al(Ag) wires

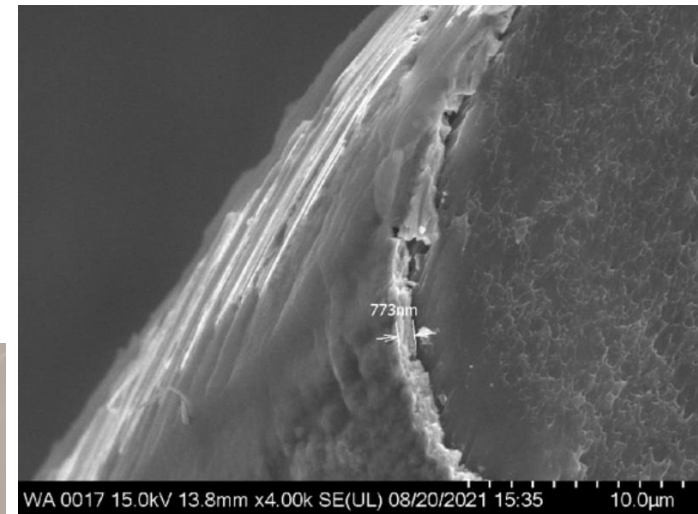
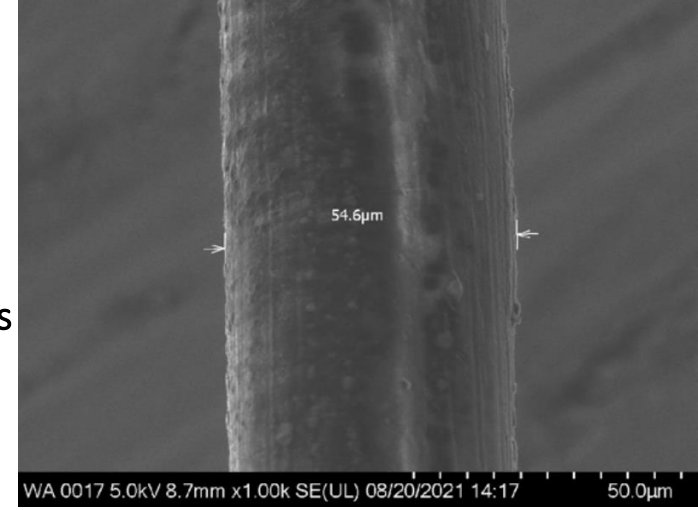
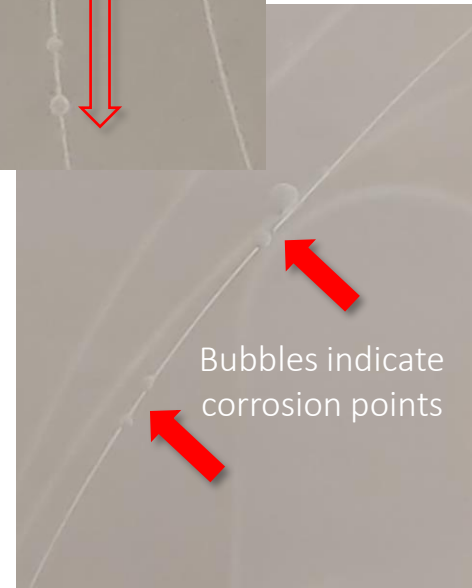
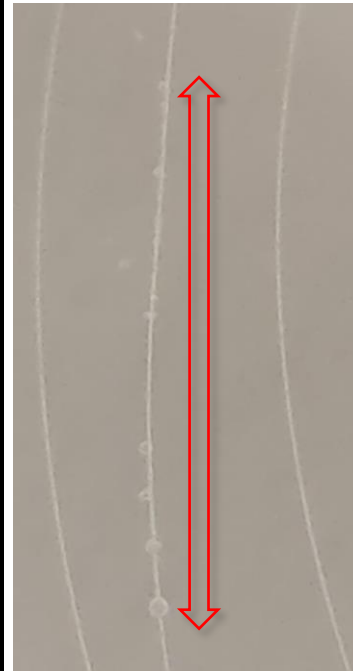


- 50 μm wire samples (1 meter each) immersed in distilled water
- Continuous corrosion points
 - Breakings with no stress
 - 40 μm wire samples completely destroyed



- Production batch-dependent wire surface quality**
- Final drawing process (polish) on plated wires
 - Cracks on the surface
 - Weak points prone to corrosion

CDCH2: 50 μm (100%) Al(Ag) wires



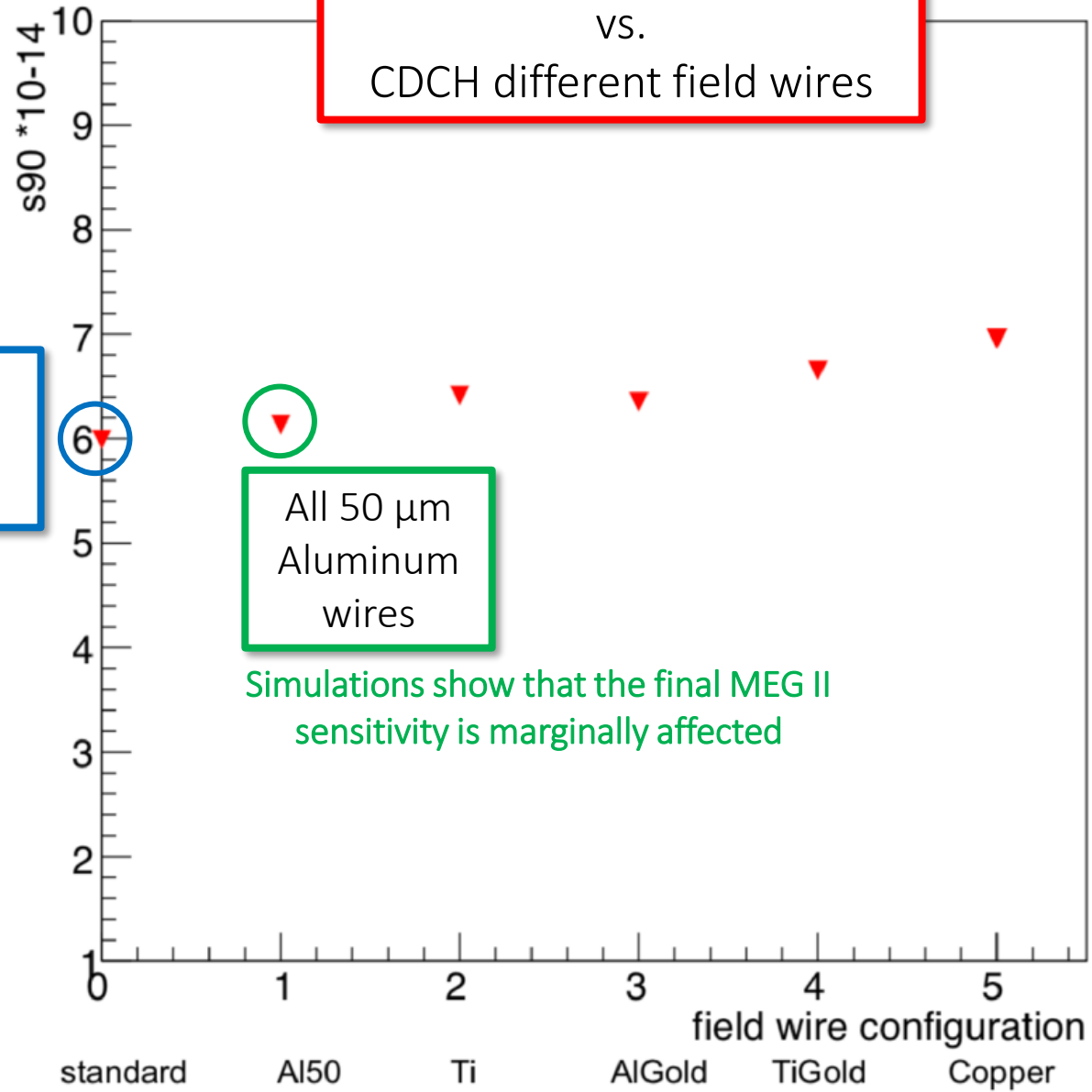
Uniform and thicker Silver coating

- No final drawing process
 - No cracks on the surface
- 50 μm wire samples (1 meter each) immersed in distilled water
- Just a few isolated corrosion points
 - A factor of 3 better than the best CDCH production batch

Sensitivity vs. wires

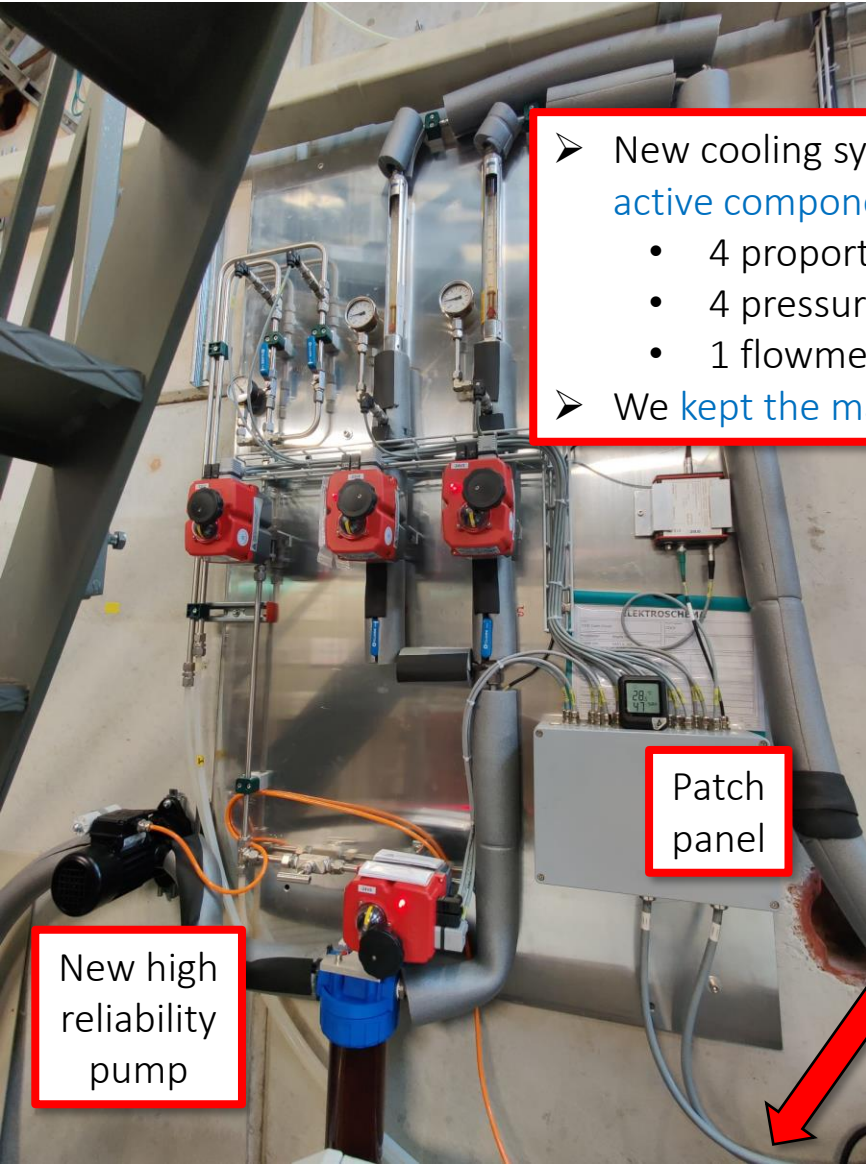
CDCH standard
➤ 40 μm (75.5%) Al wires
➤ 50 μm (24.5%) Al wires

Final MEG II sensitivity
vs.
CDCH different field wires



Simulations show that the final MEG II sensitivity is marginally affected

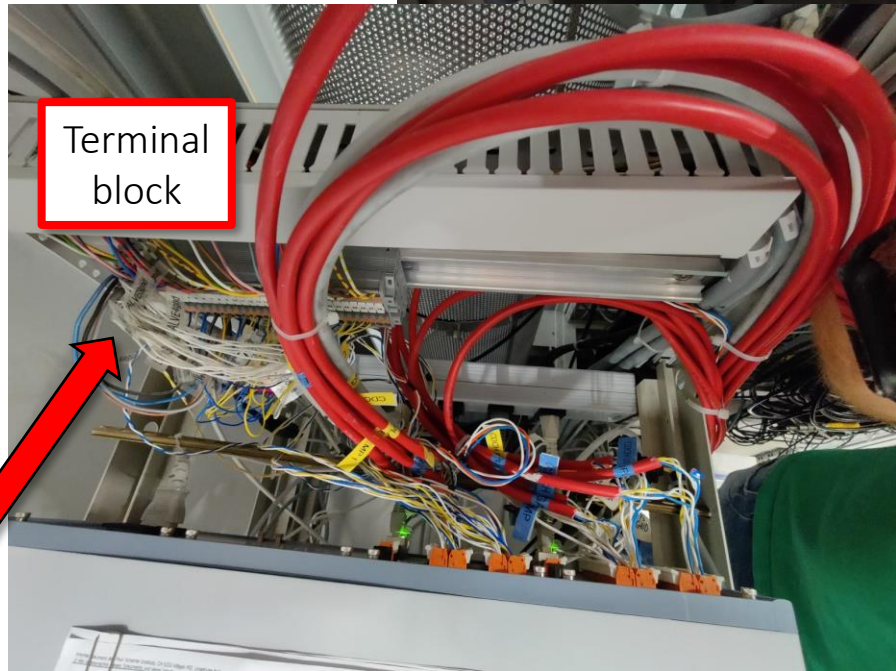
New cooling system



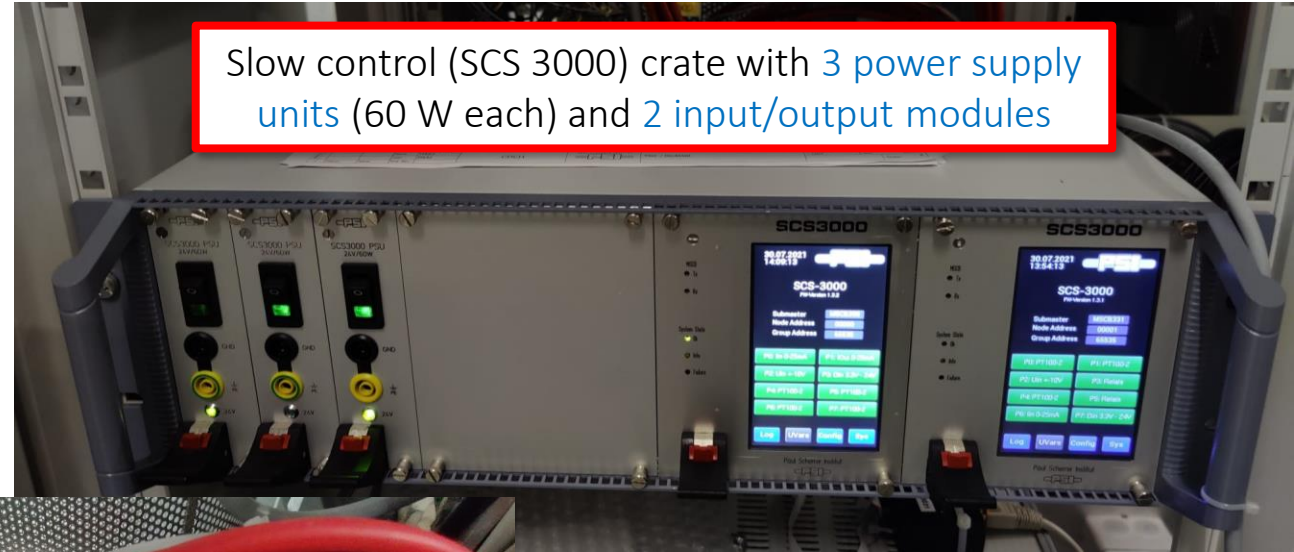
- New cooling system panel with active components
 - 4 proportional valves
 - 4 pressure sensors
 - 1 flowmeter
- We kept the manual components

New high reliability pump

Patch panel



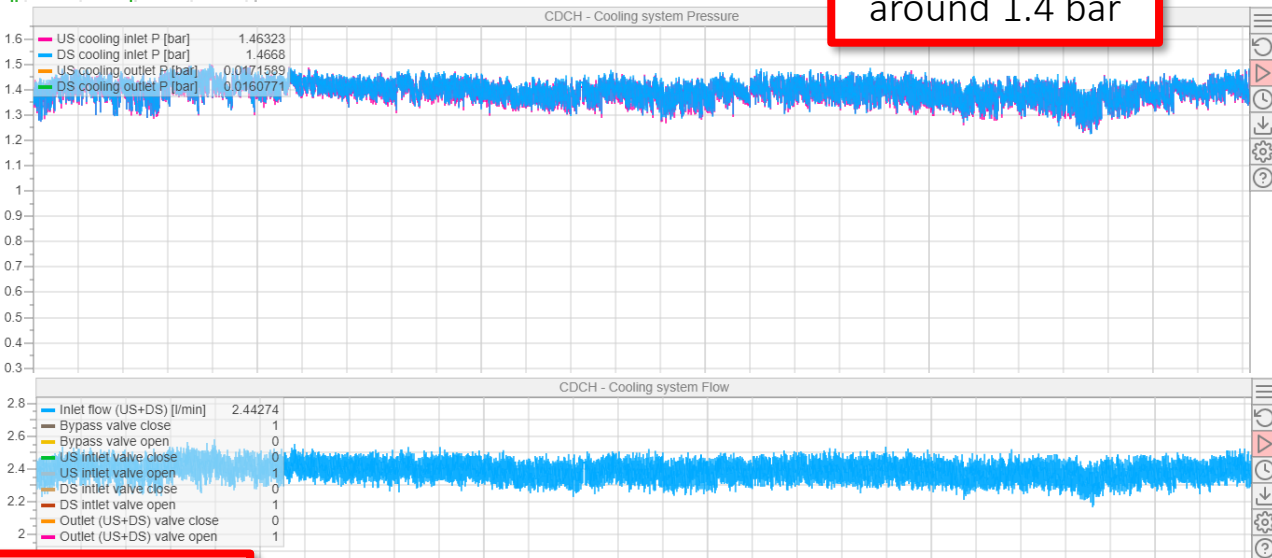
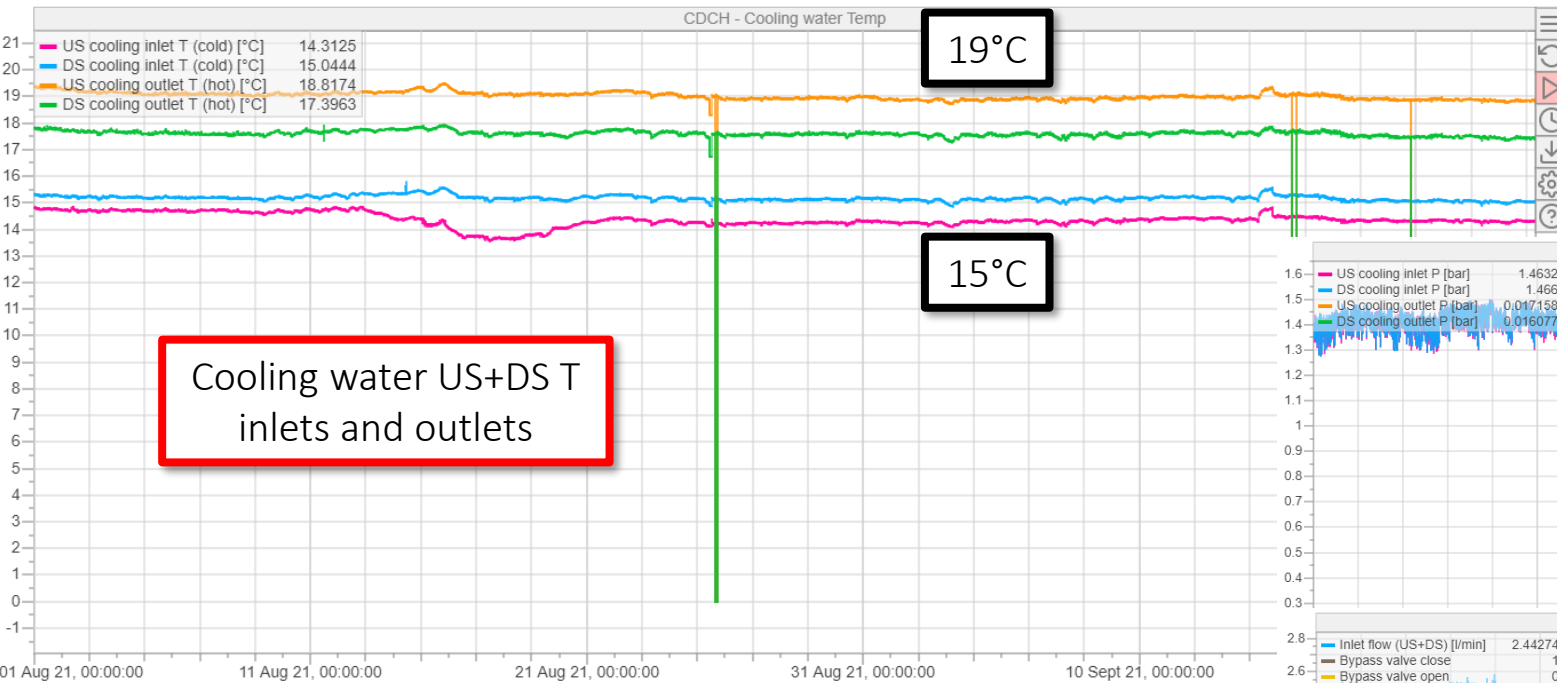
Terminal block



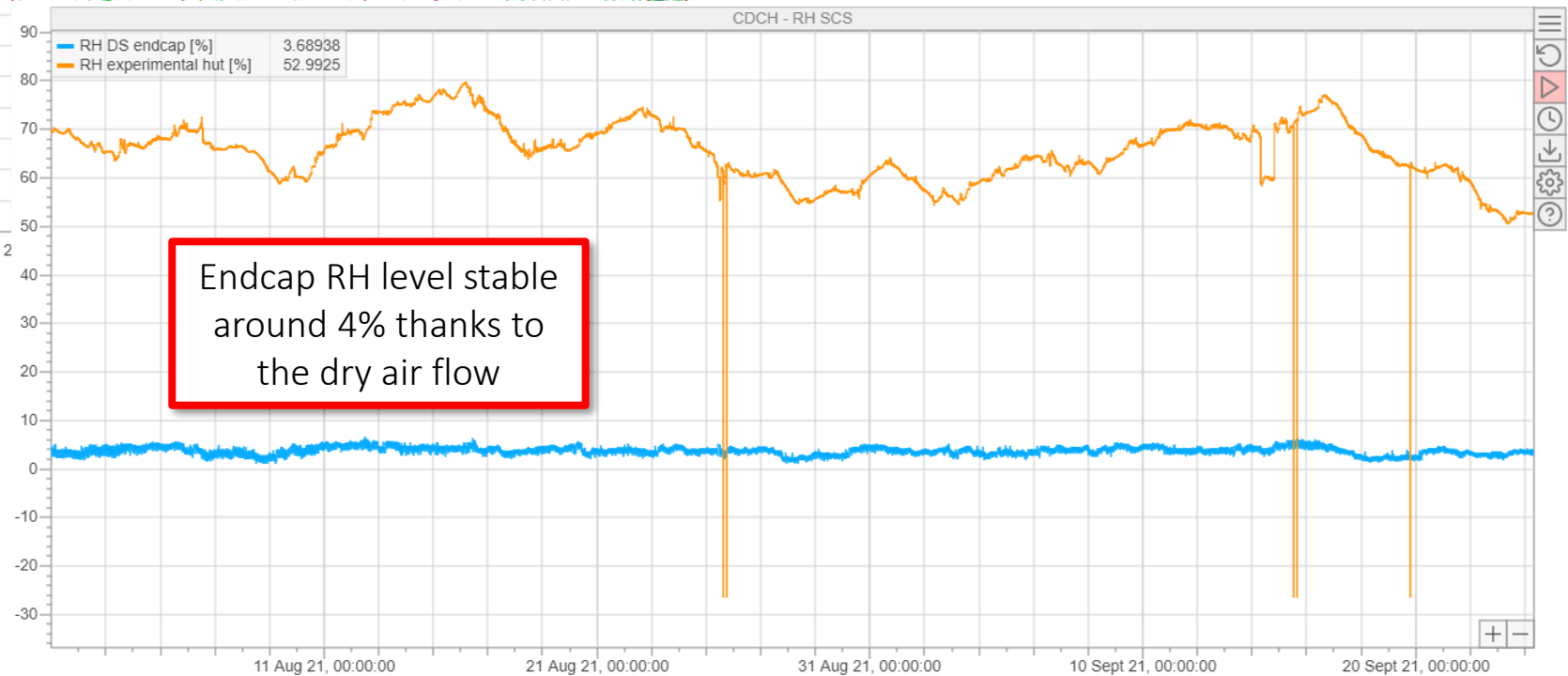
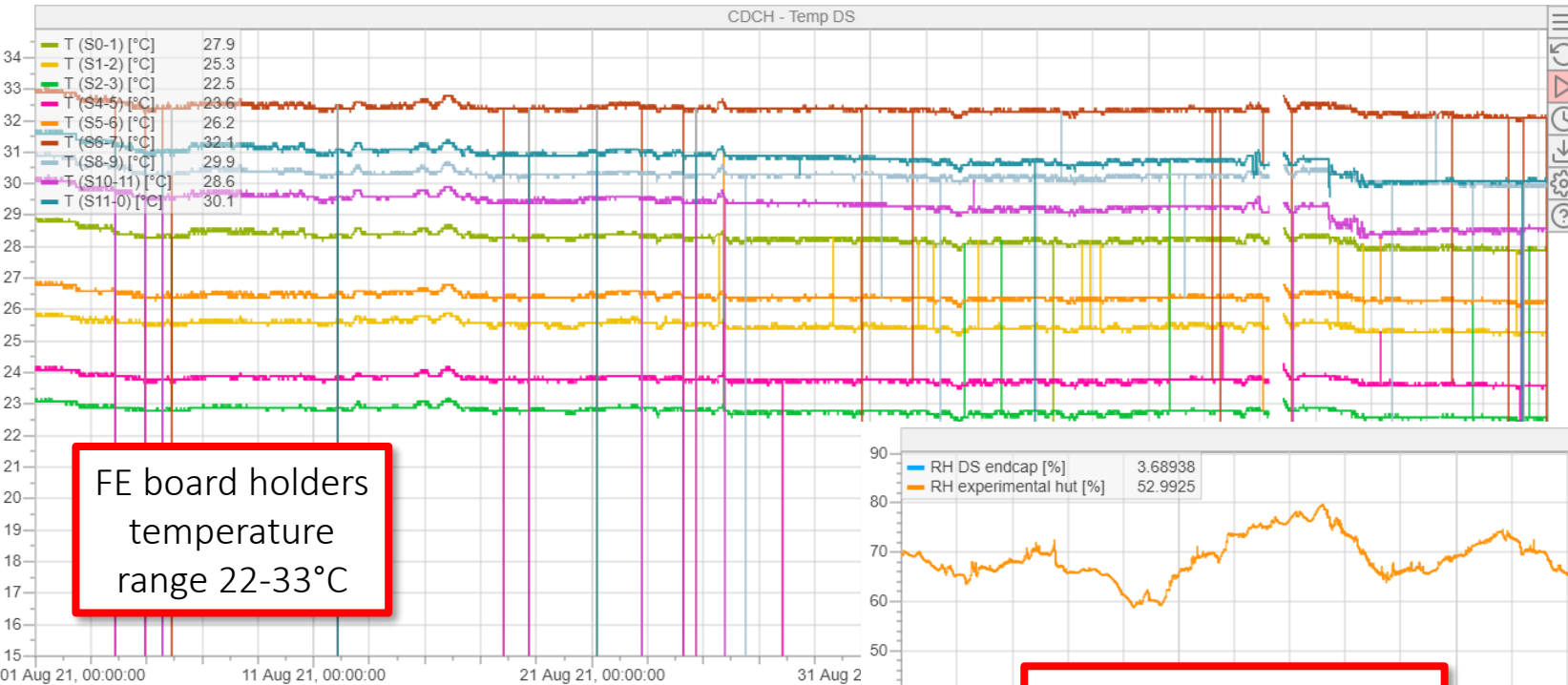
Slow control (SCS 3000) crate with 3 power supply units (60 W each) and 2 input/output modules

- New cooling system in operation since the end of May 2021
 - Full connections completed
 - Cooling system devices (input/output) + CDCH sensors (input)
- Valve control via software
- History OK

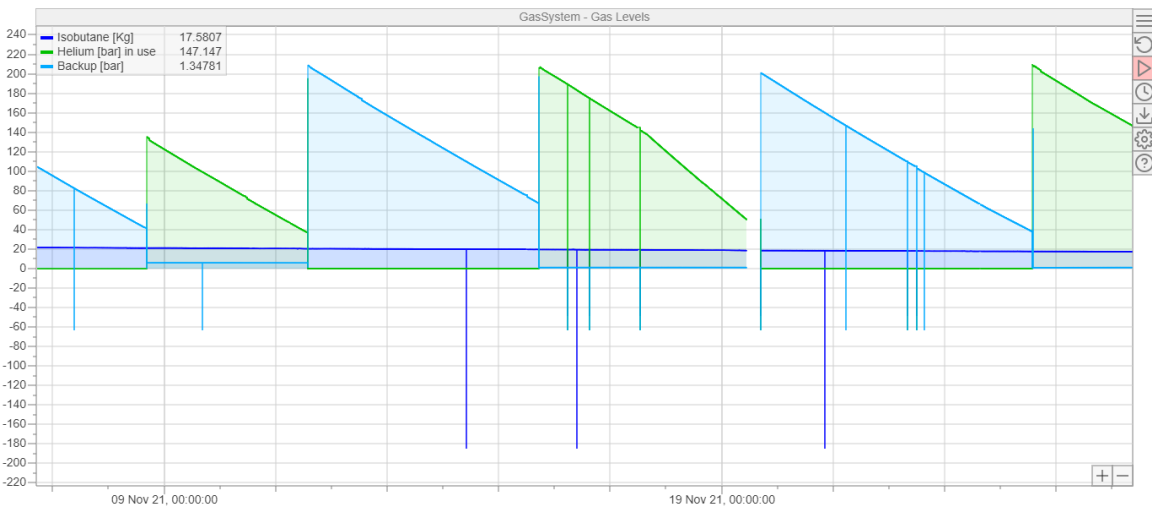
Cooling system stability 01/08-24/09



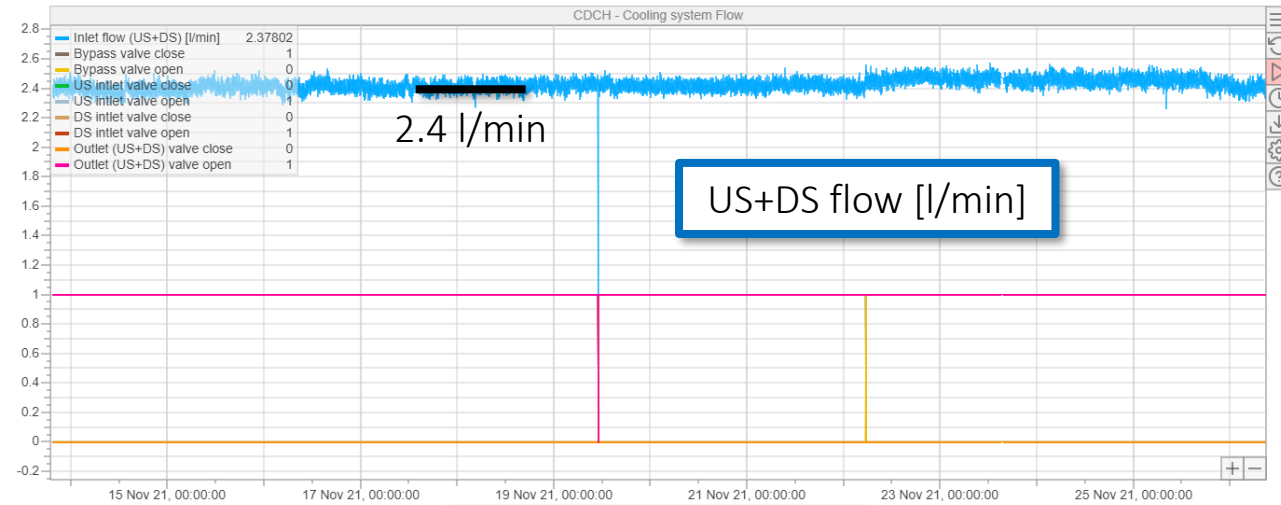
Endcap T-RH stability 01/08-24/09



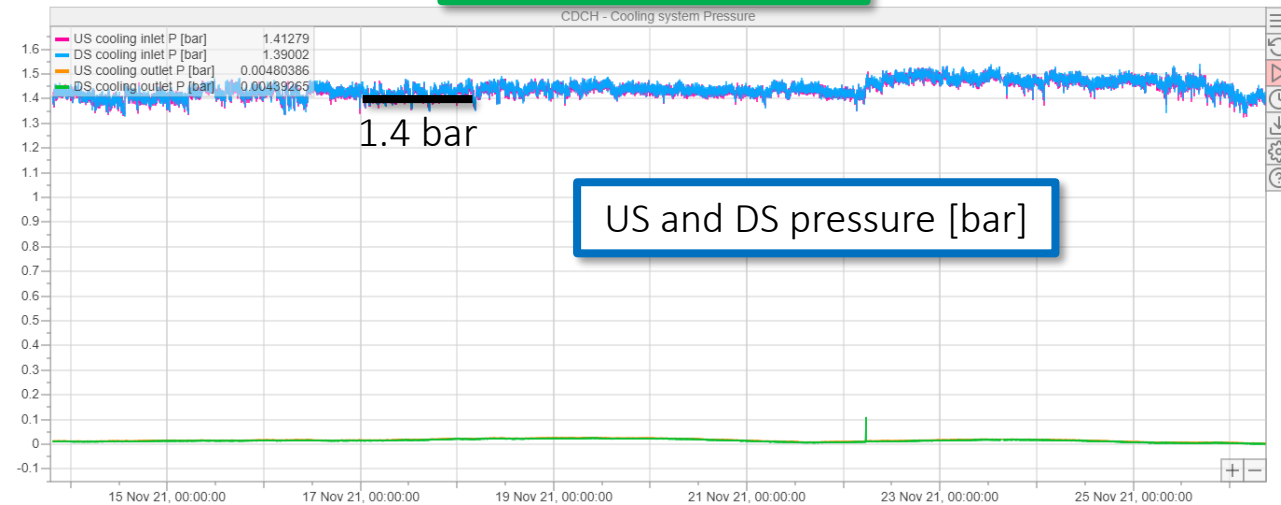
Gas and Cooling systems stability



- Gas system stable
- He bottle exchanges continue
 - Thanks to the people involved

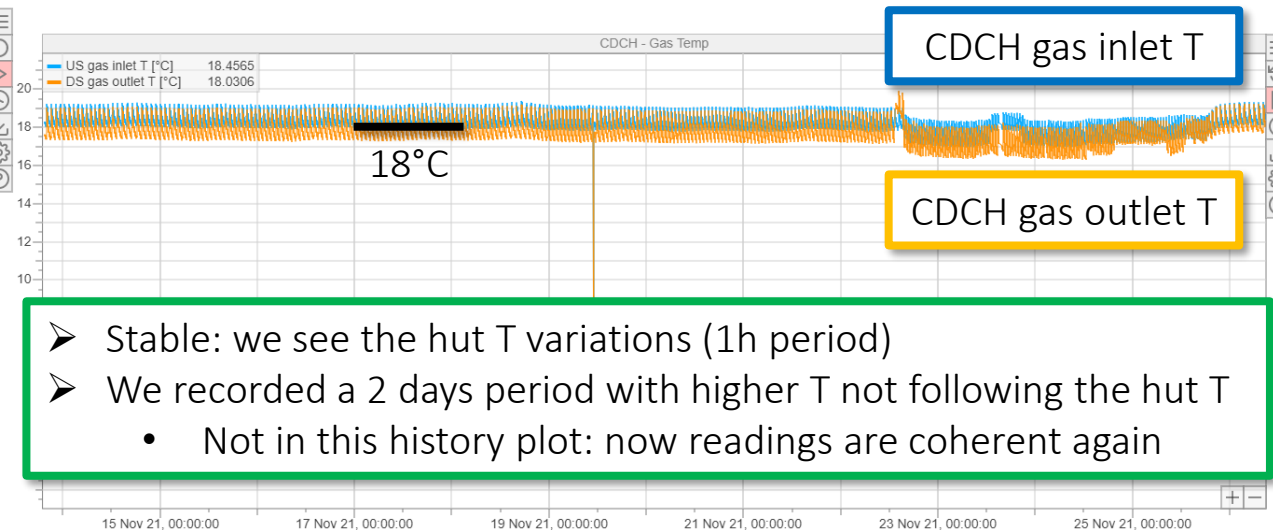
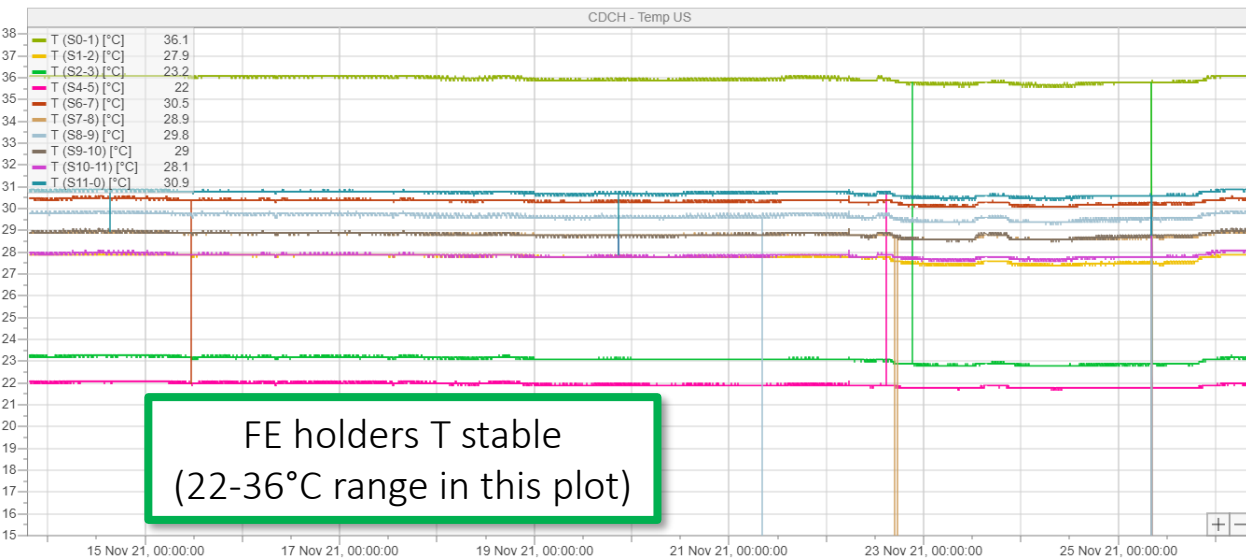
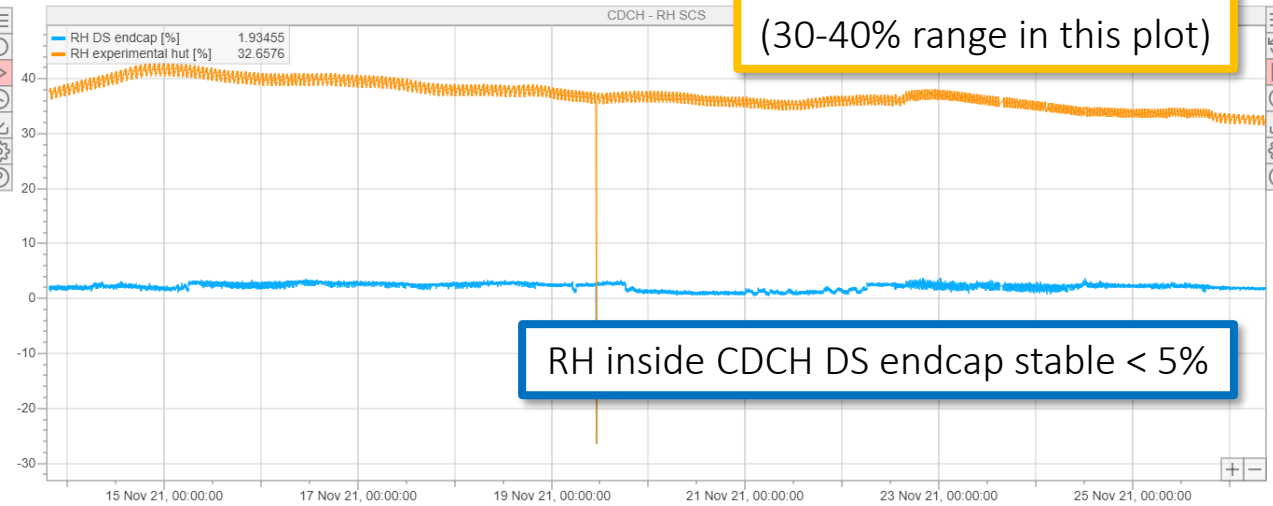
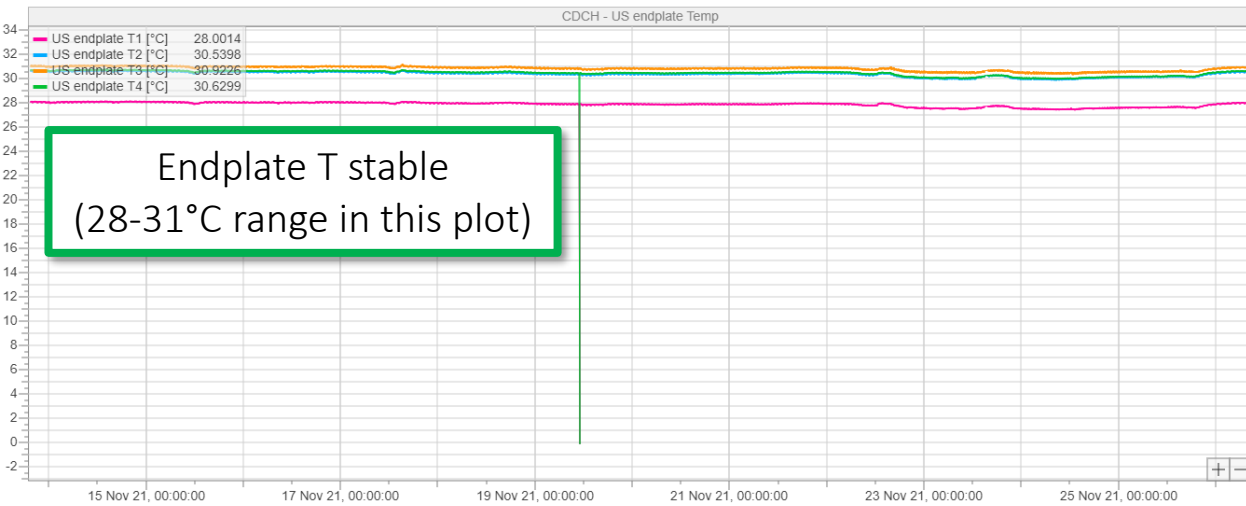


Cooling system stable



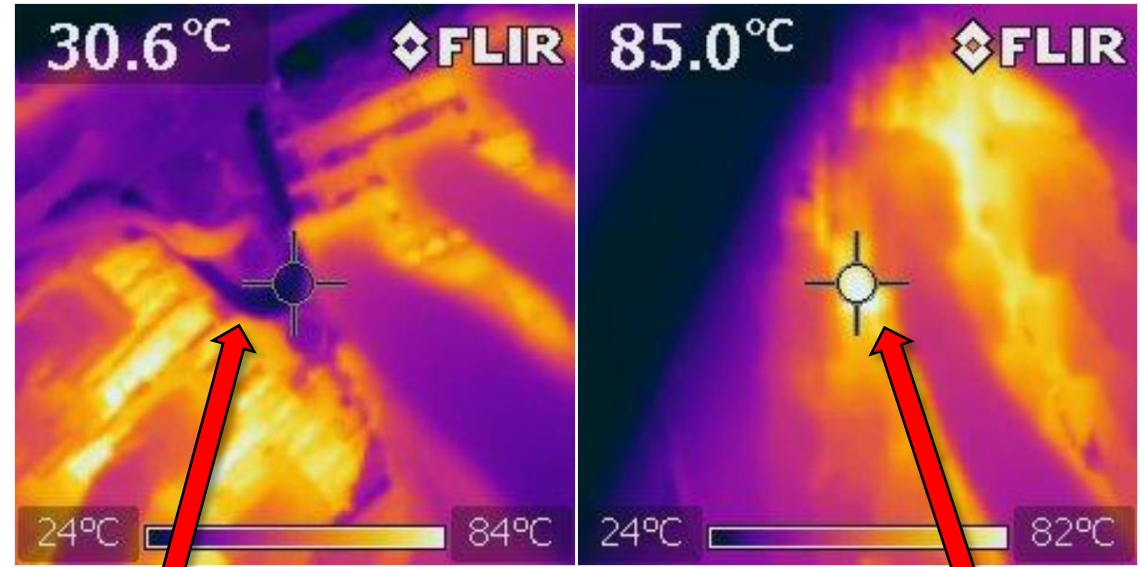
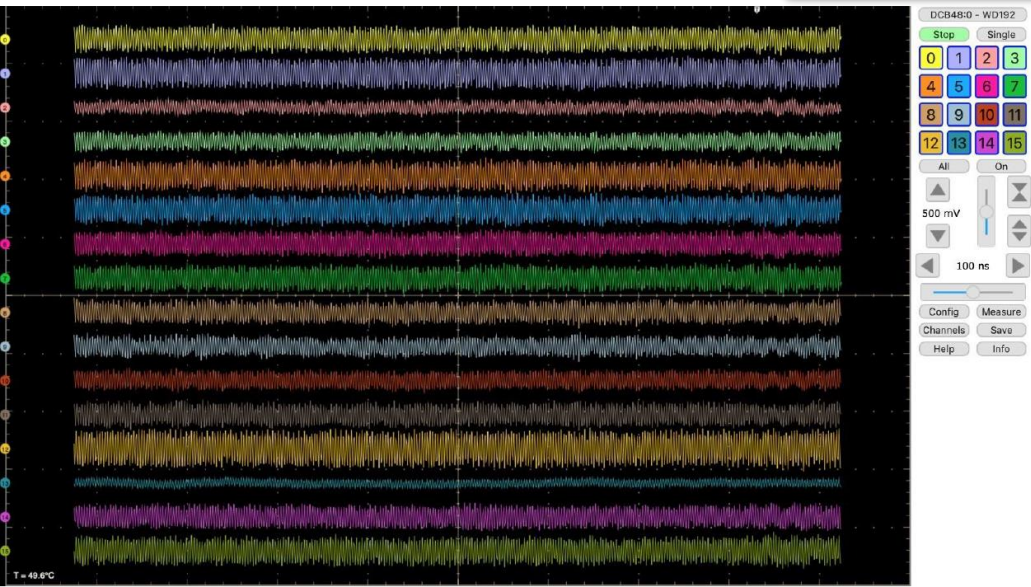
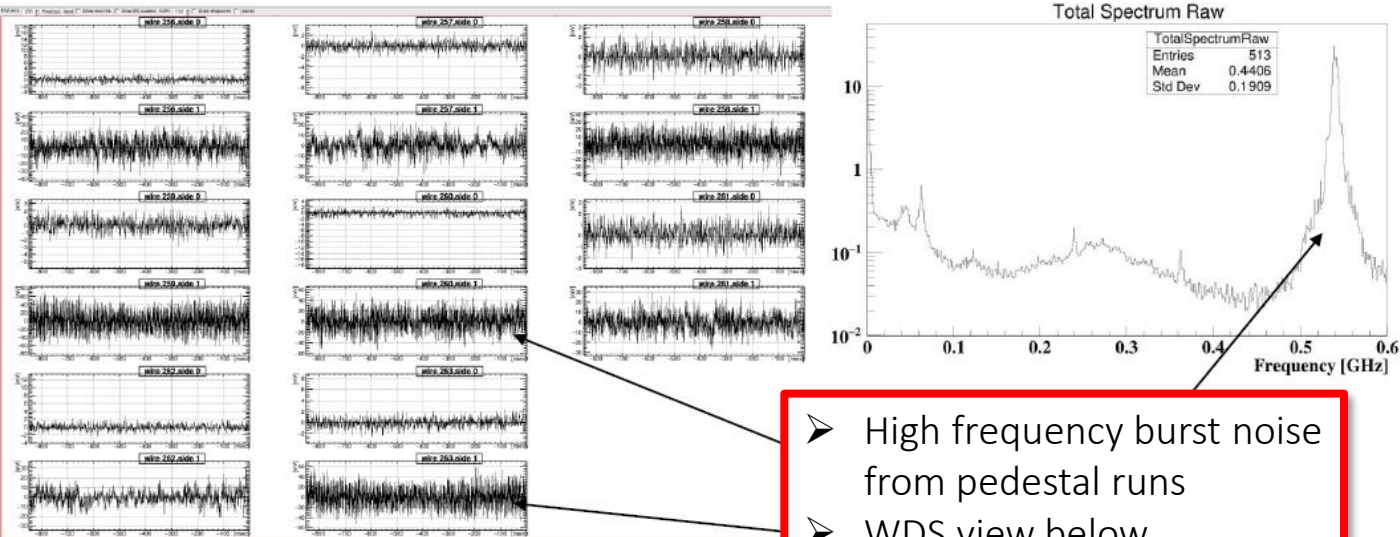
US and DS pressure [bar]

T and RH stability



- Stable: we see the hut T variations (1h period)
- We recorded a 2 days period with higher T not following the hut T
 - Not in this history plot: now readings are coherent again

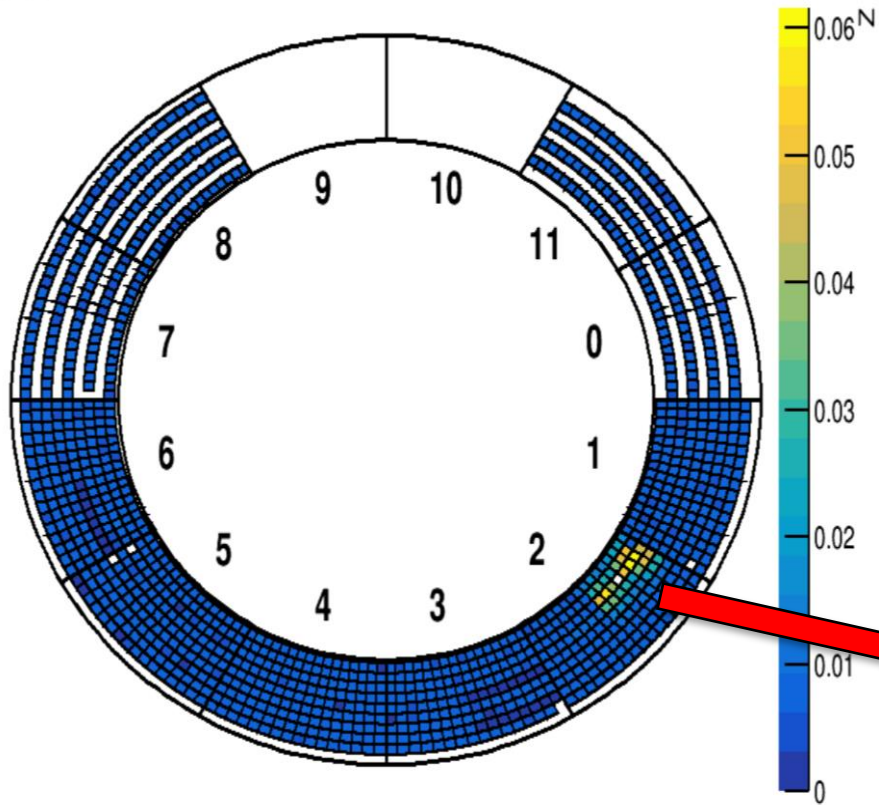
First LV power ON of the whole CDCH



- HF noise observed in several channels
- The onset occurs a few minutes after the LV power ON before reaching the equilibrium temperature
- Generated by a few FE boards and picked up everywhere

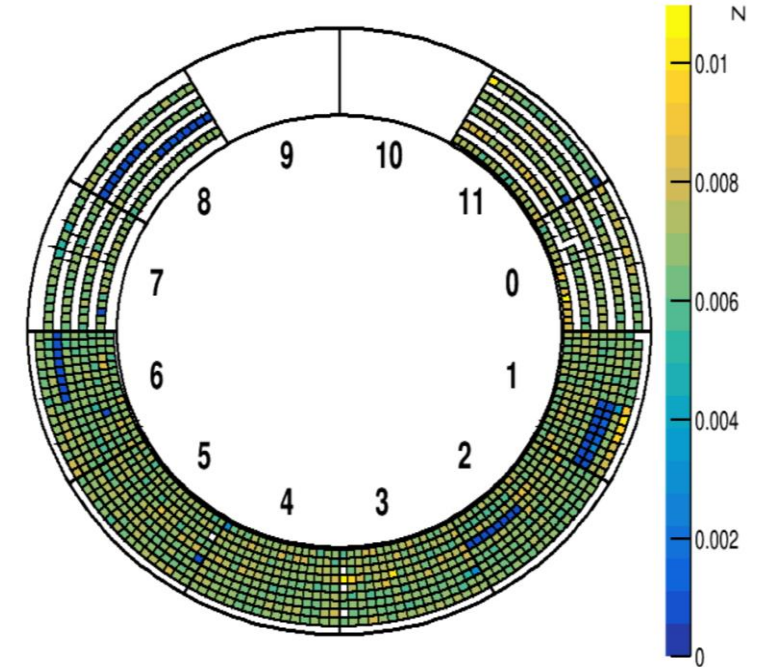
Search for the noisy boards

Downstream

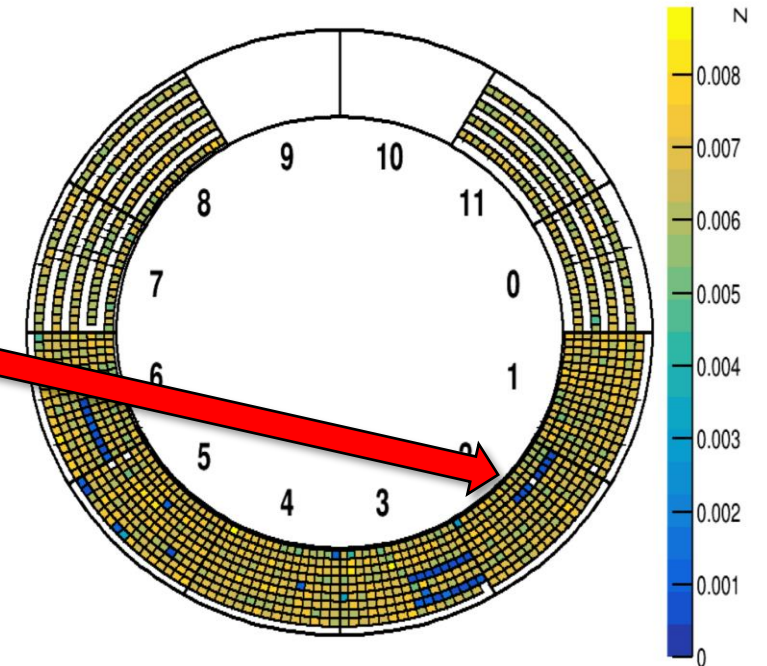


- US and DS views of the FE boards disconnected on a single side
 - 6 US
 - 4 DS
- Sometimes only one wire is masked out in the analyzer

Upstream



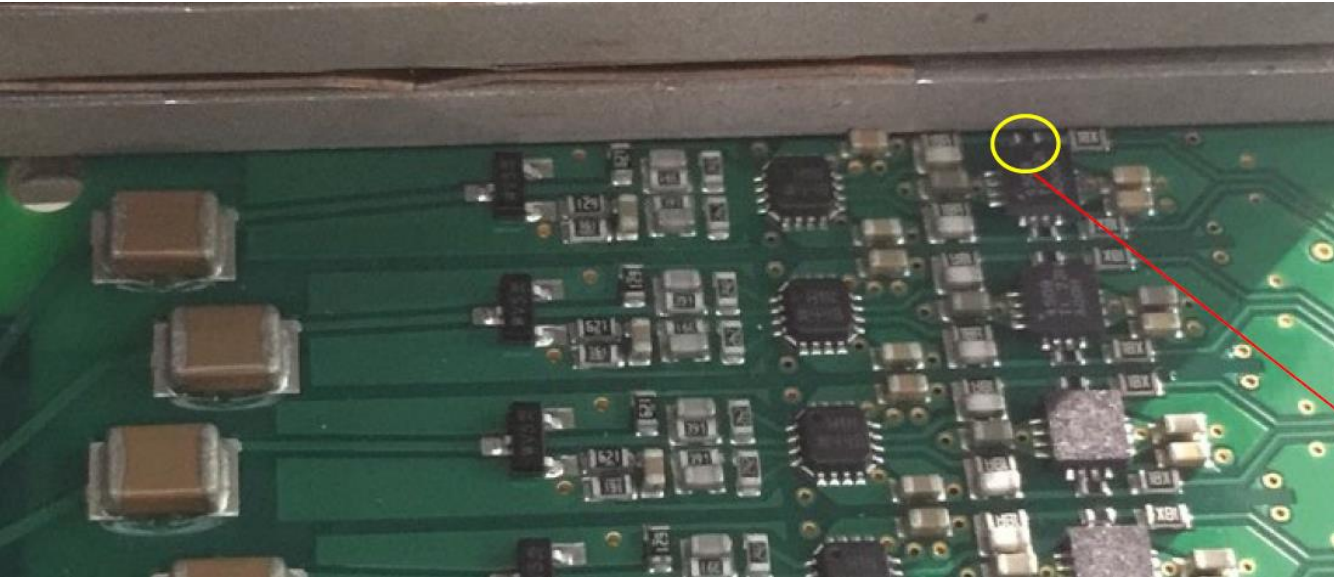
Downstream



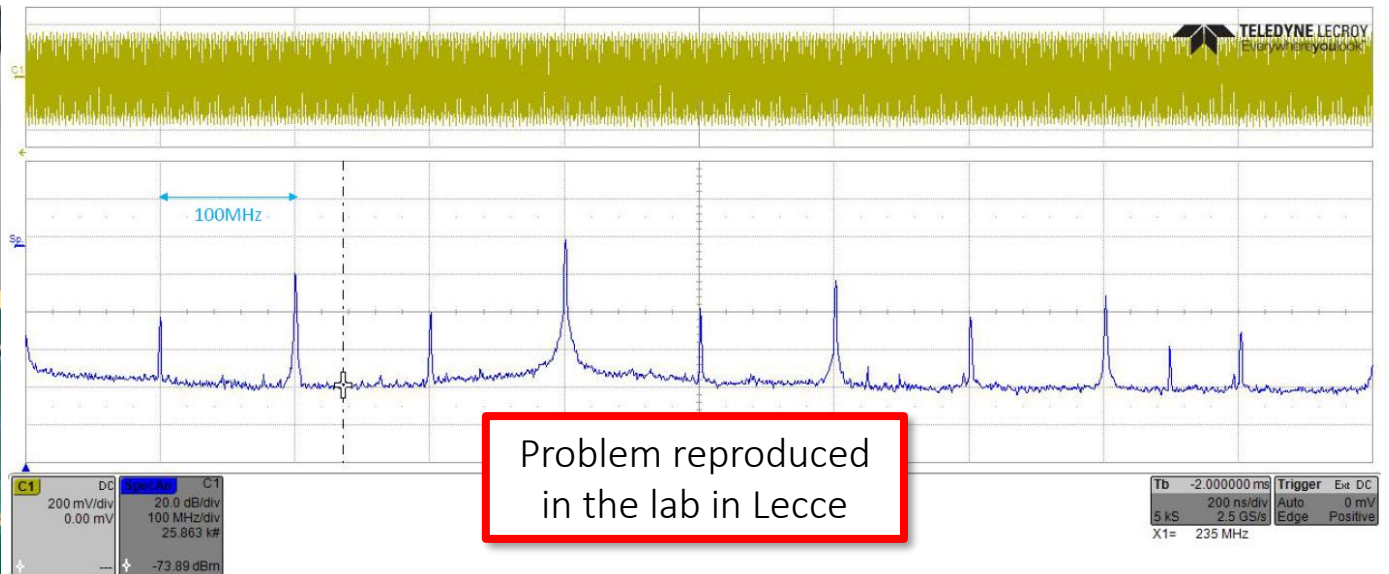
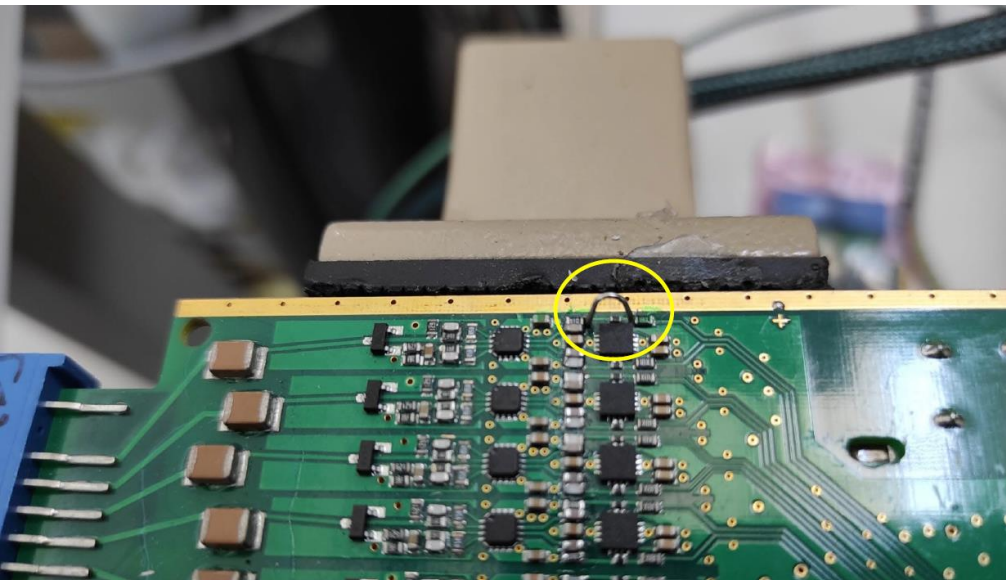
Example of noisy FE board search

- You can see a hotspot in the RMS 2D plot in the CDCH analyzer
- If you disconnect the signal cable of the involved board from the WDB a good noise level is recovered

HF noise investigation



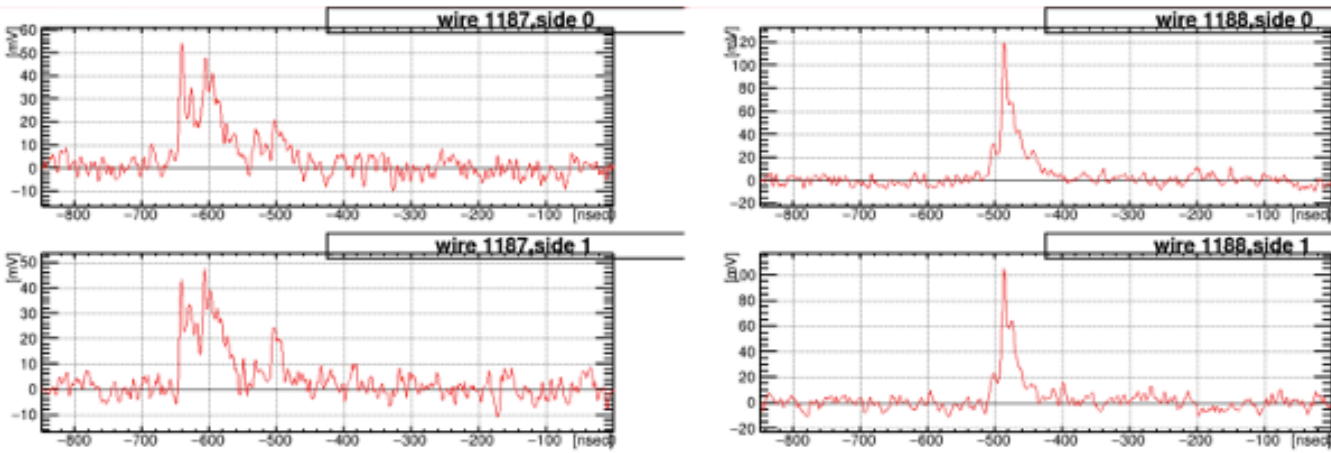
- One of the feedback resistor of the second amplification stage can touch the FE holder
 - If this component is shorted the amplifier feedback is unbalanced and the amplifier start to oscillate
 - The oscillation propagates to all the channels of the involved board
- Clearance left during the FE board mounting but during the signal cabling and likely with the higher temperatures at the LV power ON the board can slightly move
 - Signal cabling with CDCH already inside COBRA
 - Insulation (insulating varnish) and clearance of lateral components is not enough
 - This will be solved in CDCH2 with a re-design of the FE holders



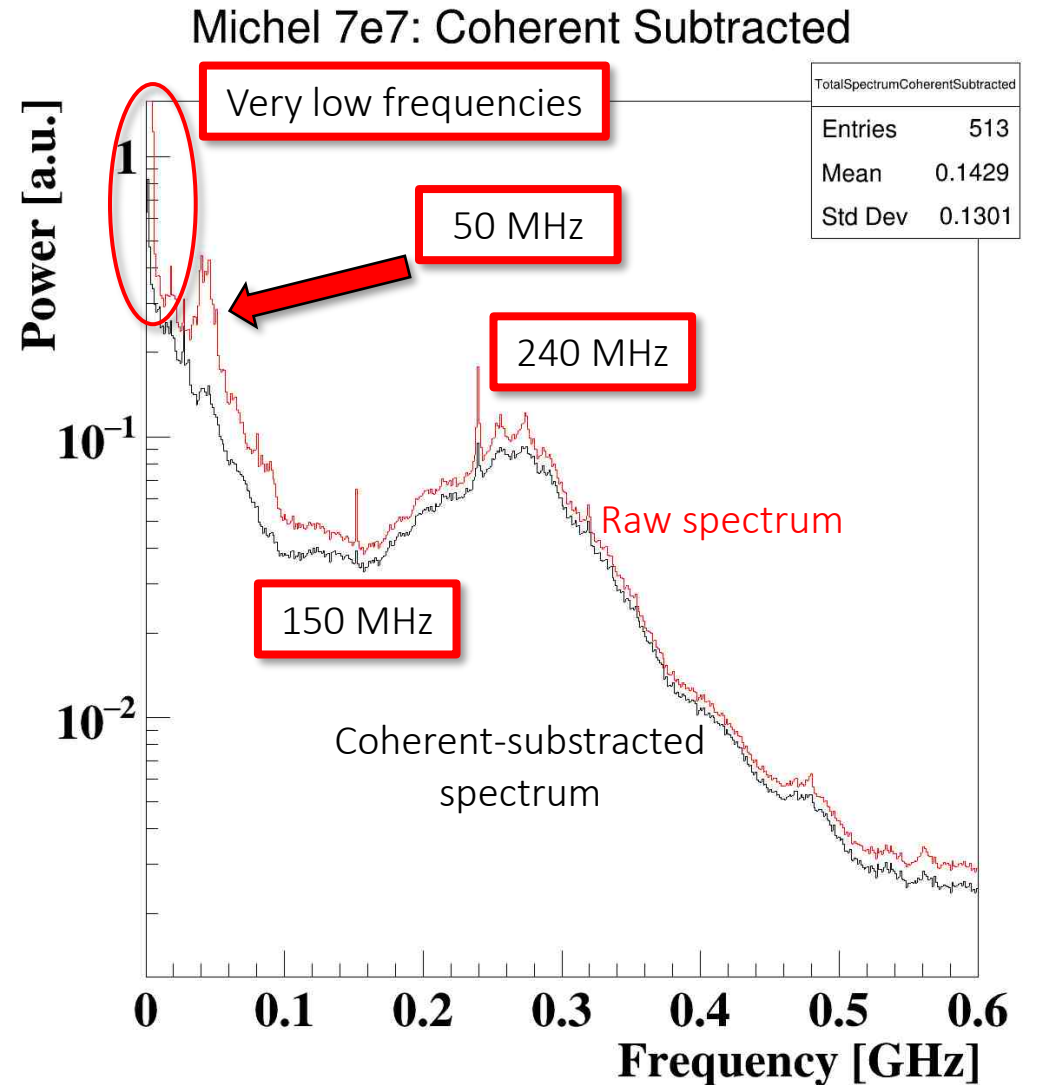
Problem reproduced
in the lab in Lecce

Signal check + noise spectrum from data

Coherent Subtracted + DFT HFC + MA



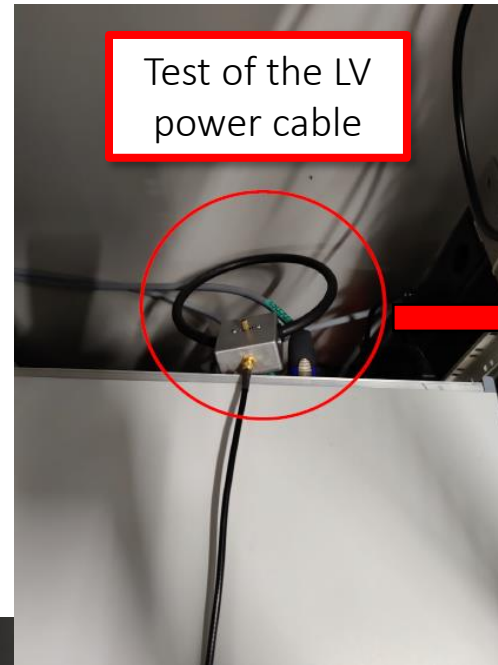
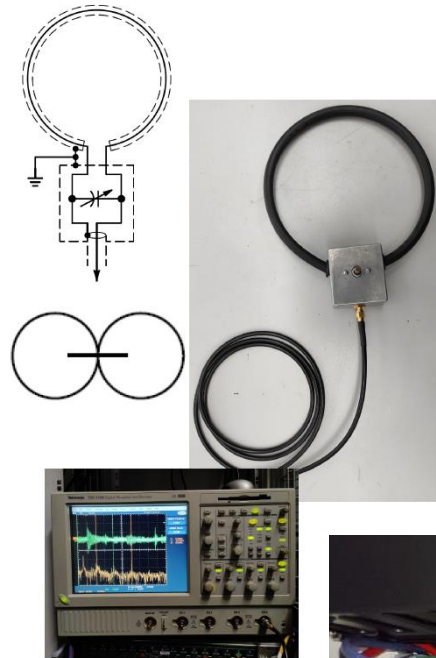
- Channels have normally voltage RMS 6-9 mV
- Coherent noise contribution clearly visible
 - Largest contributions at very low frequencies and around 50 MHz
- Investigations on the origin of the coherent component performed



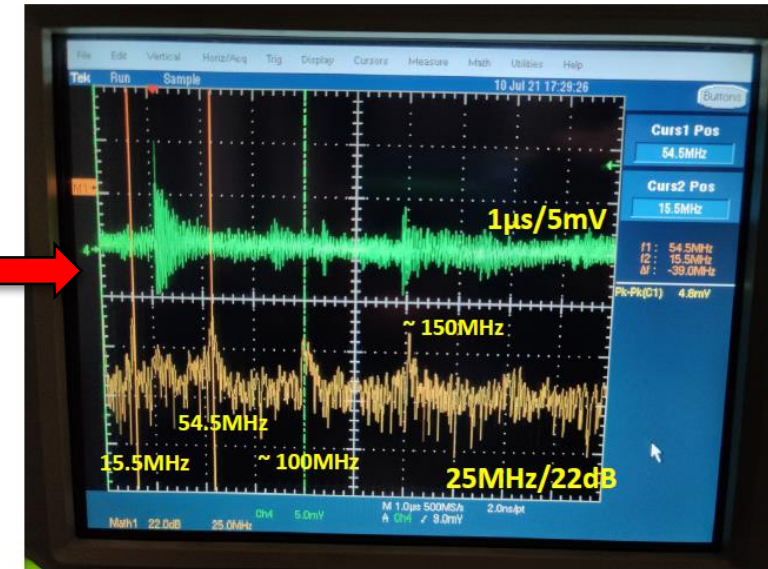
First noise investigation inside the area

The probe

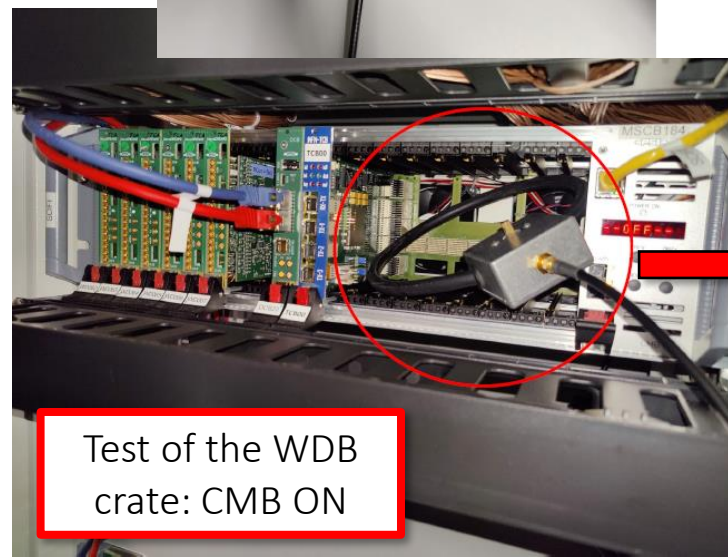
- To probe the e.m. field a **loop antenna** has been used. The antenna can be tuned by using a shielded capacitor. Diameter of the loop is about 17cm
- The pattern of the loop is balanced to indicate the direction toward the e.m. source
- The antenna is connected to an oscilloscope (Tek TDS5104 1GHz/5GSPS) though an RG58 cable
- **All the measurement has been done with the WD crates off**



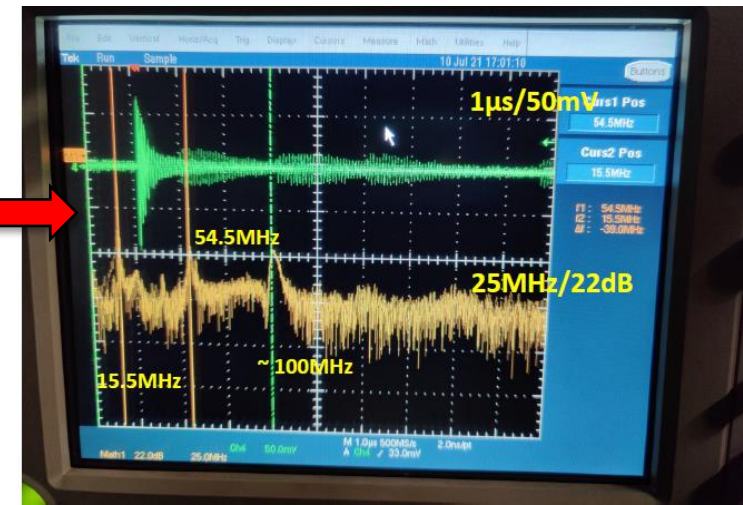
Test of the LV power cable



- CMB with old DC-DC converter
- The ≈ 15 MHz noise comes from the CDCH LV power supply modules
- One possible source of the ≈ 50 MHz noise could be the accelerator
 - Comparison between pedestal data with the accelerator ON and OFF could help to understand



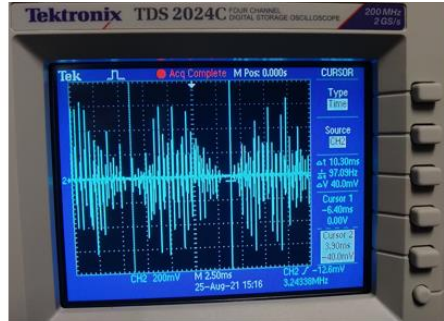
Test of the WDB crate: CMB ON



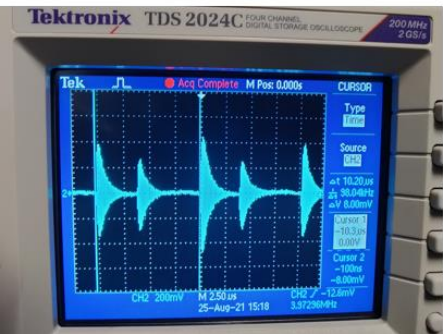
More noise investigation inside the area



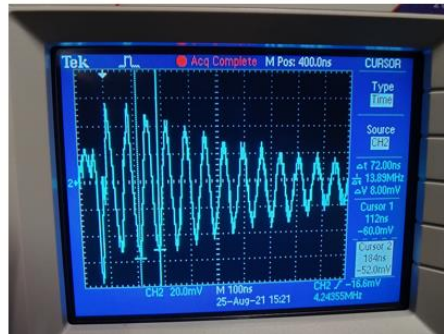
We used the noise probe by Marco P. and Alessandro C. to check the noise source at the LV module.



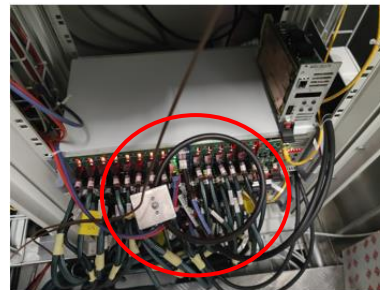
Time scale = 2.5 ms
Voltage scale = 200 mV
f = 100 Hz



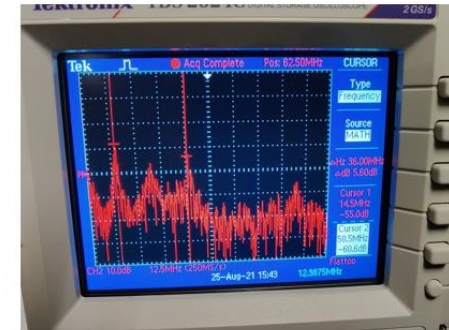
Time scale = 2.5 μ s
Voltage scale = 200 mV
f = 100 kHz



Time scale = 100 ns
Voltage scale = 20 mV
f = 14 MHz

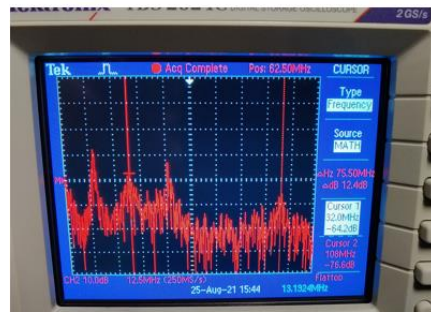


We checked the noise source at the WD crate level. The test was performed using the new CMB board with the low noise DC-DC converter.



Frequency scale = 12.5 MHz
Amplitude scale = 10 dB
f1 = 14.5 MHz
f2 = 50.5 MHz

- Test of the WDB crate
- CMB with new DC-DC converter
- Noise contributions found with the previous test confirmed
- The ferrite beads clamped on the LV power cable have no effect
- Effect only clamping the ferrites on a signal cable
 - Signal? 432 signal cables...



Frequency scale = 12.5 MHz
Amplitude scale = 10 dB
f1 = 32 MHz
f2 = 108 MHz



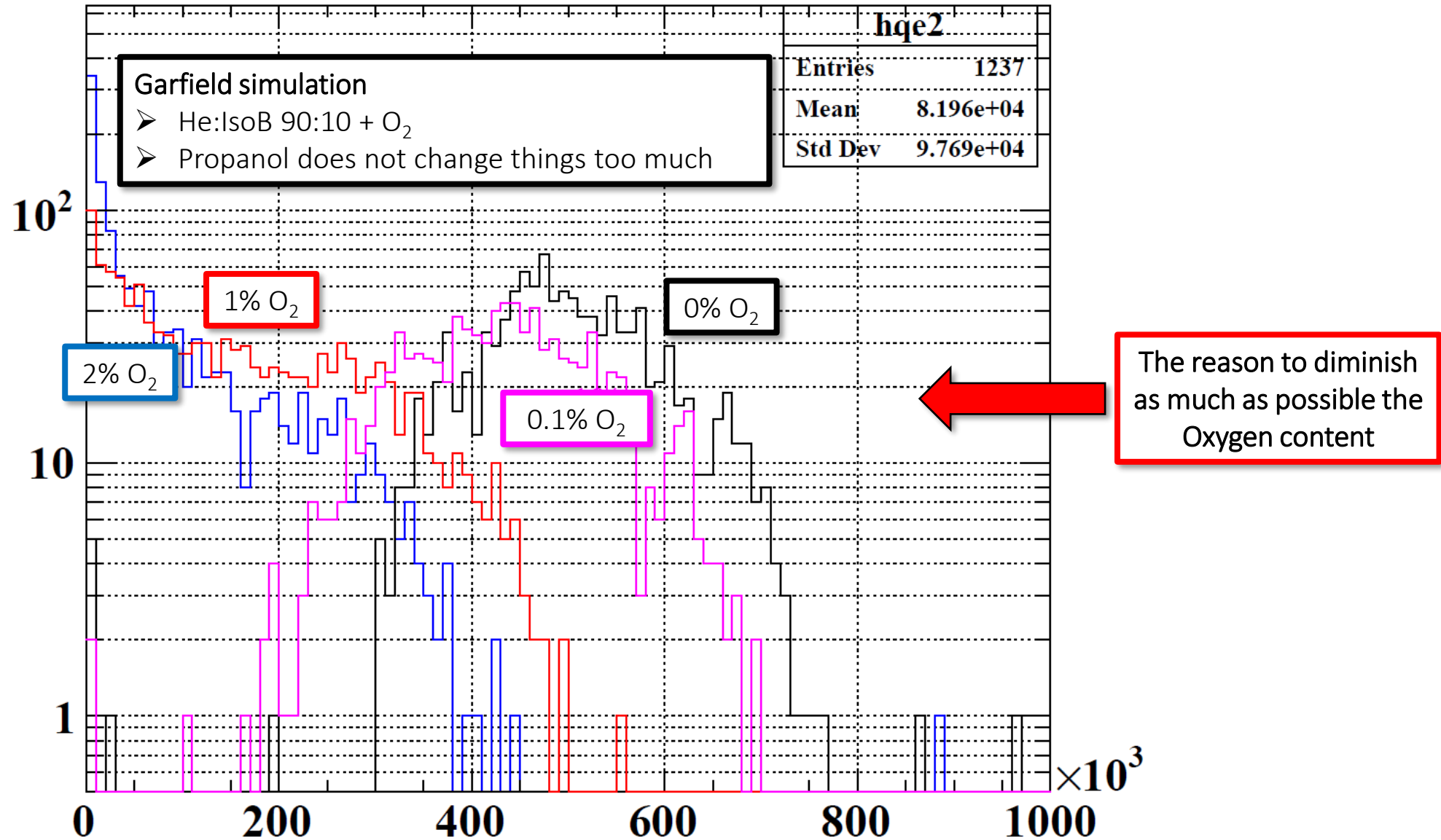
Test 0

- Ferrite components on LV cable
- Noise probe on WD crate

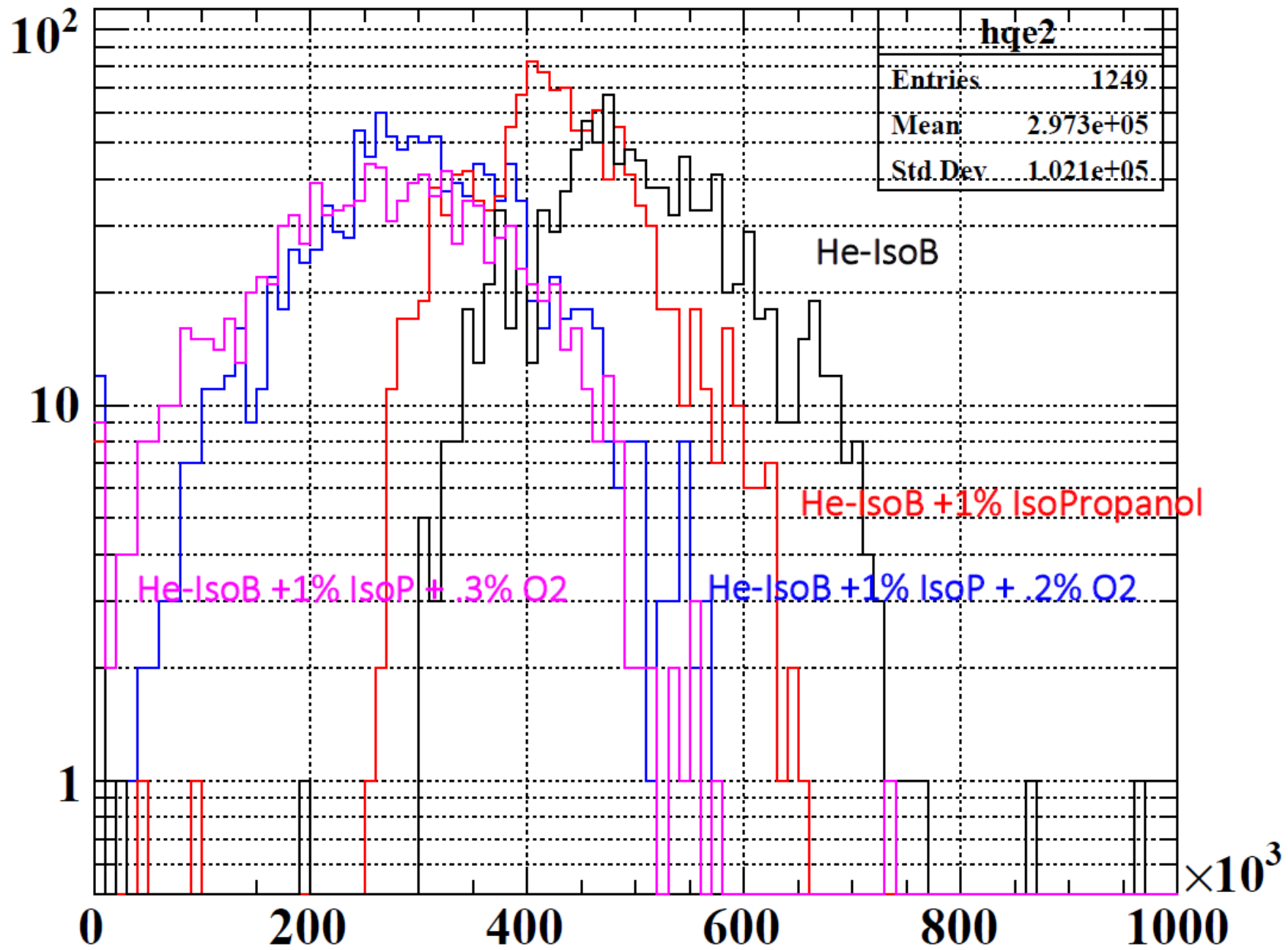
No effect.

- Test of the LV power supply module
- Found noise contributions at different time and amplitude scales

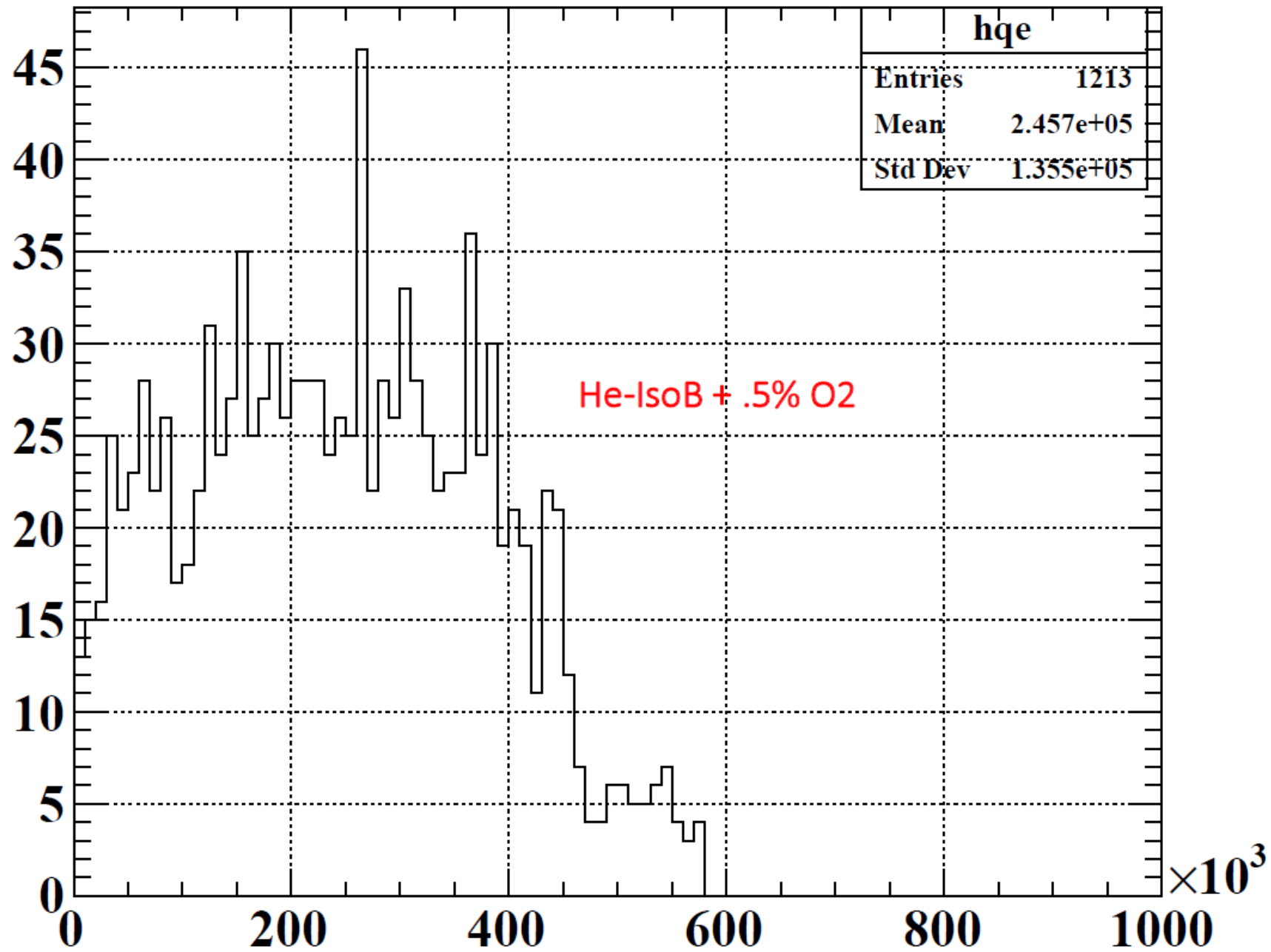
Charge per electron vs. O_2 content



Charge per electron

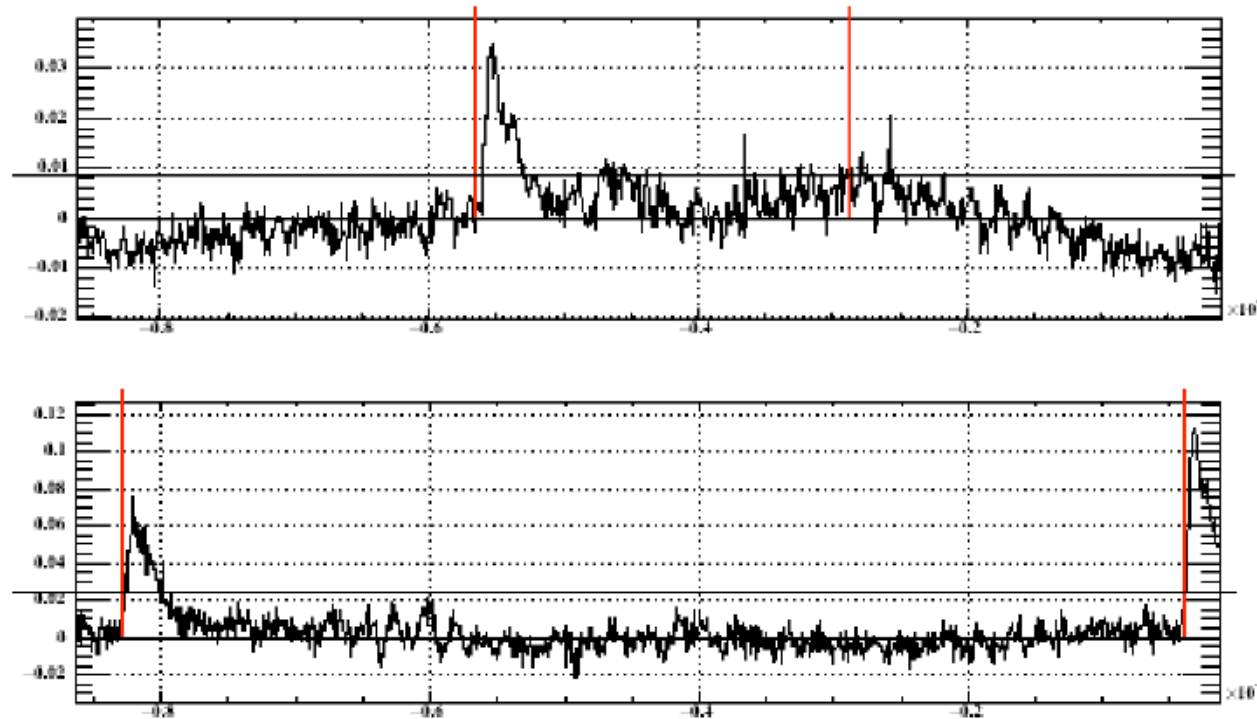


Charge per electron



Impact of O_2 from 2020 data

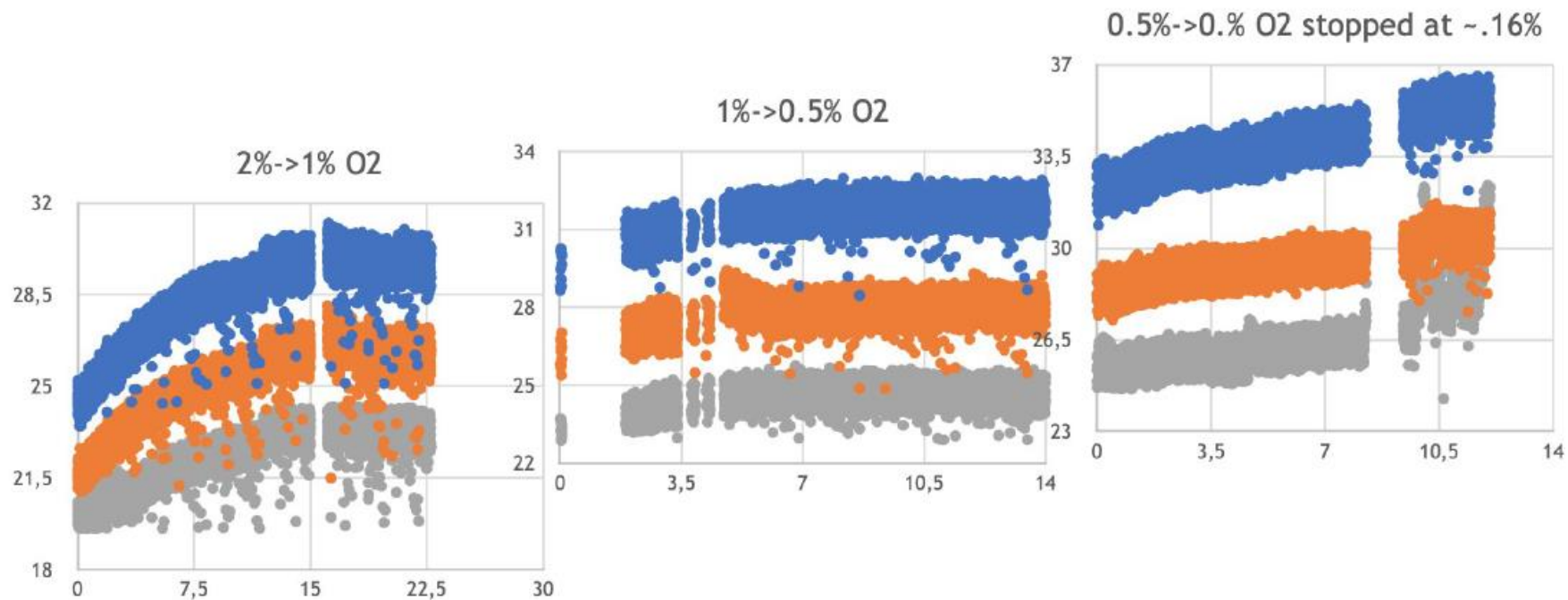
Muon beam data, 2% O_2 + 1% isopropyl alcohol



- We do not observe evident pathologies looking at the raw waveforms with the addition of O_2

Impact of O₂ from 2020 data

- Effect (similar in magnitude) observed on currents drawn by the HV power supplies (16 wires per channel)



Expected Current $\sim 5 \times 10^5 \times 16\text{ch} \times 1.3 \text{ Mhz/ch} \times 15\text{e} \sim 25 \mu\text{A}$

Gas gain

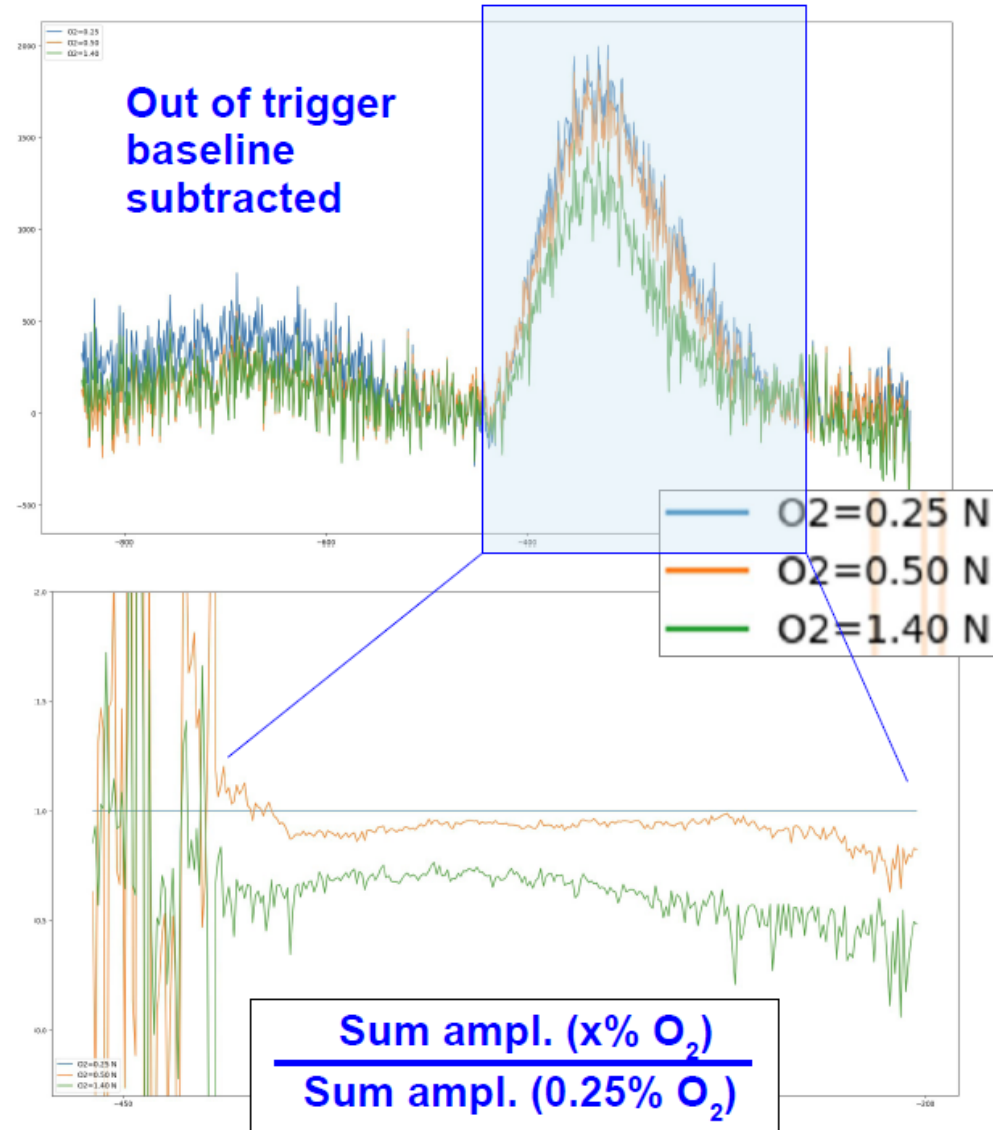
Hit rate

#electrons per hit

Impact of O₂ from 2020 data

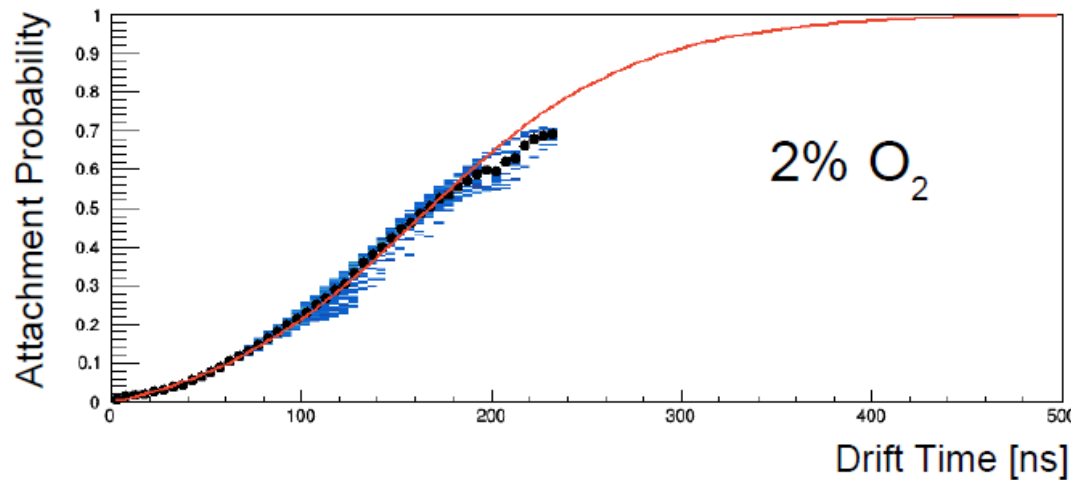
Muon beam data (1% isopropyl alcohol)

- Summing up many waveforms, with the addition of O₂ we observe a decrease of the size of hits
 - 20-30% loss with 1-2% O₂
- The decrease is larger at larger hit times, as expected from attachment



Impact of O₂ from 2020 data

- We modeled the attachment in the MC according to the expectations from GARFIELD as a function of the drift time



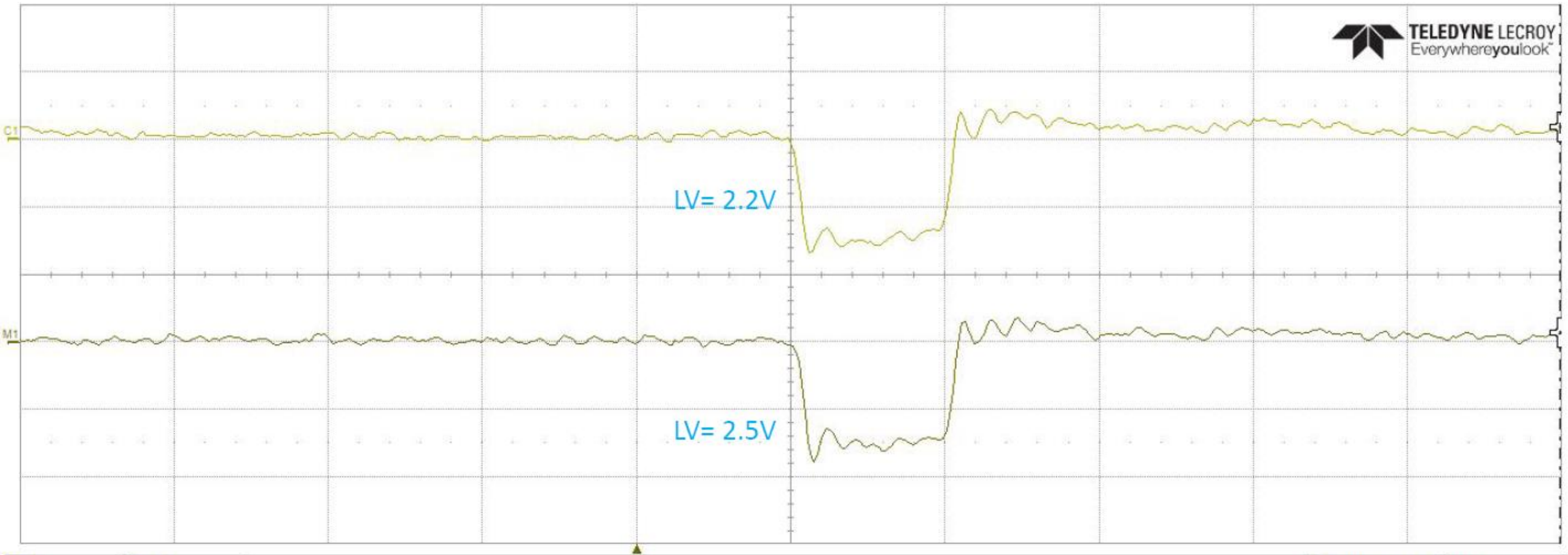
**GARFIELD with 1/6
suppression of
attachment**

O ₂ conc. [%]	Positron Efficiency [%] ± 1.0%	Momentum Resolution [keV] ± 3 keV	Angular Resolution [mrad] ± 0.15 mrad
0	64.6	96	6.7/6.7
0.5	62.5	95	6.7/6.2
1	62.7	94	6.5/6.4
2	58.2	97	6.6/6.3

Impact of O₂ from 2020 data

- We have some preliminary indication that the effect of O₂ is overestimated by GARFIELD
- Our measurements on data suggest ~ 20-30% signal size loss with 1-2% O₂, with some trends vs. time indicating that it *partially* comes from the attachment
- In cosmic ray tracks, 7-9% of hit loss, caused by the attachment of the first cluster
- If we assume that there is a factor 6 overestimate of the attachment in GARFIELD, we mainly expect a small loss of positron reconstruction efficiency with 0.5 and 1% O₂ and a more substantial one with 2% O₂
 - N.B. MEG II sensitivity is at most linear in efficiency x DAQ time (*zero background regime*)

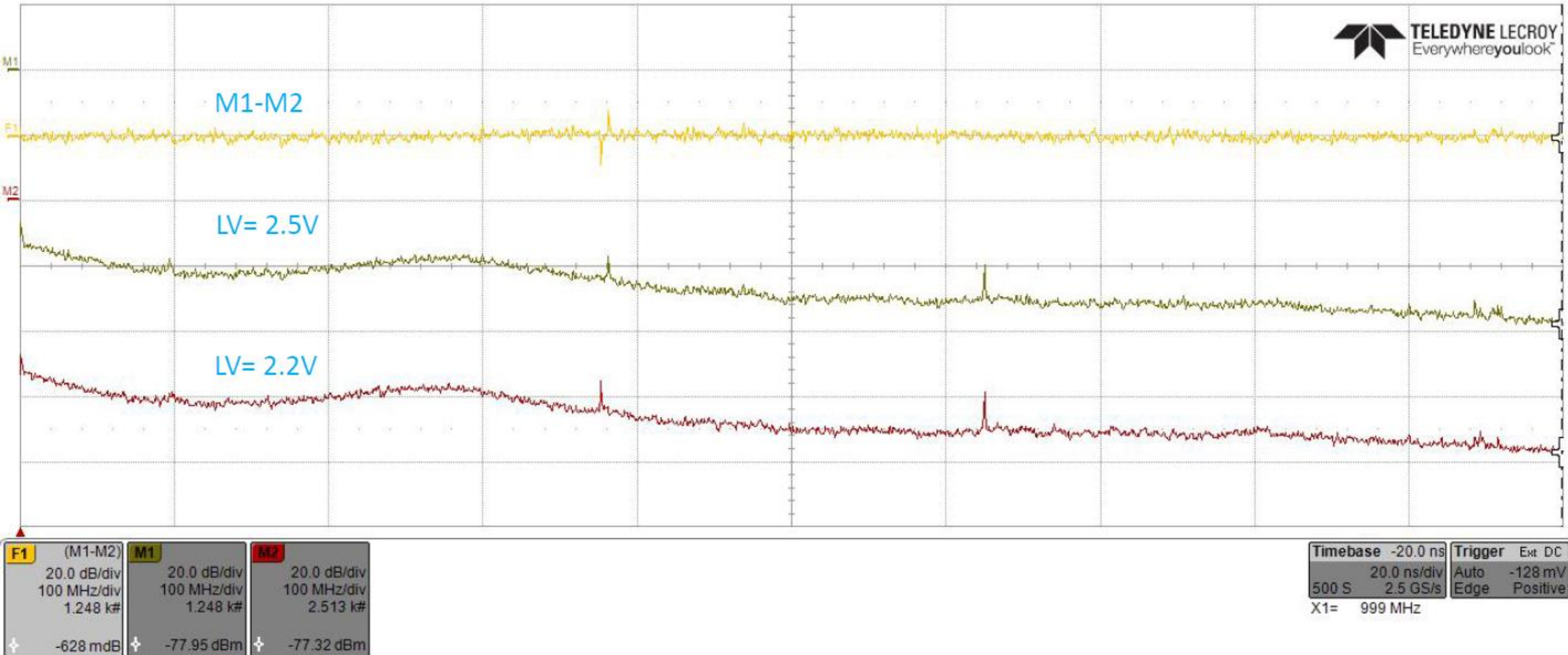
Pulse response vs. LV applied (bench test)



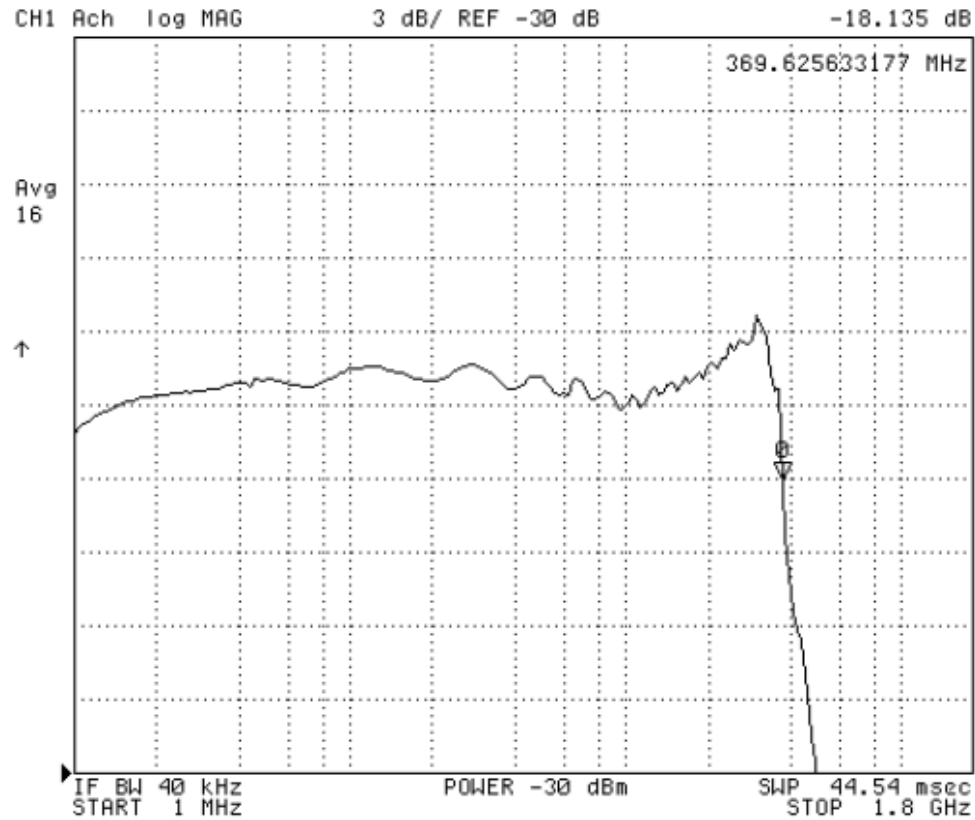
C1	DC	M1
200 mV/div	401.50 mV	200 mV/div
37.89 mV		20.0 ns/div
		27.72 mV

Timebase	-20.0 ns	Trigger	Ext DC
	20.0 ns/div	Norm.	-128 mV
500 S	2.5 GS/s	Edge	Positive
X1=	120 ns		

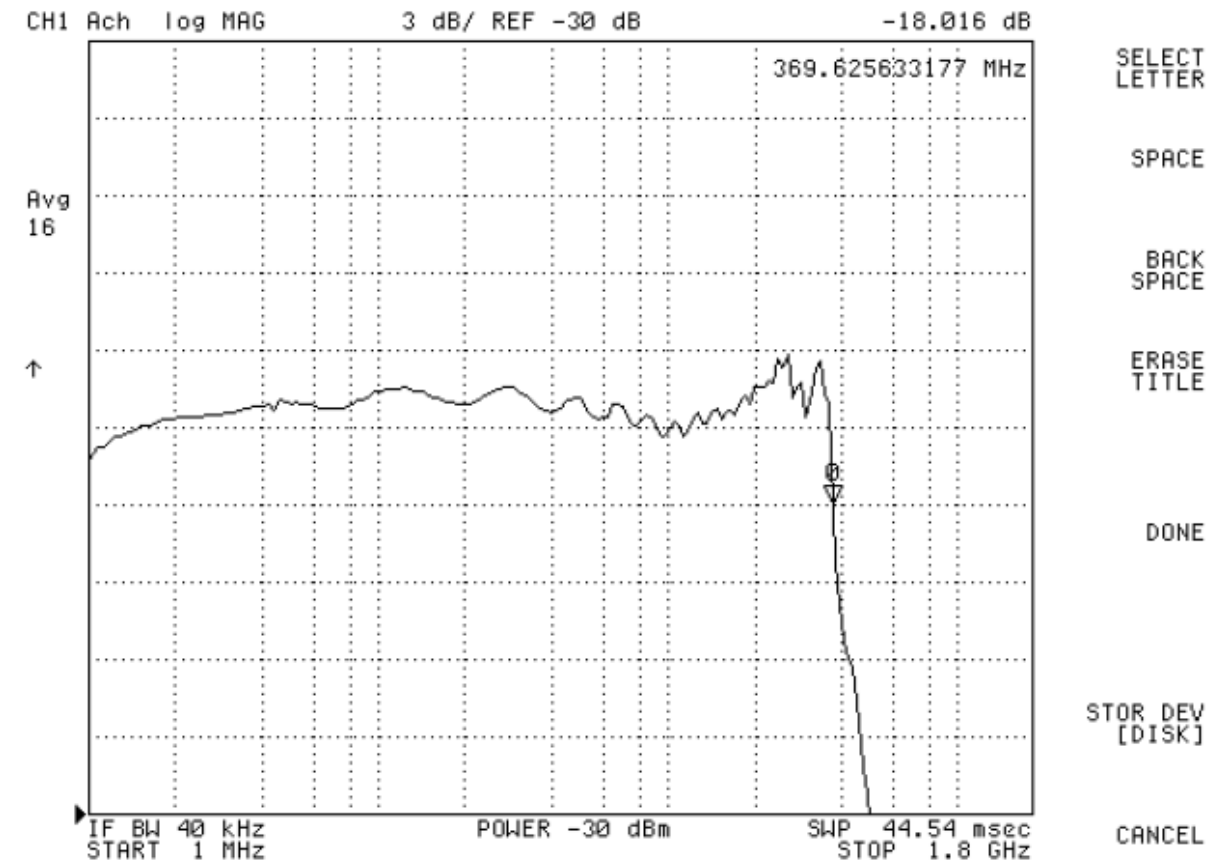
Noise spectrum vs. LV applied (bench test)



Bandwidth vs. LV applied (bench test)

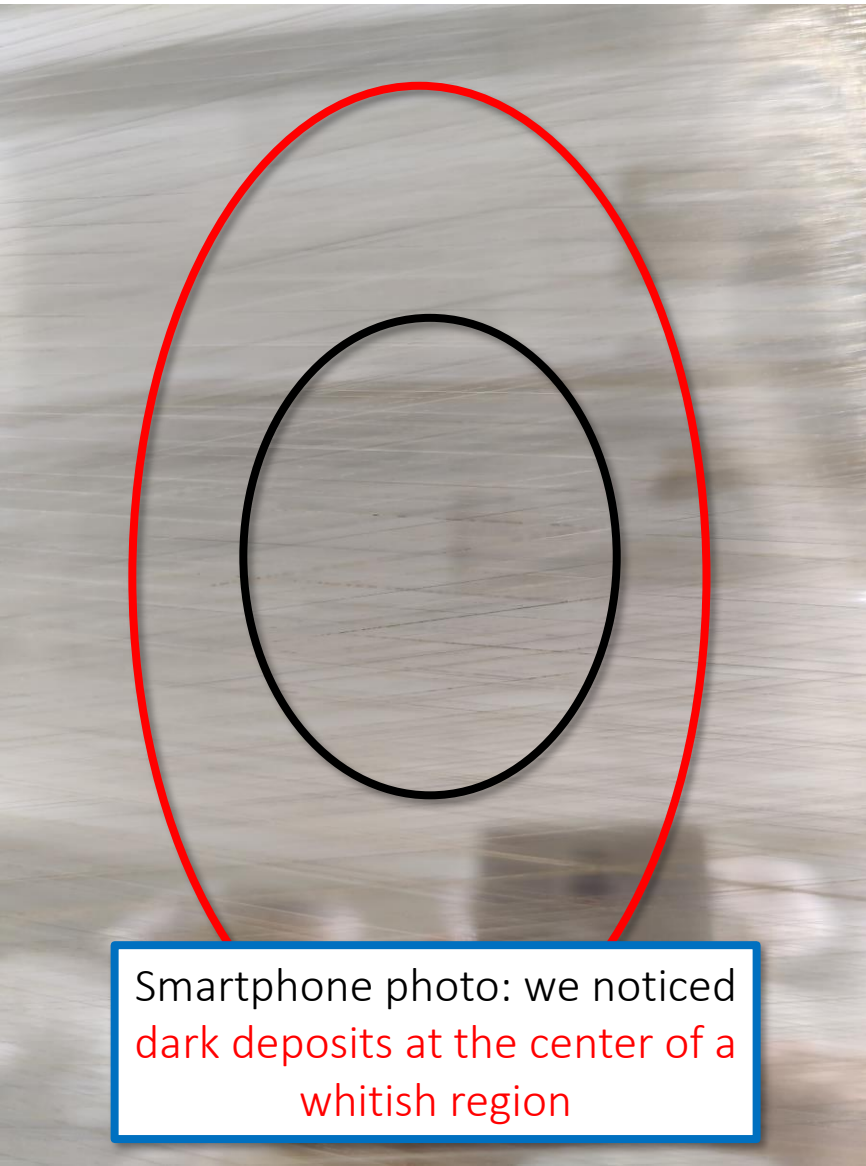


LV=2.5V

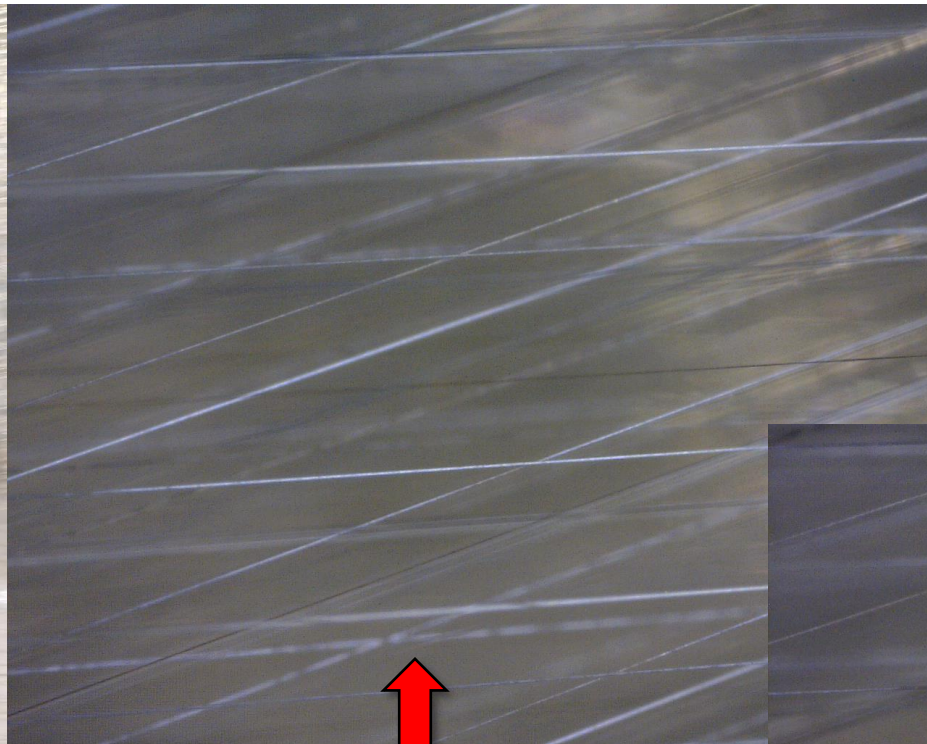


LV= 2.2V

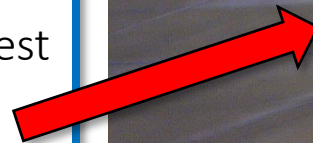
Looking closely at the whitish regions



Smartphone photo: we noticed dark deposits at the center of a whitish region



Microscope photos confirmed the white wire portions (different surface than the rest of the chamber) and dark deposits at the center



Corona discharges at Pisa

- Do white zones (deposit?) lower the corona discharge HV limit?
- Corona discharges might cause dark deposits on wires as observed in Pisa with a more powerful power supply
- They occurred **naturally** at 2300 V (100-200 μ A currents) with 40 μ m cathode wire diameter and brand-new wires (no damaged surface)
 - Known phenomenon: but **why** at 1400 V?
 - We need to understand the nature of the white zones

Electron plasma from the cathode wire (point-like fixed source) to the anode wire (diffusion)

20 μ m anode:
+HV

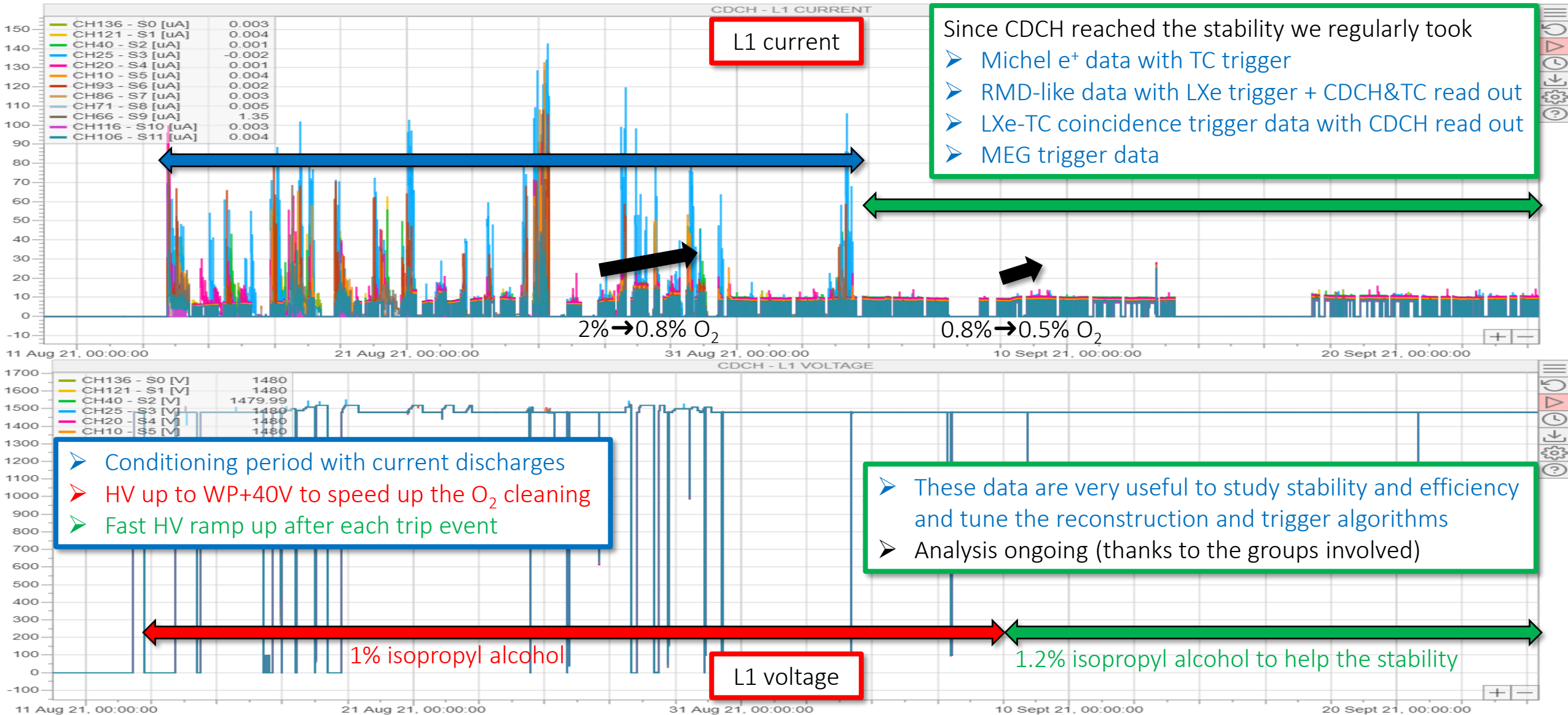
40 μ m cathode:
ground

Faint phenomenon only visible in a dark room: not easy to take a picture

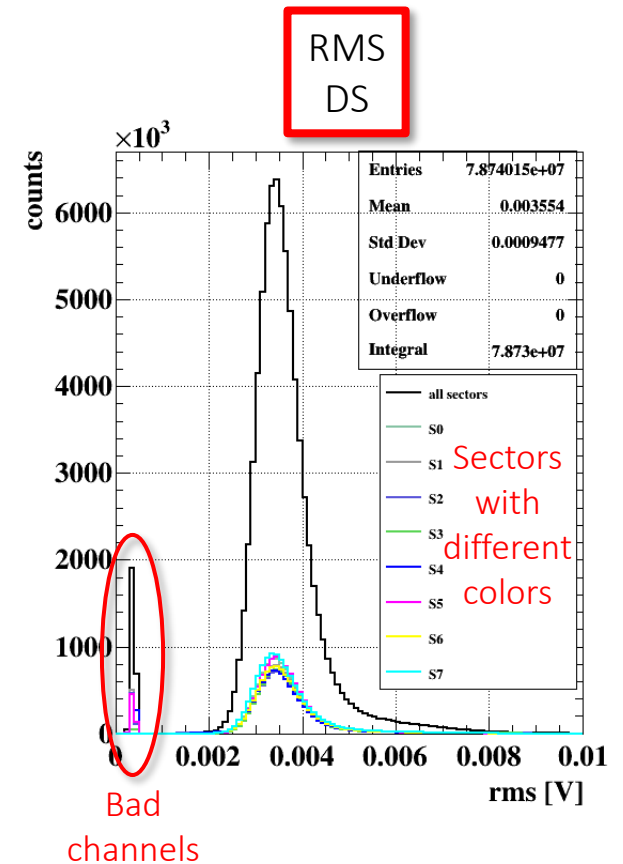
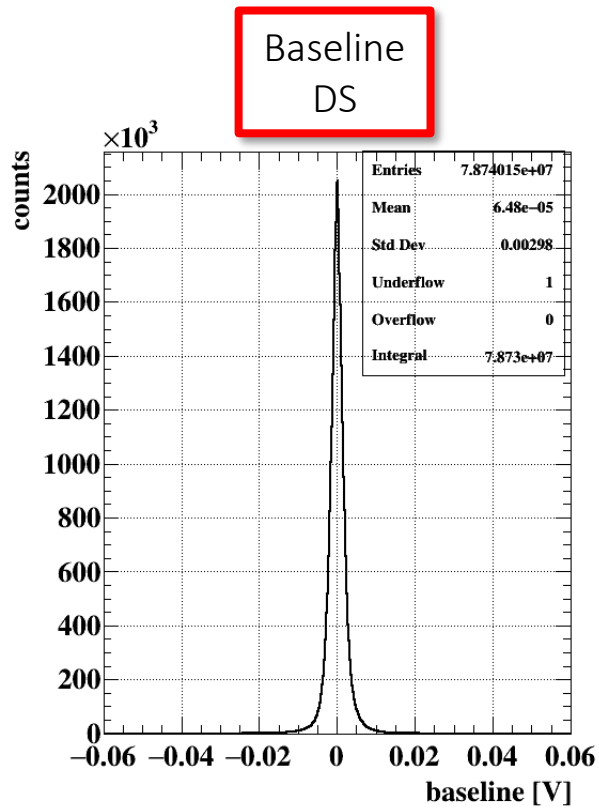
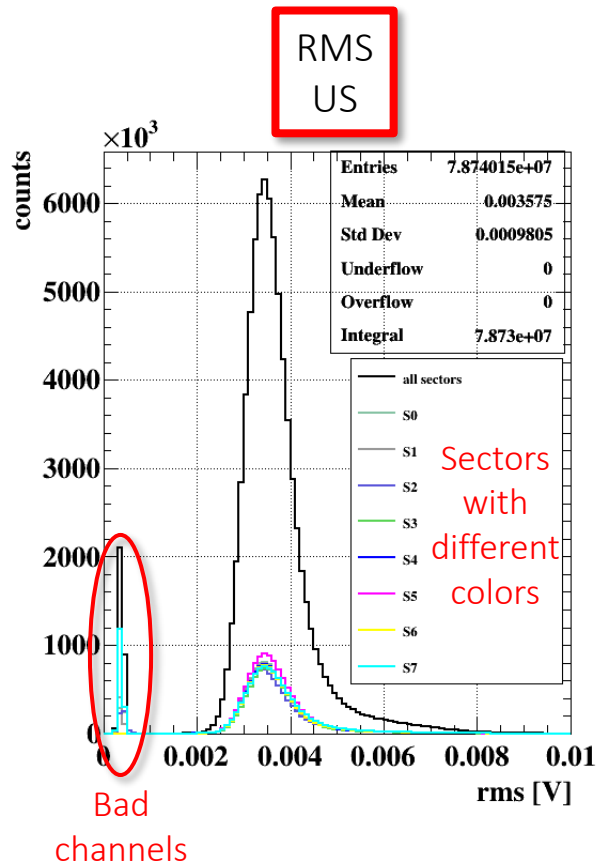
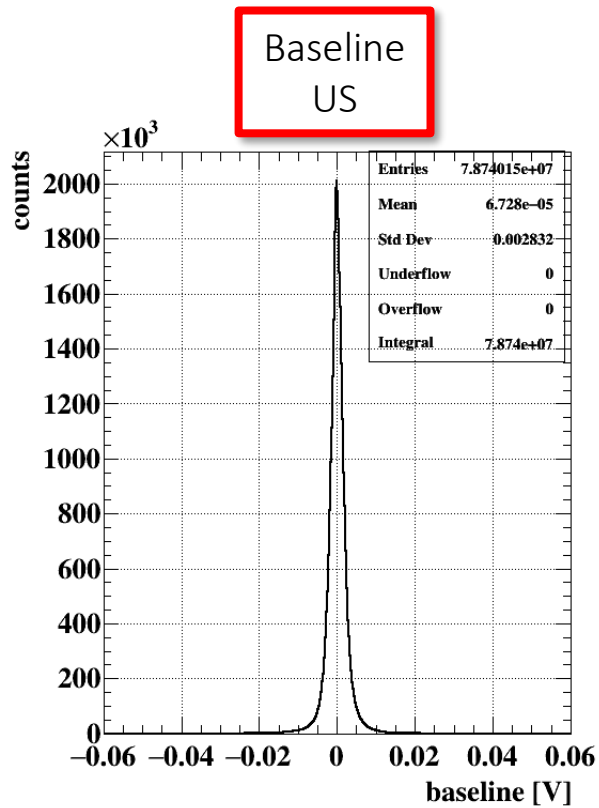
Dark deposits
on wires after
a few minutes



CDCH conditioning with beam 10/08-24/09



Some diagnostic plots from Michel e⁺ data



Some diagnostic plots from Michel e⁺ data

Baseline US
wire by wire

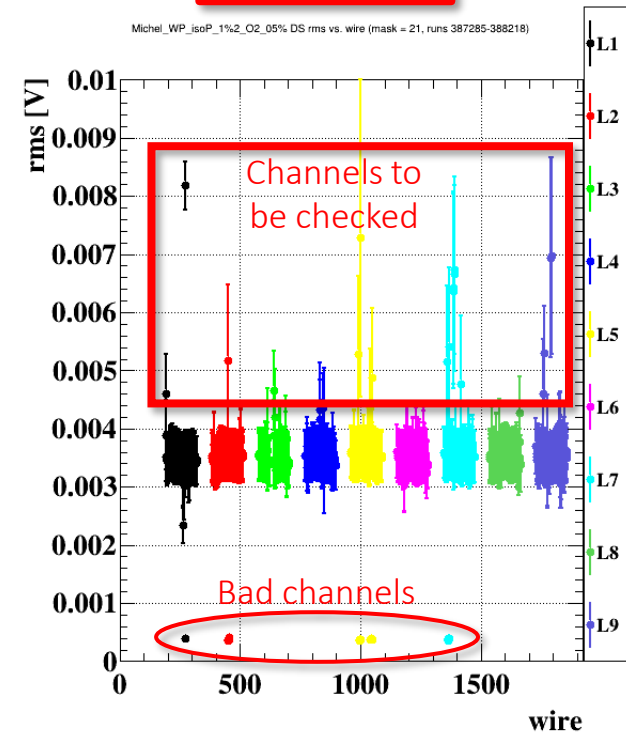
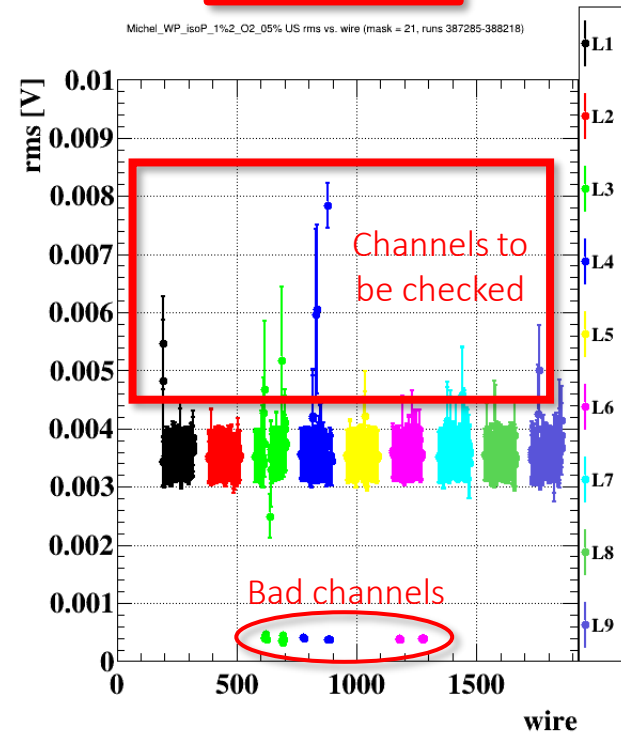
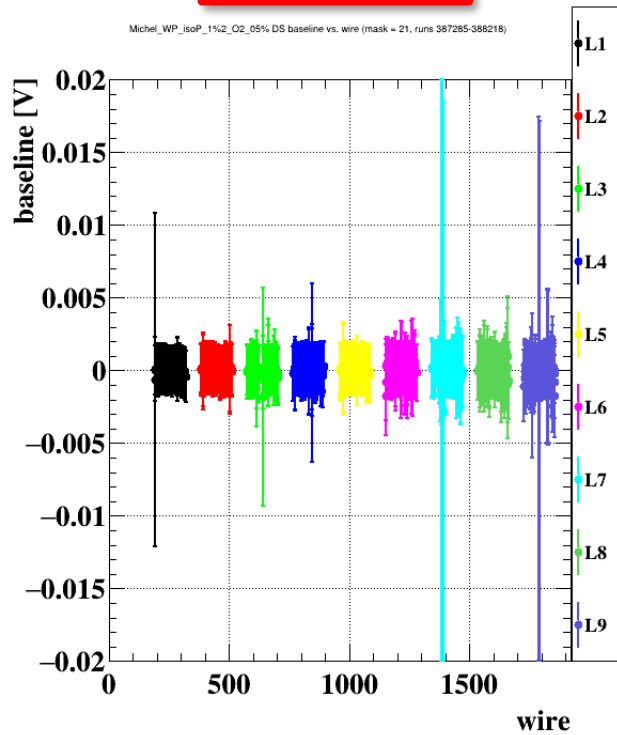
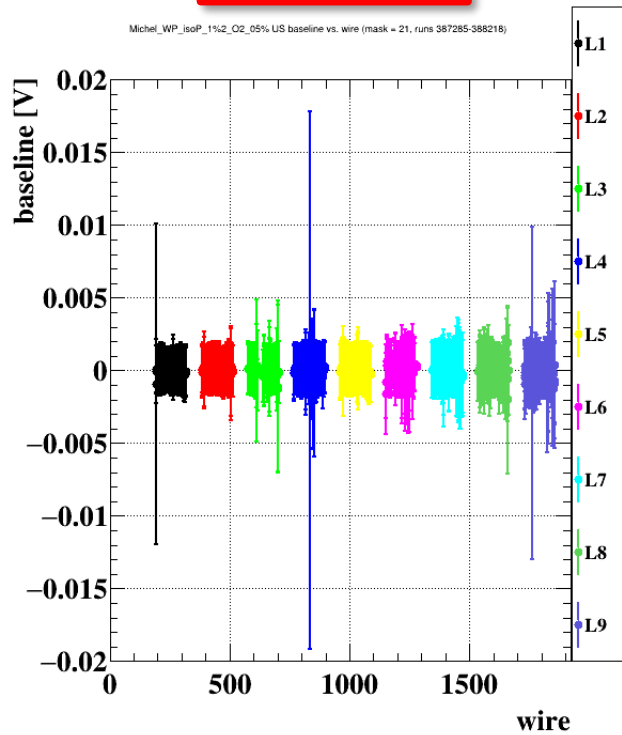
Layers with
different colors

Baseline DS
wire by wire

RMS US
wire by wire

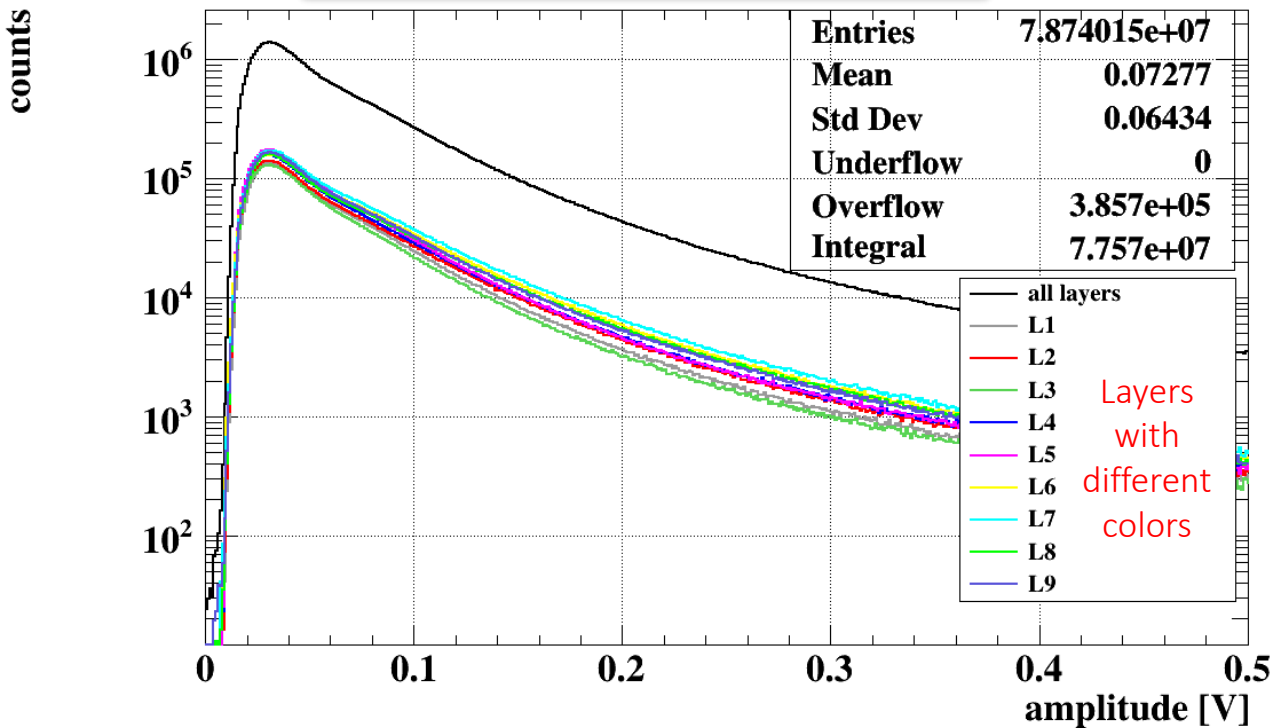
Layers with
different colors

RMS US
wire by wire

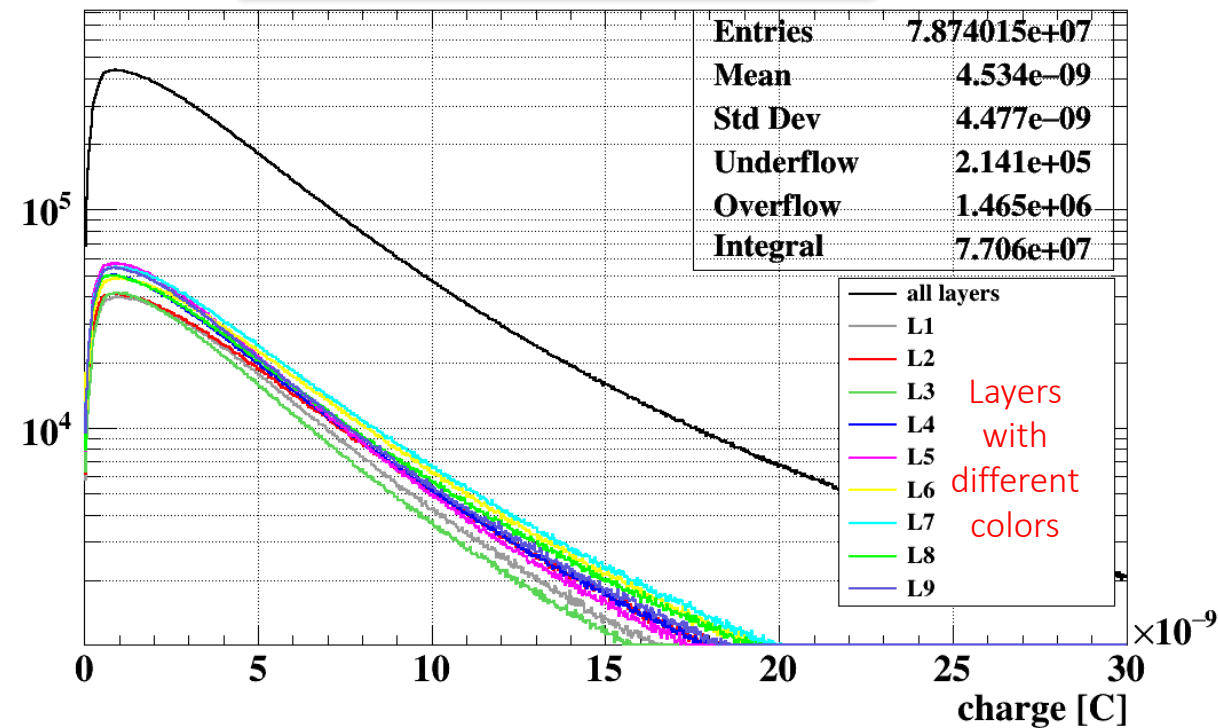


Some diagnostic plots from Michel e⁺ data

US + DS signal amplitude distribution



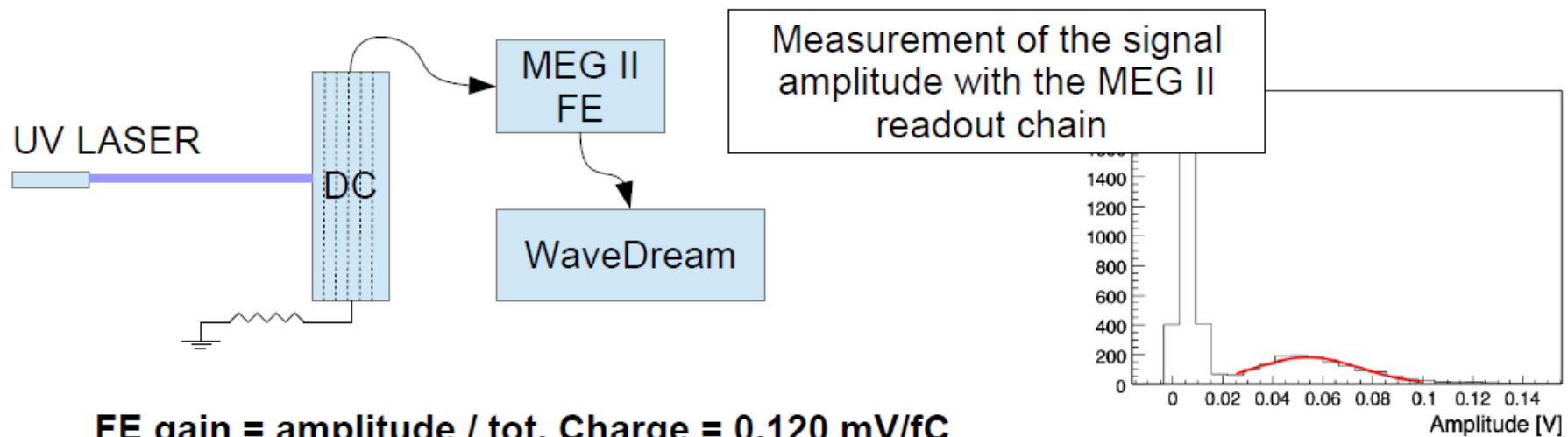
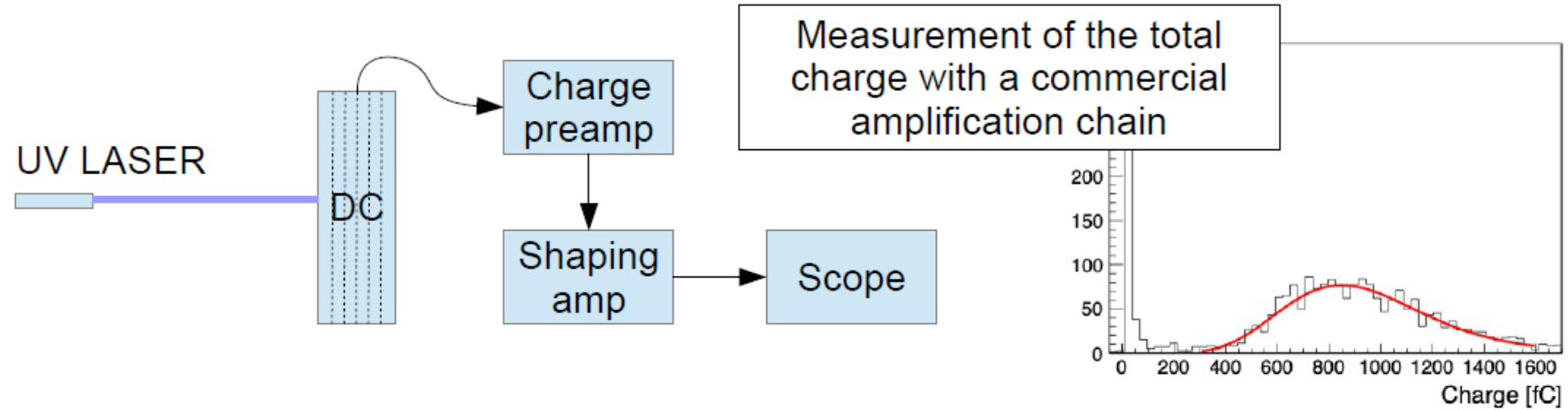
US + DS signal charge distribution



Good uniformity by layer thanks to the 10 V scaling of the HV

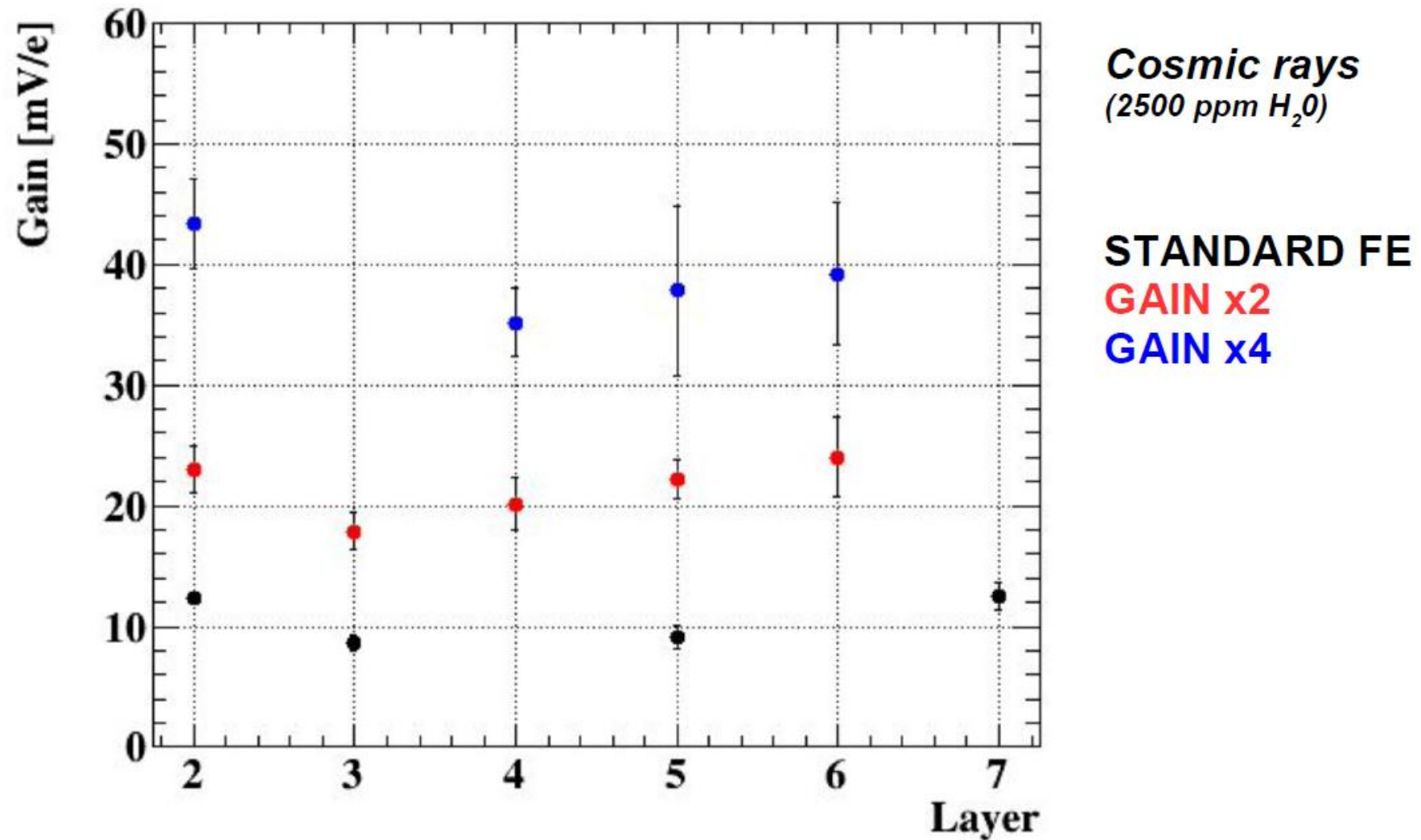
FE gain measurement

- Measurement of the FE response to real single-electron drift chamber signals produced by laser ionization on a prototype

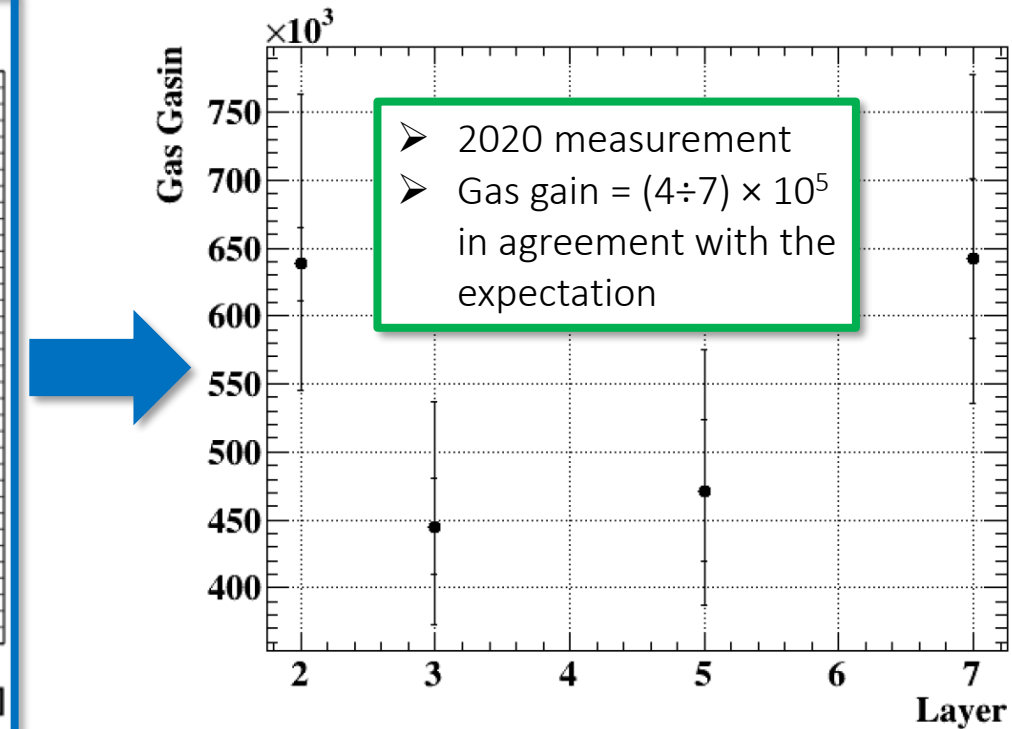
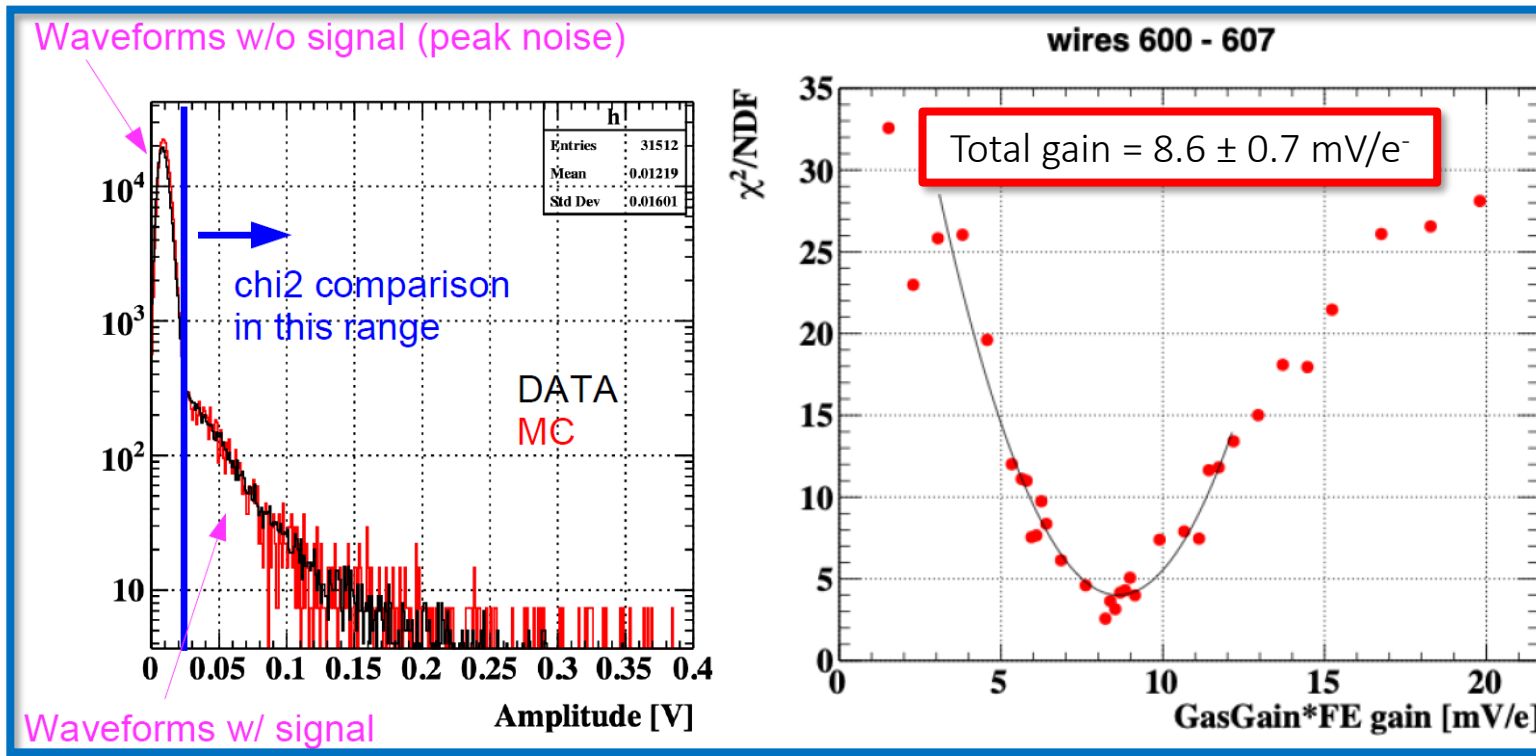


FE gain = amplitude / tot. Charge = 0.120 mV/fC

Total gain with different FE



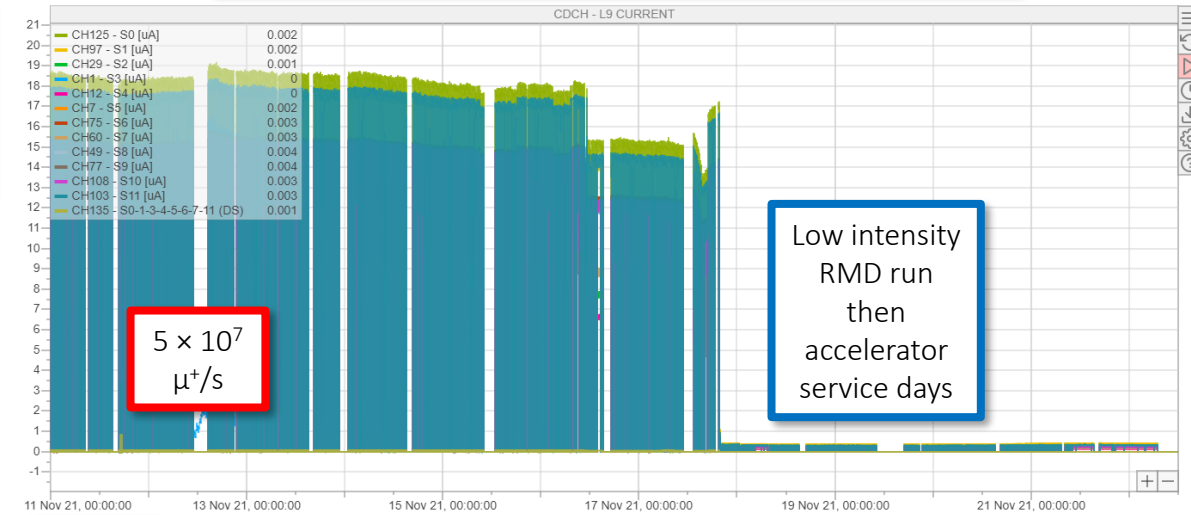
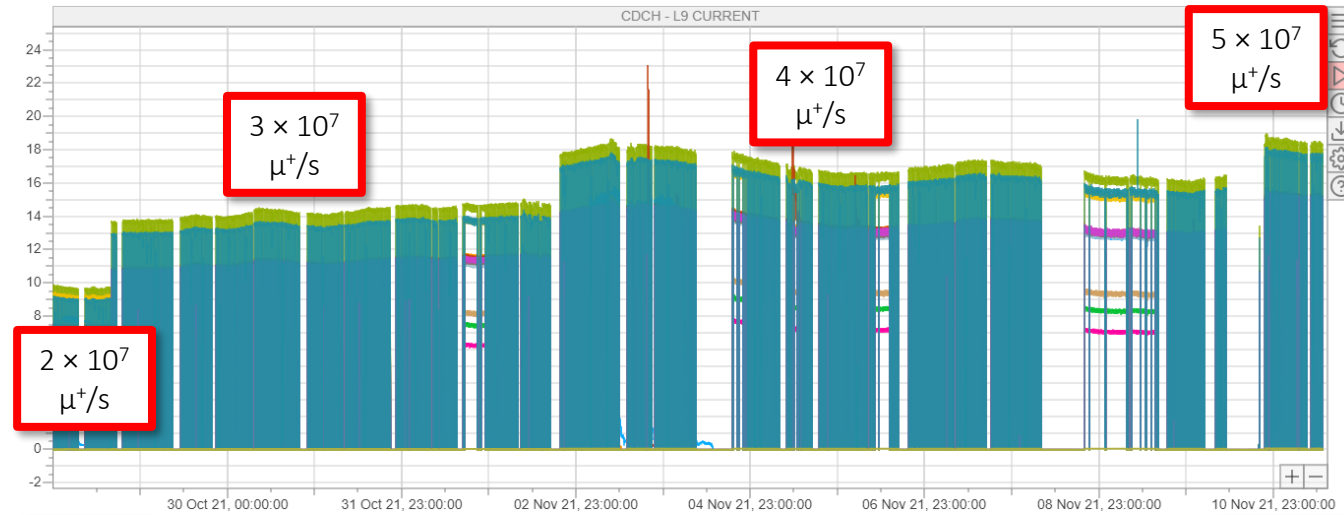
Gain measurement



- Signal amplitude distribution from Cosmic Ray events: clean environment
- The only parameter to be tuned in MC to reproduce data is the Total gain = Gas gain × FE gain
- FE gain measured to be 0.120 mV/fC
 - FE response to real single-electron drift chamber signals produced by laser ionization on a prototype
- Gas gain = Total gain / FE gain

CDCH currents stability

Currents correctly follow the beam intensity



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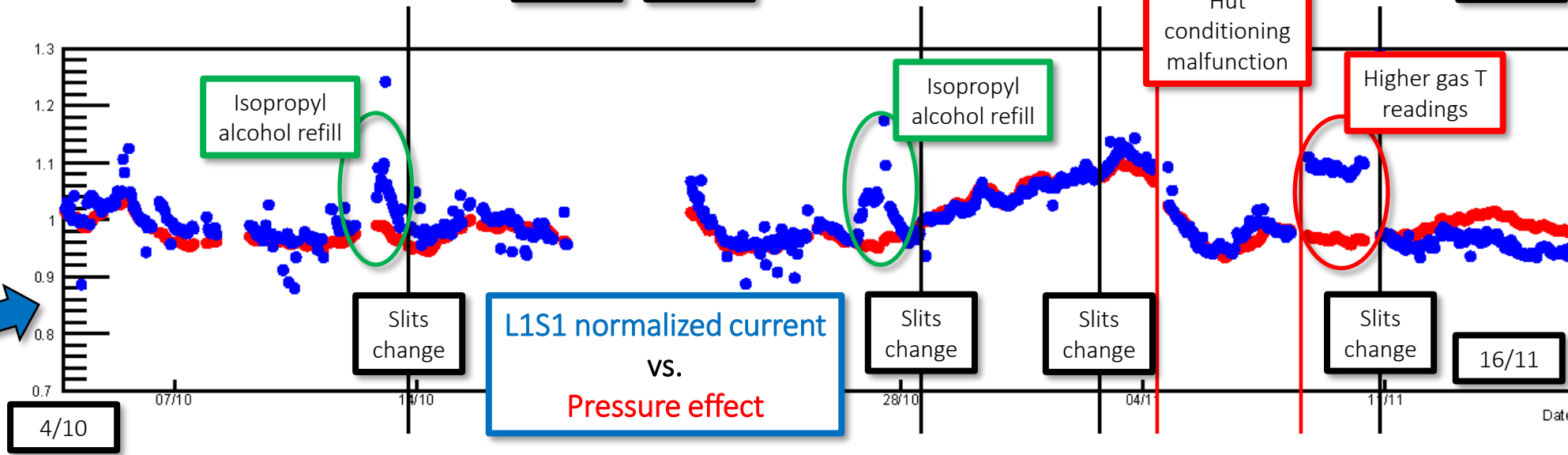
11/11

22/11

- With CDCH stable we see the gas gain variations with the atmospheric pressure (gas density)

$$\frac{\Delta G}{G} = -k \frac{\Delta P}{P}$$

- L1S1 currents (normalized to the initial values) corrected by T, proton current and slits changes

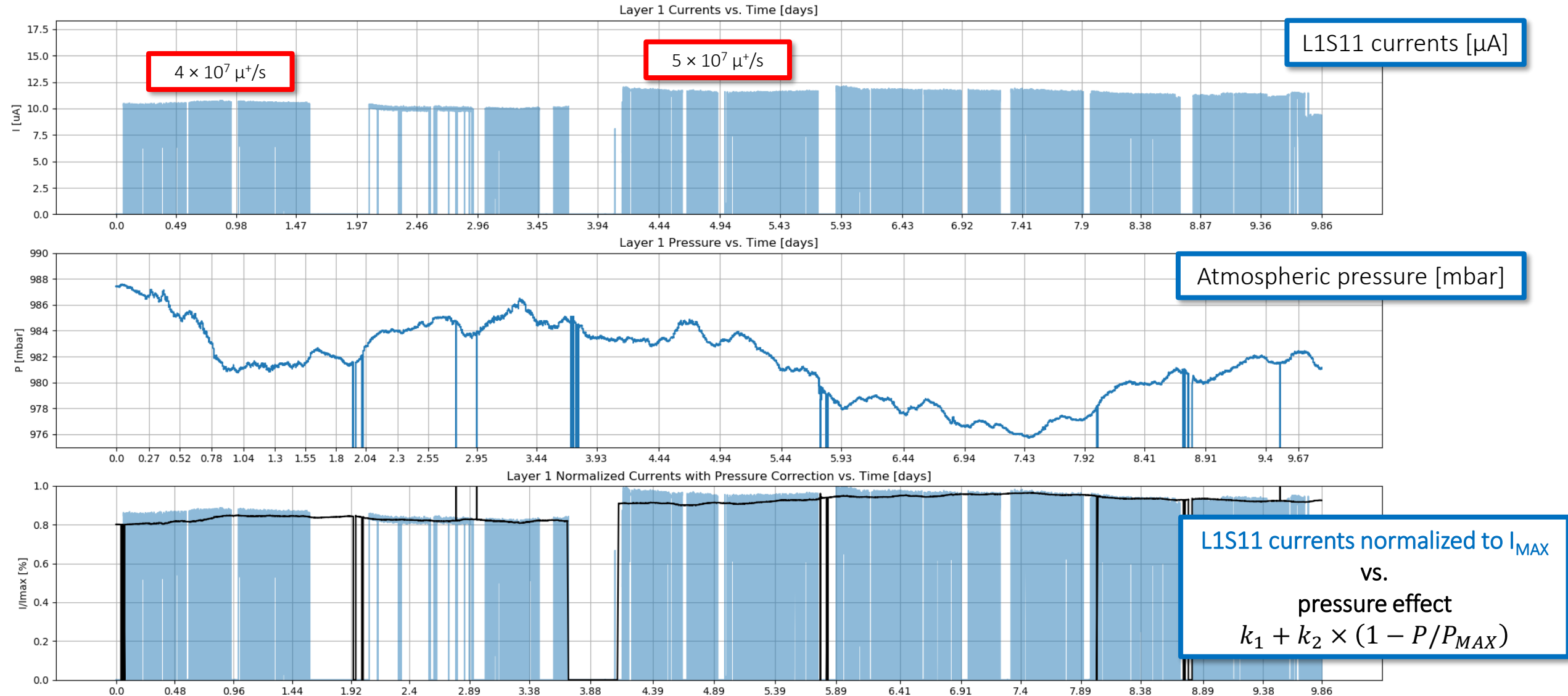


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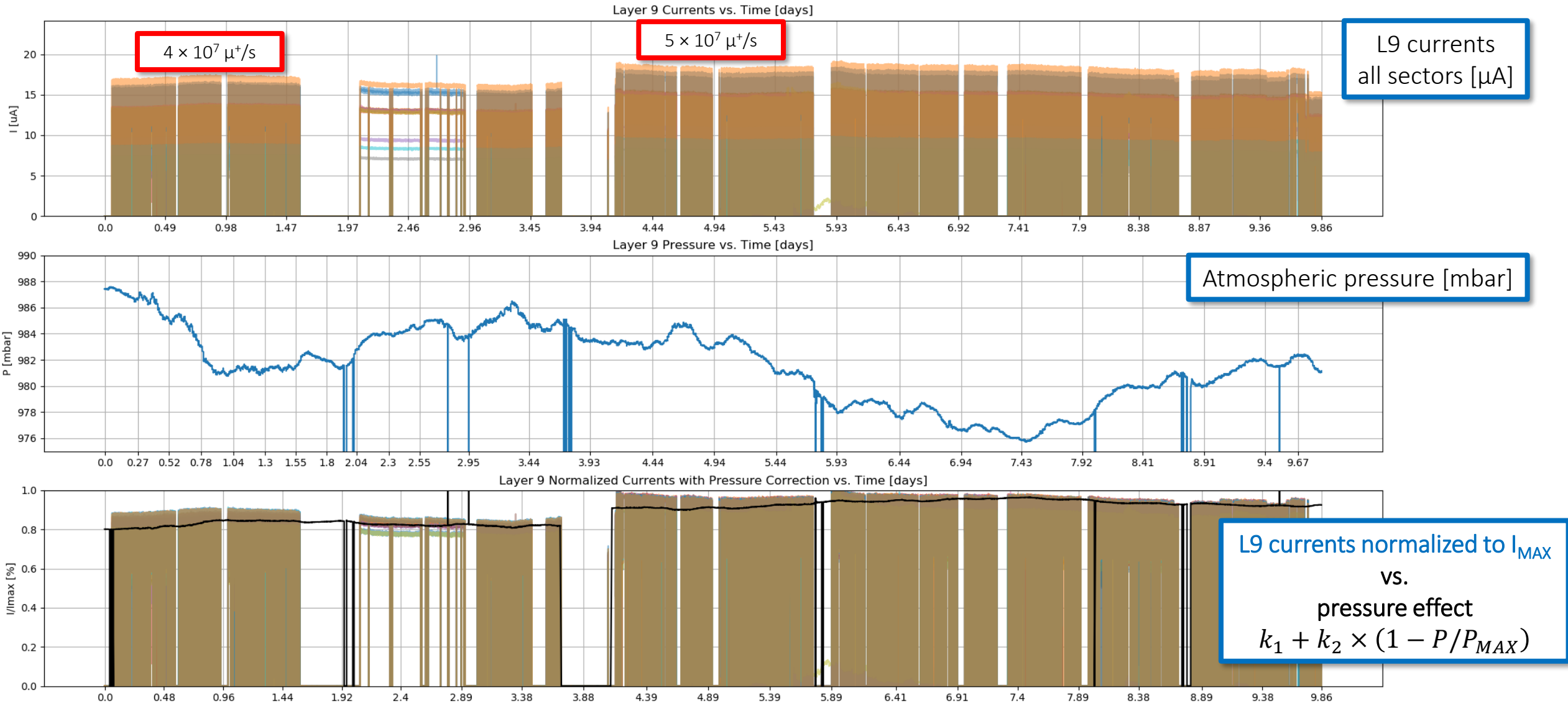
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L1S1 normalized current vs. Pressure effect

Currents (4-14/11) vs. atmospheric pressure



Currents (4-14/11) vs. atmospheric pressure

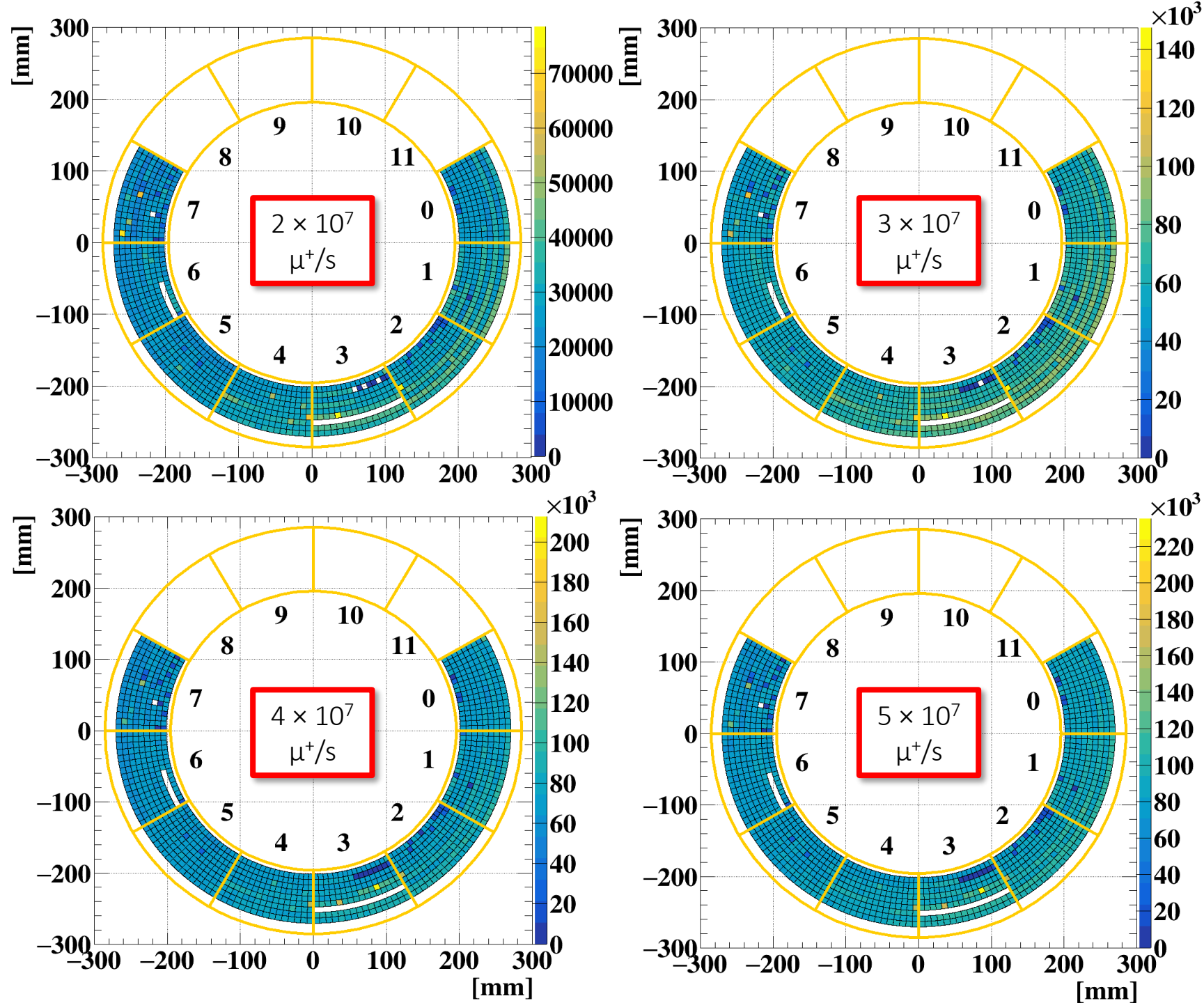


Occupancy

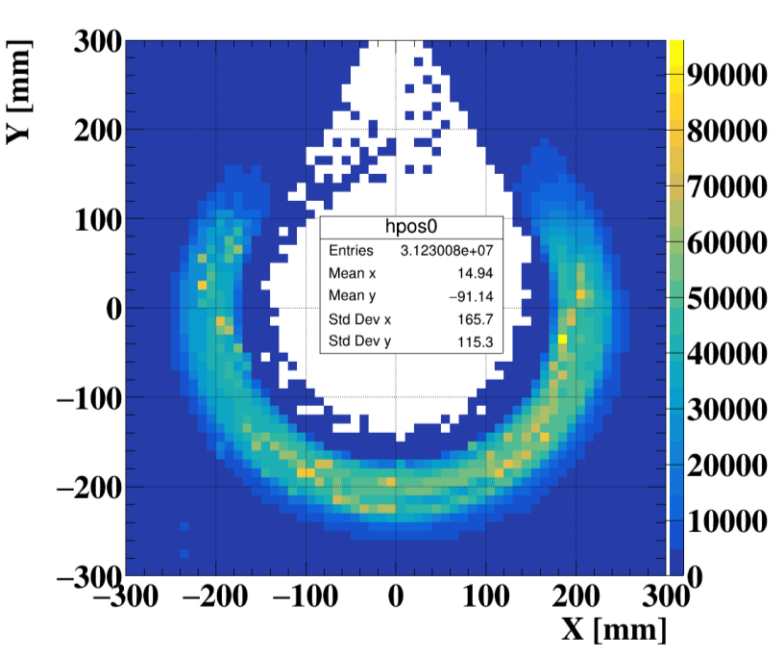
- MEG trigger (mask 0)
- 79 runs for each beam intensity

- 2×10^7
- 3×10^7
- 4×10^7
- 5×10^7

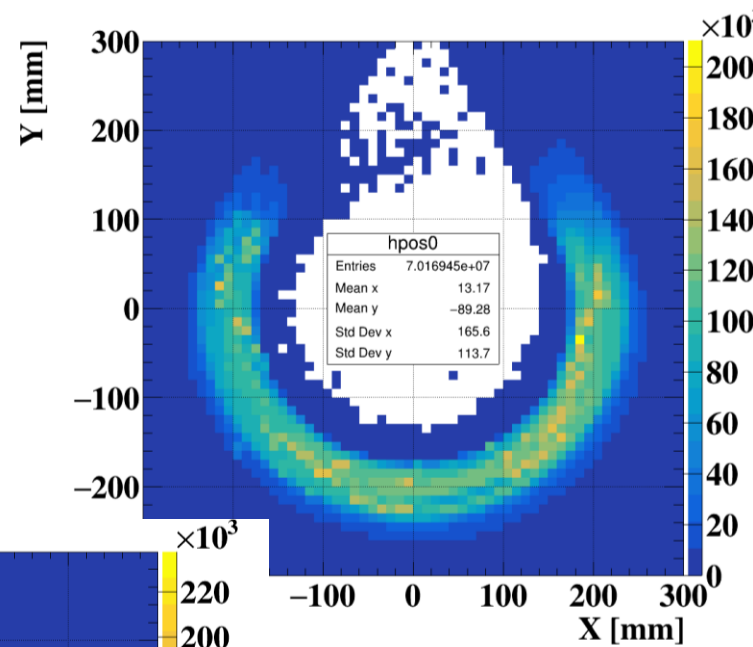
- No issues or worsening found



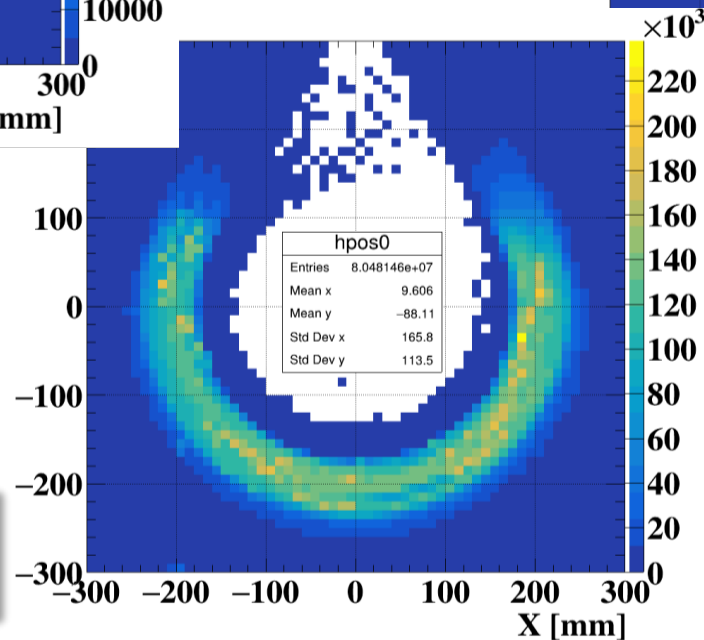
Reconstructed hit XY position



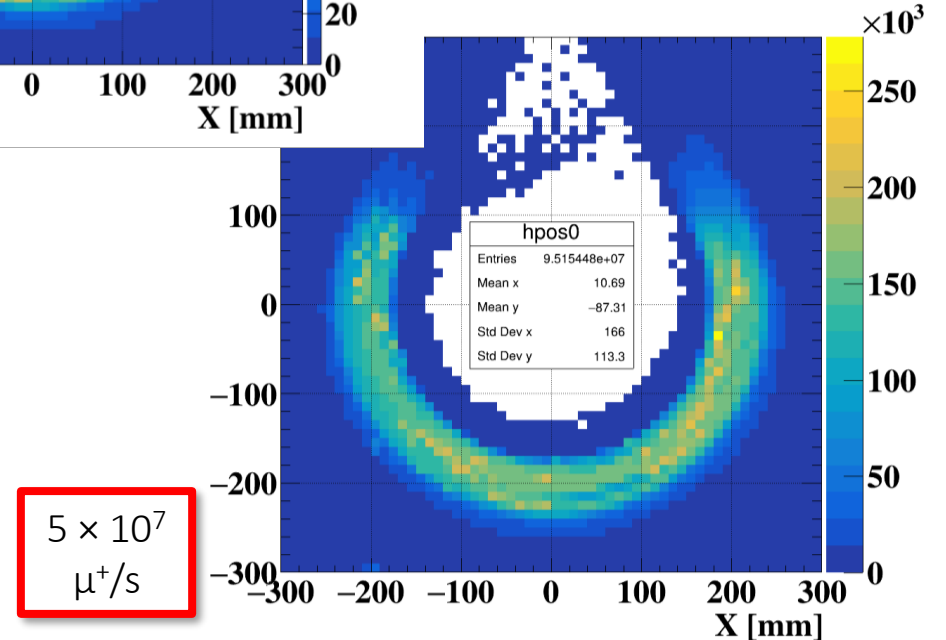
2×10^7
 μ^+/s



3×10^7
 μ^+/s

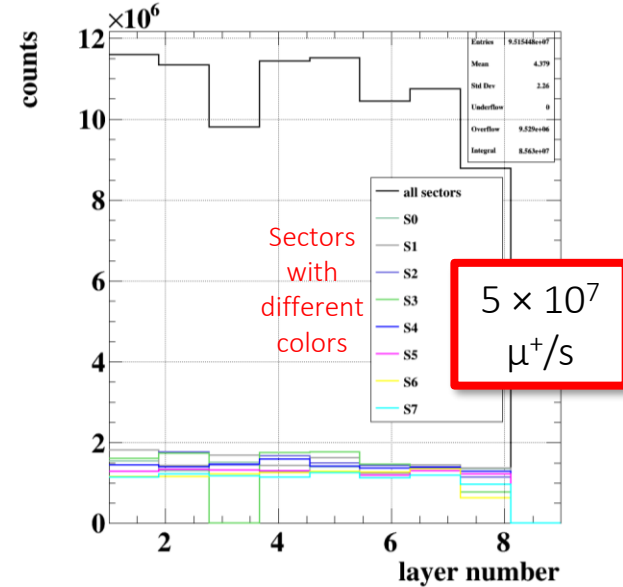
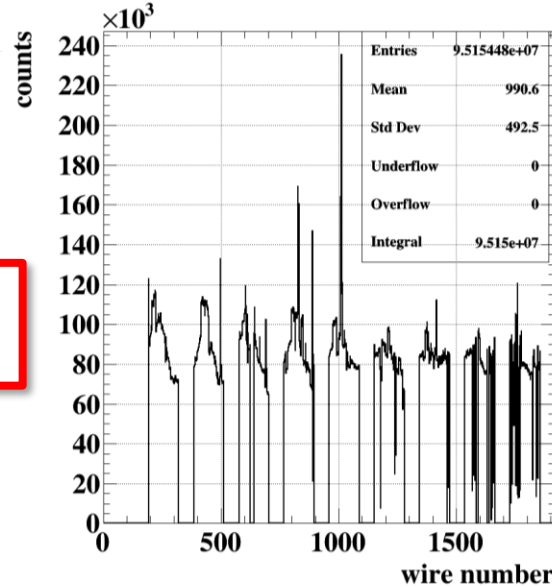
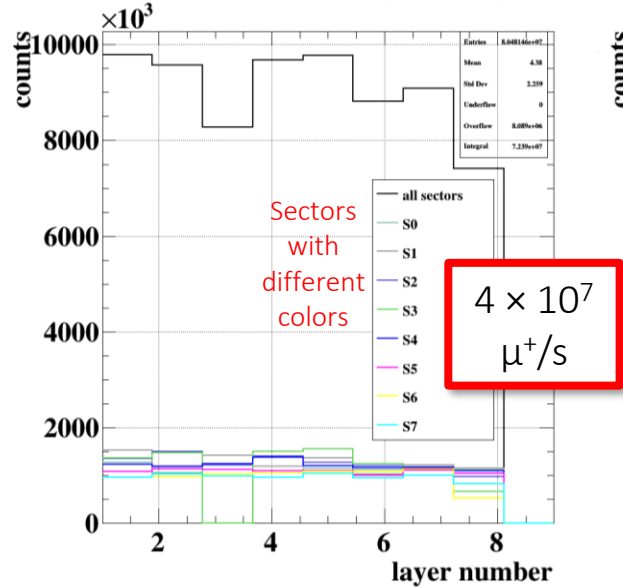
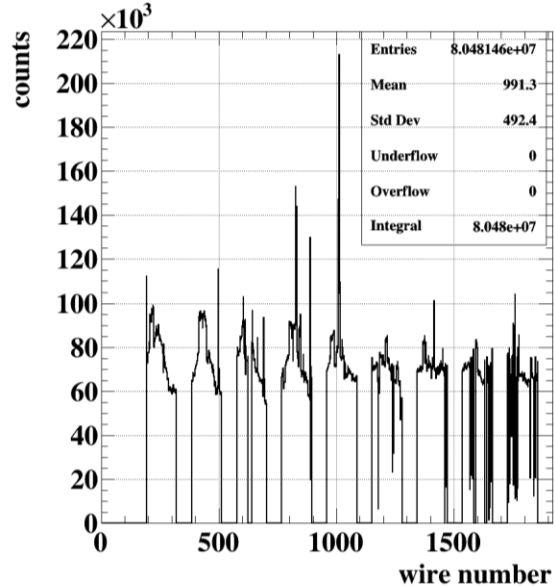
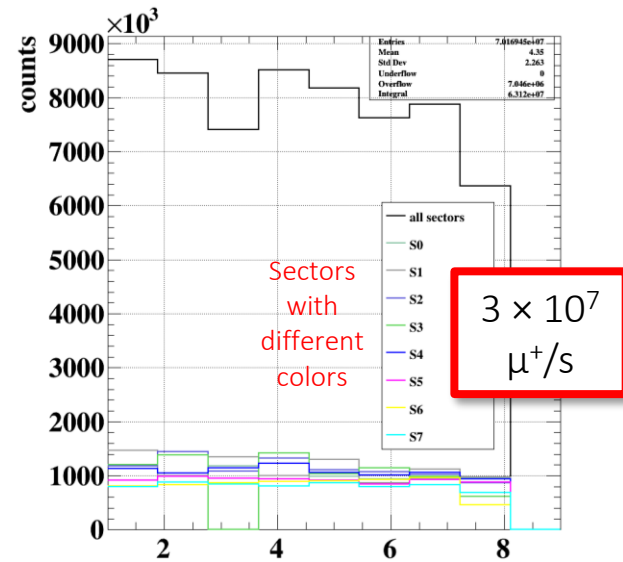
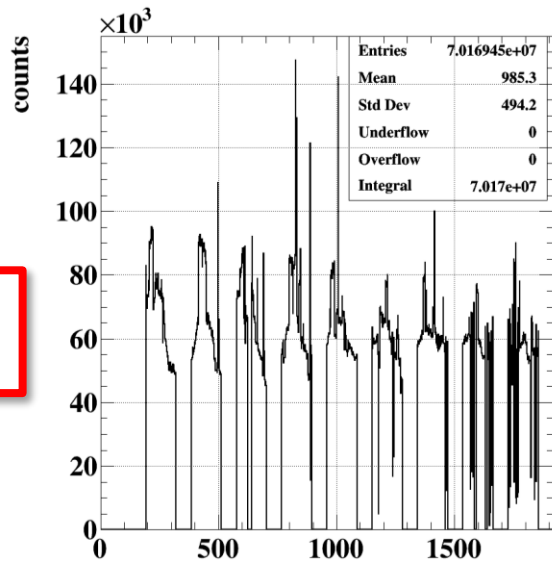
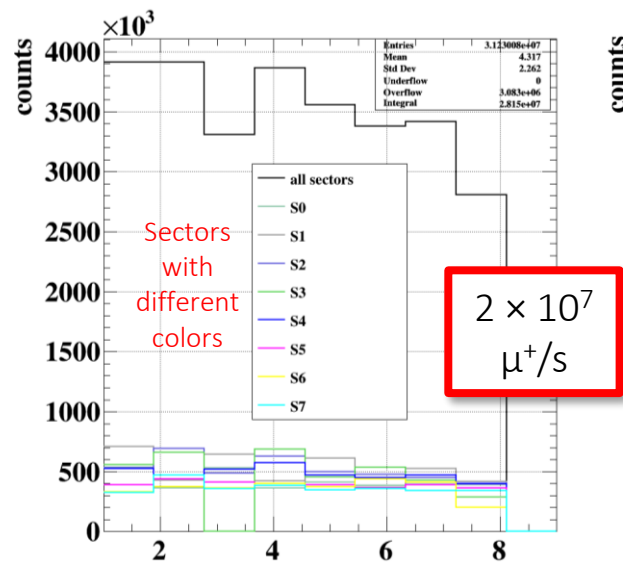
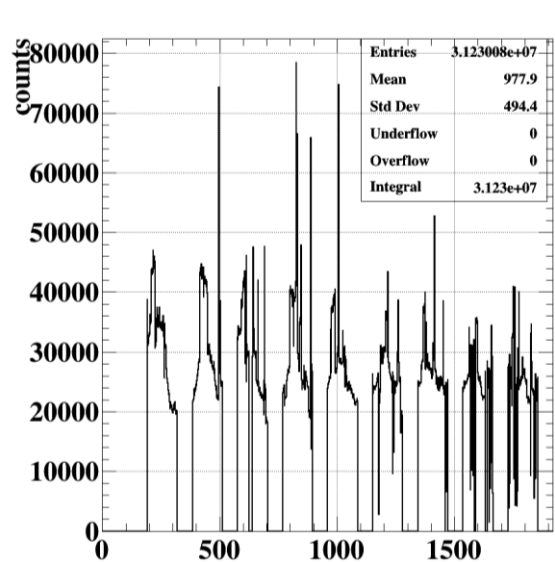


4×10^7
 μ^+/s

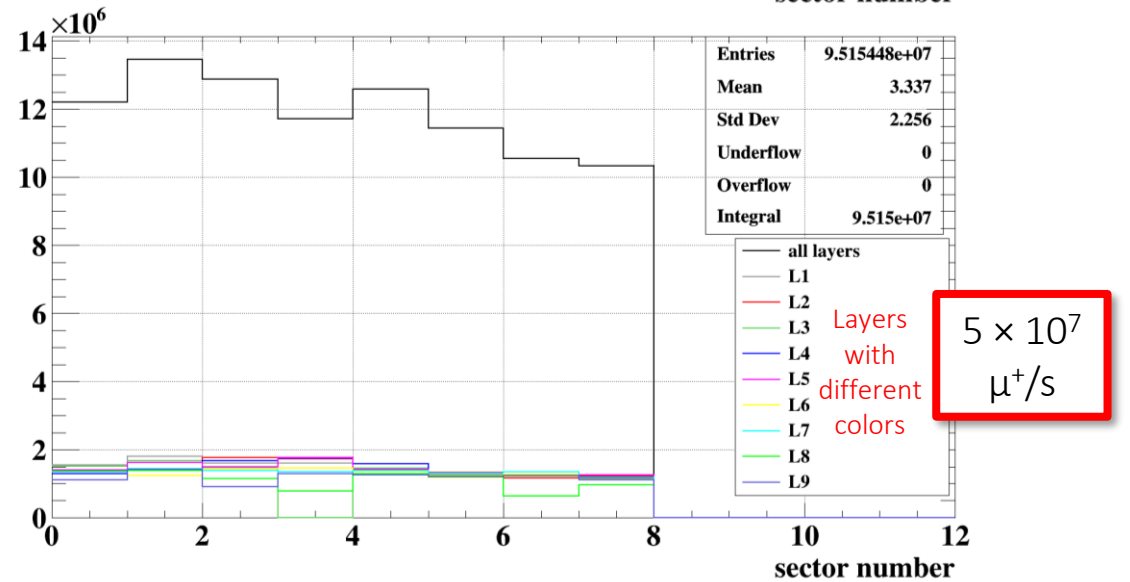
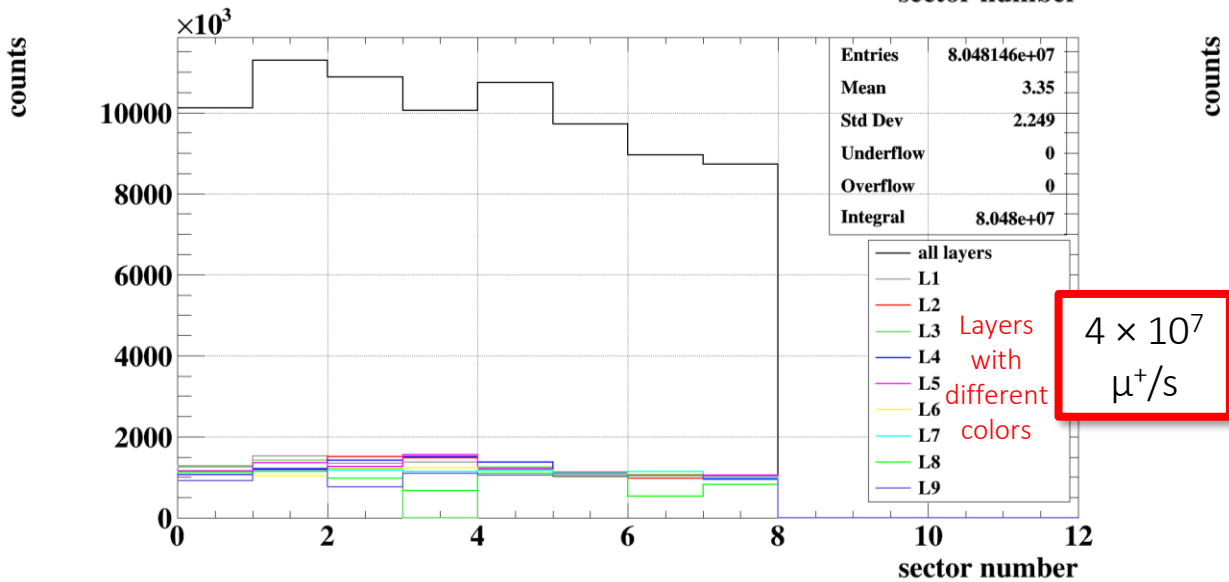
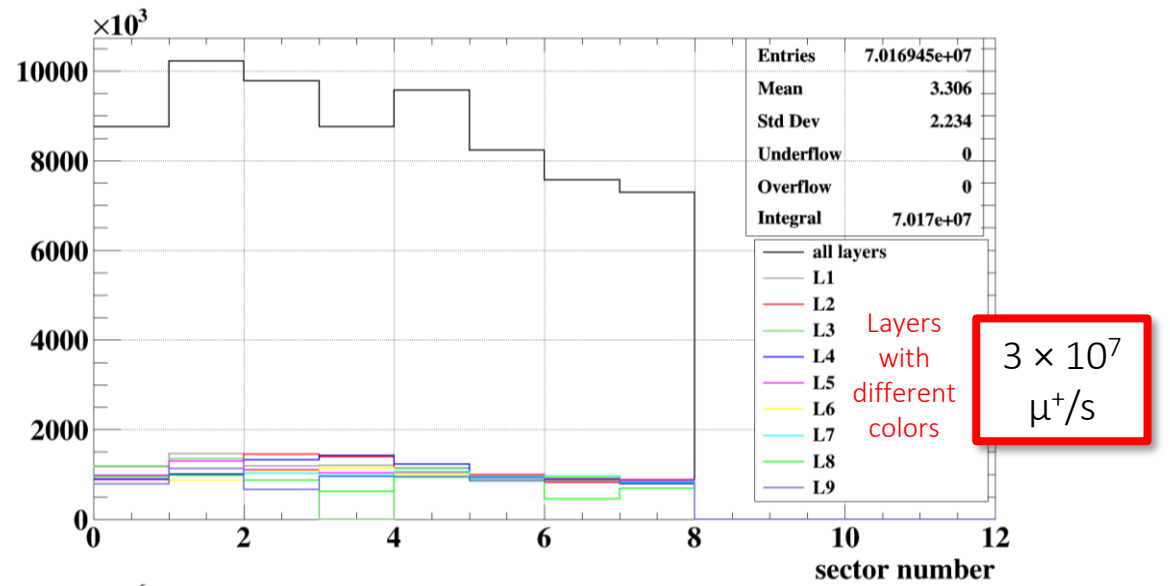
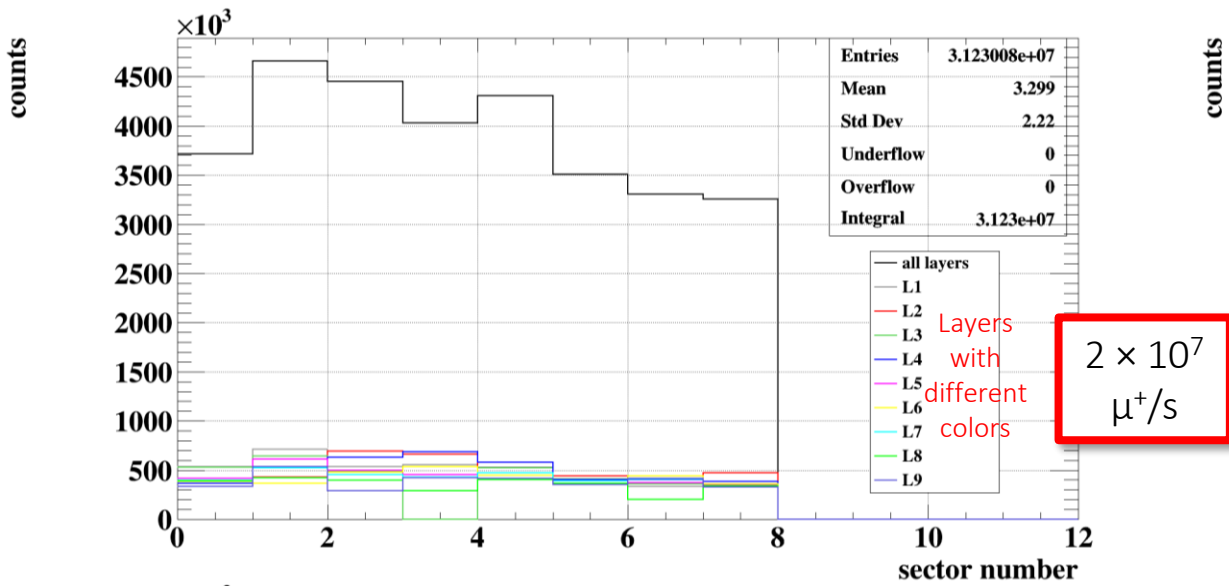


5×10^7
 μ^+/s

Occupancy by wire and layer

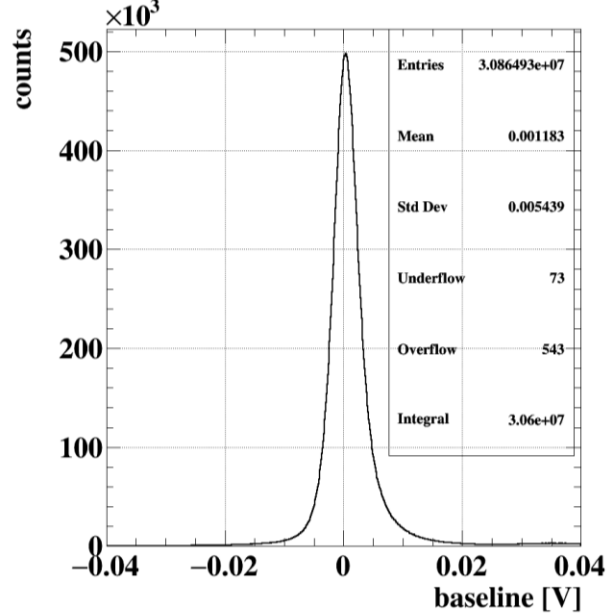


Occupancy by sector



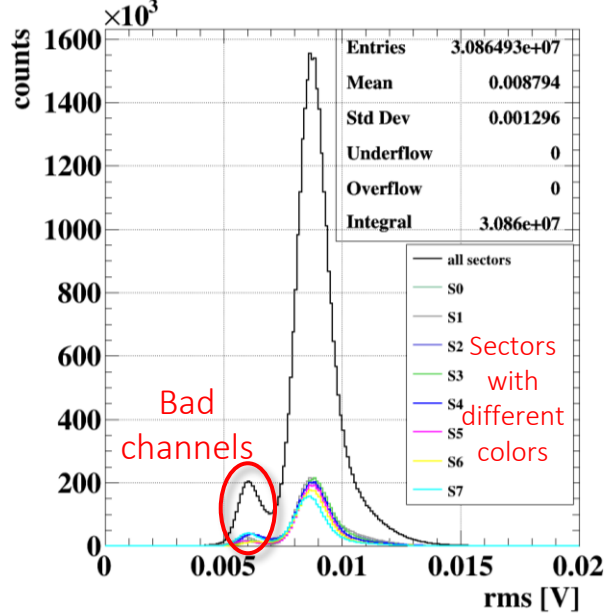
US + DS baseline and RMS

- Mean: 1.2 mV
- RMS: 5.4 mV

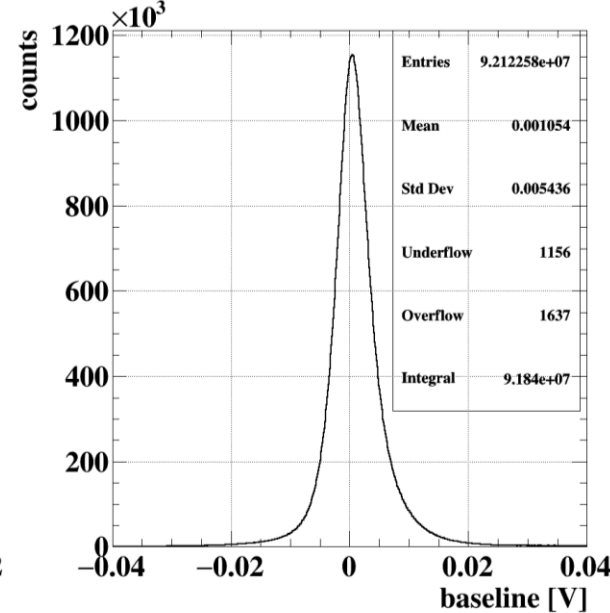


2×10^7
 μ^+/s

- Mean: 8.8 mV
- RMS: 1.3 mV

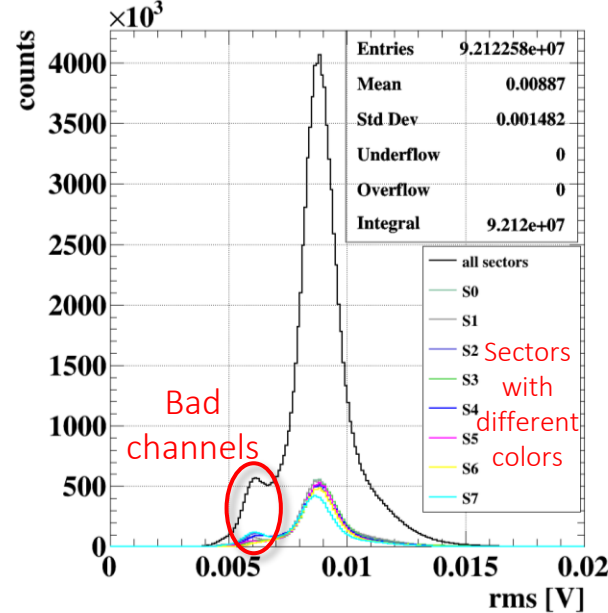


- Mean: 1.1 mV
- RMS: 5.4 mV

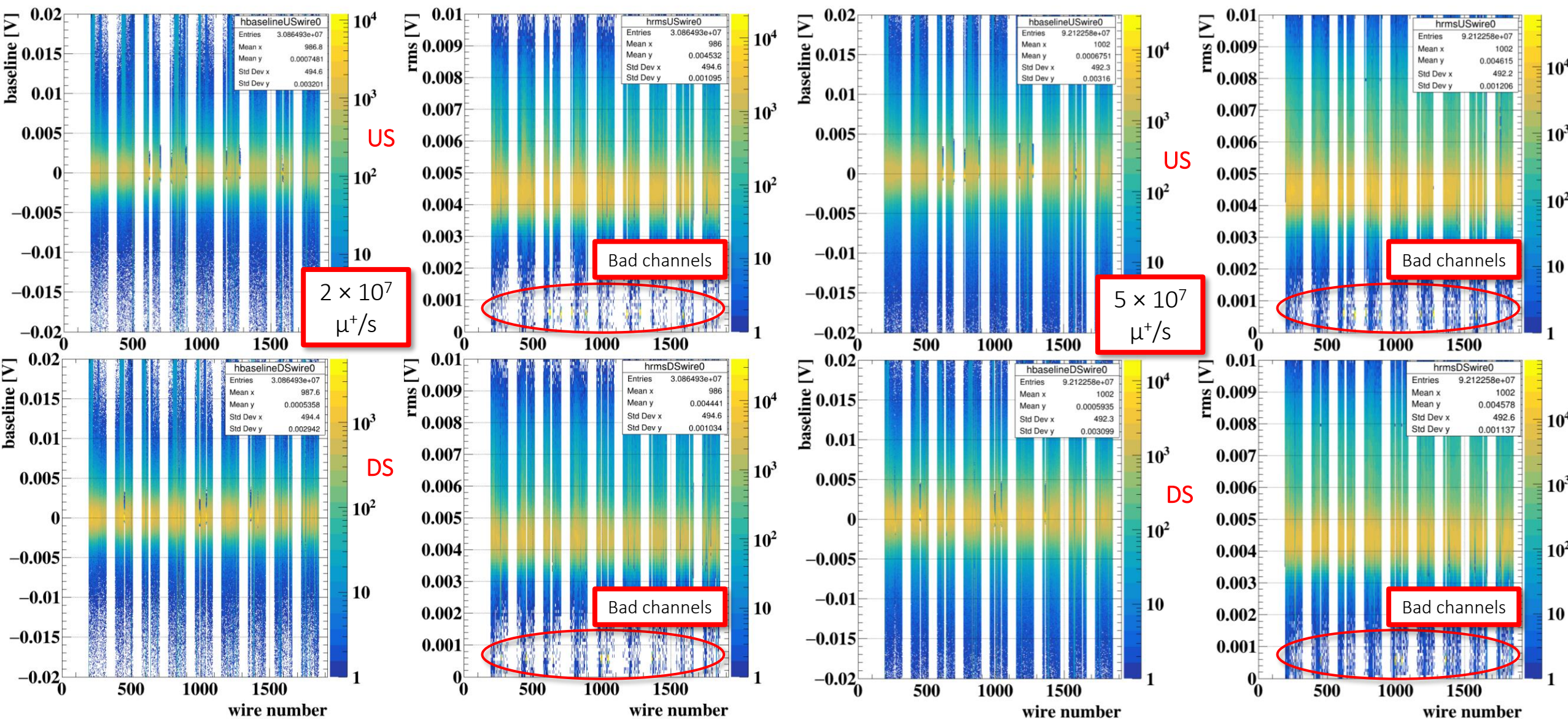


5×10^7
 μ^+/s

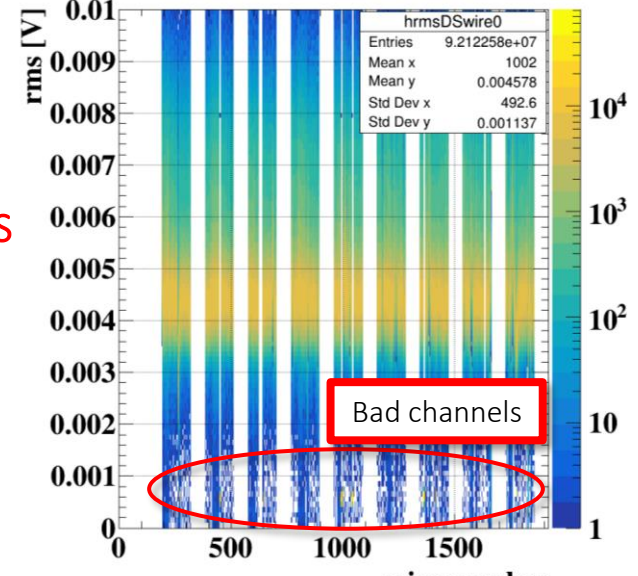
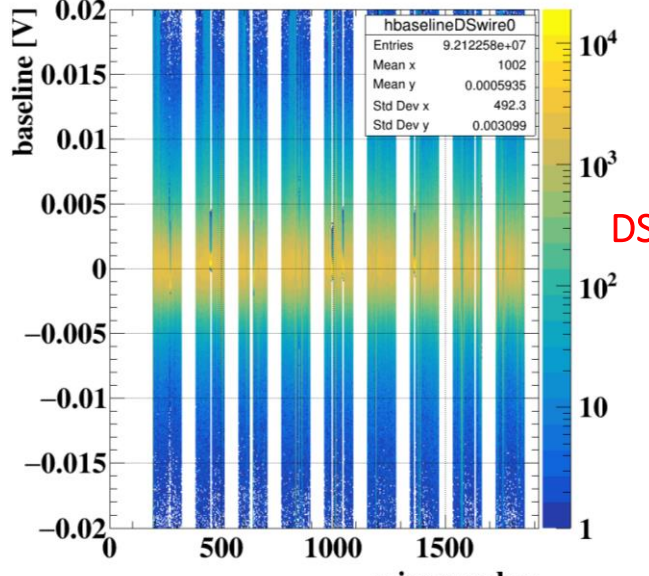
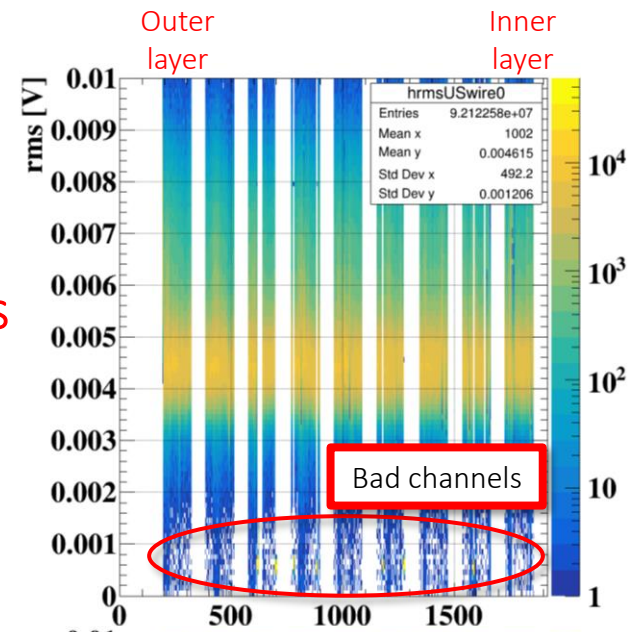
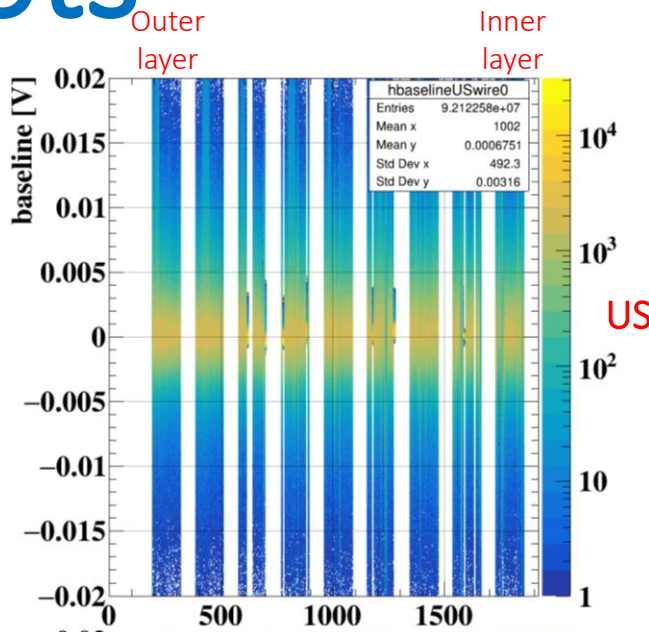
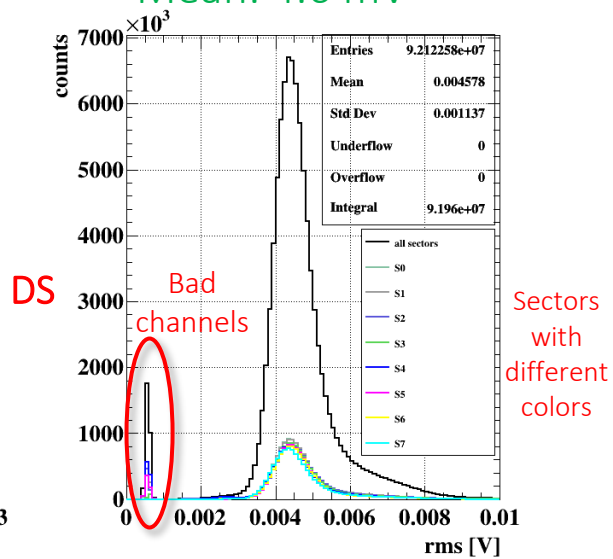
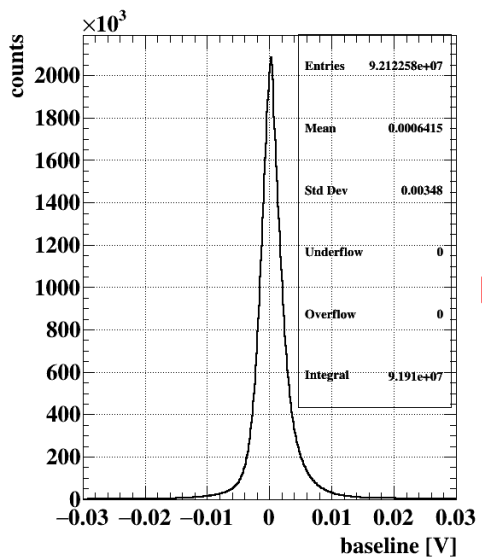
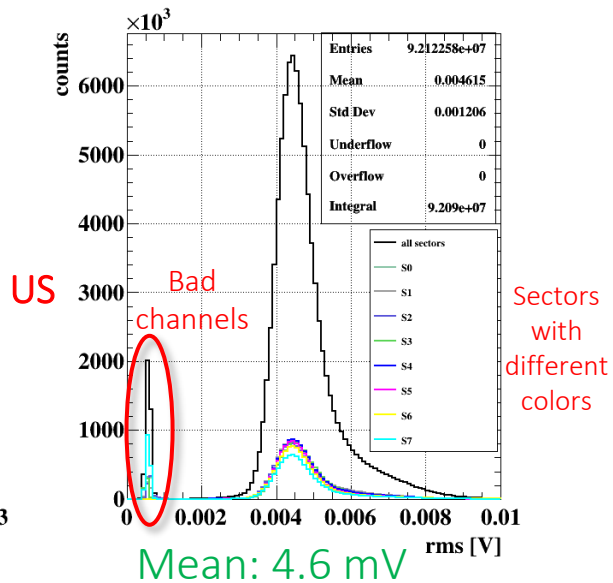
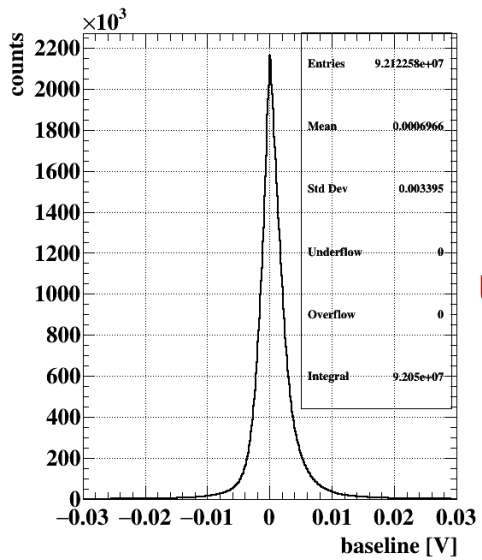
- Mean: 8.9 mV
- RMS: 1.5 mV



Baseline and RMS by wire

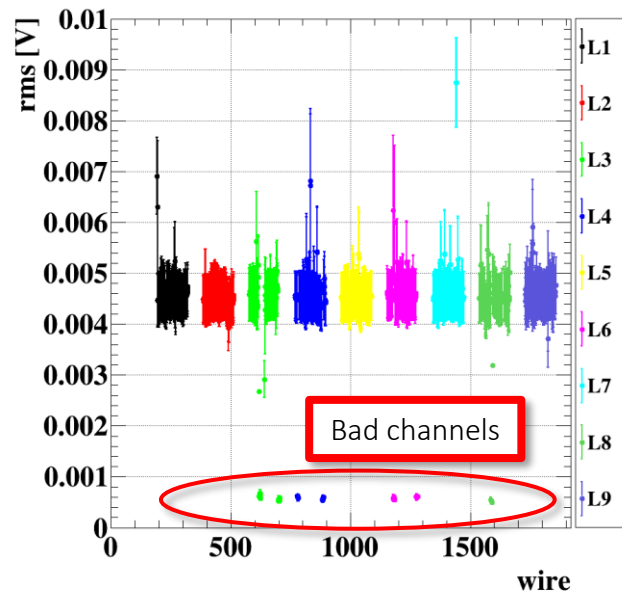


Some diagnostic plots

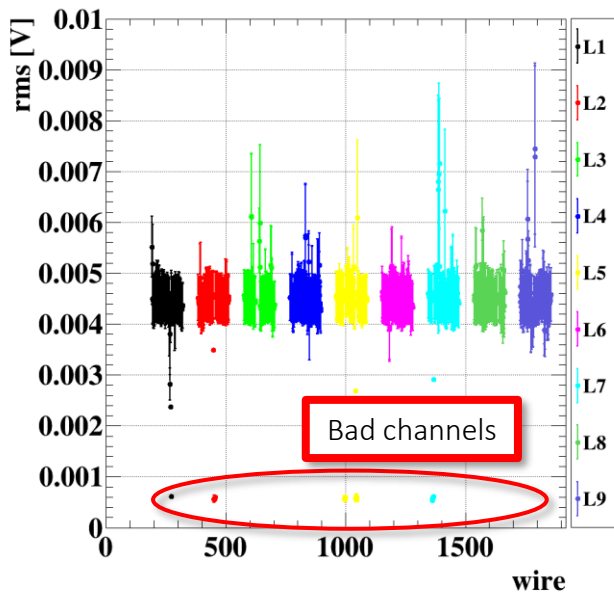


$5 \times 10^7 \mu^+/s$

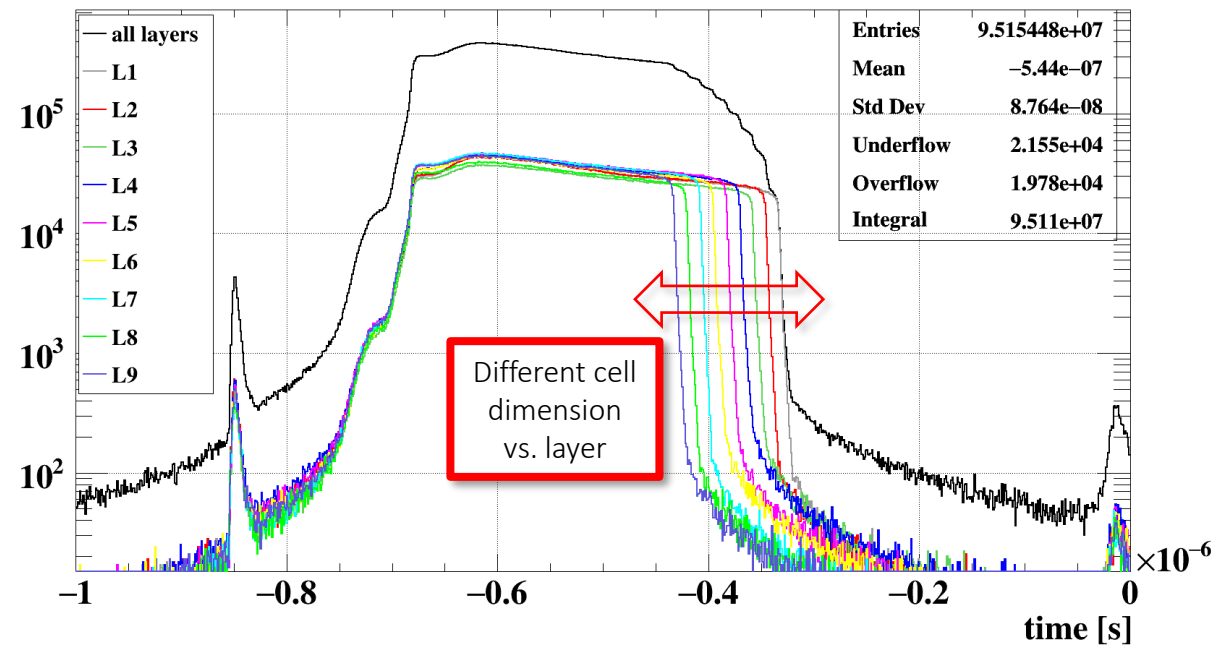
MEG_5e7_WP_isoP_1%5_O2_0%5 US rms vs. wire (mask = 0, runs 404274-404352)



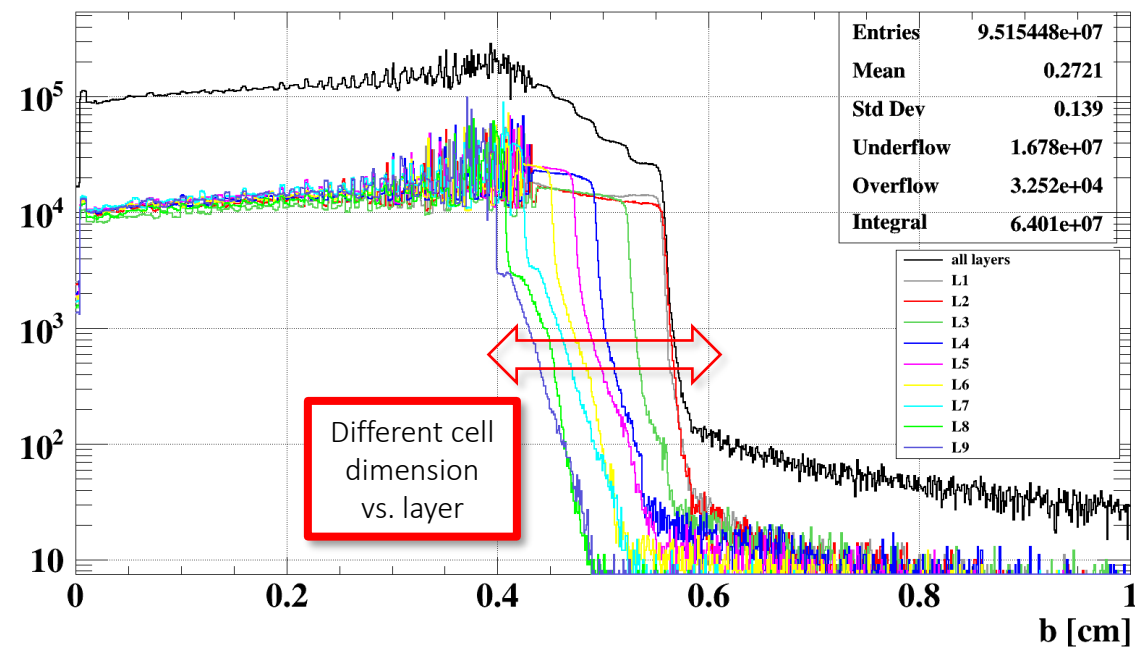
MEG_5e7_WP_isoP_1%5_O2_0%5 DS rms vs. wire (mask = 0, runs 404274-404352)



MEG_5e7_WP_isoP_1%5_O2_0%5 hit time (mask = 0, runs 404274-404352)

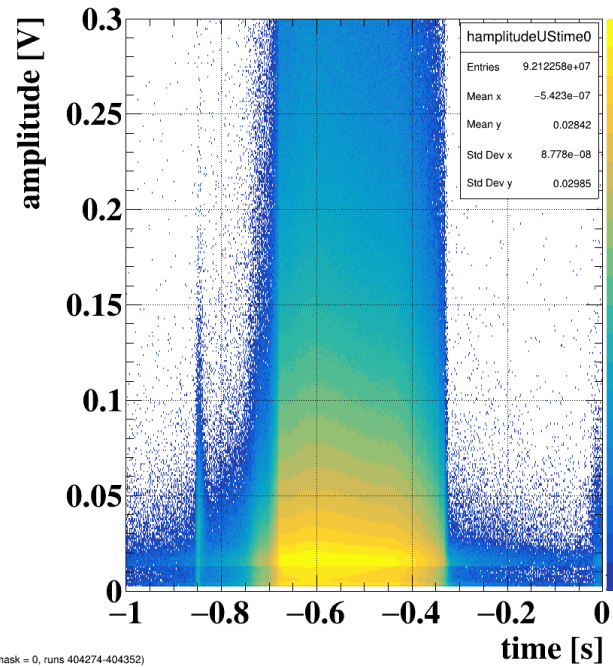


MEG_5e7_WP_isoP_1%5_O2_0%5 impact parameter (mask = 0, runs 404274-404352)

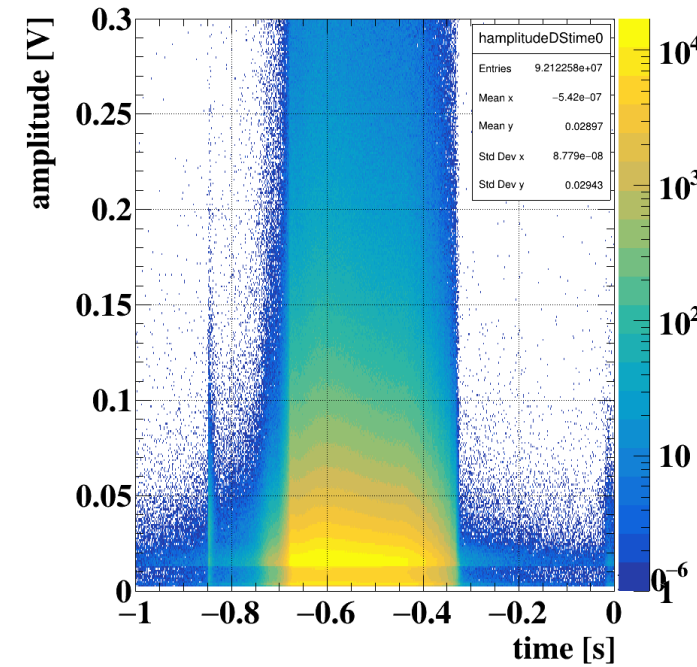


$5 \times 10^7 \mu^+ / s$

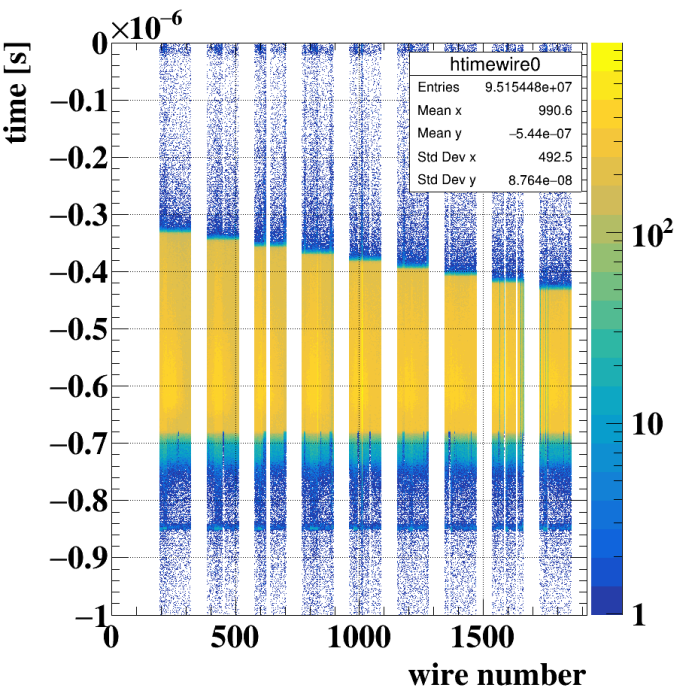
MEG_5e7_WP_isoP_1%5_O2_0%5 US amplitude vs. time (mask = 0, runs 404274-404352)



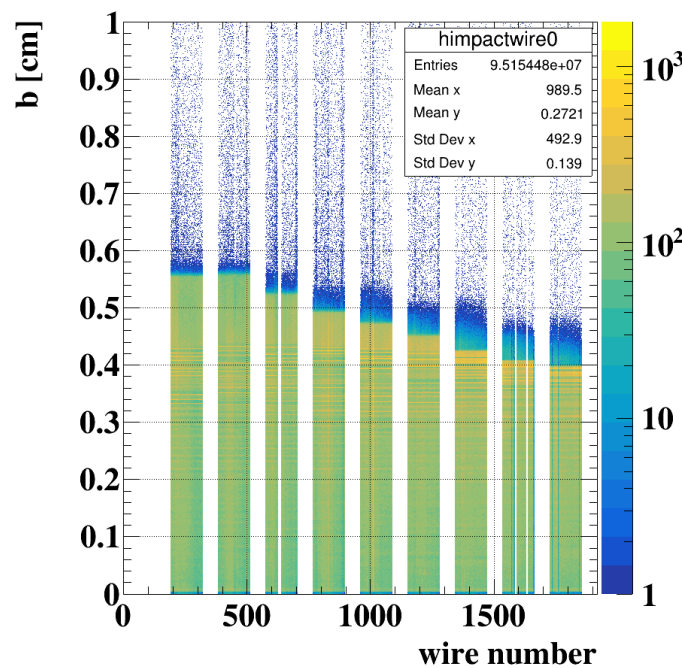
MEG_5e7_WP_isoP_1%5_O2_0%5 DS amplitude vs. time (mask = 0, runs 404274-404352)



MEG_5e7_WP_isoP_1%5_O2_0%5 hit time vs. wire (mask = 0, runs 404274-404352)



MEG_5e7_WP_isoP_1%5_O2_0%5 impact parameter vs. wire (mask = 0, runs 404274-404352)



Preliminary hit resolution

